

8-Pin Flash, 8-Bit Microcontrollers

High-Performance RISC CPU:

- C Compiler Optimized Architecture
- Only 49 Instructions
- · Operating Speed:
 - DC 20 MHz clock input
 - DC 200 ns instruction cycle
- Interrupt Capability with Automatic Context Saving
- 16-Level Deep Hardware Stack with Optional Overflow/Underflow Reset
- Direct, Indirect and Relative Addressing modes:
- Two full 16-bit File Select Registers (FSRs)
- FSRs can read program and data memory

Flexible Oscillator Structure:

- 16 MHz Internal Oscillator Block:
- Factory calibrated to ±1%, typical
- Software selectable frequency range from 16 MHz to 31 kHz
- · 31 kHz Low-Power Internal Oscillator
- Three External Clock modes up to 20 MHz

Special Microcontroller Features:

- Operating Voltage Range:
- 1.8V to 3.6V (PIC12LF1501)
- 2.3V to 5.5V (PIC12F1501)
- Self-Programmable under Software Control
- Power-on Reset (POR)
- Power-up Timer (PWRT)
- Programmable Low-Power Brown-out Reset (LPBOR)
- Extended Watchdog Timer (WDT):
- Programmable period from 1 ms to 256s
- Programmable Code Protection
- In-Circuit Serial Programming[™] (ICSP[™]) via Two Pins
- Enhanced Low-Voltage Programming (LVP)
- In-Circuit Debug (ICD) via Two Pins
- Power-Saving Sleep mode:
 - Low-Power Sleep mode
- Low-Power BOR (LPBOR)
- Integrated Temperature Indicator
- 128 Bytes High-Endurance Flash
- 100,000 write Flash endurance (minimum)

Memory:

- 1 Kwords Linear Program Memory Addressing
- 64 bytes Linear Data Memory Addressing
- High-Endurance Flash Data Memory (HEF)
 - 128 bytes if nonvolatile data storage
 - 100k erase/write cycles

eXtreme Low-Power (XLP) Features (PIC12LF1501):

- Sleep Current:
- 20 nA @ 1.8V, typical
- Watchdog Timer Current:
 260 nA @ 1.8V, typical
- Operating Current:
 - 30 μA/MHz @ 1.8V, typical

Peripheral Features:

- Analog-to-Digital Converter (ADC):
 - 10-bit resolution
 - Four external channels
 - Three internal channels:
 - Fixed Voltage Reference
 - Digital-to-Analog Converter (DAC)
 - Temperature Indicator channel
 - Auto acquisition capability
- Conversion available during Sleep
- 5-Bit Digital-to-Analog Converter (DAC):
 - Output available externally
 - Positive reference selection
 - Internal connections to comparators and ADC
- One Comparator:
 - Rail-to-rail inputs
 - Power mode control
 - Software controllable hysteresis
- Voltage Reference:
 - 1.024V Fixed Voltage Reference (FVR) with 1x, 2x and 4x Gain output levels
- Six I/O Pins (1 Input-only Pin):
 - High current sink/source 25 mA/25 mA
 - Individually programmable weak pull-ups
 - Individually programmable
 - Interrupt-on-Change (IOC) pins
- Timer0: 8-Bit Timer/Counter with 8-Bit Programmable Prescaler
- Enhanced Timer1:
 - 16-bit timer/counter with prescaler
 - External Gate Input mode
- Timer2: 8-Bit Timer/Counter with 8-Bit Period Register, Prescaler and Postscaler
- Four 10-bit PWM modules

Peripheral Features (Continued):

- Two Configurable Logic Cell (CLC) modules:
 - 16 selectable input source signals
 - Four inputs per module
 - Software control of combinational/sequential logic/state/clock functions

PIC12(L)F1501/PIC16(L)F150X FAMILY TYPES

- AND/OR/XOR/D Flop/D Latch/SR/JK
- Inputs from external and internal sources
- Output available to pins and peripherals
- Operation while in Sleep
- Numerically Controlled Oscillator (NCO):
 - 20-bit accumulator
 - 16-bit increment

- True linear frequency control
- High-speed clock input
- Selectable Output modes
 - Fixed Duty Cycle (FDC) mode
 - Pulse Frequency (PF) mode
- Complementary Waveform Generator (CWG):
 - Eight selectable signal sources
 - Selectable falling and rising edge dead-band control
 - Polarity control
 - Four auto-shutdown sources
 - Multiple input sources: PWM, CLC, NCO

Device	Data Sheet Index	Program Memory Flash (words)	Data SRAM (bytes)	I/O's ⁽²⁾	10-bit ADC (ch)	Comparators	DAC	Timers (8/16-bit)	MWA	EUSART	MSSP (I ² C/SPI)	CWG	CLC	NCO	Debug ⁽¹⁾	XLP
PIC12(L)F1501	(1)	1024	64	6	4	1	1	2/1	4	—	—	1	2	1	Н	—
PIC16(L)F1503	(2)	2048	128	12	8	2	1	2/1	4	_	1	1	2	1	Н	_
PIC16(L)F1507	(3)	2048	128	18	12			2/1	4	_	_	1	2	1	Н	_
PIC16(L)F1508	(4)	4096	256	18	12	2	1	2/1	4	1	1	1	4	1	I/H	Y
PIC16(L)F1509	(4)	8192	512	18	12	2	1	2/1	4	1	1	1	4	1	I/H	Y

Note 1: Debugging Methods: (I) - Integrated on Chip; (H) - using Debug Header; (E) - using Emulation Header.
 2: One pin is input-only.

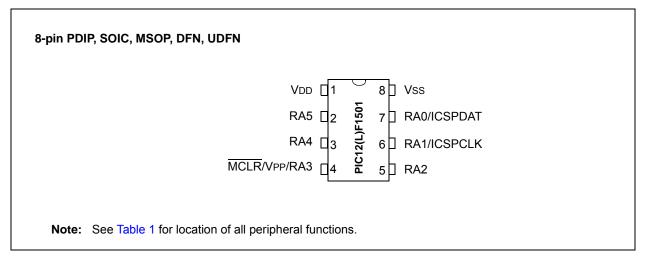
Data Sheet Index: (Unshaded devices are described in this document.)

1: DS40001615 PIC12(L)F1501 Data Sheet, 8-Pin Flash, 8-bit Microcontrollers.

- 2: DS40001607 PIC16(L)F1503 Data Sheet, 14-Pin Flash, 8-bit Microcontrollers.
- 3: DS40001586 PIC16(L)F1507 Data Sheet, 20-Pin Flash, 8-bit Microcontrollers.
- 4: DS40001609 PIC16(L)F1508/9 Data Sheet, 20-Pin Flash, 8-bit Microcontrollers.

Note: For other small form-factor package availability and marking information, please visit http://www.microchip.com/packaging or contact your local sales office.

PIN DIAGRAMS



PIN ALLOCATION TABLE

IADL		• •	IN ALLOU									
OI	8-Pin PDIP/SOIC/MSOP/DFN/UDFN	ADC	Reference	Comparator	Timer	CWG	NCO	CLC	MWG	Interrupt	Pull-Up	Basic
RA0	7	AN0	DACOUT1	C1IN+	—	CWG1B	—	CLC2IN1	PWM2	IOC	Y	ICSPDAT
RA1	6	AN1	VREF+	C1IN0-	—	_	NCO1	CLC2IN0	_	IOC	Y	ICSPCLK
RA2	5	AN2	DACOUT2	C1OUT	TOCKI	CWG1A CWG1FLT	—	CLC1	PWM1	INT IOC	Y	—
RA3	4	_	—		T1G ⁽¹⁾		—	CLC1IN0		IOC	Y	MCLR VPP
RA4	3	AN3	—	C1IN1-	T1G	CWG1B ⁽¹⁾		CLC1 ⁽¹⁾	PWM3	IOC	Y	CLKOUT
RA5	2	_	_	_	T1CKI	CWG1A ⁽¹⁾	NCO1 ⁽¹⁾ NCO1CLK	CLC1IN1 CLC2	PWM4	IOC	Y	CLKIN
Vdd	1	_	_	_	—	-	—	_	_	_	_	Vdd
Vss	8	_	_	—	_	_	—	_	_	_	_	Vss

TABLE 1: 8-PIN ALLOCATION TABLE (PIC12(L)F1501)

Note 1: Alternate pin function selected with the APFCON (Register 11-1) register.

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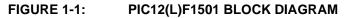
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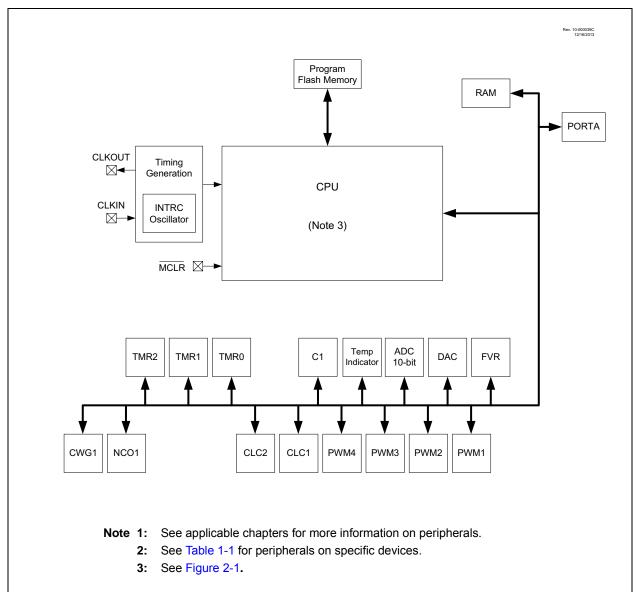
1.0 DEVICE OVERVIEW

The block diagram of these devices are shown in Figure 1-1, the available peripherals are shown in Table 1-1, and the pinout descriptions are shown in Table 1-2.

TABLE 1-1: DEVICE PERIPHERAL SUMMARY

Peripheral		PIC12(L)F1501	PIC16(L)F1503	PIC16(L)F1507	PIC16(L)F1508	PIC16(L)F1509
Analog-to-Digital Converter (A	-	•	•	•	•	•
Complementary Wave Generation		•	•	•	•	•
Digital-to-Analog Converter (I	DAC)	•	•		•	•
Enhanced Universal Synchronous/Asynchronous Transmitter (EUSART)	Receiver/				•	•
Fixed Voltage Reference (FV	R)	•	٠	•	٠	•
Numerically Controlled Oscill	ator (NCO)	•	•	•	•	•
Temperature Indicator		•	•	•	٠	•
Comparators						
	C1	•	•		•	•
	C2		•		•	•
Configurable Logic Cell (CLC)					
	CLC1	•	•	•	•	•
	CLC2	•	•	•	•	•
	CLC3				•	•
	CLC4				•	•
Master Synchronous Serial P	orts					
	MSSP1		•		•	•
PWM Modules						
	PWM1	•	•	•	•	•
	PWM2	•	•	•	•	•
	PWM3	•	•	•	٠	•
	PWM4	•	•	•	٠	•
Timers						
	Timer0	•	•	•	•	•
	Timer1	•	•	•	•	•
	Timer2	•	•	•	٠	•





Name	Function	Input Type	Output Type	Description
RA0/AN0/C1IN+/DACOUT1/	RA0	TTL	CMOS	General purpose I/O.
CWG1B ⁽¹⁾ /CLC2IN1/PWM2/	AN0	AN	_	A/D Channel input.
CSPDAT	C1IN+	AN	_	Comparator positive input.
	DACOUT1	_	AN	Digital-to-Analog Converter output.
	CWG1B	_	CMOS	CWG complementary output.
	CLC2IN1	ST	_	Configurable Logic Cell source input.
	PWM2		CMOS	Pulse Width Module source output.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
RA1/AN1/VREF+/C1IN0-/	RA1	TTL	CMOS	General purpose I/O.
NCO1 ⁽¹⁾ /CLC2IN0/ICSPCLK	AN1	AN	_	A/D Channel input.
	VREF+	AN	_	A/D Positive Voltage Reference input.
	C1IN0-	AN		Comparator negative input.
	NCO1	_	CMOS	Numerically Controlled Oscillator output.
	CLC2IN0	ST	_	Configurable Logic Cell source input.
	ICSPCLK	ST	_	ICSP™ Programming Clock.
RA2/AN2/C1OUT/DACOUT2/	RA2	ST	CMOS	General purpose I/O.
TOCKI/INT/PWM1/CLC1 ⁽¹⁾ /	AN2	AN	_	A/D Channel input.
CWG1A ⁽¹⁾ /CWG1FLT	C10UT		CMOS	Comparator output.
	DACOUT2 —		AN	Digital-to-Analog Converter output.
	TOCKI	ST	_	Timer0 clock input.
	INT	ST	_	External interrupt.
	PWM1		CMOS	Pulse Width Module source output.
	CLC1	_	CMOS	Configurable Logic Cell source output.
	CWG1A	_	CMOS	CWG complementary output.
	CWG1FLT	ST	_	Complementary Waveform Generator Fault input.
RA3/CLC1IN0/VPP/T1G ⁽¹⁾ /MCLR	RA3	TTL	_	General purpose input.
	CLC1IN0	ST	_	Configurable Logic Cell source input.
	Vpp	HV		Programming voltage.
	T1G	ST		Timer1 Gate input.
	MCLR	ST		Master Clear with internal pull-up.
RA4/AN3/C1IN1-/CWG1B ⁽¹⁾ /	RA4	TTL	CMOS	General purpose I/O.
CLC1 ⁽¹⁾ /PWM3/CLKOUT/T1G ⁽¹⁾	AN3	AN		A/D Channel input.
	C1IN1-	AN		Comparator negative input.
	CWG1B	_	CMOS	CWG complementary output.
	CLC1	_	CMOS	Configurable Logic Cell source output.
	PWM3		CMOS	Pulse Width Module source output.
	CLKOUT	_	CMOS	Fosc/4 output.

TABLE 1-2. PIC12(I)F1501 PINOUT DESCRIPTION

Note 1: Alternate pin function selected with the APFCON (Register 11-1) register.

PIC12(L)F1501 PINOUT DESCRIPTION (CONTINUED) **TABLE 1-2:**

Name	Function Typ		Output Type	Description
RA5/CLKIN/T1CKI/CWG1A ⁽¹⁾ /	RA5	TTL	CMOS	General purpose I/O.
NCO1 ⁽¹⁾ /NCO1CLK/CLC1IN1/	CLKIN	CMOS	_	External clock input (EC mode).
CLC2/PWM4	T1CKI	T1CKI ST — Timer1 clock input.		Timer1 clock input.
	CWG1A	—	CMOS	CWG complementary output.
	NCO1	ST	_	Numerically Controlled Oscillator output.
	NCO1CLK	ST		Numerically Controlled Oscillator Clock source input.
	CLC1IN1	ST	_	Configurable Logic Cell source input.
	CLC2	_	CMOS	Configurable Logic Cell source output.
	PWM4	—	CMOS	Pulse Width Module source output.
VDD	Vdd	Power		Positive supply.
Vss	Vss	Power	_	Ground reference.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain

TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I²C[™] = Schmitt Trigger input with I²C levels

HV = High Voltage XTAL = Crystal

Note 1: Alternate pin function selected with the APFCON (Register 11-1) register.

2.0 ENHANCED MID-RANGE CPU

This family of devices contain an enhanced mid-range 8-bit CPU core. The CPU has 49 instructions. Interrupt capability includes automatic context saving. The hardware stack is 16 levels deep and has Overflow and Underflow Reset capability. Direct, Indirect, and Relative addressing modes are available. Two File Select Registers (FSRs) provide the ability to read program and data memory.

- · Automatic Interrupt Context Saving
- · 16-level Stack with Overflow and Underflow
- · File Select Registers
- Instruction Set

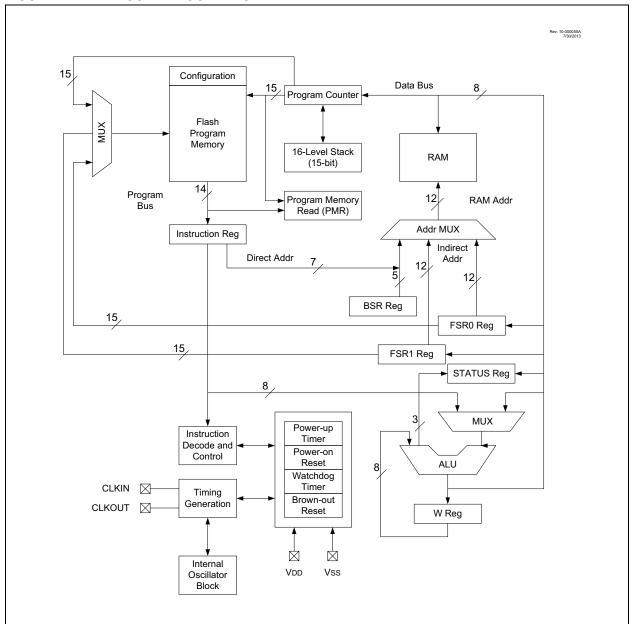


FIGURE 2-1: CORE BLOCK DIAGRAM

2.1 Automatic Interrupt Context Saving

During interrupts, certain registers are automatically saved in shadow registers and restored when returning from the interrupt. This saves stack space and user code. See **Section 7.5 "Automatic Context Saving"**, for more information.

2.2 16-Level Stack with Overflow and Underflow

These devices have a hardware stack memory 15 bits wide and 16 words deep. A Stack Overflow or Underflow will set the appropriate bit (STKOVF or STKUNF) in the PCON register, and if enabled, will cause a software Reset. See Section 3.5 "Stack" for more details.

2.3 File Select Registers

There are two 16-bit File Select Registers (FSR). FSRs can access all file registers and program memory, which allows one Data Pointer for all memory. When an FSR points to program memory, there is one additional instruction cycle in instructions using INDF to allow the data to be fetched. General purpose memory can now also be addressed linearly, providing the ability to access contiguous data larger than 80 bytes. There are also new instructions to support the FSRs. See **Section 3.6 "Indirect Addressing"** for more details.

2.4 Instruction Set

There are 49 instructions for the enhanced mid-range CPU to support the features of the CPU. See **Section 26.0 "Instruction Set Summary**" for more details.

3.0 MEMORY ORGANIZATION

These devices contain the following types of memory:

- Program Memory
 - Configuration Words
 - Device ID
 - User ID
 - Flash Program Memory
- Data Memory
 - Core Registers
 - Special Function Registers
 - General Purpose RAM
 - Common RAM

The following features are associated with access and control of program memory and data memory:

- PCL and PCLATH
- Stack
- Indirect Addressing

3.1 Program Memory Organization

The enhanced mid-range core has a 15-bit program counter capable of addressing a $32K \times 14$ program memory space. Table 3-1 shows the memory sizes implemented. Accessing a location above these boundaries will cause a wrap-around within the implemented memory space. The Reset vector is at 0000h and the interrupt vector is at 0004h (See Figure 3-1).

3.2 High-Endurance Flash

This device has a 128 byte section of high-endurance program Flash memory (PFM) in lieu of data EEPROM. This area is especially well suited for nonvolatile data storage that is expected to be updated frequently over the life of the end product. See Section 10.2 "Flash **Program Memory Overview**" for more information on writing data to PFM. See Section 3.2.1.2 "Indirect Read with FSR" for more information about using the FSR registers to read byte data stored in PFM.

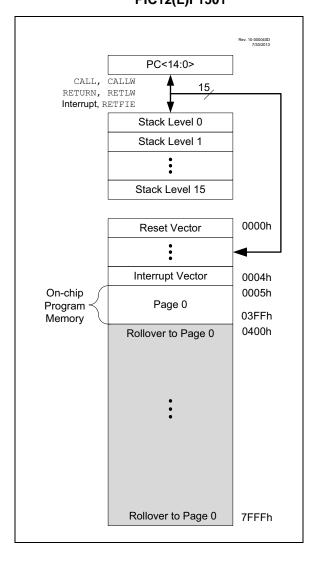
TABLE 3-1: DEVICE SIZES AND ADDRESSES

Device	Program Memory	Last Program Memory	High-Endurance Flash	
	Space (Words)	Address	Memory Address Range ⁽¹⁾	
PIC12LF1501 PIC12F1501	1,024	03FFh	0380h-03FFh	

Note 1: High-endurance Flash applies to low byte of each address in the range.

FIGURE 3-1:

PROGRAM MEMORY MAP AND STACK FOR PIC12(L)F1501



3.2.1 READING PROGRAM MEMORY AS DATA

There are two methods of accessing constants in program memory. The first method is to use tables of RETLW instructions. The second method is to set an FSR to point to the program memory.

3.2.1.1 RETLW Instruction

The RETLW instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 3-1.

EXAMPLE 3-1:	RETLW INSTRUCTION
constants	
BRW	;Add Index in W to
	;program counter to
	;select data
RETLW DATA0	;Index0 data
RETLW DATA1	;Index1 data
RETLW DATA2	
RETLW DATA3	
my_function	
; LOTS OF CO	DE
MOVLW DA	TA_INDEX
call constant	S
; THE CONSTA	NT IS IN W

The BRW instruction makes this type of table very simple to implement. If your code must remain portable with previous generations of microcontrollers, then the BRW instruction is not available so the older table read method must be used.

3.2.1.2 Indirect Read with FSR

The program memory can be accessed as data by setting bit 7 of the FSRxH register and reading the matching INDFx register. The MOVIW instruction will place the lower eight bits of the addressed word in the W register. Writes to the program memory cannot be performed via the INDF registers. Instructions that access the program memory via the FSR require one extra instruction cycle to complete. Example 3-2 demonstrates accessing the program memory via an FSR.

The HIGH operator will set bit<7> if a label points to a location in program memory.

EXAMPLE 3-2: ACCESSING PROGRAM MEMORY VIA FSR

constants	\$	
DW DATA	70	;First constant
DW DATA	41	;Second constant
DW DATA	42	
DW DATA	43	
my_functi	.on	
; LOTS	5 OF CODE	
MOVLW	DATA_INDEX	
ADDLW	LOW constants	
MOVWF	FSR1L	
MOVLW	HIGH constant	s;MSb sets
		automatically
MOVWF	FSR1H	
BTFSC	STATUS, C	;carry from ADDLW?
INCF	FSR1h, f	;yes
MOVIW	0[FSR1]	
;THE PROG	RAM MEMORY IS	IN W

3.3 Data Memory Organization

The data memory is partitioned in 32 memory banks with 128 bytes in a bank. Each bank consists of (Figure 3-2):

- 12 core registers
- 20 Special Function Registers (SFR)
- Up to 80 bytes of General Purpose RAM (GPR)
- 16 bytes of common RAM

The active bank is selected by writing the bank number into the Bank Select Register (BSR). Unimplemented memory will read as '0'. All data memory can be accessed either directly (via instructions that use the file registers) or indirectly via the two File Select Registers (FSR). See Section 3.6 "Indirect Addressing" for more information.

Data memory uses a 12-bit address. The upper five bits of the address define the Bank address and the lower seven bits select the registers/RAM in that bank.

3.3.1 CORE REGISTERS

The core registers contain the registers that directly affect the basic operation. The core registers occupy the first 12 addresses of every data memory bank (addresses x00h/x08h through x0Bh/x8Bh). These registers are listed below in Table 3-2. For detailed information, see Table 3-4.

TABLE 3-2:	CORE REGISTERS

Addresses	BANKx
x00h or x80h	INDF0
x01h or x81h	INDF1
x02h or x82h	PCL
x03h or x83h	STATUS
x04h or x84h	FSR0L
x05h or x85h	FSR0H
x06h or x86h	FSR1L
x07h or x87h	FSR1H
x08h or x88h	BSR
x09h or x89h	WREG
x0Ah or x8Ah	PCLATH
k0Bh or x8Bh	INTCON

3.3.1.1 STATUS Register

The STATUS register, shown in Register 3-1, contains:

- the arithmetic status of the ALU
- · the Reset status

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the TO and PD bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

REGISTER 3-1: STATUS: STATUS REGISTER

For example, CLRF STATUS will clear the upper three bits and set the Z bit. This leaves the STATUS register as '000u uluu' (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect any Status bits. For other instructions not affecting any Status bits (Refer to Section 26.0 "Instruction Set Summary").

Note 1: The <u>C</u> and <u>DC</u> bits operate as Borrow and <u>Digit</u> Borrow out bits, respectively, in subtraction.

U-0	U-0	U-0	R-1/q	R-1/q	R/W-0/u	R/W-0/u	R/W-0/u		
_	—	_	TO	PD	Z	DC ⁽¹⁾	C ⁽¹⁾		
bit 7 bit									
Legend:									
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'					
u = Bit is unchanged x =		x = Bit is unkn	iown	-n/n = Value at POR and BOR/Value at all other Resets					
'1' = Bit is set		'0' = Bit is clea	ared	q = Value der	pends on condit	ion			

bit 7-5	Unimplemented: Read as '0'
bit 4	TO: Time-Out bit
	 1 = After power-up, CLRWDT instruction or SLEEP instruction 0 = A WDT time-out occurred
bit 3	PD: Power-Down bit
	 1 = After power-up or by the CLRWDT instruction 0 = By execution of the SLEEP instruction
bit 2	Z: Zero bit
	 1 = The result of an arithmetic or logic operation is zero 0 = The result of an arithmetic or logic operation is not zero
bit 1	DC: Digit Carry/Digit Borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions) ⁽¹⁾
	 1 = A carry-out from the 4th low-order bit of the result occurred 0 = No carry-out from the 4th low-order bit of the result
bit 0	C: Carry/Borrow bit ⁽¹⁾ (ADDWF, ADDLW, SUBLW, SUBWF instructions) ⁽¹⁾
	 1 = A carry-out from the Most Significant bit of the result occurred 0 = No carry-out from the Most Significant bit of the result occurred
Note 1:	For Borrow, the polarity is reversed. A subtraction is executed by adding the two's complement of the

Note 1: For Borrow, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high-order or low-order bit of the source register.

3.3.2 SPECIAL FUNCTION REGISTER

The Special Function Registers are registers used by the application to control the desired operation of peripheral functions in the device. The Special Function Registers occupy the 20 bytes after the core registers of every data memory bank (addresses x0Ch/x8Ch through x1Fh/x9Fh). The registers associated with the operation of the peripherals are described in the appropriate peripheral chapter of this data sheet.

3.3.3 GENERAL PURPOSE RAM

There are up to 80 bytes of GPR in each data memory bank. The Special Function Registers occupy the 20 bytes after the core registers of every data memory bank (addresses x0Ch/x8Ch through x1Fh/x9Fh).

3.3.3.1 Linear Access to GPR

The general purpose RAM can be accessed in a non-banked method via the FSRs. This can simplify access to large memory structures. See **Section 3.6.2** "Linear Data Memory" for more information.

3.3.4 COMMON RAM

There are 16 bytes of common RAM accessible from all banks.

FIGURE 3-2: BANKED MEMORY PARTITIONING

	Rev. 10-00 7/30
7-bit Bank Offset	Memory Region
00h 0Bh	Core Registers (12 bytes)
0Ch 1Fh	Special Function Registers (20 bytes maximum)
6Fh	General Purpose RAM (80 bytes maximum)
70h 7Fh	Common RAM (16 bytes)

3.3.5 DEVICE MEMORY MAPS

The memory maps for Bank 0 through Bank 31 are shown in the tables in this section.

TABLE 3-3: PIC12(L)F1501 MEMORY MAP

	BANK 0	•	BANK 1		BANK 2		BANK 3		BANK 4		BANK 5		BANK 6		BANK 7
000h		080h		100h		180h		200h		280h		300h		380h	
	Core Registers (Table 3-2)		Core Registers (Table 3-2)		Core Registers (Table 3-2)		Core Registers (Table 3-2)		Core Registers (Table 3-2)		Core Registers (Table 3-2)		Core Registers (Table 3-2)		Core Registers (Table 3-2)
00Bh		08Bh		10Bh		18Bh		20Bh		28Bh		30Bh		38Bh	
00Ch	PORTA	08Ch	TRISA	10Ch	LATA	18Ch	ANSELA	20Ch	WPUA	28Ch	—	30Ch	_	38Ch	_
00Dh	_	08Dh		10Dh	_	18Dh	_	20Dh	_	28Dh	_	30Dh	—	38Dh	_
00Eh	_	08Eh	_	10Eh	—	18Eh	-	20Eh	—	28Eh	_	30Eh	_	38Eh	—
00Fh	—	08Fh	_	10Fh	_	18Fh	—	20Fh	_	28Fh	—	30Fh	_	38Fh	_
010h	—	090h	_	110h	_	190h		210h		290h	_	310h	_	390h	_
011h	PIR1	091h	PIE1	111h	CM1CON0	191h	PMADRL	211h	—	291h	—	311h	—	391h	IOCAP
012h	PIR2	092h	PIE2	112h	CM1CON1	192h	PMADRH	212h	—	292h	—	312h	—	392h	IOCAN
013h	PIR3	093h	PIE3	113h	_	193h	PMDATL	213h	_	293h		313h	_	393h	IOCAF
014h	_	094h	_	114h		194h	PMDATH	214h	_	294h		314h	_	394h	_
015h	TMR0	095h	OPTION_REG	115h	CMOUT	195h	PMCON1	215h	_	295h	_	315h	_	395h	—
016h	TMR1L	096h 097h	PCON WDTCON	116h 117h	BORCON FVRCON	196h 197h	PMCON2 VREGCON	216h 217h		296h 297h	_	316h 317h	_	396h 397h	_
017h	TMR1H		WDICON			-					—				_
018h	T1CON	098h	_	118h	DACCON0	198h	_	218h		298h	_	318h	_	398h	—
019h	T1GCON	099h	OSCCON	119h	DACCON1	199h	—	219h	—	299h	_	319h	—	399h	—
01Ah	TMR2	09Ah	OSCSTAT	11Ah	—	19Ah	—	21Ah	—	29Ah	—	31Ah	—	39Ah	—
01Bh	PR2	09Bh	ADRESL	11Bh	—	19Bh	_	21Bh	—	29Bh	—	31Bh	—	39Bh	_
01Ch	T2CON	09Ch	ADRESH	11Ch	—	19Ch		21Ch	_	29Ch	_	31Ch	—	39Ch	—
01Dh		09Dh	ADCON0	11Dh	APFCON	19Dh	—	21Dh	—	29Dh	—	31Dh	_	39Dh	—
01Eh		09Eh	ADCON1	11Eh	—	19Eh	—	21Eh	—	29Eh	—	31Eh	—	39Eh	—
01Fh	-	09Fh	ADCON2	11Fh	_	19Fh	—	21Fh	—	29Fh	—	31Fh	_	39Fh	—
020h		0A0h		120h		1A0h		220h		2A0h		320h		3A0h	
04Fh	General Purpose Register 48 Bytes		Unimplemented												
			Read as '0'												
050h 06Fh	Unimplemented Read as '0'	0EFh		16Fh		1EFh		26Fh		2EFh		36Fh		3EFh	
070h		0F0h		170h		1F0h		270h		2F0h		370h		3F0h	
	Common RAM		Common RAM (Accesses 70h – 7Fh)												
07Fh		0FFh		17Fh		1FFh	, on 711)	27Fh	7011 711)	2FFh	/ (11 / 11)	37Fh	/ (3FFh	

Legend: = Unimplemented data memory locations, read as '0'

TABLE 3-3: PIC12(L)F1501 MEMORY MAP (CONTINUED)

_	BANK 8		BANK 9	_	BANK 10		BANK 11		BANK 12	_	BANK 13		BANK 14		BANK 15
400h	Core Registers (Table 3-2)	480h	Core Registers (Table 3-2)	500h	Core Registers (Table 3-2)	580h	Core Registers (Table 3-2)	600h	Core Registers (Table 3-2)	680h	Core Registers (Table 3-2)	700h	Core Registers (Table 3-2)	780h	Core Registers (Table 3-2)
40Bh	. ,	48Bh		50Bh	. ,	58Bh		60Bh	. ,	68Bh	. ,	70Bh	. ,	78Bh	. ,
40Ch	_	48Ch	_	50Ch	_	58Ch	_	60Ch	_	68Ch	_	70Ch	_	78Ch	
40Dh	_	48Dh	_	50Dh		58Dh	_	60Dh	_	68Dh		70Dh		78Dh	_
40Eh	_	48Eh	_	50Eh	_	58Eh	_	60Eh	_	68Eh	_	70Eh	_	78Eh	_
40Fh	_	48Fh		50Fh	_	58Fh	_	60Fh	_	68Fh	_	70Fh	_	78Fh	_
410h	—	490h	—	510h		590h	—	610h		690h	_	710h		790h	—
411h	-	491h	_	511h	_	591h	—	611h	PWM1DCL	691h	CWG1DBR	711h	—	791h	—
412h	—	492h	—	512h		592h	—	612h	PWM1DCH	692h	CWG1DBF	712h		792h	—
413h	-	493h	_	513h	_	593h	—	613h	PWM1CON	693h	CWG1CON0	713h	—	793h	—
414h	—	494h	—	514h		594h	—	614h	PWM2DCL	694h	CWG1CON1	714h		794h	—
415h		495h	_	515h	_	595h	—	615h	PWM2DCH	695h	CWG1CON2	715h	_	795h	_
416h		496h	_	516h	_	596h	—	616h	PWM2CON	696h	_	716h	_	796h	—
417h		497h	_	517h	_	597h	—	617h	PWM3DCL	697h	_	717h	_	797h	_
418h	—	498h	NCO1ACCL	518h		598h	—	618h	PWM3DCH	698h	_	718h	—	798h	—
419h	-	499h	NCO1ACCH	519h	_	599h	—	619h	PWM3CON	699h	—	719h	—	799h	—
41Ah	—	49Ah	NCO1ACCU	51Ah		59Ah	—	61Ah	PWM4DCL	69Ah	_	71Ah	—	79Ah	—
41Bh	-	49Bh	NCO1INCL	51Bh	—	59Bh	_	61Bh	PWM4DCH	69Bh	—	71Bh	—	79Bh	_
41Ch	_	49Ch	NCO1INCH	51Ch	_	59Ch		61Ch	PWM4CON	69Ch	_	71Ch	—	79Ch	—
41Dh	_	49Dh	—	51Dh	—	59Dh		61Dh	—	69Dh	-	71Dh	—	79Dh	—
41Eh	—	49Eh	NCO1CON	51Eh		59Eh	_	61Eh	—	69Eh	—	71Eh	—	79Eh	—
41Fh	—	49Fh	NCO1CLK	51Fh	—	59Fh	_	61Fh	—	69Fh	_	71Fh	—	79Fh	—
420h		4A0h		520h		5A0h		620h		6A0h		720h		7A0h	
	Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'
46Fh		4EFh		56Fh		5EFh		66Fh		6EFh		76Fh		7EFh	
470h		4F0h		570h		5F0h		670h		6F0h		770h		7F0h	
	Common RAM		Common RAM		Common RAM		Common RAM		Common RAM		Common RAM		Common RAM		Common RAM
	(Accesses		(Accesses		(Accesses		(Accesses		(Accesses		(Accesses		(Accesses		(Accesses
47Fh	70h – 7Fh)	4FFh	70h – 7Fh)	57Fh	70h – 7Fh)	5FFh	70h – 7Fh)	67Fh	70h – 7Fh)	6FFh	70h – 7Fh)	77Fh	70h – 7Fh)	7FFh	70h – 7Fh)
7/11/1				57111		51111		0/111		01111		,,,,,,		/	
	BANK 16		BANK 17	_	BANK 18		BANK 19		BANK 20	_	BANK 21		BANK 22		BANK 23
800h		880h		900h		980h		A00h		A80h		B00h		B80h	
	Core Registers		Core Registers		Core Registers		Core Registers		Core Registers		Core Registers		Core Registers		Core Registers
	(Table 3-2)		(Table 3-2)		(Table 3-2)		(Table 3-2)		(Table 3-2)		(Table 3-2)		(Table 3-2)		(Table 3-2)
80Bh		88Bh		90Bh		98Bh		A0Bh		A8Bh		B0Bh		B8Bh	
80Ch		88Ch		90Ch		98Ch		A0Ch		A8Ch		B0Ch		B8Ch	
	Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'		Unimplemented Read as '0'
86Fh		8EFh		96Fh		9EFh		A6Fh		AEFh		B6Fh		BEFh	
870h		8F0h		970h		9F0h		A70h		AF0h		B70h		BF0h	
07011	Common RAM	0.01	Common RAM	0.01	Common RAM	0.01	Common RAM	7.0.01	Common RAM	/ 0//	Common RAM	2701	Common RAM	5.01	Common RAM
	(Accesses		(Accesses		(Accesses		(Accesses		(Accesses		(Accesses		(Accesses		(Accesses
87Fh	70h – 7Fh)	8FFh	70h – 7Fh)	97Fh	70h – 7Fh)	9FFh	70h – 7Fh)	A7Fh	70h – 7Fh)	AFFh	70h – 7Fh)	B7Fh	70h – 7Fh)	BFFh	70h – 7Fh)
0/111		0111		31111	1	31111						0/11			

Legend: = Unimplemented data memory locations, read as '0'

TABLE 3-3: PIC12(L)F1501 MEMORY MAP (CONTINUED)

	BANK 24		BANK 25		BANK 26		BANK 27		BANK 28		BANK 29		BANK 30		BANK 31
C00h	Core Registers (Table 3-2)	C80h	Core Registers (Table 3-2)	D00h	Core Registers (Table 3-2)	D80h	Core Registers (Table 3-2)	E00h	Core Registers (Table 3-2)	E80h	Core Registers (Table 3-2)	F00h	Core Registers (Table 3-2)	F80h	Core Registers (Table 3-2)
C0Bh		C8Bh		D0Bh		D8Bh		E0Bh		E8Bh		F0Bh		F8Bh	
C0Ch	—	C8Ch	_	D0Ch	—	D8Ch	—	E0Ch	—	E8Ch		F0Ch		F8Ch	
C0Dh	—	C8Dh	_	D0Dh	—	D8Dh	—	E0Dh	_	E8Dh	_	F0Dh		F8Dh	
C0Eh	_	C8Eh	_	D0Eh	_	D8Eh	—	E0Eh	—	E8Eh	—	F0Eh		F8Eh	
C0Fh	_	C8Fh	—	D0Fh	—	D8Fh	_	E0Fh	—	E8Fh	_	F0Fh		F8Fh	
C10h	_	C90h	_	D10h	_	D90h	_	E10h	—	E90h	—	F10h		F90h	
C11h	_	C91h	—	D11h	—	D91h	—	E11h	—	E91h	—	F11h		F91h	
C12h	—	C92h	—	D12h	—	D92h	_	E12h	—	E92h		F12h		F92h	
C13h	—	C93h	—	D13h	—	D93h	_	E13h	—	E93h		F13h		F93h	
C14h	_	C94h	—	D14h	_	D94h	_	E14h	—	E94h		F14h		F94h	
C15h	_	C95h	—	D15h	_	D95h	_	E15h	—	E95h		F15h		F95h	
C16h	—	C96h	—	D16h	_	D96h	_	E16h	—	E96h	_	F16h		F96h	
C17h	—	C97h	—	D17h	_	D97h	_	E17h	—	E97h	_	F17h	See Table 3-3 for	F97h	See Table 3-3 for
C18h	—	C98h	—	D18h	—	D98h	_	E18h	—	E98h	—	F18h	register mapping	F98h	register mapping
C19h	—	C99h	—	D19h	—	D99h	_	E19h	—	E99h	—	F19h	details	F99h	details
C1Ah	—	C9Ah	—	D1Ah	—	D9Ah	—	E1Ah	—	E9Ah	—	F1Ah		F9Ah	
C1Bh	—	C9Bh	—	D1Bh	—	D9Bh	—	E1Bh	—	E9Bh		F1Bh		F9Bh	
C1Ch	—	C9Ch	—	D1Ch	—	D9Ch	—	E1Ch	—	E9Ch		F1Ch		F9Ch	
C1Dh	—	C9Dh	—	D1Dh	_	D9Dh	_	E1Dh	—	E9Dh		F1Dh		F9Dh	
C1Eh	_	C9Eh	_	D1Eh	_	D9Eh	_	E1Eh	_	E9Eh		F1Eh		F9Eh	
C1Fh	_	C9Fh	_	D1Fh	_	D9Fh	_	E1Fh	_	E9Fh		F1Fh		F9Fh	
C20h		CA0h		D20h		DA0h		E20h		EA0h		F20h		FA0h	
	Unimplemented Read as '0'														
C6Fh		CEFh		D6Fh		DEFh		E6Fh		EEFh		F6Fh		FEFh	
C70h CFFh	Common RAM (Accesses 70h – 7Fh)	CF0h CFFh	Common RAM (Accesses 70h – 7Fh)	D70h D7Fh	Common RAM (Accesses 70h – 7Fh)	DF0h DFFh	Common RAM (Accesses 70h – 7Fh)	E70h E7Fh	Common RAM (Accesses 70h – 7Fh)	EF0h EFFh	Common RAM (Accesses 70h – 7Fh)	F70h F7Fh	Common RAM (Accesses 70h – 7Fh)	FF0h FFFh	Common RAM (Accesses 70h – 7Fh)

Legend: = Unimplemented data memory locations, read as '0'.

TABLE 3-3: PIC12(L)F1501 MEMORY MAP (CONTINUED)

	Bank 30		Bank 31
F0Ch	_	F8Ch	
F0Dh	_		
F0Eh	_		Unimplemented
F0Fh	CLCDATA		Read as '0'
F10h	CLC1CON	FF2h	
F11h	CLC1POL	FE3h	STATUS SHAD
F12h	CLC1SEL0	FE4h	WREG_SHAD
F13h	CLC1SEL1	FE5h	BSR_SHAD
F14h	CLC1GLS0	FE6h	PCLATH_SHAD
F15h	CLC1GLS1	FE7h	FSR0L_SHAD
F16h	CLC1GLS2	FE8h	FSR0L_SHAD
F17h	CLC1GLS3	FE9h	FSR1L_SHAD
F18h	CLC2CON	FEAh	FSR1L_SHAD
F19h	CLC2POL	FEBh	FSRIN_SHAD
F1Ah	CLC2SEL0	FECh	
F1Bh	CLC2SEL1	FEDh	STKPTR
F1Ch	CLC2GLS0	FEEh	TOSL
F1Dh	CLC2GLS1	FEFh	TOSH
F1Eh	CLC2GLS2		
F1Fh	CLC2GLS3		
F20h F6Fh	Unimplemented Read as '0'		

3.3.6 CORE FUNCTION REGISTERS SUMMARY

The Core Function registers listed in Table 3-4 can be addressed from any Bank.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank	0-31										
x00h or x80h	INDF0		this location		nts of FSR0H	/FSR0L to ad	ddress data r	memory		XXXX XXXX	uuuu uuuu
x01h or x81h	INDF1		this location		nts of FSR1H	/FSR1L to ad	ddress data r	memory		XXXX XXXX	uuuu uuuu
x02h or x82h	PCL	Program C	ounter (PC)	Least Signifi		0000 0000	0000 0000				
x03h or x83h	STATUS	_	—		TO	PD	Z	DC	С	1 1000	q quuu
x04h or x84h	FSR0L	Indirect Da	ta Memory A	ddress 0 Lo	w Pointer					0000 0000	uuuu uuuu
x05h or x85h	FSR0H	Indirect Da	ta Memory A	ddress 0 Hig	gh Pointer					0000 0000	0000 0000
x06h or x86h	FSR1L	Indirect Da	ta Memory A	ddress 1 Lo	w Pointer					0000 0000	uuuu uuuu
x07h or x87h	FSR1H	Indirect Da	ta Memory A	ddress 1 Hig	gh Pointer					0000 0000	0000 0000
x08h or x88h	BSR	_	_	_			BSR<4:0>			0 0000	0 0000
x09h or x89h	WREG	Working Re	egister							0000 0000	uuuu uuuu
x0Ahor x8Ah	PCLATH	_	Write Buffer	for the upp	er 7 bits of the	e Program Co	ounter			-000 0000	-000 0000
x0Bhor x8Bh	INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	0000 0000	0000 0000

TABLE 3-4: CORE FUNCTION REGISTERS SUMMARY

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations are unimplemented, read as '0'.

SPECIAL FUNCTION REGISTER SUMMARY **TABLE 3-5:**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 0											
00Ch	PORTA	—	—	RA5	RA4	RA3	RA2	RA1	RA0	xx xxxx	xx xxxx
00Dh to 010h	_	Unimplemen	ted							_	-
011h	PIR1	TMR1GIF	ADIF	_	_	_	_	TMR2IF	TMR1IF	0000	0000
012h	PIR2	—	—	C1IF	—	—	NCO1IF		—	00	00
013h	PIR3	_	_	_	_	_	_	CLC2IF	CLC1IF	00	00
014h	—	Unimplemen	ted							_	-
015h	TMR0	Holding Regi	ister for the 8-	-bit Timer0 C	ount					XXXX XXXX	uuuu uuuu
016h	TMR1L	Holding Regi	ister for the Le	east Significa	ant Byte of the	e 16-bit TMR	1 Count			xxxx xxxx	uuuu uuuu
017h	TMR1H	Holding Regi	ister for the M	lost Significa	nt Byte of the	16-bit TMR1	Count			xxxx xxxx	uuuu uuuu
018h	T1CON	TMR1C	CS<1:0>	T1CKF	PS<1:0>	_	T1SYNC	_	TMR10N	0000 -0-0	uuuu -u-u
019h	T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T <u>1GGO</u> / DONE	T1GVAL	T1GS	SS<1:0>	0000 0x00	uuuu uxuu
01Ah	TMR2	Timer2 Modu	le Register							0000 0000	0000 0000
01Bh	PR2	Timer2 Perio	d Register							1111 1111	1111 1111
01Ch	T2CON	_		T2OUT	PS<3:0>		TMR2ON	T2CK	PS<1:0>	-000 0000	-000 0000
01Dh to 01Fh	_	Unimplemen	ted							-	_
Bank 1											
08Ch	TRISA	—	—	TRISA5	TRISA4	(2)	TRISA2	TRISA1	TRISA0	11 1111	11 1111
08Dh to 090h	_	Unimplemen	ted							_	_
091h	PIE1	TMR1GIE	ADIE	_	-	—	—	TMR2IE	TMR1IE	0000	0000
092h	PIE2	_	_	C1IE	_	_	NCO1IE	_	_	00	00
093h	PIE3	_	_	_	_	_	_	CLC2IE	CLC1IE	00	00
094h	—	Unimplemen	ted							—	—
095h	OPTION_REG	WPUEN	INTEDG	TMR0CS	TMR0SE	PSA		PS<2:0>		1111 1111	1111 1111
096h	PCON	STKOVF	STKUNF	_	RWDT	RMCLR	RI	POR	BOR	00-1 11qq	qq-q qquu
097h	WDTCON	_	_			WDTPS<4:0	>		SWDTEN	01 0110	01 0110
098h	—	Unimplemen	ted							_	_
099h	OSCCON	_		IRCF	<3:0>		_	SCS	S<1:0>	-011 1-00	-011 1-00
09Ah	OSCSTAT	_	_	_	HFIOFR	_	_	LFIOFR	HFIOFS	000	ddd
09Bh	ADRESL	ADC Result	Register Low							xxxx xxxx	uuuu uuuu
09Ch	ADRESH	ADC Result	Register High	l						xxxx xxxx	uuuu uuuu
09Dh	ADCON0	—			CHS<4:0>			GO/DONE	ADON	-000 0000	-000 0000
09Eh	ADCON1	ADFM		ADCS<2:0>		—	—	ADPR	EF<1:0>	000000	000000
		1	•								1

 Legend:
 x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

 Note
 1:
 PIC12F1501 only.

 2:
 Unimplemented, read as '1'.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 2	2										
10Ch	LATA	_	_	LATA5	LATA4	_	LATA2	LATA1	LATA0	xx -xxx	uu -uuu
10Dh to 110h	_	Unimplemen	ted							-	—
111h	CM1CON0	C10N	C10UT	C10E	C1POL	-	C1SP	C1HYS	C1SYNC	0000 -100	0000 -100
112h to 114h	_	Unimplemen	ted					_		_	_
115h	CMOUT	—	_	—	—	_	_	_	MC10UT	00	00
116h	BORCON	SBOREN	BORFS	—	—		—	—	BORRDY	10q	uuu
117h	FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFV	′R<1:0>	ADFV	′R<1:0>	0q00 0000	0q00 0000
118h	DAC1CON0	DACEN		DACOE1	DACOE2		DACPSS	—		0-00 -0	0-00 -0
119h	DAC1CON1	_	_	_			DACR<4:()>		0 0000	0 0000
11Ah to 11Ch	_	Unimplemen	ted		-	—					
11Dh	APFCON	CWG1BSEL	CWGA1SEL	_	_	T1GSEL	_	CLC1SEL	NCO1SEL	00 0-00	00 0-00
11Eh	—	Unimplemen	ted							_	_
11Fh	—	Unimplemen	ted							_	_
Bank 3	5										
18Ch	ANSELA	—		—	ANSA4		ANSA2	ANSA1	ANSA0	1 -111	1 -111
18Dh to 190h	_	Unimplemen	ted							_	_
191h	PMADRL	Flash Progra	m Memory A	ddress Regis	ter Low Byte					0000 0000	0000 0000
192h	PMADRH	_(2)	Flash Progra	m Memory A	ddress Regis	ster High Byte	e			1000 0000	1000 0000
193h	PMDATL	Flash Progra	m Memory R	ead Data Re	gister Low By	te				xxxx xxxx	uuuu uuuu
194h	PMDATH	—	_	Flash Progr	am Memory F	Read Data Re	egister High I	Byte		xx xxxx	uu uuuu
195h	PMCON1	_(2)	CFGS	LWLO	FREE	WRERR	WREN	WR	RD	1000 x000	1000 q000
196h	PMCON2	Flash Progra	m Memory Co	ontrol Regist	er 2					0000 0000	0000 0000
197h	VREGCON ⁽¹⁾	—	-	—	—	_	—	VREGPM	Reserved	01	01
198h to 19Fh	_	Unimplemen	ted							_	_

SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED) **TABLE 3-5:**

 Legend:
 x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

 Note
 1:
 PIC12F1501 only.

 PIC12F1501 only.
 Unimplemented, read as '1'.

TABLE 3-5: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

IABLE	3-5. 3	PECIAL F		N REGIS	IER SUI		CONTIN				T
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 4											
20Ch	WPUA	—	—	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	11 1111	11 1111
20Dh to 21Fh	_	Unimplemen	ted							_	_
Bank 5											•
28Ch to 29Fh	_	Unimplemen	ted							_	_
Bank 6	;										
30Ch to 31Fh	_	Unimplemen	ted							_	_
Bank 7	,										
38Ch to 390h	_	Unimplemen	ted							_	_
391h	IOCAP	—		IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	00 0000	00 0000
392h	IOCAN	—		IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	00 0000	00 0000
393h	IOCAF	—	—	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	00 0000	00 0000
394h to 39Fh	_	Unimplemen	ted							_	_
Bank 8	1										
40Ch to 41Fh	_	Unimplemen	ted							_	_
Bank 9											
48Ch to 497h	_	Unimplemen	ted							_	_
498h	NCO1ACCL				NCO1	ACC<7:0>				0000 0000	0000 0000
499h	NCO1ACCH				NCO1A	CC<15:8>				0000 0000	0000 0000
49Ah	NCO1ACCU				NCO1A	CC<19:16>				0000 0000	0000 0000
49Bh	NCO1INCL					INC<7:0>				0000 0001	0000 0001
49Ch	NCO1INCH				NCO1I	NC<15:8>				0000 0000	0000 0000
49Dh	—	Unimplemen			1					-	—
49Eh	NCO1CON	N1EN	N10E	N1OUT	N1POL	—	—	—	N1PFM		00000
49Fh	NCO1CLK		N1PWS<2:0>		—	—	—	N1Ck	(S<1:0>	000000	000000

 Legend:
 x = unknown, u = unchanged, g = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

 Note
 1:
 PIC12F1501 only.

 2:
 Unimplemented, read as '1'.

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TABLE	3-5: S	PECIAL F	UNCTIO	N REGIS	TER SUI	MMARY (UED)			
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 1	0										
50Ch to 51Fh	_	Unimplemen	ted							_	_
Bank 1	1										
58Ch to 59Fh	_	Unimplemen	ted							_	—
Bank 1	2	-								_	
60Ch to 610h	_	Unimplemen	ted							_	_
611h	PWM1DCL	PWM1D	CL<7:6>	—	—	_	—	_	_	00	00
612h	PWM1DCH				PWM1	DCH<7:0>				XXXX XXXX	uuuu uuuu
613h	PWM1CON0	PWM1EN	PWM10E	PWM10UT	PWM1POL		_	_	_	0000	0000
614h	PWM2DCL	PWM2D	CL<7:6>	—	—	_	—	_	_	00	00
615h	PWM2DCH				PWM2	DCH<7:0>				XXXX XXXX	uuuu uuuu
616h	PWM2CON0	PWM2EN	PWM2OE	PWM2OUT	PWM2POL	—	—	—	—	0000	0000
617h	PWM3DCL	PWM3D	CL<7:6>	—	—	—	—	—	—	00	00
618h	PWM3DCH			1	PWM3	DCH<7:0>				xxxx xxxx	uuuu uuuu
619h	PWM3CON0	PWM3EN	PWM3OE	PWM3OUT	PWM3POL	—	—	—	_	0000	0000
61Ah	PWM4DCL	PWM4D	CL<7:6>	—	—	_	—	—	—	00	00
61Bh	PWM4DCH			1	PWM4	DCH<7:0>				xxxx xxxx	uuuu uuuu
61Ch	PWM4CON0	PWM4EN	PWM40E	PWM4OUT	PWM4POL		—	—	—	0000	0000
61Dh to 61Fh	_	Unimplemen	ted							-	—
Bank 1	3										
68Ch to 690h	_	Unimplemen	ted	_						_	—
691h	CWG1DBR	—	—			CWG1	DBR<5:0>			00 0000	00 0000
692h	CWG1DBF	—	—		1	CWG	1DBF<5:0>			xx xxxx	xx xxxx
693h	CWG1CON0	G1EN	G10EB	G10EA	G1POLB	G1POLA	—	—	G1CS0	0000 00	0000 00
694h	CWG1CON1	G1ASDI	LB<1:0>	G1ASD	LA<1:0>	_		G1IS<2:0>		0000 -000	0000 -000
695h	CWG1CON2	G1ASE	G1ARSEN	—	—	_	G1ASDSC1	G1ASDSFLT	G1ASDSCLC2	00000	00000
696h to 69Fh	_	Unimplemen	ted							_	—

TABLE 3-5 SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'. PIC12F1501 only. Unimplemented, read as '1'. Legend: Note 1: 1: 2:

TABLE 3-5: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Banks	14-29										
x0Ch/ x8Ch	_	Unimplemen	ted							—	—
x1Fh/ x9Fh											
Bank 3	0	-								_	
F0Ch to F0Eh	_	Unimplemen	ted							_	_
F0Fh	CLCDATA	_	_		—	—	_	MLC2OUT	MLC1OUT	00	00
F10h	CLC1CON	LC1EN	LC10E	LC10UT	LC1INTP	LC1INTN		LC1MODE<2:	0>	0000 0000	0000 0000
F11h	CLC1POL	LC1POL	_		—	LC1G4POL	LC1G3POL	LC1G2POL	LC1G1POL	0 xxxx	0 uuuu
F12h	CLC1SEL0	_	L	.C1D2S<2:0>	>	—		LC1D1S<2:0	>	-xxx -xxx	-uuu -uuu
F13h	CLC1SEL1	_	L	.C1D4S<2:0>	>	—		LC1D3S<2:0	>	-xxx -xxx	-uuu -uuu
F14h	CLC1GLS0	LC1G1D4T	LC1G1D4N	LC1G1D3T	LC1G1D3N	LC1G1D2T	LC1G1D2N	LC1G1D1T	LC1G1D1N	xxxx xxxx	uuuu uuuu
F15h	CLC1GLS1	LC1G2D4T	LC1G2D4N	LC1G2D3T	LC1G2D3N	LC1G2D2T	LC1G2D2N	LC1G2D1T	LC1G2D1N	xxxx xxxx	uuuu uuuu
F16h	CLC1GLS2	LC1G3D4T	LC1G3D4N	LC1G3D3T	LC1G3D3N	LC1G3D2T	LC1G3D2N	LC1G3D1T	LC1G3D1N	xxxx xxxx	uuuu uuuu
F17h	CLC1GLS3	LC1G4D4T	LC1G4D4N	LC1G4D3T	LC1G4D3N	LC1G4D2T	LC1G4D2N	LC1G4D1T	LC1G4D1N	xxxx xxxx	uuuu uuuu
F18h	CLC2CON	LC2EN	LC2OE	LC2OUT	LC2INTP	LC2INTN		LC2MODE<2:	0>	0000 0000	0000 0000
F19h	CLC2POL	LC2POL	_		-	LC2G4POL	LC2G3POL	LC2G2POL	LC2G1POL	0 xxxx	0 uuuu
F1Ah	CLC2SEL0	_	L	.C2D2S<2:0>	>	—		LC2D1S<2:0	>	-xxx -xxx	-uuu -uuu
F1Bh	CLC2SEL1	_	L	.C2D4S<2:0>	>	—		LC2D3S<2:0	>	-xxx -xxx	-uuu -uuu
F1Ch	CLC2GLS0	LC2G1D4T	LC2G1D4N	LC2G1D3T	LC2G1D3N	LC2G1D2T	LC2G1D2N	LC2G1D1T	LC2G1D1N	xxxx xxxx	uuuu uuuu
F1Dh	CLC2GLS1	LC2G2D4T	LC2G2D4N	LC2G2D3T	LC2G2D3N	LC2G2D2T	LC2G2D2N	LC2G2D1T	LC2G2D1N	XXXX XXXX	uuuu uuuu
F1Eh	CLC2GLS2	LC2G3D4T	LC2G3D4N	LC2G3D3T	LC2G3D3N	LC2G3D2T	LC2G3D2N	LC2G3D1T	LC2G3D1N	xxxx xxxx	uuuu uuuu
F1Fh	CLC2GLS3	LC2G4D4T	LC2G4D4N	LC2G4D3T	LC2G4D3N	LC2G4D2T	LC2G4D2N	LC2G4D1T	LC2G4D1N	xxxx xxxx	uuuu uuuu
F20h to F6Fh	_	Unimplemen	ted							_	_

 Legend:
 x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

 Note
 1:
 PIC12F1501 only.

 2:
 Unimplemented, read as '1'.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 31											
F8Ch	—	Unimplemen	ted							_	_
 FE3h											
FE4h	STATUS_ SHAD	—	—	-	-	—	Z_SHAD	DC_SHAD	C_SHAD	xxx	uuu
FE5h	WREG_ SHAD	Working Register Shadow								XXXX XXXX	uuuu uuuu
FE6h	BSR_ SHAD	—	—	—	- Bank Select Register Shadow					x xxxx	u uuuu
FE7h	PCLATH_ SHAD	—	Program Counter Latch High Register Shadow							-xxx xxxx	uuuu uuuu
FE8h	FSR0L_ SHAD	Indirect Data Memory Address 0 Low Pointer Shadow								XXXX XXXX	uuuu uuuu
FE9h	FSR0H_ SHAD	Indirect Data Memory Address 0 High Pointer Shadow								XXXX XXXX	uuuu uuuu
FEAh	FSR1L_ SHAD	Indirect Data Memory Address 1 Low Pointer Shadow								XXXX XXXX	uuuu uuuu
FEBh	FSR1H_ SHAD	Indirect Data Memory Address 1 High Pointer Shadow								XXXX XXXX	uuuu uuuu
FECh	—	Unimplemented								—	—
FEDh	STKPTR	—	_	_	Current Sta	ck Pointer				1 1111	1 1111
FEEh	TOSL	Top-of-Stack Low byte							XXXX XXXX	uuuu uuuu	
FEFh	TOSH	— Top-of-Stack High byte						-xxx xxxx	-uuu uuuu		

TABLE 3-5: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

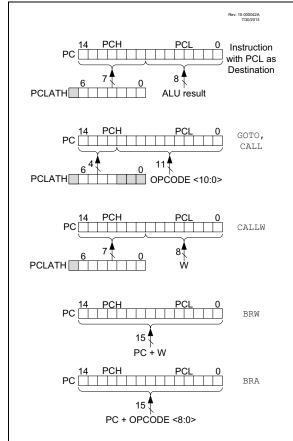
 x = unknown, u = unchanged, g = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.
 PIC12F1501 only.
 Unimplemented, read as '1'. Legend: : Note 1:

2:

3.4 PCL and PCLATH

The Program Counter (PC) is 15 bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<14:8>) is not directly readable or writable and comes from PCLATH. On any Reset, the PC is cleared. Figure 3-3 shows the five situations for the loading of the PC.





3.4.1 MODIFYING PCL

Executing any instruction with the PCL register as the destination simultaneously causes the Program Counter PC<14:8> bits (PCH) to be replaced by the contents of the PCLATH register. This allows the entire contents of the program counter to be changed by writing the desired upper seven bits to the PCLATH register. When the lower eight bits are written to the PCL register, all 15 bits of the program counter will change to the values contained in the PCLATH register and those being written to the PCL register.

3.4.2 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When performing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block). Refer to Application Note AN556, *"Implementing a Table Read"* (DS00556).

3.4.3 COMPUTED FUNCTION CALLS

A computed function CALL allows programs to maintain tables of functions and provide another way to execute state machines or look-up tables. When performing a table read using a computed function CALL, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block).

If using the CALL instruction, the PCH<2:0> and PCL registers are loaded with the operand of the CALL instruction. PCH<6:3> is loaded with PCLATH<6:3>.

The CALLW instruction enables computed calls by combining PCLATH and W to form the destination address. A computed CALLW is accomplished by loading the W register with the desired address and executing CALLW. The PCL register is loaded with the value of W and PCH is loaded with PCLATH.

3.4.4 BRANCHING

The branching instructions add an offset to the PC. This allows relocatable code and code that crosses page boundaries. There are two forms of branching, BRW and BRA. The PC will have incremented to fetch the next instruction in both cases. When using either branching instruction, a PCL memory boundary may be crossed.

If using BRW, load the W register with the desired unsigned address and execute BRW. The entire PC will be loaded with the address PC + 1 + W.

If using BRA, the entire PC will be loaded with PC + 1 +, the signed value of the operand of the BRA instruction.

3.5 Stack

All devices have a 16-level x 15-bit wide hardware stack (refer to Figures 3-4 through 3-7). The stack space is not part of either program or data space. The PC is PUSHed onto the stack when CALL or CALLW instructions are executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer if the STVREN bit is programmed to '0' (Configuration Words). This means that after the stack has been PUSHed sixteen times, the seventeenth PUSH overwrites the value that was stored from the first PUSH. The eighteenth PUSH overwrites the second PUSH (and so on). The STKOVF and STKUNF flag bits will be set on an Overflow/Underflow, regardless of whether the Reset is enabled.

Note 1: There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, CALLW, RETURN, RETLW and RETFIE instructions or the vectoring to an interrupt address.

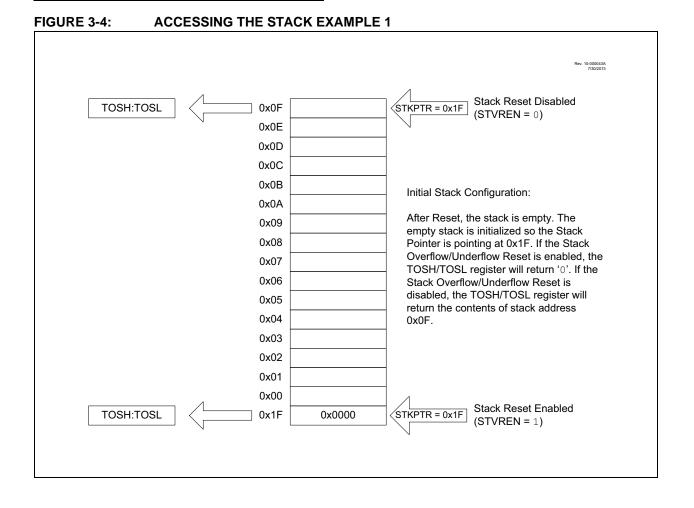
3.5.1 ACCESSING THE STACK

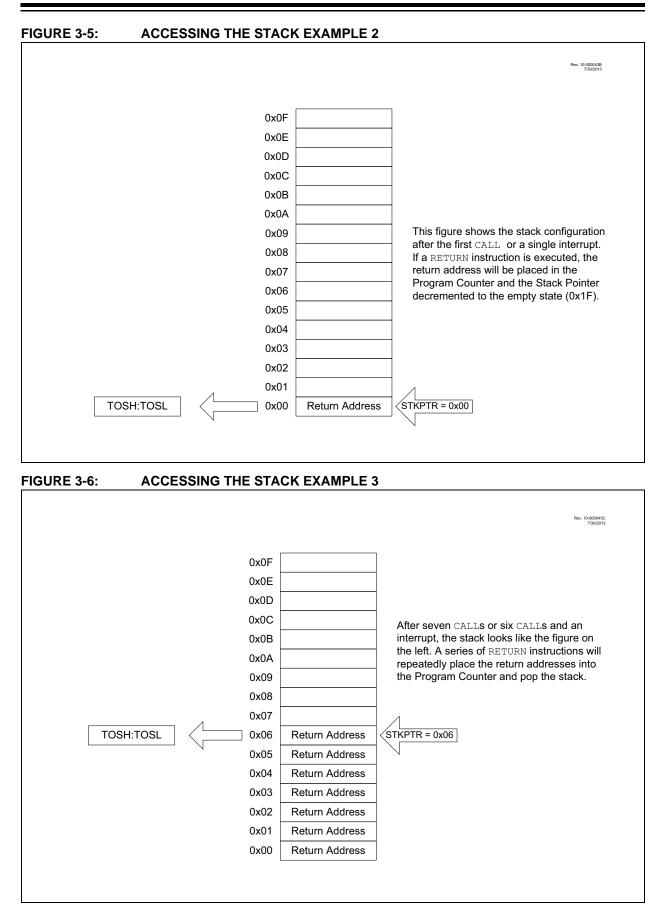
The stack is available through the TOSH, TOSL and STKPTR registers. STKPTR is the current value of the Stack Pointer. TOSH:TOSL register pair points to the TOP of the stack. Both registers are read/writable. TOS is split into TOSH and TOSL due to the 15-bit size of the PC. To access the stack, adjust the value of STKPTR, which will position TOSH:TOSL, then read/write to TOSH:TOSL. STKPTR is 5 bits to allow detection of overflow and underflow.

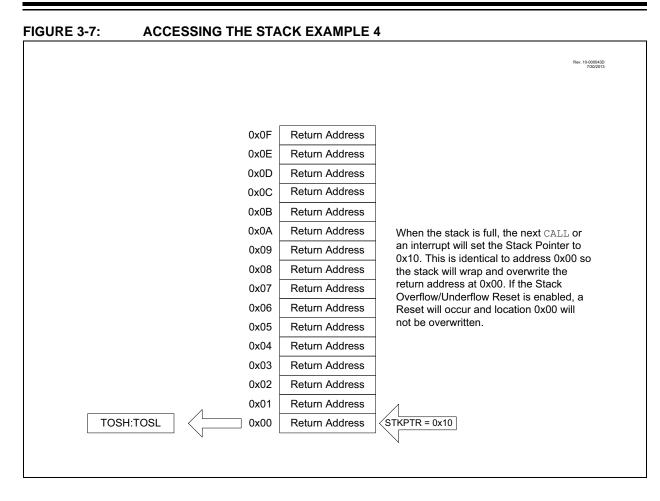
Note:	Care should be taken when modifying the
	STKPTR while interrupts are enabled.

During normal program operation, CALL, CALLW and Interrupts will increment STKPTR while RETLW, RETURN, and RETFIE will decrement STKPTR. At any time STKPTR can be inspected to see how much stack is left. The STKPTR always points at the currently used place on the stack. Therefore, a CALL or CALLW will increment the STKPTR and then write the PC, and a return will unload the PC and then decrement the STKPTR.

Reference Figure 3-4 through Figure 3-7 for examples of accessing the stack.







3.5.2 OVERFLOW/UNDERFLOW RESET

If the STVREN bit in Configuration Words is programmed to '1', the device will be reset if the stack is PUSHed beyond the sixteenth level or POPed beyond the first level, setting the appropriate bits (STKOVF or STKUNF, respectively) in the PCON register.

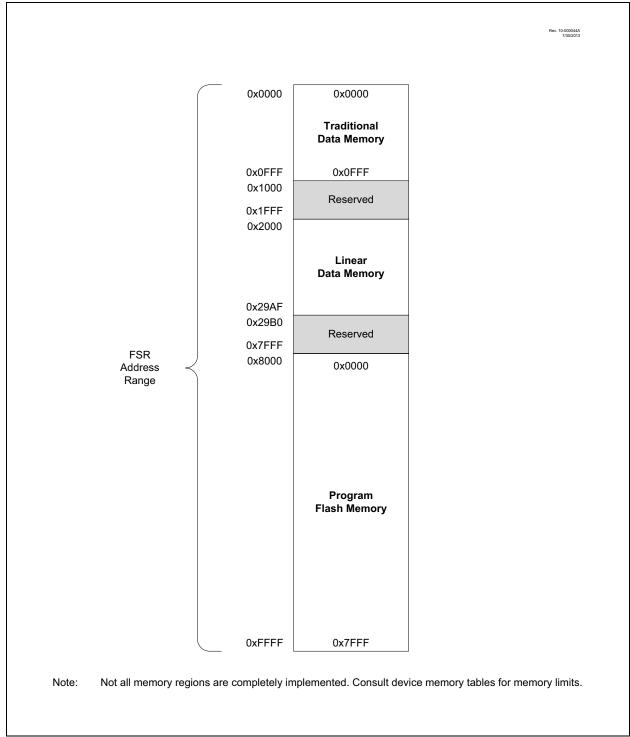
3.6 Indirect Addressing

The INDFn registers are not physical registers. Any instruction that accesses an INDFn register actually accesses the register at the address specified by the File Select Registers (FSR). If the FSRn address specifies one of the two INDFn registers, the read will return '0' and the write will not occur (though Status bits may be affected). The FSRn register value is created by the pair FSRnH and FSRnL.

The FSR registers form a 16-bit address that allows an addressing space with 65536 locations. These locations are divided into three memory regions:

- Traditional Data Memory
- Linear Data Memory
- Program Flash Memory

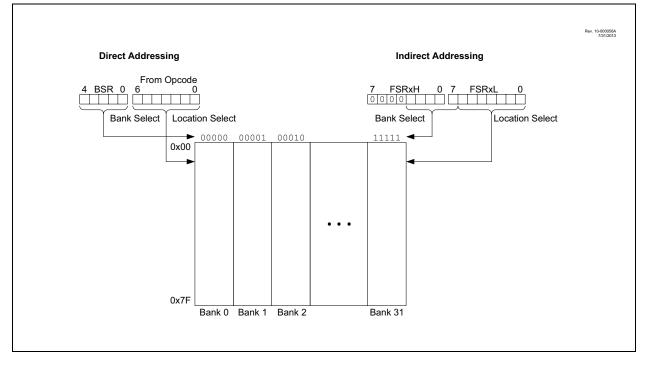




3.6.1 TRADITIONAL DATA MEMORY

The traditional data memory is a region from FSR address 0x000 to FSR address 0xFFF. The addresses correspond to the absolute addresses of all SFR, GPR and common registers.

FIGURE 3-9: TRADITIONAL DATA MEMORY MAP



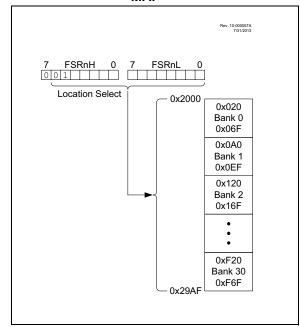
3.6.2 LINEAR DATA MEMORY

The linear data memory is the region from FSR address 0x2000 to FSR address 0x29AF. This region is a virtual region that points back to the 80-byte blocks of GPR memory in all the banks.

Unimplemented memory reads as 0x00. Use of the linear data memory region allows buffers to be larger than 80 bytes because incrementing the FSR beyond one bank will go directly to the GPR memory of the next bank.

The 16 bytes of common memory are not included in the linear data memory region.

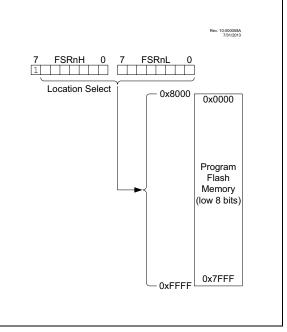
FIGURE 3-10: LINEAR DATA MEMORY MAP



3.6.3 PROGRAM FLASH MEMORY

To make constant data access easier, the entire program Flash memory is mapped to the upper half of the FSR address space. When the MSb of FSRnH is set, the lower 15 bits are the address in program memory which will be accessed through INDF. Only the lower eight bits of each memory location is accessible via INDF. Writing to the program Flash memory cannot be accomplished via the FSR/INDF interface. All instructions that access program Flash memory via the FSR/INDF interface will require one additional instruction cycle to complete.





4.0 DEVICE CONFIGURATION

Device configuration consists of Configuration Words, Code Protection and Device ID.

4.1 Configuration Words

There are several Configuration Word bits that allow different oscillator and memory protection options. These are implemented as Configuration Word 1 at 8007h and Configuration Word 2 at 8008h.

Note: The DEBUG bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.

4.2 Register Definitions: Configuration Words

bit 11 C bit 10-9 B 1 0 bit 10-9 C 1 0 0 bit 8 U bit 7 C 1 0 bit 6 N	Unimplement CLKOUTEN: = CLKOUT = CLKOUT BOREN<1:0> = BOR ena = BOR ena = BOR cor = BOR dis	function is ena : Brown-Out R abled abled during op atrolled by SBC abled	nable bit 1' ble bit abled. I/O fur abled on the (eset Enable peration and (-	U-1 — ented bit, read n blank or afte	l as '1'	
CP(2) bit 7 Legend: R = Readable bi '0' = Bit is cleare bit 13-12 U bit 11 C bit 10-9 B bit 8 U bit 7 C bit 6 N	MCLRE it ed Jnimplement CLKOUTEN: . = CLKOUT BOREN<1:0> .1 = BOR ena .0 = BOR ena .1 = BOR cor .0 = BOR dis	R/P-1 PWRTE P = Programm '1' = Bit is set ted: Read as '2 Clock Out Ena function is disa function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	WD nable bit 1' abled. I/O fur abled on the (eset Enable peration and (TE<1:0> U = Unimpleme -n = Value whe nction on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	ented bit, read n blank or afte	FOSC	R/P-1 C<1:0>
CP(2) bit 7 Legend: R = Readable bi '0' = Bit is cleare bit 13-12 U bit 11 C bit 10-9 B bit 8 U bit 7 C bit 6 N	MCLRE it ed Jnimplement CLKOUTEN: . = CLKOUT BOREN<1:0> .1 = BOR ena .0 = BOR ena .1 = BOR cor .0 = BOR dis	PWRTE P = Programn '1' = Bit is set ted: Read as '2 Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op throlled by SBC abled	WD nable bit 1' abled. I/O fur abled on the (eset Enable peration and (TE<1:0> U = Unimpleme -n = Value whe nction on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	ented bit, read n blank or afte	FOSC	C<1:0>
CP(2) bit 7 Legend: R = Readable bi '0' = Bit is cleare bit 13-12 U bit 11 C bit 10-9 B bit 8 U bit 7 C bit 6 N	MCLRE it ed Jnimplement CLKOUTEN: . = CLKOUT BOREN<1:0> .1 = BOR ena .0 = BOR ena .1 = BOR cor .0 = BOR dis	PWRTE P = Programn '1' = Bit is set ted: Read as '2 Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op throlled by SBC abled	WD nable bit 1' abled. I/O fur abled on the (eset Enable peration and (TE<1:0> U = Unimpleme -n = Value whe nction on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	ented bit, read n blank or afte	FOSC	C<1:0>
bit 7 Legend: R = Readable bi '0' = Bit is cleared bit 13-12 U bit 11 C bit 11 C bit 10-9 B 1 0 bit 8 U bit 7 C 1 0 bit 8 U bit 7 C	it ed Jnimplement CLKOUTEN: = CLKOUT = CLKOUT 30REN<1:0 > 1 = BOR ena 0 = BOR ena 0 = BOR cor 0 = BOR dis	P = Programn '1' = Bit is set ted: Read as '2 Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	nable bit 1' ble bit abled. I/O fur abled on the (eset Enable peration and (U = Unimpleme -n = Value whe action on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	n blank or afte	l as '1'	
R = Readable bi '0' = Bit is cleared bit 13-12 U bit 11 C bit 11 1 0 bit 10-9 B 1 1 0 bit 8 U bit 7 C 1 0 bit 8 U bit 7 C	Unimplement CLKOUTEN: = CLKOUT = CLKOUT BOREN<1:0> = BOR ena = BOR ena = BOR cor = BOR dis	'1' = Bit is set ted: Read as '1 Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	1' ble bit abled. I/O fur abled on the (eset Enable peration and (-n = Value whe action on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	n blank or afte		
R = Readable bi '0' = Bit is cleared bit 13-12 U bit 11 C bit 11 1 0 bit 10-9 B 1 1 0 bit 8 U bit 7 C 1 0 bit 8 U bit 7 C	Unimplement CLKOUTEN: = CLKOUT = CLKOUT BOREN<1:0> = BOR ena = BOR ena = BOR cor = BOR dis	'1' = Bit is set ted: Read as '1 Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	1' ble bit abled. I/O fur abled on the (eset Enable peration and (-n = Value whe action on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	n blank or afte		
bit 13-12 U bit 11 C bit 11 0 bit 10-9 B 1 0 bit 8 U bit 7 C 1 0 bit 6 N	Jnimplement CLKOUTEN: = CLKOUT = CLKOUT BOREN<1:0> 1 = BOR ena 1 = BOR ena 1 = BOR cor 0 = BOR dis	'1' = Bit is set ted: Read as '1 Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	1' ble bit abled. I/O fur abled on the (eset Enable peration and (-n = Value whe action on the CLK0 CLKOUT pin bits ⁽¹⁾ disabled in Sleep	n blank or afte		
bit 11 C bit 10-9 B 1 1 0 0 0 bit 8 U bit 7 C 1 0 bit 6 N	CLKOUTEN: = CLKOUT = CLKOUT 30REN<1:0 > 1 = BOR ena 0 = BOR ena 1 = BOR cor 0 = BOR dis	Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	ble bit abled. I/O fur abled on the (eset Enable peration and (CLKOUT pin bits ⁽¹⁾ disabled in Sleep			
bit 11 C bit 10-9 B 1 1 0 0 0 bit 8 U bit 7 C 1 0 bit 6 N	CLKOUTEN: = CLKOUT = CLKOUT 30REN<1:0 > 1 = BOR ena 0 = BOR ena 1 = BOR cor 0 = BOR dis	Clock Out Ena function is disa function is ena : Brown-Out R abled abled during op ntrolled by SBC abled	ble bit abled. I/O fur abled on the (eset Enable peration and (CLKOUT pin bits ⁽¹⁾ disabled in Sleep			
bit 10-9 B 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0	BOREN<1:0> 1 = BOR ena 0 = BOR ena 01 = BOR cor 00 = BOR disa	: Brown-Out R abled abled during op ntrolled by SBC abled	eset Enable	bits ⁽¹⁾ disabled in Sleep	ter		
bit 7 C 1 0 bit 6 N	Jnimplement						
1 0 bit 6 M		ted: Read as ':	1'				
bit 6 N		tection bit ⁽²⁾ nemory code p nemory code p					
<u>lf</u>	ICLRE: MCL <u>f LVP bit = 1</u> : This bit is <u>f LVP bit = 0</u> : 1 = MCLR	R/VPP Pin Fur ignored. /VPP pin functio /VPP pin functio	nction Select on is MCLR; W			eak pull-up unde	er control of
1	PWRTE: Pow = PWRT dis = PWRT en		nable bit				
bit 4-3 V 1 1 0	VDTE<1:0>: 1 = WDT ena 0 = WDT ena	Watchdog Tim abled abled while run atrolled by the \$	ining and disa		egister		
bit 2 U	Jnimplement	ted: Read as 'a	1'				
bit 1-0 F 1 1 0	OSC<1:0>: 0 1 = ECH: Ex 0 = ECM: Ex 01 = ECL: Ext	Oscillator Selec ternal Clock, H tternal Clock, N	ction bits ligh-Power m /ledium Powe ow-Power mo	ode: on CLKIN pir r mode: on CLKIN ode: on CLKIN pin CLKIN pin	l pin		

REGISTER 4-1: CONFIG1: CONFIGURATION WORD 1

- **Note 1:** Enabling Brown-out Reset does not automatically enable Power-up Timer.
 - 2: Once enabled, code-protect can only be disabled by bulk erasing the device.

		R/P-1	U-1	R/P-1	R/P-1	R/P-1	U-1
		LVP ⁽¹⁾	_	LPBOR	BORV ⁽²⁾	STVREN	_
		bit 13					bit
U-1	U-1	U-1	U-1	U-1	U-1	R/P-1	R/P-1
	—	—	—	—	—	WRT<	:1:0>
bit 7							bit
Legend:							
R = Readal	ble bit	P = Programn	nable bit	U = Unimplem	nented bit, read	l as '1'	
'0' = Bit is c	leared	'1' = Bit is set		-n = Value wh	en blank or afte	er Bulk Erase	
pit 11 pit 10	1 = Low-Pov 0 = Low-Pov BORV: Brov	w-Power BOR E ver Brown-out R ver Brown-out R vn-Out Reset Vo ut Reset voltage	eset is disable eset is enable Itage Selection	d n bit ⁽²⁾	ď		
bit 9	STVREN: S	ut Reset voltage tack Overflow/Ur verflow or Under verflow or Under	nderflow Rese flow will cause	t Enable bit a Reset	ed		
bit 8-2	Unimpleme	nted: Read as '	1'				
bit 1-0	WRT<1:0>:	Flash Memory S					

REGISTER 4-2: CONFIG2: CONFIGURATION WORD 2

2: See VBOR parameter for specific trip point voltages.

4.3 Code Protection

Code protection allows the device to be protected from unauthorized access. Internal access to the program memory is unaffected by any code protection setting.

4.3.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the \overline{CP} bit in Configuration Words. When $\overline{CP} = 0$, external reads and writes of program memory are inhibited and a read will return all '0's. The CPU can continue to read program memory, regardless of the protection bit settings. Writing the program memory is dependent upon the write protection setting. See Section 4.4 "Write Protection" for more information.

4.4 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as bootloader software, can be protected while allowing other regions of the program memory to be modified.

The WRT<1:0> bits in Configuration Words define the size of the program memory block that is protected.

4.5 User ID

Four memory locations (8000h-8003h) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are readable and writable during normal execution. See **Section 10.4 "User ID, Device ID and Configuration Word Access"** for more information on accessing these memory locations. For more information on checksum calculation, see the "*PIC12(L)F1501/PIC16(L)F150X Memory Programming Specification*" (DS41573).

4.6 Device ID and Revision ID

The memory location 8006h is where the Device ID and Revision ID are stored. The upper nine bits hold the Device ID. The lower five bits hold the Revision ID. See Section 10.4 "User ID, Device ID and Configuration Word Access" for more information on accessing these memory locations.

Development tools, such as device programmers and debuggers, may be used to read the Device ID and Revision ID.

4.7 Register Definitions: Device ID

REGISTER 4-3: DEVID: DEVICE ID REGISTER

		R	R	R	R	R	R	
				DEV	<8:3>			
		bit 13					bit 8	
R	R	R	R	R	R	R	R	
	DEV<2:0>			REV<4:0>				
bit 7							bit 0	

Legend:

R = Readable bit

'1' = Bit is set

bit 13-5 **DEV<8:0>:** Device ID bits

	2.10					
Device	DEVID<13:0> Values					
Device	DEV<8:0>	REV<4:0>				
PIC12LF1501	10 1101 100	x xxxx				
PIC12F1501	10 1100 110	x xxxx				

'0' = Bit is cleared

bit 4-0 **REV<4:0>:** Revision ID bits

These bits are used to identify the revision (see Table under DEV<8:0> above).

5.0 OSCILLATOR MODULE

5.1 Overview

The oscillator module has a wide variety of clock sources and selection features that allow it to be used in a wide range of applications while maximizing performance and minimizing power consumption. Figure 5-1 illustrates a block diagram of the oscillator module.

Clock sources can be supplied from an external clock or from one of two internal oscillators, with a choice of speeds selectable via software. Additional clock features include:

- Selectable system clock source between external or internal sources via software.
- Fast start-up oscillator allows internal circuits to power-up and stabilize before switching to the 16 MHz HFINTOSC

The oscillator module can be configured in one of the following clock modes.

- 1. ECL External Clock Low-Power mode (0 MHz to 0.5 MHz)
- 2. ECM External Clock Medium Power mode (0.5 MHz to 4 MHz)
- 3. ECH External Clock High-Power mode (4 MHz to 20 MHz)
- 4. INTOSC Internal oscillator (31 kHz to 16 MHz)

Clock Source modes are selected by the FOSC<1:0> bits in the Configuration Words. The FOSC bits determine the type of oscillator that will be used when the device is first powered.

The ECH, ECM, and ECL clock modes rely on an external logic level signal as the device clock source.

The INTOSC internal oscillator block produces a low and high-frequency clock source, designated LFINTOSC and HFINTOSC. (See Internal Oscillator Block, Figure 5-1). A wide selection of device clock frequencies may be derived from these two clock sources.

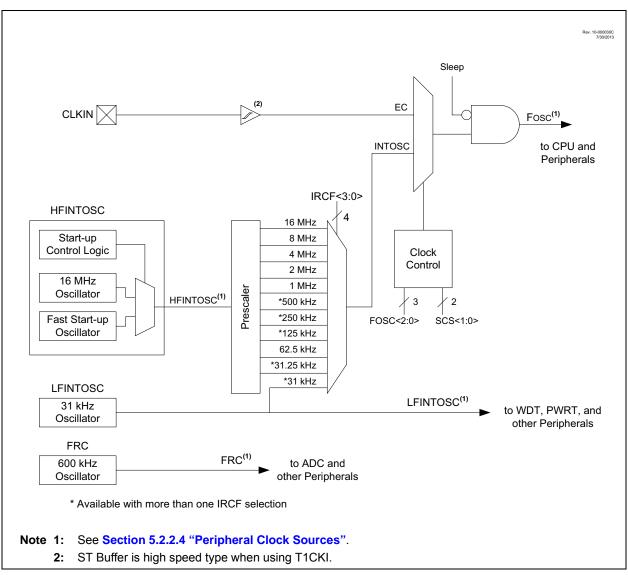


FIGURE 5-1: SIMPLIFIED PIC[®] MCU CLOCK SOURCE BLOCK DIAGRAM

5.2 Clock Source Types

Clock sources can be classified as external, internal or peripheral.

External clock sources rely on external circuitry for the clock source to function. Examples are: oscillator modules (ECH, ECM, ECL modes).

Internal clock sources are contained within the oscillator module. The internal oscillator block has two internal oscillators that are used to generate the internal system clock sources: the 16 MHz High-Frequency Internal Oscillator (HFINTOSC) and the 31 kHz Low-Frequency Internal Oscillator (LFINTOSC).

The peripheral clock source is a nominal 600 kHz internal RC oscillator, FRC. The FRC is traditionally used with the ADC module, but is sometimes available to other peripherals. See Section 5.2.2.4 "Peripheral Clock Sources".

The system clock can be selected between external or internal clock sources via the System Clock Select (SCS) bits in the OSCCON register. See **Section 5.3 "Clock Switching**" for additional information.

5.2.1 EXTERNAL CLOCK SOURCES

An external clock source can be used as the device system clock by performing one of the following actions:

- Program the FOSC<1:0> bits in the Configuration Words to select an external clock source that will be used as the default system clock upon a device Reset.
- Write the SCS<1:0> bits in the OSCCON register to switch the system clock source to:
 - Secondary oscillator during run-time, or
 - An external clock source determined by the value of the FOSC bits.

See Section 5.3 "Clock Switching" for more information.

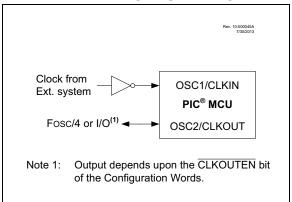
5.2.1.1 EC Mode

The External Clock (EC) mode allows an externally generated logic level signal to be the system clock source. When operating in this mode, an external clock source is connected to the OSC1 input. OSC2/CLKOUT is available for general purpose I/O or CLKOUT. Figure 5-2 shows the pin connections for EC mode.

EC mode has three power modes to select from through the Fosc bits in the Configuration Words:

- ECH High power, 4-20 MHz
- ECM Medium power, 0.5-4 MHz
- ECL Low power, 0-0.5 MHz

FIGURE 5-2: EXTERNAL CLOCK (EC) MODE OPERATION



5.2.2 INTERNAL CLOCK SOURCES

The device may be configured to use the internal oscillator block as the system clock by performing one of the following actions:

- Program the FOSC<1:0> bits in Configuration Words to select the INTOSC clock source, which will be used as the default system clock upon a device Reset.
- Write the SCS<1:0> bits in the OSCCON register to switch the system clock source to the internal oscillator during run-time. See Section
 5.3 "Clock Switching" for more information.

In **INTOSC** mode, CLKIN is available for general purpose I/O. CLKOUT is available for general purpose I/O or CLKOUT.

The function of the CLKOUT pin is determined by the CLKOUTEN bit in Configuration Words.

The internal oscillator block has two independent oscillators that provides the internal system clock source.

- 1. The **HFINTOSC** (High-Frequency Internal Oscillator) is factory calibrated and operates at 16 MHz.
- 2. The **LFINTOSC** (Low-Frequency Internal Oscillator) operates at 31 kHz.

5.2.2.1 HFINTOSC

The High-Frequency Internal Oscillator (HFINTOSC) is a factory calibrated 16 MHz internal clock source.

The output of the HFINTOSC connects to a postscaler and multiplexer (see Figure 5-1). The frequency derived from the HFINTOSC can be selected via software using the IRCF<3:0> bits of the OSCCON register. See Section 5.2.2.6 "Internal Oscillator Clock Switch Timing" for more information.

The HFINTOSC is enabled by:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired HF frequency, and
- FOSC<1:0> = 00, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'.

A fast start-up oscillator allows internal circuits to power-up and stabilize before switching to HFINTOSC.

The High-Frequency Internal Oscillator Ready bit (HFIOFR) of the OSCSTAT register indicates when the HFINTOSC is running.

The High-Frequency Internal Oscillator Stable bit (HFIOFS) of the OSCSTAT register indicates when the HFINTOSC is running within 0.5% of its final value.

5.2.2.2 LFINTOSC

The Low-Frequency Internal Oscillator (LFINTOSC) is a 31 kHz internal clock source.

The output of the LFINTOSC connects to a multiplexer (see Figure 5-1). Select 31 kHz, via software, using the IRCF<3:0> bits of the OSCCON register. See Section 5.2.2.6 "Internal Oscillator Clock Switch Timing" for more information. The LFINTOSC is also the frequency for the Power-up Timer (PWRT) and the, Watchdog Timer (WDT).

The LFINTOSC is enabled by selecting 31 kHz (IRCF<3:0> bits of the OSCCON register = 000) as the system clock source (SCS bits of the OSCCON register = 1x), or when any of the following are enabled:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired LF frequency, and
- FOSC<1:0> = 00, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'.

Peripherals that use the LFINTOSC are:

- Power-up Timer (PWRT)
- Watchdog Timer (WDT)

The Low-Frequency Internal Oscillator Ready bit (LFIOFR) of the OSCSTAT register indicates when the LFINTOSC is running.

5.2.2.3 FRC

The FRC clock is an uncalibrated, nominal 600 kHz peripheral clock source.

The FRC is automatically turned on by the peripherals requesting the FRC clock.

The FRC clock continues to run during Sleep.

5.2.2.4 Peripheral Clock Sources

The clock sources described in this chapter and the Timer's are available to different peripherals. Table 5-1 lists the clocks and timers available for each peripheral.

TABLE 5-1:	PERIPHERAL CLOCK
	SOURCES

	FOSC	FRC	HFINTOSC	LFINTOSC	TMR0	TMR1	TMR2
ADC	•	•					
CLC	•	•	•	•	٠	•	•
COMP						•	
CWG	•		•				
NCO	•		•				
PWM	•						•
PWRT				•			
TMR0	•						
TMR1	•			•			
TMR2	•						
WDT				•			

5.2.2.5 Internal Oscillator Frequency Selection

The system clock speed can be selected via software using the Internal Oscillator Frequency Select bits IRCF<3:0> of the OSCCON register.

The postscaled output of the 16 MHz HFINTOSC and 31 kHz LFINTOSC connect to a multiplexer (see Figure 5-1). The Internal Oscillator Frequency Select bits IRCF<3:0> of the OSCCON register (Register 5-1) select the frequency output of the internal oscillators.

Note:	Following any Reset, the IRCF<3:0> bits of the OSCCON register are set to '0111' and the frequency selection is set to
	500 kHz. The user can modify the IRCF bits to select a different frequency.

The IRCF<3:0> bits of the OSCCON register allow duplicate selections for some frequencies. These duplicate choices can offer system design trade-offs. Lower power consumption can be obtained when changing oscillator sources for a given frequency. Faster transition times can be obtained between frequency changes that use the same oscillator source.

5.2.2.6 Internal Oscillator Clock Switch Timing

When switching between the HFINTOSC and the LFINTOSC, the new oscillator may already be shut down to save power (see Figure 5-3). If this is the case, there is a delay after the IRCF<3:0> bits of the OSCCON register are modified before the frequency selection takes place. The OSCSTAT register will reflect the current active status of the HFINTOSC and LFINTOSC oscillators. The sequence of a frequency selection is as follows:

- 1. IRCF<3:0> bits of the OSCCON register are modified.
- 2. If the new clock is shut down, a clock start-up delay is started.
- 3. Clock switch circuitry waits for a falling edge of the current clock.
- 4. The current clock is held low and the clock switch circuitry waits for a rising edge in the new clock.
- 5. The new clock is now active.
- 6. The OSCSTAT register is updated as required.
- 7. Clock switch is complete.

See Figure 5-3 for more details.

If the internal oscillator speed is switched between two clocks of the same source, there is no start-up delay before the new frequency is selected. Clock switching time delays are shown in Table 5-2.

Start-up delay specifications are located in Table 27-8, "Oscillator Parameters".

FIGURE 5-3:	INTERNAL OSCILLATOR SWITCH TIMING
	LFINTOSC (WDT disabled)
HFINTOSC	Osçillator Delay ⁽¹⁾ 2-cycle Sync
LFINTOSC	
IRCF <3:0>	$\neq 0$ $X = 0$
System Clock	
HFINTOSC I	LFINTOSC (WDT enabled)
HFINTOSC .	2-cycle Sync Running
LFINTOSC -	
IRCF <3:0>	$\neq 0$ $X = 0$
System Clock	
LFINTOSC I	HFINTOSC LFINTOSC turns off unless WDT is enabled ⁽²⁾
LFINTOSC	Oscillator Delay ⁽¹⁾ 2-cycle Sync Running
HFINTOSC	
IRCF <3:0>	$= 0 \qquad \qquad \neq 0$
System Clock	
2: LFIN	Table 5-2, "Oscillator Switching Delays" for more information. TOSC will continue to run if a peripheral has selected it as the clock source. See ion 5.2.2.4 "Peripheral Clock Sources".

5.3 Clock Switching

The system clock source can be switched between external and internal clock sources via software using the System Clock Select (SCS) bits of the OSCCON register. The following clock sources can be selected using the SCS bits:

- Default system oscillator determined by FOSC bits in Configuration Words
- Internal Oscillator Block (INTOSC)

5.3.1 SYSTEM CLOCK SELECT (SCS) BITS

The System Clock Select (SCS) bits of the OSCCON register selects the system clock source that is used for the CPU and peripherals.

- When the SCS bits of the OSCCON register = 00, the system clock source is determined by value of the FOSC<1:0> bits in the Configuration Words.
- When the SCS bits of the OSCCON register = 01, the system clock source is the secondary oscillator.
- When the SCS bits of the OSCCON register = 1x, the system clock source is chosen by the internal oscillator frequency selected by the IRCF<3:0>

TABLE 5-2: OSCILLATOR SWITCHING DELAYS

bits of the OSCCON register. After a Reset, the SCS bits of the OSCCON register are always cleared.

When switching between clock sources, a delay is required to allow the new clock to stabilize. These oscillator delays are shown in Table 5-2.

5.3.2 CLOCK SWITCHING BEFORE SLEEP

When clock switching from an old clock to a new clock is requested just prior to entering Sleep mode, it is necessary to confirm that the switch is complete before the SLEEP instruction is executed. Failure to do so may result in an incomplete switch and consequential loss of the system clock altogether. Clock switching is confirmed by monitoring the clock status bits in the OSCSTAT register. Switch confirmation can be accomplished by sensing that the ready bit for the new clock is set or the ready bit for the old clock is cleared. For example, when switching between the internal oscillator with the PLL and the internal oscillator without the PLL, monitor the PLLR bit. When PLLR is set, the switch to 32 MHz operation is complete. Conversely, when PPLR is cleared, the switch from 32 MHz operation to the selected internal clock is complete.

Switch From	Switch To	Oscillator Delay	
	LFINTOSC	1 cycle of each clock source	
Any clock source	HFINTOSC	2 μs (approx.)	
	ECH, ECM, ECL	2 cycles	

5.4 Register Definitions: Oscillator Control

U-0	R/W-0/0	R/W-1/1	R/W-1/1	R/W-1/1	U-0	R/W-0/0	R/W-0/0		
_		IRCF	<3:0>		_	SCS	<1:0>		
oit 7							bit (
egend:									
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	d as '0'			
ı = Bit is unch	anged	x = Bit is unkn	iown	-n/n = Value a	at POR and BC	R/Value at all o	other Resets		
1' = Bit is set		'0' = Bit is clea	ared						
oit 7	Unimplemer	nted: Read as '	כ'						
oit 6-3	IRCF<3:0>:	Internal Oscillate	or Frequency	Select bits					
	1111 = 16 N								
	1110 = 8 M								
	1101 = 4 MHz								
	1100 = 2 M								
	1011 = 1 M								
	1010 = 500								
	1001 = 250 1000 = 125								
			on Depat)						
	0111 = 500 0110 = 250	kHz (default up	on Resel)						
	0110 = 230 0101 = 125								
	0100 = 62.5								
	$0.01 \times = 31.2$								
	000x = 31 k								
oit 2	Unimplemer	nted: Read as '	o'						
oit 1-0	SCS<1:0>: 8	System Clock Se	elect bits						
		oscillator block							
	01 = Reserve	ed							
	00 = Clock d	etermined by F	OSC<1:0> in (Configuration V	Vords.				
	olicate frequen								

REGISTER 5-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	U-0	U-0	R-0/q	U-0	U-0	R-0/q	R-0/q		
_	— — HFIOFR				_	LFIOFR	HFIOFS		
bit 7						•	bit 0		
Logondi									
Legend: R = Readable	e bit	W = Writable b	bit	U = Unimplemented bit, read as '0'					
u = Bit is und	changed	x = Bit is unkn	own	-n/n = Value a	t POR and BOR	/Value at all oth	er Resets		
'1' = Bit is set '0' = Bit is cleared q = Conditional					al				
bit 7-5 bit 4	HFIOFR: High 1 = HFINTOS								
bit 3-2	Unimplement	ed: Read as '0'							
bit 1	1 = LFINTOS	LFIOFR: Low-Frequency Internal Oscillator Ready bit 1 = LFINTOSC is ready 0 = LFINTOSC is not ready							
bit 0	1 = HFINTOS	HFIOFS: High-Frequency Internal Oscillator Stable bit 1 = HFINTOSC 16 MHz Oscillator is stable and is driving the INTOSC							

REGISTER 5-2: OSCSTAT: OSCILLATOR STATUS REGISTER

TABLE 5-3: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON			IRCF<3:0>				SCS	<1:0>	49
OSCSTAT	_	_	_	HFIOFR	_		LFIOFR	HFIOFS	50

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

TABLE 5-4: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
	13:8	_	_	_	—	CLKOUTEN	BORE	BOREN<1:0>		20
CONFIG1	7:0	CP	MCLRE	PWRTE	WDTE<1:0>			FOSC	<1:0>	38

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

6.0 RESETS

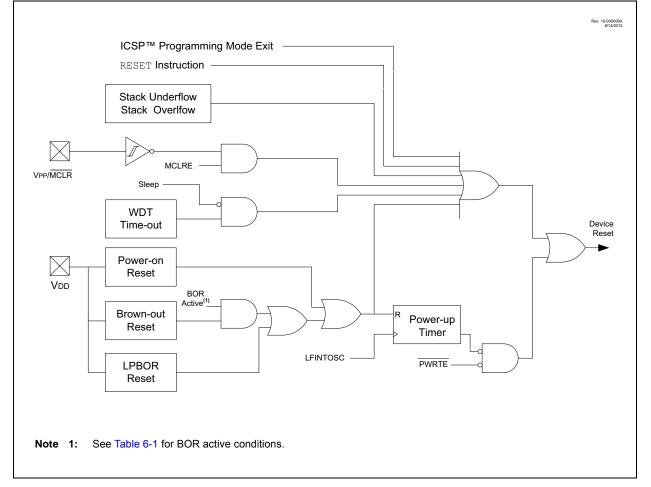
There are multiple ways to reset this device:

- Power-on Reset (POR)
- Brown-out Reset (BOR)
- Low-Power Brown-out Reset (LPBOR)
- MCLR Reset
- WDT Reset
- RESET instruction
- Stack Overflow
- Stack Underflow
- Programming mode exit

To allow VDD to stabilize, an optional power-up timer can be enabled to extend the Reset time after a BOR or POR event.

A simplified block diagram of the On-chip Reset Circuit is shown in Figure 6-1.





6.1 Power-On Reset (POR)

The POR circuit holds the device in Reset until VDD has reached an acceptable level for minimum operation. Slow rising VDD, fast operating speeds or analog performance may require greater than minimum VDD. The PWRT, BOR or MCLR features can be used to extend the start-up period until all device operation conditions have been met.

6.1.1 POWER-UP TIMER (PWRT)

The Power-up Timer provides a nominal 64 ms time-out on POR or Brown-out Reset.

The device is held in Reset as long as PWRT is active. The PWRT delay allows additional time for the VDD to rise to an acceptable level. The Power-up Timer is enabled by clearing the PWRTE bit in Configuration Words.

The Power-up Timer starts after the release of the POR and BOR.

For additional information, refer to Application Note AN607, *"Power-up Trouble Shooting"* (DS00607).

6.2 Brown-Out Reset (BOR)

The BOR circuit holds the device in Reset when VDD reaches a selectable minimum level. Between the POR and BOR, complete voltage range coverage for execution protection can be implemented.

The Brown-out Reset module has four operating modes controlled by the BOREN<1:0> bits in Configuration Words. The four operating modes are:

- BOR is always on
- · BOR is off when in Sleep
- BOR is controlled by software
- · BOR is always off

Refer to Table 6-1 for more information.

The Brown-out Reset voltage level is selectable by configuring the BORV bit in Configuration Words.

A VDD noise rejection filter prevents the BOR from triggering on small events. If VDD falls below Vpor for a duration greater than parameter TBORDC, the device will reset. See Figure 6-2 for more information.

	BOIL OF ERATI			
BOREN<1:0>	SBOREN	Device Mode	BOR Mode	Instruction Execution upon: Release of POR or Wake-up from Sleep
11	Х	х	Active	Waits for BOR ready ⁽¹⁾ (BORRDY = 1)
1.0		Awake	Active	Waits for BOR ready
10	Х	Sleep	Disabled	(BORRDY = 1)
01	1	х	Active	Waits for BOR ready ⁽¹⁾ (BORRDY = 1)
	0	Х	Disabled	Begins immediately
00	Х	х	Disabled	(BORRDY = x)

TABLE 6-1:BOR OPERATING MODES

Note 1: In these specific cases, "release of POR" and "wake-up from Sleep," there is no delay in start-up. The BOR ready flag, (BORRDY = 1), will be set before the CPU is ready to execute instructions because the BOR circuit is forced on by the BOREN<1:0> bits.

6.2.1 BOR IS ALWAYS ON

When the BOREN bits of Configuration Words are programmed to '11', the BOR is always on. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is active during Sleep. The BOR does not delay wake-up from Sleep.

6.2.2 BOR IS OFF IN SLEEP

When the BOREN bits of Configuration Words are programmed to '10', the BOR is on, except in Sleep. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold. BOR protection is not active during Sleep. The device wake-up will be delayed until the BOR is ready.

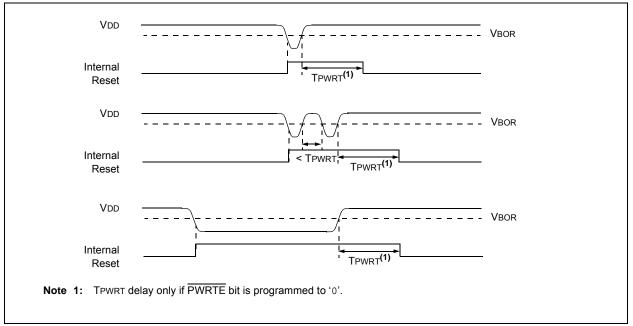
6.2.3 BOR CONTROLLED BY SOFTWARE

When the BOREN bits of Configuration Words are programmed to '01', the BOR is controlled by the SBOREN bit of the BORCON register. The device start-up is not delayed by the BOR ready condition or the VDD level.

BOR protection begins as soon as the BOR circuit is ready. The status of the BOR circuit is reflected in the BORRDY bit of the BORCON register.

BOR protection is unchanged by Sleep.





6.3 Register Definitions: BOR Control

REGISTER 6-1: BORCON: BROWN-OUT RESET CONTROL REGISTER

R/W-1/u	R/W-0/u	U-0	U-0	U-0	U-0	U-0	R-q/u
SBOREN	BORFS	—	—	—	—	—	BORRDY
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7	SBOREN: Software Brown-Out Reset Enable bit
	If BOREN <1:0> in Configuration Words = 01:
	1 = BOR Enabled
	0 = BOR Disabled
	<u>If BOREN <1:0> in Configuration Words ≠ 01</u> :
	SBOREN is read/write, but has no effect on the BOR
bit 6	BORFS: Brown-Out Reset Fast Start bit ⁽¹⁾
	If BOREN <1:0> = 10 (Disabled in Sleep) or BOREN<1:0> = 01 (Under software control):
	 1 = Band gap is forced on always (covers sleep/wake-up/operating cases)
	0 = Band gap operates normally, and may turn off
	<u>If BOREN<1:0> = 11 (Always on) or BOREN<1:0> = 00 (Always off)</u>
	BORFS is Read/Write, but has no effect.
bit 5-1	Unimplemented: Read as '0'
bit 0	BORRDY: Brown-Out Reset Circuit Ready Status bit
	1 = The Brown-out Reset circuit is active
	0 = The Brown-out Reset circuit is inactive
Noto 1.	POPEN<1:0> hits are located in Configuration Words

Note 1: BOREN<1:0> bits are located in Configuration Words.

6.4 Low-Power Brown-Out Reset (LPBOR)

The Low-Power Brown-out Reset (LPBOR) operates like the BOR to detect low voltage conditions on the VDD pin. When too low of a voltage is detected, the device is held in Reset. When this occurs, a register bit (BOR) is changed to indicate that a BOR Reset has occurred. The BOR bit in PCON is used for both BOR and the LPBOR. Refer to Register 6-2.

The LPBOR voltage threshold (Lapboard) has a wider tolerance than the BOR (Vpor), but requires much less current (LPBOR current) to operate. The LPBOR is intended for use when the BOR is configured as disabled (BOREN = 00) or disabled in Sleep mode (BOREN = 10).

Refer to Figure 6-1 to see how the LPBOR interacts with other modules.

6.4.1 ENABLING LPBOR

The LPBOR is controlled by the $\overline{\text{LPBOR}}$ bit of Configuration Words. When the device is erased, the LPBOR module defaults to disabled.

6.5 MCLR

The $\overline{\text{MCLR}}$ is an optional external input that can reset the device. The $\overline{\text{MCLR}}$ function is controlled by the MCLRE bit of Configuration Words and the LVP bit of Configuration Words (Table 6-2).

TABLE 6-2: MCLR CONFIGURATION

MCLRE	LVP	MCLR
0	0	Disabled
1	0	Enabled
x	1	Enabled

6.5.1 MCLR ENABLED

When $\overline{\text{MCLR}}$ is enabled and the pin is held low, the device is held in Reset. The $\overline{\text{MCLR}}$ pin is connected to VDD through an internal weak pull-up.

The device has a noise filter in the $\overline{\text{MCLR}}$ Reset path. The filter will detect and ignore small pulses.

Note: A Reset does not drive the MCLR pin low.

6.5.2 MCLR DISABLED

When MCLR is disabled, the pin functions as a general purpose input and the internal weak pull-up is under software control. See **Section 11.3 "PORTA Registers"** for more information.

6.6 Watchdog Timer (WDT) Reset

The Watchdog Timer generates a Reset if the firmware does not issue a CLRWDT instruction within the time-out period. The \overline{TO} and \overline{PD} bits in the STATUS register are changed to indicate the WDT Reset. See **Section 9.0 "Watchdog Timer (WDT)**" for more information.

6.7 RESET Instruction

A RESET instruction will cause a device Reset. The \overline{RI} bit in the PCON register will be set to '0'. See Table 6-4 for default conditions after a RESET instruction has occurred.

6.8 Stack Overflow/Underflow Reset

The device can reset when the Stack Overflows or Underflows. The STKOVF or STKUNF bits of the PCON register indicate the Reset condition. These Resets are enabled by setting the STVREN bit in Configuration Words. See Section 3.5.2 "Overflow/Underflow Reset" for more information.

6.9 Programming Mode Exit

Upon exit of Programming mode, the device will behave as if a POR had just occurred.

6.10 Power-Up Timer

The Power-up Timer optionally delays device execution after a BOR or POR event. This timer is typically used to allow VDD to stabilize before allowing the device to start running.

The Power-up Timer is controlled by the $\overline{\text{PWRTE}}$ bit of Configuration Words.

6.11 Start-up Sequence

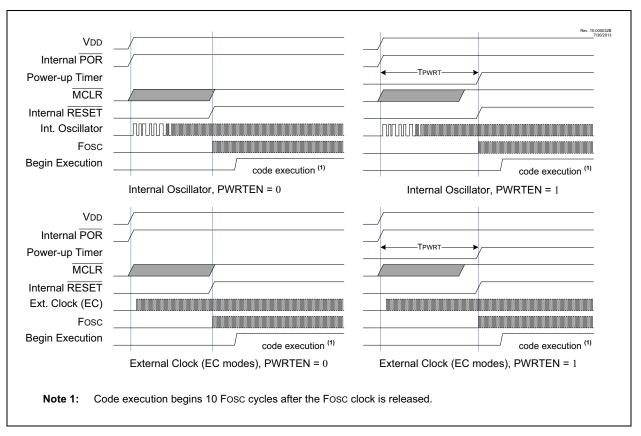
Upon the release of a POR or BOR, the following must occur before the device will begin executing:

- 1. Power-up Timer runs to completion (if enabled).
- 2. MCLR must be released (if enabled).

The total time-out will vary based on oscillator configuration and Power-up Timer configuration. See **Section 5.0** "Oscillator Module" for more information.

The Power-up Timer runs independently of MCLR Reset. If MCLR is kept low long enough, the Power-up Timer will expire. Upon bringing MCLR high, the device will begin execution after 10 FOSS cycles (see Figure 6-3). This is useful for testing purposes or to synchronize more than one device operating in parallel.





6.12 Determining the Cause of a Reset

Upon any Reset, multiple bits in the STATUS and PCON registers are updated to indicate the cause of the Reset. Table 6-3 and Table 6-4 show the Reset conditions of these registers.

STKOVF	STKUNF	RWDT	RMCLR	RI	POR	BOR	то	PD	Condition
0	0	1	1	1	0	x	1	1	Power-on Reset
0	0	1	1	1	0	x	0	x	Illegal, $\overline{\text{TO}}$ is set on $\overline{\text{POR}}$
0	0	1	1	1	0	x	x	0	Illegal, PD is set on POR
0	0	u	1	1	u	0	1	1	Brown-out Reset
u	u	0	u	u	u	u	0	u	WDT Reset
u	u	u	u	u	u	u	0	0	WDT Wake-up from Sleep
u	u	u	u	u	u	u	1	0	Interrupt Wake-up from Sleep
u	u	u	0	u	u	u	u	u	MCLR Reset during normal operation
u	u	u	0	u	u	u	1	0	MCLR Reset during Sleep
u	u	u	u	0	u	u	u	u	RESET Instruction Executed
1	u	u	u	u	u	u	u	u	Stack Overflow Reset (STVREN = 1)
u	1	u	u	u	u	u	u	u	Stack Underflow Reset (STVREN = 1)

TABLE 6-3: RESET STATUS BITS AND THEIR SIGNIFICANCE

TABLE 6-4: RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	0000h	1 1000	00 110x
MCLR Reset during normal operation	0000h	u muumuu	uu Ouuu
MCLR Reset during Sleep	0000h	1 Ouuu	uu Ouuu
WDT Reset	0000h	0 muumuu	uu uuuu
WDT Wake-up from Sleep	PC + 1	0 Ouuu	uu uuuu
Brown-out Reset	0000h	1 luuu	00 11u0
Interrupt Wake-up from Sleep	PC + 1 ⁽¹⁾	1 Ouuu	uu uuuu
RESET Instruction Executed	0000h	u uuuu	uu u0uu
Stack Overflow Reset (STVREN = 1)	0000h	u uuuu	lu uuuu
Stack Underflow Reset (STVREN = 1)	0000h	u uuuu	ul uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and the Global Interrupt Enable bit (GIE) is set, the return address is pushed on the stack and PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

6.13 Power Control (PCON) Register

The Power Control (PCON) register contains flag bits to differentiate between a:

- Power-on Reset (POR)
- Brown-out Reset (BOR)
- Reset Instruction Reset (RI)
- MCLR Reset (RMCLR)
- Watchdog Timer Reset (RWDT)
- Stack Underflow Reset (STKUNF)
- Stack Overflow Reset (STKOVF)

The PCON register bits are shown in Register 6-2.

6.14 Register Definitions: Power Control

REGISTER 6-2: PCON: POWER CONTROL REGISTER

R/W/HS-0/q	R/W/HS-0/q	U-0	R/W/HC-1/q	R/W/HC-1/q	R/W/HC-1/q	R/W/HC-q/u	R/W/HC-q/u
STKOVF	STKUNF	—	RWDT	RMCLR	RI	POR	BOR
bit 7						•	bit 0

Legend:						
HC = Bit is cleared by har	dware	HS = Bit is set by hardware				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets				
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition				

bit 7	STKOVF: Stack Overflow Flag bit
	1 = A Stack Overflow occurred
	0 = A Stack Overflow has not occurred or cleared by firmware
bit 6	STKUNF: Stack Underflow Flag bit
	1 = A Stack Underflow occurred
	0 = A Stack Underflow has not occurred or cleared by firmware
bit 5	Unimplemented: Read as '0'
bit 4	RWDT: Watchdog Timer Reset Flag bit
	1 = A Watchdog Timer Reset has not occurred or set by firmware
	0 = A Watchdog Timer Reset has occurred (cleared by hardware)
bit 3	RMCLR: MCLR Reset Flag bit
	1 = A $\overline{\text{MCLR}}$ Reset has not occurred or set by firmware
	0 = A MCLR Reset has occurred (cleared by hardware)
bit 2	RI: RESET Instruction Flag bit
	1 = A RESET instruction has not been executed or set by firmware
	0 = A RESET instruction has been executed (cleared by hardware)
bit 1	POR: Power-On Reset Status bit
	1 = No Power-on Reset occurred
	0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)
bit 0	BOR: Brown-Out Reset Status bit
	1 = No Brown-out Reset occurred
	 0 = A Brown-out Reset occurred (must be set in software after a Power-on Reset or Brown-out Reset occurs)

TABLE 6-5: SUMMARY OF REGISTERS ASSOCIATED WITH RESETS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BORCON	SBOREN	BORFS				_	_	BORRDY	53
PCON	STKOVF	STKUNF	_	RWDT	RMCLR	RI	POR	BOR	57
STATUS		_		TO	PD	Z	DC	С	17
WDTCON	—	—		V	SWDTEN	77			

Legend: — = unimplemented bit, reads as '0'. Shaded cells are not used by Resets.

TABLE 6-6: SUMMARY OF CONFIGURATION WORD WITH RESETS

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page	
	13:8					CLKOUTEN	BOREI	BOREN<1:0> —		20	
CONFIG1	7:0	CP	MCLRE	PWRTE	WD	TE<1:0>	_	FOSC	<1:0>	38	
	13:8		_	LVP	DEBUG	LPBOR	BORV	STVREN	_	20	
CONFIG2	7:0					_		WRT	<1:0>	39	

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by Resets.

7.0 INTERRUPTS

The interrupt feature allows certain events to preempt normal program flow. Firmware is used to determine the source of the interrupt and act accordingly. Some interrupts can be configured to wake the MCU from Sleep mode.

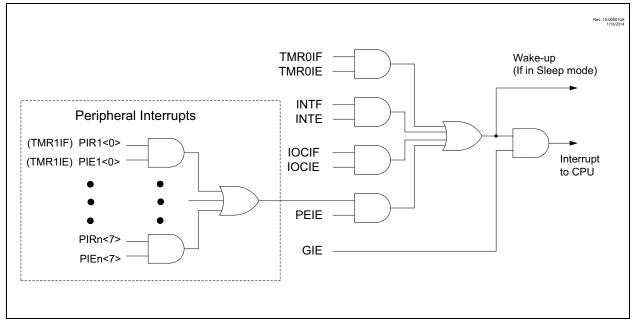
This chapter contains the following information for Interrupts:

- Operation
- Interrupt Latency
- Interrupts During Sleep
- INT Pin
- Automatic Context Saving

Many peripherals produce interrupts. Refer to the corresponding chapters for details.

A block diagram of the interrupt logic is shown in Figure 7-1.

FIGURE 7-1: INTERRUPT LOGIC



7.1 Operation

Interrupts are disabled upon any device Reset. They are enabled by setting the following bits:

- GIE bit of the INTCON register
- Interrupt Enable bit(s) for the specific interrupt event(s)
- PEIE bit of the INTCON register (if the Interrupt Enable bit of the interrupt event is contained in the PIE1, PIE2 and PIE3 registers)

The INTCON, PIR1, PIR2 and PIR3 registers record individual interrupts via interrupt flag bits. Interrupt flag bits will be set, regardless of the status of the GIE, PEIE and individual interrupt enable bits.

The following events happen when an interrupt event occurs while the GIE bit is set:

- Current prefetched instruction is flushed
- · GIE bit is cleared
- Current Program Counter (PC) is pushed onto the stack
- Critical registers are automatically saved to the shadow registers (See "Section 7.5 "Automatic Context Saving".")
- · PC is loaded with the interrupt vector 0004h

The firmware within the Interrupt Service Routine (ISR) should determine the source of the interrupt by polling the interrupt flag bits. The interrupt flag bits must be cleared before exiting the ISR to avoid repeated interrupts. Because the GIE bit is cleared, any interrupt that occurs while executing the ISR will be recorded through its interrupt flag, but will not cause the processor to redirect to the interrupt vector.

The RETFIE instruction exits the ISR by popping the previous address from the stack, restoring the saved context from the shadow registers and setting the GIE bit.

For additional information on a specific interrupt's operation, refer to its peripheral chapter.

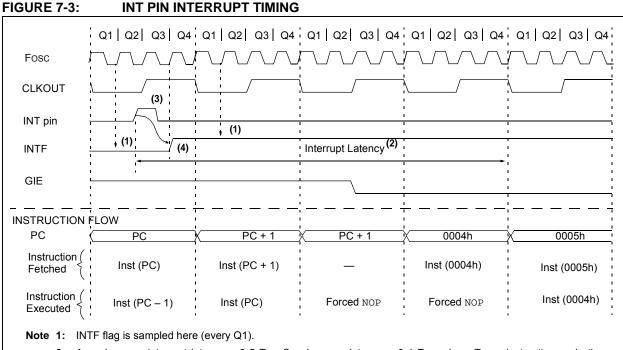
- Note 1: Individual interrupt flag bits are set, regardless of the state of any other enable bits.
 - 2: All interrupts will be ignored while the GIE bit is cleared. Any interrupt occurring while the GIE bit is clear will be serviced when the GIE bit is set again.

7.2 Interrupt Latency

Interrupt latency is defined as the time from when the interrupt event occurs to the time code execution at the interrupt vector begins. The latency for synchronous interrupts is three or four instruction cycles. For asynchronous interrupts, the latency is three to five instruction cycles, depending on when the interrupt occurs. See Figure 7-2 and Figure 7-3 for more details.



Fosc	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4			Q1 Q2 Q3 Q4	4 Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	
			Interru during	pt Sampled Q1				
Interrupt								
GIE								
PC	PC-1	PC	PC	+1	0004h	0005h		(
Execute	1-Cycle Instr	uction at PC	Inst(PC)	NOP	NOP	Inst(0004h)		
Interrupt								
GIE								
PC	PC-1	PC	PC+1/FSR ADDR	New PC/ PC+1	0004h	0005h		/
Execute-	2-Cycle Instr	uction at PC	Inst(PC)	NOP	NOP	Inst(0004h)		
Interrupt								
GIE								
PC	PC-1	PC	FSR ADDR	PC+1	PC+2	0004h	0005h	
Execute	3-Cycle Instr	uction at PC	INST(PC)	NOP	NOP	NOP	Inst(0004h)	Inst(0005h)
Interrupt								
GIE								
PC	PC-1	PC	FSR ADDR	PC+1	Р	C+2	0004h	0005h
Execute	3-Cycle Instr	uction at PC	INST(PC)	NOP	NOP	NOP	NOP	Inst(0004h)



2: Asynchronous interrupt latency = 3-5 TCY. Synchronous latency = 3-4 TCY, where TCY = instruction cycle time. Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.

3: For minimum width of INT pulse, refer to AC specifications in Section 27.0 "Electrical Specifications".

4: INTF is enabled to be set any time during the Q4-Q1 cycles.

7.3 Interrupts During Sleep

Some interrupts can be used to wake from Sleep. To wake from Sleep, the peripheral must be able to operate without the system clock. The interrupt source must have the appropriate Interrupt Enable bit(s) set prior to entering Sleep.

On waking from Sleep, if the GIE bit is also set, the processor will branch to the interrupt vector. Otherwise, the processor will continue executing instructions after the SLEEP instruction. The instruction directly after the SLEEP instruction will always be executed before branching to the ISR. Refer to Section 8.0 "Power-Down Mode (Sleep)" for more details.

7.4 INT Pin

The INT pin can be used to generate an asynchronous edge-triggered interrupt. This interrupt is enabled by setting the INTE bit of the INTCON register. The INTEDG bit of the OPTION_REG register determines on which edge the interrupt will occur. When the INTEDG bit is set, the rising edge will cause the interrupt. When the INTEDG bit is clear, the falling edge will cause the interrupt. The INTF bit of the INTCON register will be set when a valid edge appears on the INT pin. If the GIE and INTE bits are also set, the processor will redirect program execution to the interrupt vector.

7.5 Automatic Context Saving

Upon entering an interrupt, the return PC address is saved on the stack. Additionally, the following registers are automatically saved in the shadow registers:

- W register
- STATUS register (except for TO and PD)
- BSR register
- FSR registers
- PCLATH register

Upon exiting the Interrupt Service Routine, these registers are automatically restored. Any modifications to these registers during the ISR will be lost. If modifications to any of these registers are desired, the corresponding shadow register should be modified and the value will be restored when exiting the ISR. The shadow registers are available in Bank 31 and are readable and writable. Depending on the user's application, other registers may also need to be saved.

7.6 Register Definitions: Interrupt Control

R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R-0/0 GIE⁽¹⁾ PEIE⁽²⁾ IOCIF⁽³⁾ INTF TMR0IE INTE IOCIE TMR0IF bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n/n = Value at POR and BOR/Value at all other Resets u = Bit is unchanged x = Bit is unknown '0' = Bit is cleared '1' = Bit is set GIE: Global Interrupt Enable bit⁽¹⁾ bit 7 1 = Enables all active interrupts 0 = Disables all interrupts bit 6 PEIE: Peripheral Interrupt Enable bit⁽²⁾ 1 = Enables all active peripheral interrupts 0 = Disables all peripheral interrupts TMR0IE: Timer0 Overflow Interrupt Enable bit bit 5 1 = Enables the Timer0 interrupt 0 = Disables the Timer0 interrupt **INTE:** INT External Interrupt Enable bit bit 4 1 = Enables the INT external interrupt 0 = Disables the INT external interrupt bit 3 IOCIE: Interrupt-on-Change Enable bit 1 = Enables the interrupt-on-change 0 = Disables the interrupt-on-change TMR0IF: Timer0 Overflow Interrupt Flag bit bit 2 1 = TMR0 register has overflowed 0 = TMR0 register did not overflow bit 1 **INTF:** INT External Interrupt Flag bit 1 = The INT external interrupt occurred 0 = The INT external interrupt did not occur IOCIF: Interrupt-on-Change Interrupt Flag bit⁽³⁾ bit 0 1 = When at least one of the interrupt-on-change pins changed state 0 = None of the interrupt-on-change pins have changed state Note 1: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

- 2: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt.
- **3:** The IOCIF Flag bit is read-only and cleared when all the interrupt-on-change flags in the IOCxF registers have been cleared by software.

R/W-0/0	R/W-0/0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	
TMR1GIE	ADIE	—	—	—	—	TMR2IE	TMR1IE	
bit 7							bit 0	
Legend:								
R = Readab	le bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'		
u = Bit is und	changed	x = Bit is unkr	nown	-n/n = Value a	at POR and BO	R/Value at all c	other Resets	
'1' = Bit is se	et	'0' = Bit is clea	ared					
bit 7	TMR1GIE: Ti	mer1 Gate Inte	rrupt Enable b	oit				
		he Timer1 gate						
	0 = Disables	the Timer1 gate	e acquisition in	nterrupt				
bit 6	ADIE: Analog	g-to-Digital Con	verter (ADC)	Interrupt Enabl	e bit			
		he ADC interru	•					
		the ADC interru						
bit 5-2	•	ted: Read as '						
bit 1	TMR2IE: TM	R2 to PR2 Mate	ch Interrupt Er	nable bit				
		he Timer2 to P						
		the Timer2 to P		-				
bit 0		er1 Overflow In	•					
	 1 = Enables the Timer1 overflow interrupt 0 = Disables the Timer1 overflow interrupt 							
			mow interrupt					
Note: B	Bit PEIE of the IN	TCON register	must be					
	et to enable any p	Ų						

REGISTER 7-2: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

U-0	U-0	R/W-0/0	U-0	U-0	R/W-0/0	U-0	U-0
_	—	C1IE	_	—	NCO1IE	—	—
bit 7							bit 0
Legend:							
R = Reada	ble bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
u = Bit is u	nchanged	x = Bit is unkr	iown	-n/n = Value a	at POR and BOI	R/Value at all o	ther Resets
'1' = Bit is s	set	'0' = Bit is clea	ared				
bit 7-6	Unimplement	ted: Read as ')'				
bit 5	C1IE: Compa	rator C1 Interru	ipt Enable bit				
	1 = Enables t	he Comparato	r C1 interrupt				
	0 = Disables	the Comparato	or C1 interrupt				
bit 4-3	Unimplement	ted: Read as '	כ'				
bit 2	NCO1IE: Nun	nerically Contro	olled Oscillato	r Interrupt Ena	ble bit		
		he NCO interru					
	0 = Disables	the NCO interr	upt				
bit 1-0	Unimplement	ted: Read as ')'				
Note:	Bit PEIE of the IN	CON register	must be				
	set to enable any p	•					

REGISTER 7-3: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
_	—	—	_	—	—	CLC2IE	CLC1IE
bit 7							bit 0
· ·							
Legend:							
R = Read	dable bit	W = Writable	bit	U = Unimpler	mented bit, read	l as '0'	
u = Bit is	unchanged	x = Bit is unkr	nown	-n/n = Value	at POR and BO	R/Value at all o	ther Resets
'1' = Bit is	s set	'0' = Bit is clea	ared				
bit 7-2	Unimplem	ented: Read as '	כי				
bit 1	1 = Enable	onfigurable Logic as the CLC 2 inter as the CLC 2 inter	rupt	rupt Enable bit			
bit 0	1 = Enable	onfigurable Logic es the CLC 1 inter es the CLC 1 inte	rupt	rupt Enable bit			
Note:		INTCON register y peripheral inter					

REGISTER 7-4: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

R/W-0/	/0 R/W-0)/0 U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0		
TMR1G	SIF ADIF		_	_	_	TMR2IF	TMR1IF		
bit 7				·	·	·	bit		
<u> </u>									
Legend:									
R = Read		W = Writable		-	mented bit, read				
	unchanged	x = Bit is unk		-n/n = Value	at POR and BC	R/Value at all c	other Resets		
'1' = Bit is	set	'0' = Bit is cle	ared						
L:1 7	THE								
bit 7		F: Timer1 Gate Inte	rrupt Flag bit						
		rupt is pending							
bit 6		DC Interrupt Flag bi	t						
		rupt is pending							
		rupt is not pending							
bit 5-2	Unimple	mented: Read as '	0'						
bit 1	TMR2IF	TMR2IF: Timer2 to PR2 Interrupt Flag bit							
		rupt is pending							
		rupt is not pending							
bit 0		Timer1 Overflow Ir	nterrupt Flag b	it					
		rupt is pending							
	0 = Inter	rupt is not pending							
Note:		bits are set when an							
		urs, regardless of th							
		ding enable bit or th ble bit, GIE of the							
		software should er							
		terrupt flag bits are o	clear prior						
	to enabling ar	n interrupt.							

REGISTER 7-5: PIR1: PERIPHERAL INTERRUPT REQUEST REGISTER 1

	U-0		U-0			11.0	11.0			
U-0	0-0	R/W-0/0	0-0	U-0	R/W-0/0	U-0	U-0			
_		C1IF	—		NCO1IF					
bit 7							bit 0			
Legend:										
R = Read	labla bit	W = Writable I	hit	II – Unimplor	mented bit, read	ac '0'				
				•	,					
u = Bit is	unchanged	x = Bit is unkn	iown	-n/n = Value a	at POR and BOF	R/Value at all c	ther Resets			
'1' = Bit is	s set	'0' = Bit is clea	ared							
bit 7-6	Unimplemer	Unimplemented: Read as '0'								
bit 5	C1IF: Compa	arator C1 Interru	pt Flag bit							
	1 = Interrupt	is pending								
	0 = Interrupt	is not pending								
bit 4-3	Unimplemer	nted: Read as 'd)'							
bit 2	NCO1IF: Nur	merically Contro	lled Oscillato	or Flag bit						
	1 = Interrupt	•		5						
		is not pending								
bit 1-0	Unimplemer	nted: Read as 'o)'							
			-							
Note:	Interrupt flag bits a									
	condition occurs, r									
	its corresponding Interrupt Enable b									
	register. User soft									
	appropriate interru									
	to enabling an inte									

REGISTER 7-6: PIR2: PERIPHERAL INTERRUPT REQUEST REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
_	_					CLC2IF	CLC1IF
bit 7				·			bit 0
Legend:							
R = Read	dable bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
u = Bit is	unchanged	x = Bit is unkr	nown	-n/n = Value a	at POR and BO	R/Value at all c	ther Resets
'1' = Bit is	s set	'0' = Bit is clea	ared				
bit 7-2 bit 1 bit 0	CLC2IF: Con 1 = Interrupt i 0 = Interrupt i CLC1IF: Con 1 = Interrupt i	is not pending figurable Logic is pending	Block 2 Interr				
Note:	Interrupt flag bits a condition occurs, r its corresponding o Enable bit, GIE o User software	egardless of the enable bit or th f the INTCON should ensu	e state of e Global register. ire the				

REGISTER 7-7: PIR3: PERIPHERAL INTERRUPT REQUEST REGISTER 3

appropriate interrupt flag bits are clear prior to enabling an interrupt.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
OPTION_REG	WPUEN	INTEDG	TMR0CS	TMR0SE	PSA	PS<2:0>			136
PIE1	TMR1GIE	ADIE	_	_	—	—	TMR2IE	TMR1IE	65
PIE2	_	_	C1IE	_	_	NCO1IE	_	—	66
PIE3	_	_	_	_	_	_	CLC2IE	CLC1IE	67
PIR1	TMR1GIF	ADIF	_	_	_	_	TMR2IF	TMR1IF	68
PIR2	_	_	C1IF	_	_	NCO1IF	_	—	68
PIR3	_	_	_	_	_	_	CLC2IF	CLC1IF	70

TABLE 7-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by interrupts.

8.0 POWER-DOWN MODE (SLEEP)

The Power-down mode is entered by executing a **SLEEP** instruction.

Upon entering Sleep mode, the following conditions exist:

- 1. WDT will be cleared but keeps running, if enabled for operation during Sleep.
- 2. PD bit of the STATUS register is cleared.
- 3. $\overline{\text{TO}}$ bit of the STATUS register is set.
- 4. CPU clock is disabled.
- 5. 31 kHz LFINTOSC is unaffected and peripherals that operate from it may continue operation in Sleep.
- 6. Timer1 and peripherals that operate from Timer1 continue operation in Sleep when the Timer1 clock source selected is:
 - LFINTOSC
 - T1CKI
- 7. ADC is unaffected, if the dedicated FRC oscillator is selected.
- 8. I/O ports maintain the status they had before SLEEP was executed (driving high, low or highimpedance).
- 9. Resets other than WDT are not affected by Sleep mode.

Refer to individual chapters for more details on peripheral operation during Sleep.

To minimize current consumption, the following conditions should be considered:

- · I/O pins should not be floating
- External circuitry sinking current from I/O pins
- Internal circuitry sourcing current from I/O pins
- Current draw from pins with internal weak pull-ups
- Modules using 31 kHz LFINTOSC
- CWG, NCO and CLC modules using HFINTOSC

I/O pins that are high-impedance inputs should be pulled to VDD or VSS externally to avoid switching currents caused by floating inputs.

Examples of internal circuitry that might be sourcing current include the FVR module. See **Section 13.0 "Fixed Voltage Reference (FVR)"** for more information on this module.

8.1 Wake-up from Sleep

The device can wake-up from Sleep through one of the following events:

- 1. External Reset input on MCLR pin, if enabled
- 2. BOR Reset, if enabled
- 3. POR Reset
- 4. Watchdog Timer, if enabled
- 5. Any external interrupt
- 6. Interrupts by peripherals capable of running during Sleep (see individual peripheral for more information)

The first three events will cause a device Reset. The last three events are considered a continuation of program execution. To determine whether a device Reset or wake-up event occurred, refer to Section 6.12 "Determining the Cause of a Reset".

When the SLEEP instruction is being executed, the next instruction (PC + 1) is prefetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be enabled. Wake-up will occur regardless of the state of the GIE bit. If the GIE bit is disabled, the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is enabled, the device executes the instruction after the SLEEP instruction, the device will then call the Interrupt Service Routine. In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

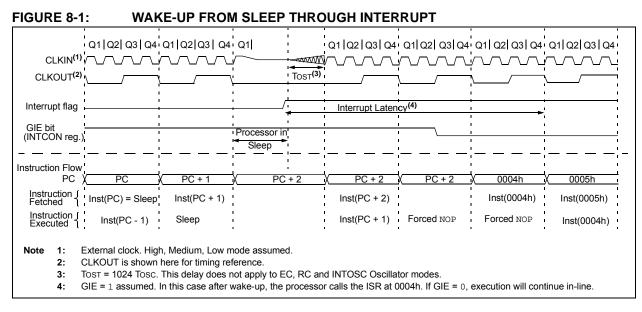
The WDT is cleared when the device wakes up from Sleep, regardless of the source of wake-up.

8.1.1 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction
 - SLEEP instruction will execute as a NOP.
 - WDT and WDT prescaler will not be cleared
 - TO bit of the STATUS register will not be set
 - PD bit of the STATUS register will not be cleared.
- If the interrupt occurs **during or after** the execution of a SLEEP instruction
 - SLEEP instruction will be completely executed
 - Device will immediately wake-up from Sleep
 - WDT and WDT prescaler will be cleared
 - TO bit of the STATUS register will be set
 - PD bit of the STATUS register will be cleared

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the PD bit. If the PD bit is set, the SLEEP instruction was executed as a NOP.



8.2 Low-Power Sleep Mode

This device contains an internal Low Dropout (LDO) voltage regulator, which allows the device I/O pins to operate at voltages up to 5.5V while the internal device logic operates at a lower voltage. The LDO and its associated reference circuitry must remain active when the device is in Sleep mode.

Low-Power Sleep mode allows the user to optimize the operating current in Sleep. Low-Power Sleep mode can be selected by setting the VREGPM bit of the VREGCON register, putting the LDO and reference circuitry in a low-power state whenever the device is in Sleep.

8.2.1 SLEEP CURRENT VS. WAKE-UP TIME

In the Default Operating mode, the LDO and reference circuitry remain in the normal configuration while in Sleep. The device is able to exit Sleep mode quickly since all circuits remain active. In Low-Power Sleep mode, when waking up from Sleep, an extra delay time is required for these circuits to return to the normal configuration and stabilize.

The Low-Power Sleep mode is beneficial for applications that stay in Sleep mode for long periods of time. The Normal mode is beneficial for applications that need to wake from Sleep quickly and frequently.

8.2.2 PERIPHERAL USAGE IN SLEEP

Some peripherals that can operate in Sleep mode will not operate properly with the Low-Power Sleep mode selected. The LDO will remain in the Normal Power mode when those peripherals are enabled. The Low-Power Sleep mode is intended for use with these peripherals:

- Brown-out Reset (BOR)
- Watchdog Timer (WDT)
- · External interrupt pin/Interrupt-on-change pins
- Timer1 (with external clock source)

The Complementary Waveform Generator (CWG), the Numerically Controlled Oscillator (NCO) and the Configurable Logic Cell (CLC) modules can utilize the HFINTOSC oscillator as either a clock source or as an input source. Under certain conditions, when the HFINTOSC is selected for use with the CWG, NCO or CLC modules, the HFINTOSC will remain active during Sleep. This will have a direct effect on the Sleep mode current.

Please refer to sections Section 22.5 "Operation During Sleep", 23.7 "Operation In Sleep" and 24.10 "Operation During Sleep" for more information.

Note:	The PIC12LF1501 does not have a con-
	figurable Low-Power Sleep mode.
	PIC12LF1501 is an unregulated device
	and is always in the lowest power state
	when in Sleep, with no wake-up time pen-
	alty. This device has a lower maximum
	VDD and I/O voltage than the
	PIC12F1501. See Section
	27.0 "Electrical Specifications" for
	more information.

8.3 Register Definitions: Voltage Regulator Control

REGISTER 8-1: VREGCON: VOLTAGE REGULATOR CONTROL REGISTER⁽¹⁾

Logond							
bit 7							bit 0
	—	—	_	—		VREGPM	Reserved
U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-1/1

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-2 Unimplemented: Read as '0'

- 0 = Normal Power mode enabled in Sleep⁽²⁾
 Draws higher current in Sleep, faster wake-up
- Reserved: Read as '1'. Maintain this bit set.

Note 1: PIC12F1501 only.

bit 0

2: See Section 27.0 "Electrical Specifications".

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page	
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64	
IOCAF	—		IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	103	
IOCAN	—		IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	103	
IOCAP	—		IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	103	
PIE1	TMR1GIE	ADIE	—	_	_	—	TMR2IE	TMR1IE	65	
PIE2	—		C1IE	_	_	NCO1IE	—	—	66	
PIE3	—		_	_	_	—	CLC2IE	CLC1IE	67	
PIR1	TMR1GIF	ADIF	_	_	_	—	TMR2IF	TMR1IF	68	
PIR2	—		C1IF	_	_	NCO1IF	—	—	67	
PIR3	—		—	_	_	_	CLC2IF	CLC1IF	70	
STATUS	—		—	TO	PD	Z	DC	С	17	
WDTCON	—			V		SWDTEN	77			

TABLE 8-1: SUMMARY OF REGISTERS ASSOCIATED WITH POWER-DOWN MODE

Legend: — = unimplemented, read as '0'. Shaded cells are not used in Power-Down mode.

bit 1 VREGPM: Voltage Regulator Power Mode Selection bit

Low-Power Sleep mode enabled in Sleep⁽²⁾
 Draws lowest current in Sleep, slower wake-up

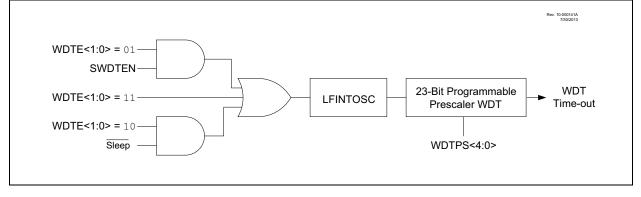
9.0 WATCHDOG TIMER (WDT)

The Watchdog Timer is a system timer that generates a Reset if the firmware does not issue a CLRWDT instruction within the time-out period. The Watchdog Timer is typically used to recover the system from unexpected events.

The WDT has the following features:

- Independent clock source
- Multiple operating modes
 - WDT is always on
 - WDT is off when in Sleep
 - WDT is controlled by software
 - WDT is always off
- Configurable time-out period is from 1 ms to 256 seconds (nominal)
- Multiple Reset conditions
- Operation during Sleep





9.1 Independent Clock Source

The WDT derives its time base from the 31 kHz LFINTOSC internal oscillator. Time intervals in this chapter are based on a nominal interval of 1 ms. See **Section 27.0 "Electrical Specifications"** for the LFINTOSC tolerances.

9.2 WDT Operating Modes

The Watchdog Timer module has four operating modes controlled by the WDTE<1:0> bits in Configuration Words. See Table 9-1.

9.2.1 WDT IS ALWAYS ON

When the WDTE bits of Configuration Words are set to '11', the WDT is always on.

WDT protection is active during Sleep.

9.2.2 WDT IS OFF IN SLEEP

When the WDTE bits of Configuration Words are set to '10', the WDT is on, except in Sleep.

WDT protection is not active during Sleep.

9.2.3 WDT CONTROLLED BY SOFTWARE

When the WDTE bits of Configuration Words are set to '01', the WDT is controlled by the SWDTEN bit of the WDTCON register.

WDT protection is unchanged by Sleep. See Table 9-1 for more details.

TABLE 9-1: WDT OPERATING	MODES
--------------------------	-------

WDTE<1:0>	SWDTEN	Device Mode	WDT Mode
11	Х	Х	Active
10		Awake	Active
10	Х	Sleep	Disabled
0.1	1	х	Active
01	0	х	Disabled
00	Х	х	Disabled

TABLE 9-2: WDT CLEARING CONDITIONS

ConditionsWDTWDTE<1:0> = 00WDTE<1:0> = 01 and SWDTEN = 0WDTE<1:0> = 10 and enter SleepClearedCLRWDT CommandOscillator Fail DetectedExit Sleep + System Clock = INTOSC, EXTCLKUnaffectedChange INTOSC divider (IRCF bits)Unaffected

9.3 Time-Out Period

The WDTPS bits of the WDTCON register set the time-out period from 1 ms to 256 seconds (nominal). After a Reset, the default time-out period is two seconds.

9.4 Clearing the WDT

The WDT is cleared when any of the following conditions occur:

- Any Reset
- CLRWDT instruction is executed
- · Device enters Sleep
- Device wakes up from Sleep
- Oscillator fail
- · WDT is disabled

See Table 9-2 for more information.

9.5 Operation During Sleep

When the device enters Sleep, the WDT is cleared. If the WDT is enabled during Sleep, the WDT resumes counting. When the device exits Sleep, the WDT is cleared again.

When a WDT time-out occurs while the device is in Sleep, no Reset is generated. Instead, the device wakes up and resumes operation. The TO and PD bits in the STATUS register are changed to indicate the event. The RWDT bit in the PCON register can also be used. See Section 3.0 "Memory Organization" for more information.

9.6 Register Definitions: Watchdog Timer Control

U-0	U-0	R/W-0/0	R/W-1/1	R/W-0/0	R/W-1/1	R/W-1/1	R/W-0/0		
—				WDTPS<4:0>			SWDTEN		
oit 7							bit (
_egend:									
R = Readab		W = Writable		U = Unimpleme					
u = Bit is un	changed	x = Bit is unkr	nown	-n/n = Value at	POR and BC	OR/Value at all o	other Resets		
1' = Bit is se	et	'0' = Bit is clea	ared						
bit 7-6	Unimpleme	nted: Read as '	0'						
oit 5-1	-	>: Watchdog Ti		elect bits ⁽¹⁾					
		Prescale Rate							
		eserved. Result	s in minimum	interval (1:32)					
	•								
	•								
	•								
	10011 = R0	eserved. Result	s in minimum	interval (1:32)					
	10010 = 1 :	8388608 (2 ²³) (Interval 256s	nominal)					
$10001 = 1:4194304 (2^{22})$ (Interval 128s nominal)									
	10000 = 1:	2097152 (2 ²¹) (1048576 (2 ²⁰) (Interval 64s r	ominal)					
	01111 = 1:	1048576 (2 ²⁰) (524288 (2 ¹⁹) (Ir	Interval 32s r	iominal)					
	01110 = 1. 01101 = 1	262144 (2 ¹⁸) (Ir	iterval 8s nor	ninal)					
		131072 (2 ¹⁷) (Ir							
		65536 (Interval		,					
		32768 (Interval							
		16384 (Interval							
		= 1:8192 (Interval 256 ms nominal)							
		 11 = 1:4096 (Interval 128 ms nominal) 10 = 1:2048 (Interval 64 ms nominal) 							
		1024 (Interval 3							
		512 (Interval 16		,					
		256 (Interval 8 r							
		128 (Interval 4 r							
		64 (Interval 2 m							
sit O		32 (Interval 1 m		latabdag Timar b	.1				
oit 0			Disable for V	/atchdog Timer b	IL				
	<u>If WDTE<1:(</u> This bit is igr								
	If WDTE<1:0								
	1 = WDT is								
	0 = WDT is	turned off							
	If WDTE<1:0								
	This bit is igr	nored.							

REGISTER 9-1: WDTCON: WATCHDOG TIMER CONTROL REGISTER



TABLE 9-3:	SUMMARY OF REGISTERS ASSOCIATED WITH WATCHDOG TIMER
TADLL 3-3.	SOMMART OF REGISTERS ASSOCIATED WITH WATCHDOG HMER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON	—		IRCF	<3:0>		—	SCS<1:0>		49
PCON	STKOVF	STKUNF	_	RWDT	RMCLR	RI	POR	BOR	57
STATUS	—	—	_	TO	PD	Z	DC	С	17
WDTCON	_	—	WDTPS<4:0>					SWDTEN	77

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Watchdog Timer.

TABLE 9-4: SUMMARY OF CONFIGURATION WORD WITH WATCHDOG TIMER

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
	13:8	_	—	—	—	CLKOUTEN	BOREN<1:0>		—	20
CONFIG1	7:0	CP	MCLRE	PWRTE	WDTE<1:0>		_	FOSC	<1:0>	38

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by Watchdog Timer.

10.0 FLASH PROGRAM MEMORY CONTROL

The Flash program memory is readable and writable during normal operation over the full VDD range. Program memory is indirectly addressed using Special Function Registers (SFRs). The SFRs used to access program memory are:

- PMCON1
- PMCON2
- PMDATL
- PMDATH
- PMADRL
- PMADRH

When accessing the program memory, the PMDATH:PMDATL register pair forms a 2-byte word that holds the 14-bit data for read/write, and the PMADRH:PMADRL register pair forms a 2-byte word that holds the 15-bit address of the program memory location being read.

The write time is controlled by an on-chip timer. The write/erase voltages are generated by an on-chip charge pump rated to operate over the operating voltage range of the device.

The Flash program memory can be protected in two ways; by code protection (CP bit in Configuration Words) and write protection (WRT<1:0> bits in Configuration Words).

Code protection ($\overline{CP} = 0$)⁽¹⁾, disables access, reading and writing, to the Flash program memory via external device programmers. Code protection does not affect the self-write and erase functionality. Code protection can only be reset by a device programmer performing a Bulk Erase to the device, clearing all Flash program memory, Configuration bits and User IDs.

Write protection prohibits self-write and erase to a portion or all of the Flash program memory, as defined by the bits WRT<1:0>. Write protection does not affect a device programmers ability to read, write or erase the device.

Note 1: Code protection of the entire Flash program memory array is enabled by clearing the CP bit of Configuration Words.

10.1 PMADRL and PMADRH Registers

The PMADRH:PMADRL register pair can address up to a maximum of 32K words of program memory. When selecting a program address value, the MSB of the address is written to the PMADRH register and the LSB is written to the PMADRL register.

10.1.1 PMCON1 AND PMCON2 REGISTERS

PMCON1 is the control register for Flash program memory accesses.

Control bits RD and WR initiate read and write, respectively. These bits cannot be cleared, only set, in software. They are cleared by hardware at completion of the read or write operation. The inability to clear the WR bit in software prevents the accidental, premature termination of a write operation.

The WREN bit, when set, will allow a write operation to occur. On power-up, the WREN bit is clear. The WRERR bit is set when a write operation is interrupted by a Reset during normal operation. In these situations, following Reset, the user can check the WRERR bit and execute the appropriate error handling routine.

The PMCON2 register is a write-only register. Attempting to read the PMCON2 register will return all '0's.

To enable writes to the program memory, a specific pattern (the unlock sequence), must be written to the PMCON2 register. The required unlock sequence prevents inadvertent writes to the program memory write latches and Flash program memory.

10.2 Flash Program Memory Overview

It is important to understand the Flash program memory structure for erase and programming operations. Flash program memory is arranged in rows. A row consists of a fixed number of 14-bit program memory words. A row is the minimum size that can be erased by user software.

After a row has been erased, the user can reprogram all or a portion of this row. Data to be written into the program memory row is written to 14-bit wide data write latches. These write latches are not directly accessible to the user, but may be loaded via sequential writes to the PMDATH:PMDATL register pair.

Note:	If the user wants to modify only a portion of a previously programmed row, then the contents of the entire row must be read and saved in RAM prior to the erase. Then, new data and retained data can be written into the write latches to reprogram the row of Flash program memory. How- ever, any unprogrammed locations can be written without first erasing the row. In this case, it is not necessary to save and rewrite the other previously programmed locations.

See Table 10-1 for Erase Row size and the number of write latches for Flash program memory.

TABLE 10-1: FLASH MEMORY ORGANIZATION BY DEVICE

Device	Row Erase (words)	Write Latches (words)
PIC12(L)F1501	16	16

10.2.1 READING THE FLASH PROGRAM MEMORY

To read a program memory location, the user must:

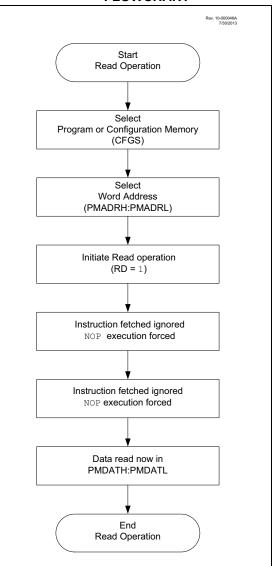
- 1. Write the desired address to the PMADRH:PMADRL register pair.
- 2. Clear the CFGS bit of the PMCON1 register.
- 3. Then, set control bit RD of the PMCON1 register.

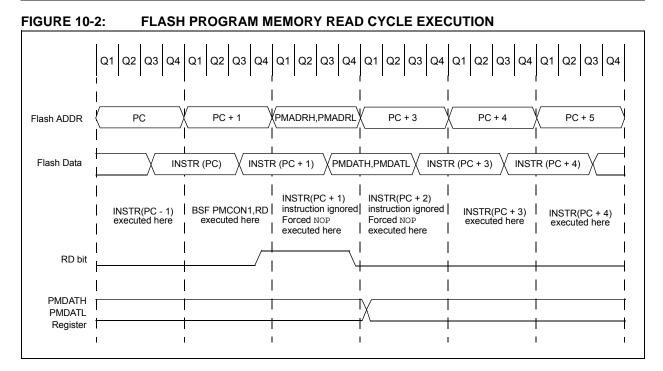
Once the read control bit is set, the program memory Flash controller will use the second instruction cycle to read the data. This causes the second instruction immediately following the "BSF PMCON1, RD" instruction to be ignored. The data is available in the very next cycle, in the PMDATH:PMDATL register pair; therefore, it can be read as two bytes in the following instructions.

PMDATH:PMDATL register pair will hold this value until another read or until it is written to by the user.

Note:	The two instructions following a program				
	memory read are required to be NOPs.				
	This prevents the user from executing a				
	2-cycle instruction on the next instruction				
	after the RD bit is set.				

FIGURE 10-1: FLASH PROGRAM MEMORY READ FLOWCHART





EXAMPLE 10-1: FLASH PROGRAM MEMORY READ

```
* This code block will read 1 word of program
* memory at the memory address:
   PROG_ADDR_HI : PROG_ADDR_LO
   data will be returned in the variables;
   PROG_DATA_HI, PROG_DATA_LO
   BANKSEL PMADRL
                             ; Select Bank for PMCON registers
            PROG_ADDR_LO
   MOVLW
                             ;
   MOVWF
            PMADRL
                             ; Store LSB of address
            PROG_ADDR_HI
   MOVLW
                              ;
   MOVWF
            PMADRH
                              ; Store MSB of address
   BCF
            PMCON1,CFGS
                             ; Do not select Configuration Space
   BSF
            PMCON1,RD
                              ; Initiate read
   NOP
                              ; Ignored (Figure 10-2)
   NOP
                              ; Ignored (Figure 10-2)
   MOVF
            PMDATL,W
                              ; Get LSB of word
   MOVWF
            PROG_DATA_LO
                             ; Store in user location
                             ; Get MSB of word
            PMDATH,W
   MOVF
   MOVWF
            PROG_DATA_HI
                             ; Store in user location
```

10.2.2 FLASH MEMORY UNLOCK SEQUENCE

The unlock sequence is a mechanism that protects the Flash program memory from unintended self-write programming or erasing. The sequence must be executed and completed without interruption to successfully complete any of the following operations:

- Row Erase
- · Load program memory write latches
- Write of program memory write latches to program memory
- Write of program memory write latches to User IDs

The unlock sequence consists of the following steps:

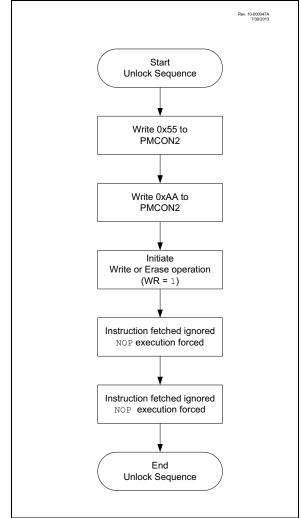
- 1. Write 55h to PMCON2
- 2. Write AAh to PMCON2
- 3. Set the WR bit in PMCON1
- 4. NOP instruction
- 5. NOP instruction

Once the WR bit is set, the processor will always force two NOP instructions. When an Erase Row or Program Row operation is being performed, the processor will stall internal operations (typical 2 ms), until the operation is complete and then resume with the next instruction. When the operation is loading the program memory write latches, the processor will always force the two NOP instructions and continue uninterrupted with the next instruction.

Since the unlock sequence must not be interrupted, global interrupts should be disabled prior to the unlock sequence and re-enabled after the unlock sequence is completed.

FIGURE 10-3: FLASH PROGRAM

MEMORY UNLOCK SEQUENCE FLOWCHART



FLASH PROGRAM

MEMORY ERASE

FIGURE 10-4:

10.2.3 ERASING FLASH PROGRAM MEMORY

While executing code, program memory can only be erased by rows. To erase a row:

- 1. Load the PMADRH:PMADRL register pair with any address within the row to be erased.
- 2. Clear the CFGS bit of the PMCON1 register.
- 3. Set the FREE and WREN bits of the PMCON1 register.
- 4. Write 55h, then AAh, to PMCON2 (Flash programming unlock sequence).
- 5. Set control bit WR of the PMCON1 register to begin the erase operation.

See Example 10-2.

After the "BSF PMCON1, WR" instruction, the processor requires two cycles to set up the erase operation. The user must place two NOP instructions immediately following the WR bit set instruction. The processor will halt internal operations for the typical 2 ms erase time. This is not Sleep mode as the clocks and peripherals will continue to run. After the erase cycle, the processor will resume operation with the third instruction after the PMCON1 write instruction.

FLOWCHART Rev. 10-000048A 7/30/2013 Start Erase Operation **Disable Interrupts** (GIE = 0) Select Program or Configuration Memory (CFGS) Select Row Address (PMADRH:PMADRL) Select Erase Operation (FREE = 1) Enable Write/Erase Operation (WREN = 1) Unlock Sequence (See Note 1) CPU stalls while Erase operation completes (2 ms typical) **Disable Write/Erase Operation** (WREN = 0) **Re-enable Interrupts** (GIE = 1) End **Erase Operation**

Note 1: See Figure 10-3.

EXAMPLE 10-2: ERASING ONE ROW OF PROGRAM MEMORY

; 1. A	; This row erase routine assumes the following: ; 1. A valid address within the erase row is loaded in ADDRH:ADDRL ; 2. ADDRH and ADDRL are located in shared data memory 0x70 - 0x7F (common RAM)						
	BCF BANKSEL	INTCON,GIE PMADRL	; Disable ints so required sequences will execute properly				
	MOVF MOVWF	ADDRL,W PMADRL	; Load lower 8 bits of erase address boundary				
	MOVF MOVWF	ADDRH , W PMADRH	; Load upper 6 bits of erase address boundary				
	BCF	PMCON1,CFGS	; Not configuration space				
	BSF	PMCON1, FREE	; Specify an erase operation				
	BSF	PMCON1,WREN	; Enable writes				
	MOVLW	55h	; Start of required sequence to initiate erase				
- O	MOVWF	PMCON2	; Write 55h				
irec	MOVLW	0AAh	;				
inb	MOVWF	PMCON2	; Write AAh				
Required Sequence	BSF	PMCON1,WR	; Set WR bit to begin erase				
	NOP		; NOP instructions are forced as processor starts				
	NOP		; row erase of program memory.				
			;				
			; The processor stalls until the erase process is complete				
			; after erase processor continues with 3rd instruction				
	BCF	PMCON1,WREN					
	BSF	INTCON,GIE	; Enable interrupts				

10.2.4 WRITING TO FLASH PROGRAM MEMORY

Program memory is programmed using the following steps:

- 1. Load the address in PMADRH:PMADRL of the row to be programmed.
- 2. Load each write latch with data.
- 3. Initiate a programming operation.
- 4. Repeat steps 1 through 3 until all data is written.

Before writing to program memory, the word(s) to be written must be erased or previously unwritten. Program memory can only be erased one row at a time. No automatic erase occurs upon the initiation of the write.

Program memory can be written one or more words at a time. The maximum number of words written at one time is equal to the number of write latches. See Figure 10-5 (row writes to program memory with 16 write latches) for more details.

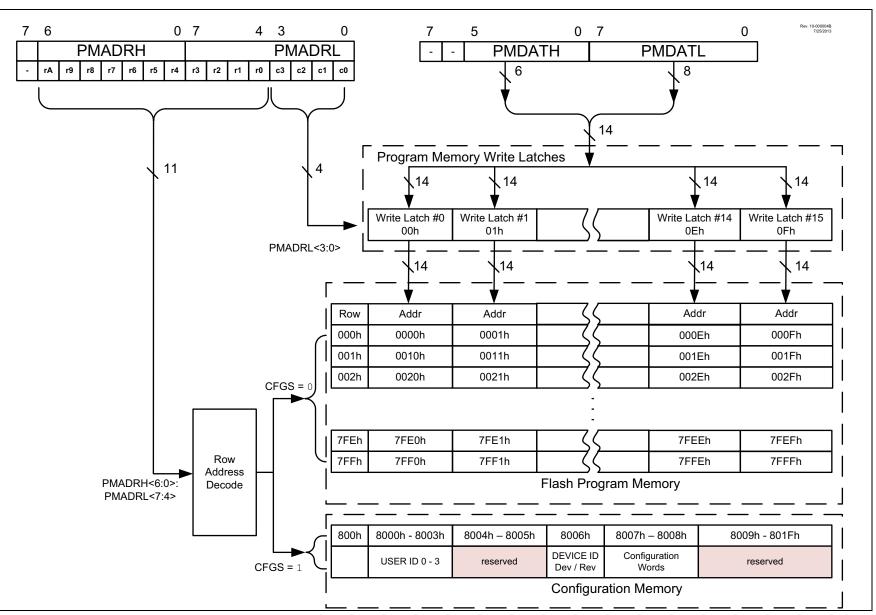
The write latches are aligned to the Flash row address boundary defined by the upper 10-bits of PMADRH:PMADRL, (PMADRH<6:0>:PMADRL<7:5>) with the lower five bits of PMADRL, (PMADRL<7:5>) determining the write latch being loaded. Write operations do not cross these boundaries. At the completion of a program memory write operation, the data in the write latches is reset to contain 0x3FFF. The following steps should be completed to load the write latches and program a row of program memory. These steps are divided into two parts. First, each write latch is loaded with data from the PMDATH:PMDATL using the unlock sequence with LWLO = 1. When the last word to be loaded into the write latch is ready, the LWLO bit is cleared and the unlock sequence executed. This initiates the programming operation, writing all the latches into Flash program memory.

Note:	The special unlock sequence is required to load a write latch with data or initiate a					
	Flash programming operation. If the unlock sequence is interrupted, writing to					
	the latches or program memory will not be					
	initiated.					

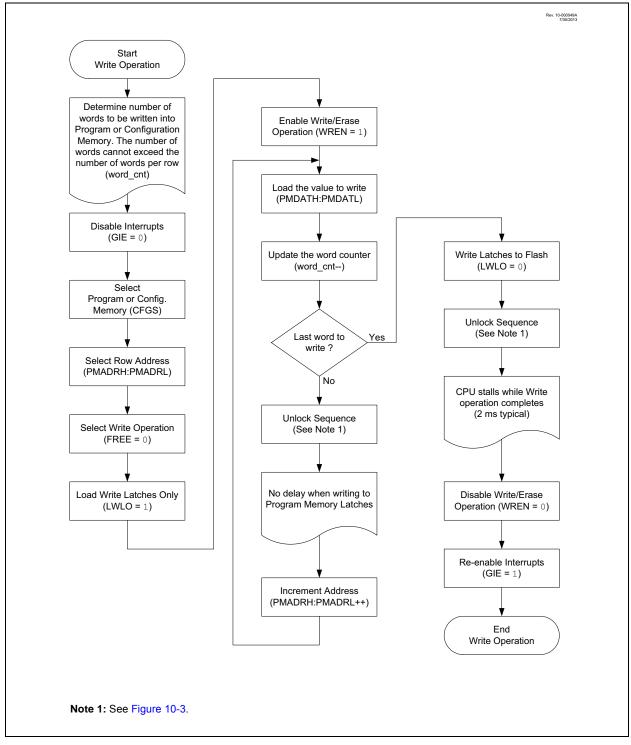
- 1. Set the WREN bit of the PMCON1 register.
- 2. Clear the CFGS bit of the PMCON1 register.
- 3. Set the LWLO bit of the PMCON1 register. When the LWLO bit of the PMCON1 register is '1', the write sequence will only load the write latches and will not initiate the write to Flash program memory.
- 4. Load the PMADRH:PMADRL register pair with the address of the location to be written.
- 5. Load the PMDATH:PMDATL register pair with the program memory data to be written.
- Execute the unlock sequence (Section 10.2.2 "Flash Memory Unlock Sequence"). The write latch is now loaded.
- 7. Increment the PMADRH:PMADRL register pair to point to the next location.
- 8. Repeat steps 5 through 7 until all but the last write latch has been loaded.
- Clear the LWLO bit of the PMCON1 register. When the LWLO bit of the PMCON1 register is '0', the write sequence will initiate the write to Flash program memory.
- 10. Load the PMDATH:PMDATL register pair with the program memory data to be written.
- Execute the unlock sequence (Section 10.2.2 "Flash Memory Unlock Sequence"). The entire program memory latch content is now written to Flash program memory.
- Note: The program memory write latches are reset to the blank state (0x3FFF) at the completion of every write or erase operation. As a result, it is not necessary to load all the program memory write latches. Unloaded latches will remain in the blank state.

An example of the complete write sequence is shown in Example 10-3. The initial address is loaded into the PMADRH:PMADRL register pair; the data is loaded using indirect addressing.









EXAMPLE 10-3: WRITING TO FLASH PROGRAM MEMORY (16 WRITE LATCHES)

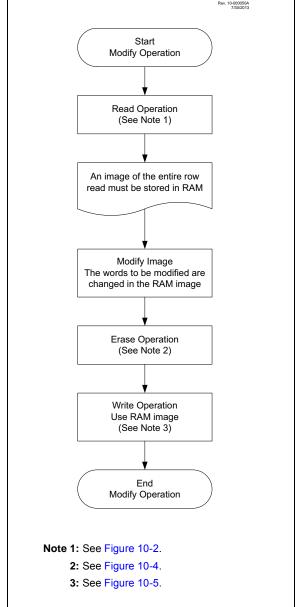
_///								
;]	This	write rout	ine assumes the f	ollowing:				
				starting at the address in DATA_ADDR				
		-		en is made up of two adjacent bytes in DATA_ADDR,				
	; stored in little endian format							
	3. A valid starting address (the least significant bits = 00000) is loaded in ADDRH:ADDRL							
				n shared data memory 0x70 - 0x7F (common RAM)				
;				• • • • •				
		BCF	INTCON, GIE	; Disable ints so required sequences will execute properly				
		BANKSEL		i Bank 3				
		MOVF	ADDRH,W	; Load initial address				
		MOVWF	PMADRH	i				
		MOVF		i				
		MOVWF	PMADRL	i				
		MOVLW	LOW DATA_ADDR	; Load initial data address				
		MOVWF	FSROL	i				
		MOVLW	HIGH DATA_ADDR	; Load initial data address				
		MOVWF	FSR0H -	i				
		BCF	PMCON1,CFGS	; Not configuration space				
		BSF		; Enable writes				
		BSF		; Only Load Write Latches				
LOC	ЭР							
		MOVIW	FSR0++	; Load first data byte into lower				
		MOVWF	PMDATL	;				
		MOVIW	FSR0++	; Load second data byte into upper				
		MOVWF	PMDATH	i				
		MOVF	PMADRL,W	; Check if lower bits of address are '00000'				
		XORLW	0x0F	; Check if we're on the last of 16 addresses				
		ANDLW	0x0F	;				
		BTFSC	STATUS , Z	; Exit if last of 16 words,				
		GOTO	START_WRITE	;				
		MOVLW	55h	; Start of required write sequence:				
		MOVWF	PMCON2	; Write 55h				
		MOVLW	0AAh	i				
		MOVWF	PMCON2	; Write AAh				
		BSF		; Set WR bit to begin write				
		NOP		; NOP instructions are forced as processor				
				; loads program memory write latches				
		NOP		;				
		INCF		; Still loading latches Increment address				
		GOTO	LOOP	; Write next latches				
STA	ART_V	WRITE						
		BCF		; No more loading latches - Actually start Flash program				
				; memory write				
Г			1					
		MOVLW		; Start of required write sequence:				
	~	MOVWF		; Write 55h				
	ed	MOVLW						
	Required Sequence	MOVWF		; Write AAh				
	Sec	BSF		; Set WR bit to begin write				
	т ()	NOP		; NOP instructions are forced as processor writes				
		NOD		; all the program memory write latches simultaneously				
		NOP		; to program memory.				
L				; After NOPs, the processor				
				; stalls until the self-write process in complete				
		DOE		; after write processor continues with 3rd instruction				
		BCF		; Disable writes				
		BSF	INTCON,GIE	; Enable interrupts				

10.3 Modifying Flash Program Memory

When modifying existing data in a program memory row, and data within that row must be preserved, it must first be read and saved in a RAM image. Program memory is modified using the following steps:

- 1. Load the starting address of the row to be modified.
- 2. Read the existing data from the row into a RAM image.
- 3. Modify the RAM image to contain the new data to be written into program memory.
- 4. Load the starting address of the row to be rewritten.
- 5. Erase the program memory row.
- 6. Load the write latches with data from the RAM image.
- 7. Initiate a programming operation.

FIGURE 10-7: FLASH PROGRAM MEMORY MODIFY FLOWCHART



10.4 User ID, Device ID and Configuration Word Access

Instead of accessing program memory, the User ID's, Device ID/Revision ID and Configuration Words can be accessed when CFGS = 1 in the PMCON1 register. This is the region that would be pointed to by PC<15> = 1, but not all addresses are accessible. Different access may exist for reads and writes. Refer to Table 10-2.

When read access is initiated on an address outside the parameters listed in Table 10-2, the PMDATH:PMDATL register pair is cleared, reading back '0's.

Address	Function	Read Access	Write Access
8000h-8003h	User IDs	Yes	Yes
8006h	Device ID/Revision ID	Yes	No
8007h-8008h	Configuration Words 1 and 2	Yes	No

EXAMPLE 10-4: CONFIGURATION WORD AND DEVICE ID ACCESS

* This code block will read 1 word of program memory at the memory address:

* PROG_ADDR_LO (must be 00h-08h) data will be returned in the variables;

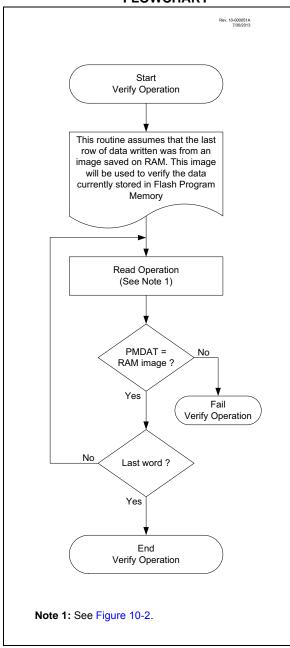
* PROG_DATA_HI, PROG_DATA_LO

BANKSEL	PMADRL	; Select correct Bank
MOVLW	PROG_ADDR_LO	;
MOVWF	PMADRL	; Store LSB of address
CLRF	PMADRH	; Clear MSB of address
BSF BCF BSF NOP NOP BSF	PMCON1,CFGS INTCON,GIE PMCON1,RD INTCON,GIE	<pre>; Select Configuration Space ; Disable interrupts ; Initiate read ; Executed (See Figure 10-2) ; Ignored (See Figure 10-2) ; Restore interrupts</pre>
MOVF	PMDATL,W	; Get LSB of word
MOVWF	PROG_DATA_LO	; Store in user location
MOVF	PMDATH,W	; Get MSB of word
MOVWF	PROG_DATA_HI	; Store in user location

10.5 Write Verify

It is considered good programming practice to verify that program memory writes agree with the intended value. Since program memory is stored as a full page then the stored program memory contents are compared with the intended data stored in RAM after the last write is complete.

FIGURE 10-8: FLASH PROGRAM MEMORY VERIFY FLOWCHART



10.6 Register Definitions: Flash Program Memory Control

REGISTER 10-1: PMDATL: PROGRAM MEMORY DATA LOW BYTE REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
			PMDA	AT<7:0>			
bit 7							bit C
Legend:							
R = Readable bit		W = Writable bit		U = Unimpleme	nted bit, read as '0	,	
u = Bit is unchange	ed	x = Bit is unknowr	า	-n/n = Value at F	OR and BOR/Valu	ue at all other Res	ets
'1' = Bit is set		'0' = Bit is cleared					

bit 7-0

PMDAT<7:0>: Read/write value for Least Significant bits of program memory

REGISTER 10-2: PMDATH: PROGRAM MEMORY DATA HIGH BYTE REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—			PMDA	\T<13:8>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 Unimplemented: Read as '0'

bit 5-0 PMDAT<13:8>: Read/write value for Most Significant bits of program memory

REGISTER 10-3: PMADRL: PROGRAM MEMORY ADDRESS LOW BYTE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PMADR<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0

PMADR<7:0>: Specifies the Least Significant bits for program memory address

REGISTER 10-4: PMADRH: PROGRAM MEMORY ADDRESS HIGH BYTE REGISTER

U-1	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
_(1)				PMADR<14:8>	>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 Unimplemented: Read as '1'

bit 6-0 PMADR<14:8>: Specifies the Most Significant bits for program memory address

Note 1: Unimplemented, read as '1'.

U-1	R/W-0/0	R/W-0/0	R/W/HC-0/0	R/W/HC-x/q ⁽²⁾	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0
(1)	CFGS	LWLO	FREE	WRERR	WREN	WR	RD
bit 7							bit (
Legend:							
R = Readable	bit	W = Writable b	it	U = Unimplemer	nted bit, read as	s 'O'	
S = Bit can on	ly be set	x = Bit is unkno	own	-n/n = Value at F	POR and BOR/	/alue at all other I	Resets
'1' = Bit is set		'0' = Bit is clea	red	HC = Bit is clear	ed by hardware	9	
bit 7	Unimplemen	ted: Read as '1'					
bit 6	CFGS: Config	guration Select bit					
		Configuration, Use Flash program me		ID Registers			
bit 5	LWLO: Load	Write Latches On	ly bit ⁽³⁾				
		addressed progra					
		ressed program m nitiated on the nex		n is loaded/update	ed and a write of	all program memo	ory write latche
bit 4	FREE: Progra	am Flash Erase E	nable bit				
		s an erase operati s a write operatior		•	rdware cleared	upon completion)	
bit 3		gram/Erase Error	•				
		n indicates an imp			e attempt or te	rmination (bit is s	et automaticall
		et attempt (write ' gram or erase ope					
bit 2		ram/Erase Enable	•	, , , , , , , , , , , , , , , , , , ,			
	0	rogram/erase cyc					
	0 = Inhibits	programming/eras	ing of program F	lash			
bit 1	WR: Write Co						
		a program Flash p ration is self-timed			o onco onorativ	on is complete	
	•	bit can only be se		•	e once operatio	on is complete.	
		/erase operation f	` '		ive.		
bit 0	RD: Read Co	ontrol bit					
		a program Flash r	ead. Read takes	s one cycle. RD is	cleared in hard	lware. The RD bit	can only be se
	```	ared) in software. It initiate a prograr	n Flash read				
Note 1: U	nimplemented bit						
	•	automatically set I	by hardware whe	en a program men	nory write or era	ase operation is st	arted (WR = 1
	he LWLO bit is igi	-	-			•	•

# REGISTER 10-5: PMCON1: PROGRAM MEMORY CONTROL 1 REGISTER

W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	W-0/0	
	Program Memory Control Register 2							
bit 7							bit 0	
Legend:								
R = Readable	bit	W = Writable b	oit	U = Unimpler	nented bit, read	l as '0'		
S = Bit can onl	y be set	x = Bit is unkno	own	-n/n = Value at POR and BOR/Value at all other Resets			ther Resets	
'1' = Bit is set		'0' = Bit is clea	red					

# REGISTER 10-6: PMCON2: PROGRAM MEMORY CONTROL 2 REGISTER

## bit 7-0 Flash Memory Unlock Pattern bits

To unlock writes, a 55h must be written first, followed by an AAh, before setting the WR bit of the PMCON1 register. The value written to this register is used to unlock the writes. There are specific timing requirements on these writes.

## TABLE 10-3: SUMMARY OF REGISTERS ASSOCIATED WITH FLASH PROGRAM MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
PMCON1	_(1)	CFGS	LWLO	FREE	WRERR	WREN	WR	RD	93
PMCON2	Program Memory Control Register 2							94	
PMADRL	PMADRL<7:0>						92		
PMADRH	_(1)			F	MADRH<6:0	>			92
PMDATL	PMDATL<7:0>						92		
PMDATH	_	— — PMDATH<5:0>						92	

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by Flash program memory.

**Note 1:** Unimplemented, read as '1'.

## TABLE 10-4: SUMMARY OF CONFIGURATION WORD WITH RESETS

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
	13:8		_	_		CLKOUTEN	BOREI	N<1:0>	_	20
CONFIG1	7:0	CP	MCLRE	PWRTE	WE	)TE<1:0>	—	FOSC	<1:0>	38
	13:8	_	_	LVP	DEBUG	LPBOR	BORV	STVREN	_	
CONFIG2	7:0	_	_	_	_	_	_	WRT	<1:0>	39

**Legend:** — = unimplemented location, read as '0'. Shaded cells are not used by Resets.

# 11.0 I/O PORTS

Each port has three standard registers for its operation. These registers are:

- TRISx registers (data direction)
- PORTx registers (reads the levels on the pins of the device)
- LATx registers (output latch)

Some ports may have one or more of the following additional registers. These registers are:

- · ANSELx (analog select)
- · WPUx (weak pull-up)

In general, when a peripheral is enabled on a port pin, that pin cannot be used as a general purpose output. However, the pin can still be read.

# TABLE 11-1:PORT AVAILABILITY PER<br/>DEVICE

Device	PORTA	PORTB	PORTC
PIC12(L)F1501	•		

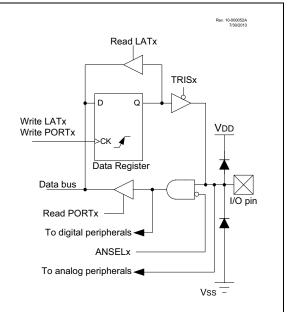
The Data Latch (LATx registers) is useful for read-modify-write operations on the value that the I/O pins are driving.

A write operation to the LATx register has the same effect as a write to the corresponding PORTx register. A read of the LATx register reads of the values held in the I/O PORT latches, while a read of the PORTx register reads the actual I/O pin value.

Ports that support analog inputs have an associated ANSELx register. When an ANSEL bit is set, the digital input buffer associated with that bit is disabled. Disabling the input buffer prevents analog signal levels on the pin between a logic high and low from causing excessive current in the logic input circuitry. A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 11-1.

# FIGURE 11-1: G

#### GENERIC I/O PORT OPERATION



# 11.1 Alternate Pin Function

The Alternate Pin Function Control (APFCON) register is used to steer specific peripheral input and output functions between different pins. The APFCON register is shown in Register 11-1. For this device family, the following functions can be moved between different pins.

- T1G
- CLC1
- NCO1
- CWG1A
- CWG1B

# **11.2** Register Definitions: Alternate Pin Function Control

# **REGISTER 11-1: APFCON: ALTERNATE PIN FUNCTION CONTROL REGISTER**

R/W-0/0	R/W-0/0	U-0	U-0	R/W-0/0	U-0	R/W-0/0	R/W-0/0
CWG1BSEL	CWG1ASEL	_	—	T1GSEL	—	CLC1SEL	NCO1SEL
bit 7							bit 0
Legend:							

Legena.		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7	<b>CWG1BSEL:</b> Pin Selection bit 1 = CWG1B function is on RA4 0 = CWG1B function is on RA0
bit 6	<b>CWG1ASEL:</b> Pin Selection bit 1 = CWG1A function is on RA5 0 = CWG1A function is on RA2
bit 5-4	Unimplemented: Read as '0'
bit 3	<b>T1GSEL:</b> Pin Selection bit 1 = T1G function is on RA3
	0 = T1G function is on RA4
bit 2	Unimplemented: Read as '0'
bit 1	CLC1SEL: Pin Selection bit
	1 = CLC1 function is on RA4
	0 = CLC1 function is on RA2
bit 0	NCO1SEL: Pin Selection bit
	1 = NCO1 function is on RA5
	0 = NCO1 function is on RA1

These bits have no effect on the values of any TRIS register. PORT and TRIS overrides will be routed to the correct pin. The unselected pin will be unaffected.

# 11.3 PORTA Registers

# 11.3.1 DATA REGISTER

PORTA is a 6-bit wide, bidirectional port. The corresponding data direction register is TRISA (Register 11-3). Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., disable the output driver). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., enables output driver and puts the contents of the output latch on the selected pin). The exception is RA3, which is input-only and its TRIS bit will always read as '1'. Example 11-1 shows how to initialize an I/O port.

Reading the PORTA register (Register 11-2) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the PORT data latch (LATA).

# 11.3.2 DIRECTION CONTROL

The TRISA register (Register 11-3) controls the PORTA pin output drivers, even when they are being used as analog inputs. The user should ensure the bits in the TRISA register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'.

# 11.3.3 ANALOG CONTROL

The ANSELA register (Register 11-5) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSELA bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSELA bits has no effect on digital output functions. A pin with TRIS clear and ANSEL set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

Note:	The ANSELA bits default to the Analog
	mode after Reset. To use any pins as
	digital general purpose or peripheral
	inputs, the corresponding ANSEL bits
	must be initialized to '0' by user software.

## EXAMPLE 11-1: INITIALIZING PORTA

BANKSEL	PORTA	;
CLRF	PORTA	;Init PORTA
BANKSEL	LATA	;Data Latch
CLRF	LATA	;
BANKSEL	ANSELA	;
CLRF	ANSELA	;digital I/O
BANKSEL	TRISA	;
MOVLW	B'00111000'	;Set RA<5:3> as inputs
MOVWF	TRISA	;and set RA<2:0> as
		;outputs
1		

# 11.3.4 PORTA FUNCTIONS AND OUTPUT PRIORITIES

Each PORTA pin is multiplexed with other functions. The pins, their combined functions and their output priorities are shown in Table 11-2.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the highest priority.

Analog input functions, such as ADC and comparator inputs, are not shown in the priority lists. These inputs are active when the I/O pin is set for Analog mode using the ANSELx registers. Digital output functions may control the pin when it is in Analog mode with the priority shown below in Table 11-2.

# TABLE 11-2: PORTA OUTPUT PRIORITY

Pin Name	Function Priority ⁽¹⁾
RA0	ICSPDAT DACOUT1 CWG1B ⁽²⁾ PWM2 RA0
RA1	NCO1 ⁽²⁾ RA1
RA2	DACOUT2 CWG1A ⁽²⁾ CLC1 ⁽²⁾ C1OUT PWM1 RA2
RA3	None
RA4	CLKOUT CWG1B ⁽³⁾ CLC1 ⁽³⁾ PWM3 RA4
RA5	CWG1A ⁽³⁾ CLC2 NCO1 ⁽³⁾ PWM4 RA5

Note 1: Priority listed from highest to lowest.

2: Default pin (see APFCON register).

3: Alternate pin (see APFCON register).

# 11.4 Register Definitions: PORTA

# REGISTER 11-2: PORTA: PORTA REGISTER

U-0	U-0	R/W-x/x	R/W-x/x	R-x/x	R/W-x/x	R/W-x/x	R/W-x/x	
—	—	RA5	RA4	RA3	RA2	RA1	RA0	
bit 7							bit 0	
Legend:								
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'		
u = Bit is unchanged x = Bit is unknown			nown	-n/n = Value at POR and BOR/Value at all other Resets				
'1' = Bit is set	t	'0' = Bit is clea	ared					
	•			-n/n = Value a	at POR and BOI	R/Value	at all c	

bit 7-6	Unimplemented: Read as '0'
---------	----------------------------

bit 5-0 RA<5:0>: PORTA I/O Value bits⁽¹⁾

1 = Port pin is <u>></u> Vін

0 = Port pin is <u><</u> Vı∟

**Note 1:** Writes to PORTA are actually written to corresponding LATA register. Reads from PORTA register is return of actual I/O pin values.

# REGISTER 11-3: TRISA: PORTA TRI-STATE REGISTER

U-0	U-0	R/W-1/1	R/W-1/1	U-1	R/W-1/1	R/W-1/1	R/W-1/1
—	—	TRISA5	TRISA4	_(1)	TRISA2	TRISA1	TRISA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6	Unimplemented: Read as '0'
bit 5-4	<b>TRISA&lt;5:4&gt;:</b> PORTA Tri-State Control bit 1 = PORTA pin configured as an input (tri-stated) 0 = PORTA pin configured as an output
bit 3	Unimplemented: Read as '1'
bit 2-0	<b>TRISA&lt;2:0&gt;:</b> PORTA Tri-State Control bit 1 = PORTA pin configured as an input (tri-stated) 0 = PORTA pin configured as an output

Note 1: Unimplemented, read as '1'.

U-0	U-0	R/W-x/u	R/W-x/u	U-0	R/W-x/u	R/W-x/u	R/W-x/u		
_	_	LATA5	LATA4		LATA2	LATA1	LATA0		
bit 7		•					bit 0		
Legend:									
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'					
u = Bit is une	changed	x = Bit is unkr	nown	-n/n = Value a	at POR and BO	R/Value at all o	ther Resets		
'1' = Bit is set '0' = Bit is cleared			ared						
bit 7-6	7-6 Unimplemented: Read as '0'								
bit 5-4	LATA<5:4>: RA<5:4> Output Latch Value bits ⁽¹⁾								

# REGISTER 11-4: LATA: PORTA DATA LATCH REGISTER

bit 5-4	LATA<5:4>: RA<5:4> Output Latch Value bits ⁽¹⁾
bit 3	Unimplemented: Read as '0'

- bit 2-0 LATA<2:0>: RA<2:0> Output Latch Value bits⁽¹⁾
- **Note 1:** Writes to PORTA are actually written to corresponding LATA register. Reads from PORTA register is return of actual I/O pin values.

# REGISTER 11-5: ANSELA: PORTA ANALOG SELECT REGISTER

U-0	U-0	U-0	R/W-1/1	U-0	R/W-1/1	R/W-1/1	R/W-1/1
—	—		ANSA4	—	ANSA2	ANSA1	ANSA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5	Unimplemented: Read as '0'
bit 4	<ul> <li>ANSA4: Analog Select between Analog or Digital Function on pins RA4, respectively</li> <li>1 = Analog input. Pin is assigned as analog input⁽¹⁾. Digital input buffer disabled.</li> <li>0 = Digital I/O. Pin is assigned to port or digital special function.</li> </ul>
bit 3	Unimplemented: Read as '0'
bit 2-0	<ul> <li>ANSA&lt;2:0&gt;: Analog Select between Analog or Digital Function on pins RA&lt;2:0&gt;, respectively</li> <li>1 = Analog input. Pin is assigned as analog input⁽¹⁾. Digital input buffer disabled.</li> <li>0 = Digital I/O. Pin is assigned to port or digital special function.</li> </ul>
Note 1:	When setting a pin to an analog input, the corresponding TRIS bit must be set to Input mode in order to

allow external control of the voltage on the pin.

U-0	U-0	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	
—	_	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	
bit 7							bit 0	
Legend:								
R = Readable I	oit	W = Writable	bit	U = Unimpler	nented bit, read	as '0'		
u = Bit is unchanged x = Bit is unknown			nown	-n/n = Value at POR and BOR/Value at all other Resets				
'1' = Bit is set '0' = Bit is cleared			ared					

# REGISTER 11-6: WPUA: WEAK PULL-UP PORTA REGISTER

bit 7-6 Unimplemented: Read as '0'

bit 5-0 WPUA<5:0>: Weak Pull-up Register bits⁽³⁾ 1 = Pull-up enabled 0 = Pull-up disabled

**Note 1:** Global WPUEN bit of the OPTION_REG register must be cleared for individual pull-ups to be enabled.

- 2: The weak pull-up device is automatically disabled if the pin is configured as an output.
- **3:** For the WPUA3 bit, when MCLRE = 1, weak pull-up is internally enabled, but not reported here.

TABLE 11-3: S	SUMMARY OF REGISTERS ASSOCIATED WITH PORTA
---------------	--------------------------------------------

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	_	—		ANSA4		ANSA2	ANSA1	ANSA0	99
APFCON	CWG1BSEL	CWG1ASEL	_	_	T1GSEL	_	CLC1SEL	NCO1SEL	96
LATA	_	_	LATA5	LATA4	_	LATA2	LATA1	LATA0	99
OPTION_REG	WPUEN	INTEDG	TMR0CS	TMR0SE	PSA	PS<2:0>			136
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	98
TRISA	_	_	TRISA5	TRISA4	_(1)	TRISA2	TRISA1	TRISA0	98
WPUA	_	_	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	100

Legend:x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.Note1:Unimplemented, read as '1'.

# TABLE 11-4: SUMMARY OF CONFIGURATION WORD WITH PORTA

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
0015104	13:8			_	—	CLKOUTEN	BOREN<1:0>		—	
CONFIG1	7:0	CP	MCLRE	PWRTE	WDTE<1:0>			FOSC	C<1:0>	38

**Legend:** — = unimplemented location, read as '0'. Shaded cells are not used by PORTA.

# 12.0 INTERRUPT-ON-CHANGE

The PORTA pins can be configured to operate as Interrupt-on-Change (IOC) pins. An interrupt can be generated by detecting a signal that has either a rising edge or a falling edge. Any individual port pin, or combination of port pins, can be configured to generate an interrupt. The interrupt-on-change module has the following features:

- Interrupt-on-Change enable (Master Switch)
- Individual pin configuration
- · Rising and falling edge detection
- Individual pin interrupt flags

Figure 12-1 is a block diagram of the IOC module.

# 12.1 Enabling the Module

To allow individual port pins to generate an interrupt, the IOCIE bit of the INTCON register must be set. If the IOCIE bit is disabled, the edge detection on the pin will still occur, but an interrupt will not be generated.

# 12.2 Individual Pin Configuration

For each port pin, a rising edge detector and a falling edge detector are present. To enable a pin to detect a rising edge, the associated bit of the IOCxP register is set. To enable a pin to detect a falling edge, the associated bit of the IOCxN register is set.

A pin can be configured to detect rising and falling edges simultaneously by setting both associated bits of the IOCxP and IOCxN registers, respectively.

# 12.3 Interrupt Flags

The IOCAFx bits located in the IOCAF register are status flags that correspond to the interrupt-on-change pins of the associated port. If an expected edge is detected on an appropriately enabled pin, then the status flag for that pin will be set, and an interrupt will be generated if the IOCIE bit is set. The IOCIF bit of the INTCON register reflects the status of all IOCAFx bits.

# 12.4 Clearing Interrupt Flags

The individual status flags, (IOCAFx bits), can be cleared by resetting them to zero. If another edge is detected during this clearing operation, the associated status flag will be set at the end of the sequence, regardless of the value actually being written.

In order to ensure that no detected edge is lost while clearing flags, only AND operations masking out known changed bits should be performed. The following sequence is an example of what should be performed.

## EXAMPLE 12-1: CLEARING INTERRUPT FLAGS (PORTA EXAMPLE)

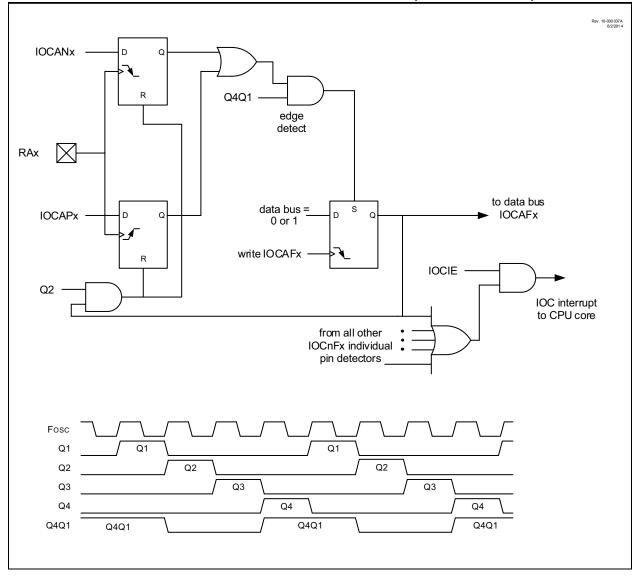
MOVLW 0xff XORWF IOCAF, W ANDWF IOCAF, F

# 12.5 Operation in Sleep

The interrupt-on-change interrupt sequence will wake the device from Sleep mode, if the IOCIE bit is set.

If an edge is detected while in Sleep mode, the IOCxF register will be updated prior to the first instruction executed out of Sleep.





# 12.6 Register Definitions: Interrupt-on-Change Control

# **REGISTER 12-1:** IOCAP: INTERRUPT-ON-CHANGE PORTA POSITIVE EDGE REGISTER

U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	
—	—	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	
bit 7	•						bit 0	
Legend:								
R = Readable bit		W = Writable bi	t	U = Unimplemented bit, read as '0'				
u = Bit is unchan	= Bit is unchanged x = Bit is unknown			-n/n = Value at POR and BOR/Value at all other Resets				
'1' = Bit is set		'0' = Bit is clear	ed					

#### bit 7-6 Unimplemented: Read as '0'

bit 5-0

bit 5-0

bit 5-0

IOCAP<5:0>: Interrupt-on-Change PORTA Positive Edge Enable bits

1 = Interrupt-on-Change enabled on the pin for a positive going edge. IOCAFx bit and IOCIF flag will be set upon detecting an edge.

0 = Interrupt-on-Change disabled for the associated pin.

## REGISTER 12-2: IOCAN: INTERRUPT-ON-CHANGE PORTA NEGATIVE EDGE REGISTER

U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 Unimplemented: Read as '0'

IOCAN<5:0>: Interrupt-on-Change PORTA Negative Edge Enable bits

- 1 = Interrupt-on-Change enabled on the pin for a negative going edge. IOCAFx bit and IOCIF flag will be set upon detecting an edge.
- 0 = Interrupt-on-Change disabled for the associated pin.

## REGISTER 12-3: IOCAF: INTERRUPT-ON-CHANGE PORTA FLAG REGISTER

U-0	U-0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0
—	—	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS - Bit is set in hardware

bit 7-6 Unimplemented: Read as '0'

IOCAF<5:0>: Interrupt-on-Change PORTA Flag bits

1 = An enabled change was detected on the associated pin.

Set when IOCAPx = 1 and a rising edge was detected on RAx, or when IOCANx = 1 and a falling edge was detected on RAx.

0 = No change was detected, or the user cleared the detected change.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	—	—	—	ANSA4	—	ANSA2	ANSA1	ANSA0	99
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
IOCAF	_	_	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	103
IOCAN	—	—	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	103
IOCAP	_	_	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	103
TRISA	_	_	TRISA5	TRISA4	—(1)	TRISA2	TRISA1	TRISA0	98

#### TABLE 12-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPT-ON-CHANGE

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by interrupt-on-change.

**Note 1:** Unimplemented, read as '1'.

# 13.0 FIXED VOLTAGE REFERENCE (FVR)

The Fixed Voltage Reference (FVR) is a stable voltage reference, independent of VDD, with a nominal output level (VFVR) of 1.024V. The output of the FVR can be configured to supply a reference voltage to the following:

- ADC input channel
- Comparator positive input
- · Comparator negative input

The FVR can be enabled by setting the FVREN bit of the FVRCON register.

# 13.1 Independent Gain Amplifier

The output of the FVR supplied to the peripherals, (listed above), is routed through a programmable gain amplifier. Each amplifier can be programmed for a gain of 1x, 2x or 4x, to produce the three possible voltage levels.

The ADFVR<1:0> bits of the FVRCON register are used to enable and configure the gain amplifier settings for the reference supplied to the ADC module. Reference Section 15.0 "Analog-to-Digital Converter (ADC) Module" for additional information.

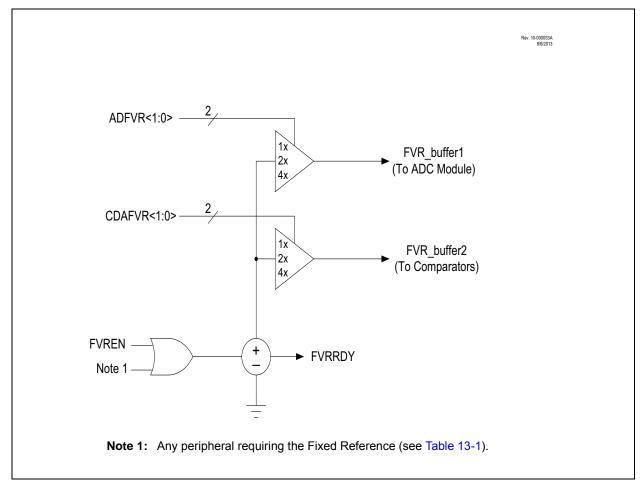
The CDAFVR<1:0> bits of the FVRCON register are used to enable and configure the gain amplifier settings for the reference supplied to the comparator modules. Reference **Section 17.0 "Comparator Module**" for additional information.

To minimize current consumption when the FVR is disabled, the FVR buffers should be turned off by clearing the Buffer Gain Selection bits.

# 13.2 FVR Stabilization Period

When the Fixed Voltage Reference module is enabled, it requires time for the reference and amplifier circuits to stabilize. Once the circuits stabilize and are ready for use, the FVRRDY bit of the FVRCON register will be set. See the FVR Stabilization Period characterization graph, Figure 28-52.

# FIGURE 13-1: VOLTAGE REFERENCE BLOCK DIAGRAM



Peripheral	Conditions	Description
HFINTOSC	FOSC<2:0> = 010 and IRCF<3:0> = 000x	INTOSC is active and device is not in Sleep.
	BOREN<1:0> = 11	BOR always enabled.
BOR	BOREN<1:0> = 10 and BORFS = 1	BOR disabled in Sleep mode, BOR Fast Start enabled.
	BOREN<1:0> = 01 and BORFS = 1	BOR under software control, BOR Fast Start enabled.
LDO	All PIC12F1501 devices, when VREGPM = 1 and not in Sleep	The device runs off of the Low-Power Regulator when in Sleep mode.

# TABLE 13-1: PERIPHERALS REQUIRING THE FIXED VOLTAGE REFERENCE (FVR)

# 13.3 Register Definitions: FVR Control

R/W-0/0	R-q/q	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0				
FVREN ⁽¹⁾	FVRRDY ⁽²⁾	TSEN ⁽³⁾	TSRNG ⁽³⁾	CDAFV	′R<1:0> ⁽¹⁾	ADFVR	<1:0> ⁽¹⁾				
bit 7			1				bit				
Legend:											
R = Readable	bit	W = Writable	bit	U = Unimplemented bit, read as '0'							
u = Bit is unchanged		x = Bit is unk	nown	-n/n = Value	at POR and BO	R/Value at all o	ther Resets				
'1' = Bit is set		'0' = Bit is cle	ared	q = Value de	pends on condit	ion					
bit 7	1 = Fixed Vo	d Voltage Refe Itage Referenc Itage Referenc		bit ⁽¹⁾							
bit 6	1 = Fixed Vo	Itage Reference	ference Ready e output is rea e output is not	dy for use	enabled						
bit 5	1 = Tempera	erature Indicato ture Indicator i ture Indicator i		)							
bit 4	1 = VOUT = V	perature Indica ′DD - 4VT (Higł ′DD - 2VT (Low		lection bit ⁽³⁾							
bit 3-2	11 = Compara 10 = Compara 01 = Compara	ator FVR Buffe ator FVR Buffe	er Gain is 2x, w er Gain is 1x, w	vith output volt vith output volt	bits ⁽¹⁾ age = 4x VFVR ( age = 2x VFVR ( age = 1x VFVR (	2.048V nomina	al) ⁽⁴⁾				
bit 1-0	11 = ADC FV 10 = ADC FV 01 = ADC FV	R Buffer Gain R Buffer Gain	is 2x, with out	out voltage = 4 out voltage = 2	x Vfvr (4.096V x Vfvr (2.048V x Vfvr (1.024V	nominal) ⁽⁴⁾					
ing	minimize curren the Buffer Gain RRDY is always	Selection bits	i.		he FVR buffers :	should be turne	ed off by clea				

# **REGISTER 13-1:** FVRCON: FIXED VOLTAGE REFERENCE CONTROL REGISTER

- **2:** FVRRDY is always '1' for the PIC12F1501 devices.
- 3: See Section 14.0 "Temperature Indicator Module" for additional information.
- 4: Fixed Voltage Reference output cannot exceed VDD.

## TABLE 13-2: SUMMARY OF REGISTERS ASSOCIATED WITH THE FIXED VOLTAGE REFERENCE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFV	CDAFVR>1:0>		R<1:0>	107

**Legend:** Shaded cells are unused by the Fixed Voltage Reference module.

# 14.0 TEMPERATURE INDICATOR MODULE

This family of devices is equipped with a temperature circuit designed to measure the operating temperature of the silicon die. The circuit's range of operating temperature falls between -40°C and +85°C. The output is a voltage that is proportional to the device temperature. The output of the temperature indicator is internally connected to the device ADC.

The circuit may be used as a temperature threshold detector or a more accurate temperature indicator, depending on the level of calibration performed. A one-point calibration allows the circuit to indicate a temperature closely surrounding that point. A two-point calibration allows the circuit to sense the entire range of temperature more accurately. Reference Application Note AN1333, "Use and Calibration of the Internal Temperature Indicator" (DS01333) for more details regarding the calibration process.

# 14.1 Circuit Operation

Figure 14-1 shows a simplified block diagram of the temperature circuit. The proportional voltage output is achieved by measuring the forward voltage drop across multiple silicon junctions.

Equation 14-1 describes the output characteristics of the temperature indicator.

# EQUATION 14-1: VOUT RANGES

High Range: VOUT = VDD - 4VT

Low Range: VOUT = VDD - 2VT

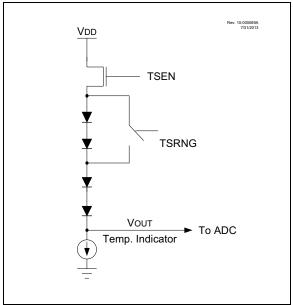
The temperature sense circuit is integrated with the Fixed Voltage Reference (FVR) module. See Section 13.0 "Fixed Voltage Reference (FVR)" for more information.

The circuit is enabled by setting the TSEN bit of the FVRCON register. When disabled, the circuit draws no current.

The circuit operates in either high or low range. The high range, selected by setting the TSRNG bit of the FVRCON register, provides a wider output voltage. This provides more resolution over the temperature range, but may be less consistent from part to part. This range requires a higher bias voltage to operate and thus, a higher VDD is needed.

The low range is selected by clearing the TSRNG bit of the FVRCON register. The low range generates a lower voltage drop and thus, a lower bias voltage is needed to operate the circuit. The low range is provided for low voltage operation.

# FIGURE 14-1: TEMPERATURE CIRCUIT DIAGRAM



# 14.2 Minimum Operating VDD

When the temperature circuit is operated in low range, the device may be operated at any operating voltage that is within specifications.

When the temperature circuit is operated in high range, the device operating voltage, VDD, must be high enough to ensure that the temperature circuit is correctly biased.

Table 14-1 shows the recommended minimum VDD vs.range setting.

TABLE 14-1: RECOMMENDED VDD VS. RANGE

Min. VDD, TSRNG = 1	Min. VDD, TSRNG = 0
3.6V	1.8V

# 14.3 Temperature Output

The output of the circuit is measured using the internal Analog-to-Digital Converter. A channel is reserved for the temperature circuit output. Refer to **Section 15.0 "Analog-to-Digital Converter (ADC) Module**" for detailed information.

# 14.4 ADC Acquisition Time

To ensure accurate temperature measurements, the user must wait at least 200  $\mu$ s after the ADC input multiplexer is connected to the temperature indicator output before the conversion is performed. In addition, the user must wait 200  $\mu$ s between sequential conversions of the temperature indicator output.

#### TABLE 14-2: SUMMARY OF REGISTERS ASSOCIATED WITH THE TEMPERATURE INDICATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR>1:0>		CDAFVR>1:0> ADFVR<1:0>		107

**Legend:** Shaded cells are unused by the temperature indicator module.

# 15.0 ANALOG-TO-DIGITAL CONVERTER (ADC) MODULE

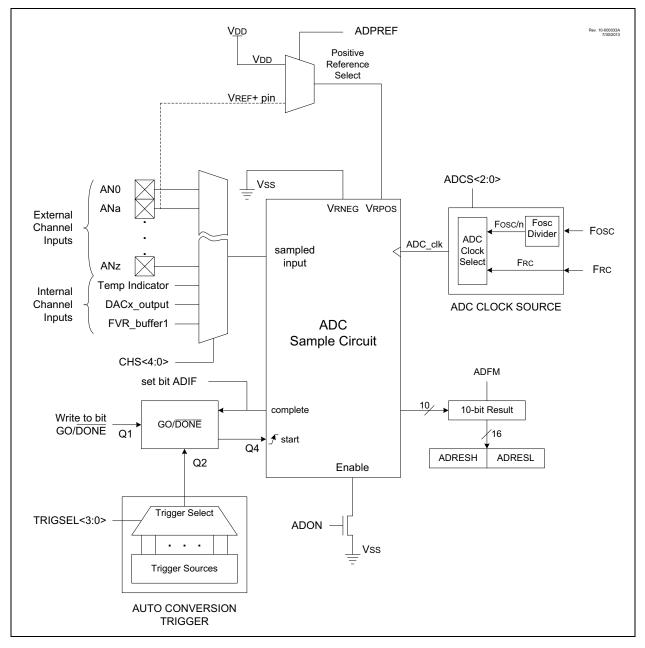
The Analog-to-Digital Converter (ADC) allows conversion of an analog input signal to a 10-bit binary representation of that signal. This device uses analog inputs, which are multiplexed into a single sample and hold circuit. The output of the sample and hold is connected to the input of the converter. The converter generates a 10-bit binary result via successive

FIGURE 15-1: ADC BLOCK DIAGRAM

approximation and stores the conversion result into the ADC result registers (ADRESH:ADRESL register pair). Figure 15-1 shows the block diagram of the ADC.

The ADC voltage reference is software selectable to be either internally generated or externally supplied.

The ADC can generate an interrupt upon completion of a conversion. This interrupt can be used to wake-up the device from Sleep.



# **15.1 ADC Configuration**

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
- ADC voltage reference selection
- ADC conversion clock source
- · Interrupt control
- · Result formatting

#### 15.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin should be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 11.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined									
	as a digital input may cause the input									
	buffer to conduct excess current.									

#### 15.1.2 CHANNEL SELECTION

There are 7 channel selections available:

- AN<3:0> pins
- · Temperature Indicator
- DAC1_output
- · FVR buffer1

The CHS bits of the ADCON0 register determine which channel is connected to the sample and hold circuit.

When changing channels, a delay (TACQ) is required before starting the next conversion. Refer to **Section 15.2.6 "ADC Conversion Procedure"** for more information.

#### 15.1.3 ADC VOLTAGE REFERENCE

The ADC module uses a positive and a negative voltage reference. The positive reference is labeled ref+ and the negative reference is labeled ref-.

The positive voltage reference (ref+) is selected by the ADPREF bits in the ADCON1 register. The positive voltage reference source can be:

- VREF+ pin
- Vdd

The negative voltage reference (ref-) source is:

Vss

#### 15.1.4 CONVERSION CLOCK

The source of the conversion clock is software selectable via the ADCS bits of the ADCON1 register. There are seven possible clock options:

- Fosc/2
- Fosc/4
- Fosc/8
- Fosc/16
- Fosc/32
- Fosc/64
- · FRC (internal RC oscillator)

The time to complete one bit conversion is defined as TAD. One full 10-bit conversion requires 11.5 TAD periods as shown in Figure 15-2.

For correct conversion, the appropriate TAD specification must be met. Refer to the ADC conversion requirements in **Section 27.0 "Electrical Specifications"** for more information. Table 15-1 gives examples of appropriate ADC clock selections.

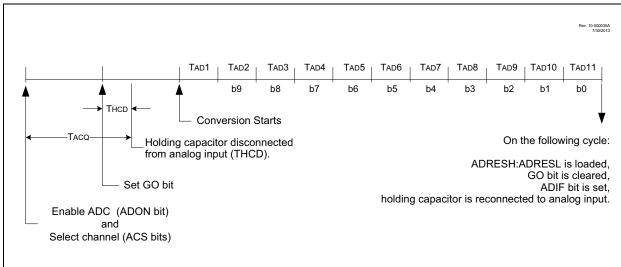
**Note:** Unless using the FRC, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.

ADC Clock	Period (TAD)	Device Frequency (Fosc)							
ADC Clock Source	ADCS<2:0 >	20 MHz 16 MHz 8 MHz		4 MHz	1 MHz				
Fosc/2	000	100 ns	125 ns	250 ns	500 ns	2.0 μs			
Fosc/4	100	200 ns	250 ns	500 ns	1.0 μs	4.0 μs			
Fosc/8	001	400 ns	500 ns	1.0 μs	2.0 μs	8.0 μs			
Fosc/16	101	800 ns	1.0 μs	2.0 μs	4.0 μs	16.0 μs			
Fosc/32	010	1.6 μs	2.0 μs	4.0 μs	8.0 μs	32.0 μs			
Fosc/64	110	3.2 μs	4.0 μs	8.0 μs	16.0 μs	64.0 μs			
FRC	x11	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs	1.0-6.0 μs			

#### TABLE 15-1: ADC CLOCK PERIOD (TAD) Vs. DEVICE OPERATING FREQUENCIES

Legend: Shaded cells are outside of recommended range.

**Note:** The TAD period when using the FRC clock source can fall within a specified range, (see TAD parameter). The TAD period when using the FOSC-based clock source can be configured for a more precise TAD period. However, the FRC clock source must be used when conversions are to be performed with the device in Sleep mode.



#### FIGURE 15-2: ANALOG-TO-DIGITAL CONVERSION TAD CYCLES

#### 15.1.5 INTERRUPTS

The ADC module allows for the ability to generate an interrupt upon completion of an Analog-to-Digital conversion. The ADC Interrupt Flag is the ADIF bit in the PIR1 register. The ADC Interrupt Enable is the ADIE bit in the PIE1 register. The ADIF bit must be cleared in software.

Note 1:	The ADIF bit is set at the completion of
	every conversion, regardless of whether
	or not the ADC interrupt is enabled.

**2:** The ADC operates during Sleep only when the FRC oscillator is selected.

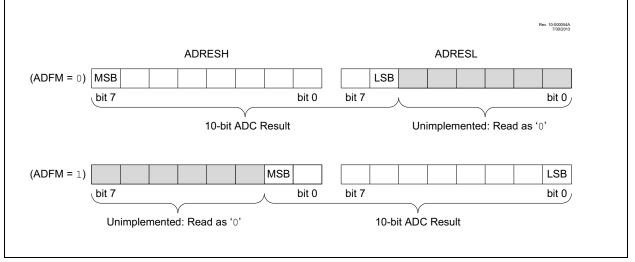
This interrupt can be generated while the device is operating or while in Sleep. If the device is in Sleep, the interrupt will wake-up the device. Upon waking from Sleep, the next instruction following the SLEEP instruction is always executed. If the user is attempting to wake-up from Sleep and resume in-line code execution, the GIE and PEIE bits of the INTCON register must be disabled. If the GIE and PEIE bits of the INTCON register are enabled, execution will switch to the Interrupt Service Routine.

#### 15.1.6 RESULT FORMATTING

The 10-bit ADC conversion result can be supplied in two formats, left justified or right justified. The ADFM bit of the ADCON1 register controls the output format.

Figure 15-3 shows the two output formats.

# FIGURE 15-3: 10-BIT ADC CONVERSION RESULT FORMAT



# 15.2 ADC Operation

#### 15.2.1 STARTING A CONVERSION

To enable the ADC module, the ADON bit of the ADCON0 register must be set to a '1'. Setting the GO/ DONE bit of the ADCON0 register to a '1' will start the Analog-to-Digital conversion.

Note:	The GO/DONE bit should not be set in the
	same instruction that turns on the ADC.
	Refer to Section 15.2.6 "ADC Conver-
	sion Procedure".

## 15.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/DONE bit
- Set the ADIF Interrupt Flag bit
- Update the ADRESH and ADRESL registers with new conversion result

#### 15.2.3 TERMINATING A CONVERSION

If a conversion must be terminated before completion, the GO/DONE bit can be cleared in software. The ADRESH and ADRESL registers will be updated with the partially complete Analog-to-Digital conversion sample. Incomplete bits will match the last bit converted.

Note:	A device Reset forces all registers to their						
	Reset state. Thus, the ADC module is						
	turned off and any pending conversion is						
	terminated.						

## 15.2.4 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the FRC option. Performing the ADC conversion during Sleep can reduce system noise. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than FRC, a SLEEP instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

# 15.2.5 AUTO-CONVERSION TRIGGER

The auto-conversion trigger allows periodic ADC measurements without software intervention. When a rising edge of the selected source occurs, the GO/DONE bit is set by hardware.

The auto-conversion trigger source is selected with the TRIGSEL<3:0> bits of the ADCON2 register.

Using the auto-conversion trigger does not assure proper ADC timing. It is the user's responsibility to ensure that the ADC timing requirements are met.

See Table 15-2 for auto-conversion sources.

#### TABLE 15-2: AUTO-CONVERSION SOURCES

Source Peripheral	Signal Name
Timer0	T0_overflow
Timer1	T1_overflow
Timer2	T2_match
Comparator C1	C1OUT_sync
CLC1	LC1_out
CLC2	LC2_out

#### 15.2.6 ADC CONVERSION PROCEDURE

This is an example procedure for using the ADC to perform an Analog-to-Digital conversion:

- 1. Configure Port:
  - Disable pin output driver (Refer to the TRIS register)
  - Configure pin as analog (Refer to the ANSEL register)
  - Disable weak pull-ups either globally (Refer to the OPTION_REG register) or individually (Refer to the appropriate WPUx register).
- 2. Configure the ADC module:
  - · Select ADC conversion clock
  - Configure voltage reference
  - · Select ADC input channel
  - Turn on ADC module
- 3. Configure ADC interrupt (optional):
  - Clear ADC interrupt flag
  - Enable ADC interrupt
  - Enable peripheral interrupt
  - Enable global interrupt⁽¹⁾
- 4. Wait the required acquisition time⁽²⁾.
- 5. Start conversion by setting the GO/DONE bit.
- 6. Wait for ADC conversion to complete by one of the following:
  - Polling the GO/DONE bit
  - Waiting for the ADC interrupt (interrupts enabled)
- 7. Read ADC Result.
- 8. Clear the ADC interrupt flag (required if interrupt is enabled).

**Note 1:** The global interrupt can be disabled if the user is attempting to wake-up from Sleep and resume in-line code execution.

2: Refer to Section 15.4 "ADC Acquisition Requirements".

#### EXAMPLE 15-1: ADC CONVERSION

```
;This code block configures the ADC
; for polling, Vdd and Vss references, FRC
;oscillator and ANO input.
;Conversion start & polling for completion
; are included.
BANKSEL
 ADCON1
 ;
 B'11110000' ;Right justify, FRC
MOVLW
 ;oscillator
MOVWF
 ADCON1
 ;Vdd and Vss Vref+
BANKSEL
 TRISA
 TRISA,0
 ;Set RA0 to input
BSF
BANKSEL
 ANSEL
 ;
BSF
 ANSEL,0
 ;Set RA0 to analog
BANKSEL
 WPUA
BCF
 WPUA,0
 ;Disable weak
 pull-up on RAO
BANKSEL
 ADCON0
 ;
 B'00000001' ;Select channel AN0
MOVLW
MOVWF
 ADCON0
 ;Turn ADC On
 SampleTime ;Acquisiton delay
CALL
 ADCON0, ADGO ; Start conversion
BSF
BTFSC
 ADCON0, ADGO ; Is conversion done?
GOTO
 ;No, test again
 $-1
BANKSEL
 ADRESH
 ;
MOVE
 ADRESH,W ;Read upper 2 bits
MOVWF
 RESULTHI ;store in GPR space
BANKSEL
 ADRESL
 ;
 ADRESL,W
 ;Read lower 8 bits
MOVF
MOVWF
 RESULTLO
 ;Store in GPR space
```

# 15.3 Register Definitions: ADC Control

# REGISTER 15-1: ADCON0: ADC CONTROL REGISTER 0

U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
_			CHS<4:0>			GO/DONE	ADON
bit 7							bit 0
Legend:							
R = Read	able bit	W = Writable	bit	U = Unimpler	nented bit, rea	id as '0'	
u = Bit is u	unchanged	x = Bit is unki	nown	-n/n = Value a	at POR and BO	OR/Value at all o	other Resets
'1' = Bit is	set	'0' = Bit is cle	ared				
bit 7	Unimpleme	ented: Read as '	0'				
bit 6-2	-	Analog Channel					
511 0 2	00000 = A	•					
	00000 = A						
	00010 = A	N2					
	00011 = AN	N3					
	00100 = Re	eserved. No cha	nnel connecte	d.			
	•						
	•						
	11100 <b>= R</b> e	eserved. No cha	nnel connecte	d.			
		mperature Indica					
	11110 <b>= D</b> A	AC (Digital-to-An	alog Converte				
	11111 <b>= FV</b>	R (Fixed Voltage	e Reference) I	Buffer 1 Output	2)		
bit 1	GO/DONE:	ADC Conversio	n Status bit				
		nversion cycle ir					
		is automatically			e ADC convers	sion has comple	eted.
	0 = ADC co	nversion comple	eted/not in pro	gress			
bit 0	ADON: ADO						
	1 = ADC is						
		disabled and co	•	•			
Note 1:	See Section 14.						
2:	See Section 13.	-					
3:	See Section 16.	0 "5-Bit Digital-	-to-Analog Co	onverter (DAC)	Module" for r	more information	n.

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	R/W-0/0	R/W-0/0
ADFM		ADCS<2:0>			—	ADPRE	EF<1:0>
oit 7							bit 0
_egend:							
R = Readab	le bit	W = Writable	bit	U = Unimpler	nented bit, rea	ad as '0'	
u = Bit is un	changed	x = Bit is unkr	nown	-n/n = Value a	at POR and B	OR/Value at all	other Resets
1' = Bit is se	et	'0' = Bit is clea	ared				
	loaded. 0 = Left just loaded.		Significant bi	ts of ADRESL a			
bit 6-4	000 = Fosc 001 = Fosc 010 = Fosc 011 = FRC 100 = Fosc 101 = Fosc 110 = Fosc	/8 :/32 (clock supplied :/4 :/16	from an intern	al RC oscillator			
oit 3-2	Unimpleme	nted: Read as '	0'				
bit 1-0	00 = VRPOS 01 = Reserv	is connected to	Vdd		iration bits		

# REGISTER 15-3: ADCON2: ADC CONTROL REGISTER 2

R/W-0/0	R/W-0	-	'W-0/0	R/W-0/0	U-0	U-0	U-0	U-0
TRIGSEL<3:0> ⁽¹⁾					—	—		_
bit 7								bit 0
Legend:								
R = Readable	e bit	W =	Writable	bit	U = Unimpler	nented bit, read	l as '0'	
u = Bit is uncl	hanged	x = E	Bit is unkı	nown	-n/n = Value a	at POR and BO	R/Value at all c	other Resets
'1' = Bit is set	-	'0' =	Bit is cle	ared				
bit 7-4	TRIGSE	L<3:0>: A	uto-Conv	ersion Trigger	Selection bits ⁽¹	)		
	0000 =			n trigger selec	cted			
	0001 =	Reserved						
	0010 =			(2)				
	0011 =	Timer0 –	T0_over	10w ⁽²⁾				
		Timer1 –						
		Timer2 –						
	0110 =			C1OUT_sync				
	0111 =		-					
		CLC1 – L						
		CLC2 – L Reserved	_					
	1010 =	Reserved						
		Reserved						
		Reserved						
		Reserved						
		Reserved						
bit 3-0	Unimple	emented: F	Read as '	0'				

- **Note 1:** This is a rising edge sensitive input for all sources.
  - 2: Signal also sets its corresponding interrupt flag.

# **REGISTER 15-4:** ADRESH: ADC RESULT REGISTER HIGH (ADRESH) ADFM = 0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
			ADRE	S<9:2>			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	it	U = Unimpler	nented bit, read	d as '0'	
u = Bit is unch	anged	x = Bit is unkno	own -n/n = Value at POR and BOR/Value at all other R				other Resets
'1' = Bit is set		'0' = Bit is clear	red				

bit 7-0 **ADRES<9:2>**: ADC Result Register bits Upper eight bits of 10-bit conversion result

#### **REGISTER 15-5:** ADRESL: ADC RESULT REGISTER LOW (ADRESL) ADFM = 0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADRES<1:0>		—	—	—	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 ADRES<1:0>: ADC Result Register bits Lower two bits of 10-bit conversion result bit 5-0 Reserved: Do not use.

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	—	—	_	-	ADRE	S<9:8>
bit 7				-			bit C
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplen	nented bit, read	as '0'	
u = Bit is unchanged x = Bit is unknown -n/n = Value at POR and BOR/Value at all other F					other Resets		
'1' = Bit is set		'0' = Bit is clea	ared				

bit 7-2 **Reserved**: Do not use.

bit 1-0	ADRES<9:8>: ADC Result Register bits
	Upper two bits of 10-bit conversion result

# REGISTER 15-7: ADRESL: ADC RESULT REGISTER LOW (ADRESL) ADFM = 1

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u		
ADRES<7:0>									
bit 7	bit 7 b								

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 ADRES<7:0>: ADC Result Register bits Lower eight bits of 10-bit conversion result

## **15.4 ADC Acquisition Requirements**

For the ADC to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The Analog Input model is shown in Figure 15-4. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD), refer to Figure 15-4. The maximum recommended impedance for analog sources is 10 k $\Omega$ . As the

source impedance is decreased, the acquisition time may be decreased. After the analog input channel is selected (or changed), an ADC acquisition must be done before the conversion can be started. To calculate the minimum acquisition time, Equation 15-1 may be used. This equation assumes that 1/2 LSb error is used (1,024 steps for the ADC). The 1/2 LSb error is the maximum error allowed for the ADC to meet its specified resolution.

## EQUATION 15-1: ACQUISITION TIME EXAMPLE

Assumptions: Temperature = 50°C and external impedance of 10k 
$$\Omega$$
 5.0V VDD  

$$T_{ACQ} = Amplifier Settling Time + Hold Capacitor Charging Time + Temperature Coefficient
= T_{AMP} + T_C + T_{COFF}
= 2 \mu s + T_C + [(Temperature - 25°C)(0.05 \mu s/°C)]
The value for T_C can be approximated with the following equations:
$$V_{APPLIED} \left( 1 - \frac{1}{(2^{n+1}) - 1} \right) = V_{CHOLD} ; [1] V_{CHOLD} charged to within 1/2 lsb$$

$$V_{APPLIED} \left( 1 - e^{\frac{-T_C}{RC}} \right) = V_{CHOLD} ; [2] V_{CHOLD} charge response to V_{APPLIED} V_{APPLIED} \left( 1 - e^{\frac{-T_C}{RC}} \right) = V_{APPLIED} \left( 1 - \frac{1}{(2^{n+1}) - 1} \right) ; combining [1] and [2]$$
Note: Where n = number of bits of the ADC.  
Solving for T_C:  

$$T_C = -C_{HOLD}(R_{IC} + R_{SS} + R_S) \ln(1/2047)$$$$

 $= -12.5pF(1k\Omega + 7k\Omega + 10k\Omega) \ln(0.0004885)$ = 1.72µs

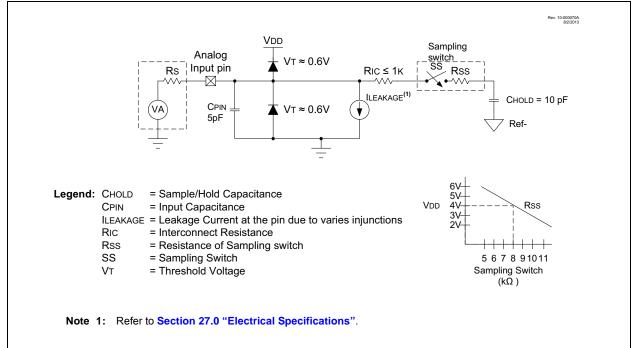
Therefore:

$$TACQ = 2\mu s + 1.72\mu s + [(50^{\circ}C - 25^{\circ}C)(0.05\mu s/^{\circ}C)]$$
  
= 4.97\mu s

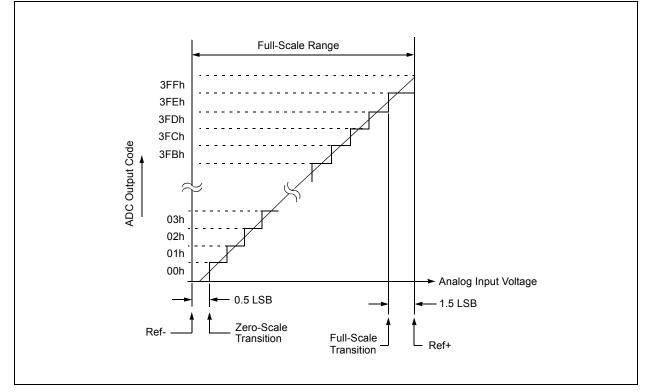
Note 1: The reference voltage (VRPOS) has no effect on the equation, since it cancels itself out.

- 2: The charge holding capacitor (CHOLD) is not discharged after each conversion.
- **3:** The maximum recommended impedance for analog sources is 10 k $\Omega$ . This is required to meet the pin leakage specification.

#### FIGURE 15-4: ANALOG INPUT MODEL



#### FIGURE 15-5: ADC TRANSFER FUNCTION



Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ADCON0	—			CHS<4:0>			GO/DONE	ADON	116
ADCON1	ADFM		ADCS<2:0>		_	—	ADPRE	F<1:0>	117
ADCON2		TRIGSEL<3:0>							118
ADRESH ADC Result Register High								119, 120	
ADRESL	ADRESL ADC Result Register Low								119, 120
ANSELA	_	_	_	ANSA4	-	ANSA2	ANSA1	ANSA0	99
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
PIE1	TMR1GIE	ADIE	_	_	_	—	TMR2IE	TMR1IE	65
PIR1	TMR1GIF	ADIF	_	-	-	—	TMR2IF	TMR1IF	68
TRISA	_	_	TRISA5	TRISA4	—(1)	TRISA2	TRISA1	TRISA0	98
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFV	′R<1:0>	ADFV	۲<1:0>	107

TABLE 15-3: SUMMARY OF REGISTERS ASSOCIATED WITH ADC

Legend: x = unknown, u = unchanged, - = unimplemented read as '0', q = value depends on condition. Shaded cells are not used for ADC module.

**Note 1:** Unimplemented, read as '1'.

# 16.0 5-BIT DIGITAL-TO-ANALOG CONVERTER (DAC) MODULE

The Digital-to-Analog Converter supplies a variable voltage reference, ratiometric with the input source, with 32 selectable output levels.

The positive input source (VSOURCE+) of the DAC can be connected to:

- External VREF+ pin
- VDD supply voltage

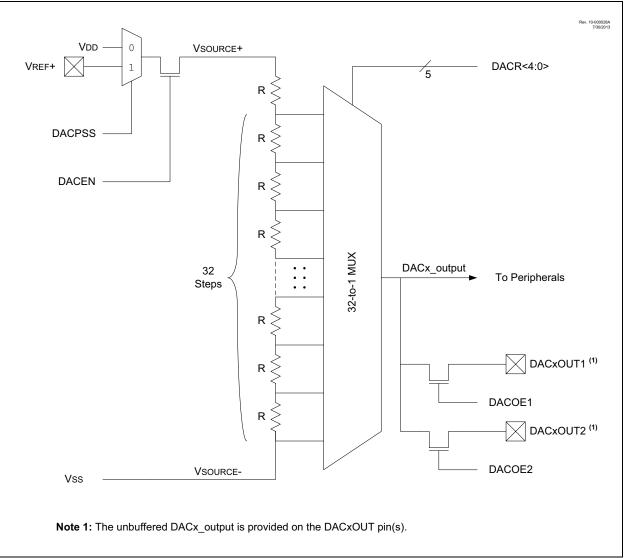
The negative input source (VSOURCE-) of the DAC can be connected to:

Vss

The output of the DAC (DACx_output) can be selected as a reference voltage to the following:

- Comparator positive input
- · ADC input channel
- DACxOUT1 pin
- DACxOUT2 pin

The Digital-to-Analog Converter (DAC) can be enabled by setting the DACEN bit of the DACxCON0 register.



## FIGURE 16-1: DIGITAL-TO-ANALOG CONVERTER BLOCK DIAGRAM

## 16.1 Output Voltage Selection

The DAC has 32 voltage level ranges. The 32 levels are set with the DACR<4:0> bits of the DACxCON1 register.

The DAC output voltage can be determined by using Equation 16-1.

# 16.2 Ratiometric Output Level

The DAC output value is derived using a resistor ladder with each end of the ladder tied to a positive and negative voltage reference input source. If the voltage of either input source fluctuates, a similar fluctuation will result in the DAC output value.

The value of the individual resistors within the ladder can be found in Table 27-14.

# 16.3 DAC Voltage Reference Output

The unbuffered DAC voltage can be output to the DACxOUTn pin(s) by setting the respective DACOEn bit(s) of the DACxCON0 register. Selecting the DAC reference voltage for output on either DACxOUTn pin automatically overrides the digital output buffer, the weak pull-up and digital input threshold detector functions of that pin.

Reading the DACxOUTn pin when it has been configured for DAC reference voltage output will always return a '0'.

**Note:** The unbuffered DAC output (DACxOUTn) is not intended to drive an external load.

# 16.4 Operation During Sleep

When the device wakes up from Sleep through an interrupt or a Watchdog Timer time-out, the contents of the DACxCON0 register are not affected. To minimize current consumption in Sleep mode, the voltage reference should be disabled.

# 16.5 Effects of a Reset

A device Reset affects the following:

- · DACx is disabled.
- DACx output voltage is removed from the DACxOUTn pin(s).
- The DACR<4:0> range select bits are cleared.

## EQUATION 16-1: DAC OUTPUT VOLTAGE

## <u>IF DACEN = 1</u>

$$DACx_output = \left( (VSOURCE+ - VSOURCE-) \times \frac{DACR[4:0]}{2^5} \right) + VSOURCE-$$

**Note:** See the DACxCON0 register for the available VSOURCE+ and VSOURCE- selections.

# 16.6 Register Definitions: DAC Control

#### REGISTER 16-1: DACxCON0: VOLTAGE REFERENCE CONTROL REGISTER 0

R/W-0/0	U-0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	U-0	U-0
DACEN	—	DACOE1	DACOE2	—	DACPSS	—	_
bit 7							bit C
Legend:							
R = Readable bi	it	W = Writable bi	it	U = Unimplem	ented bit, read as	'0'	
u = Bit is unchar	nged	x = Bit is unkno	wn	-n/n = Value at	POR and BOR/Va	alue at all other R	esets
'1' = Bit is set		'0' = Bit is clear	ed				
bit 7	DACEN: DAC E	Enable bit					
	1 = DACx is e						
	0 = DACx is di	isabled					
bit 6	Unimplemente	ed: Read as '0'					
bit 5	DACOE1: DAC	Voltage Output	Enable bit				
		age level is outp		•			
	0 = DACx volta	age level is disco	onnected from t	he DACxOUT1 p	pin		
bit 4	DACOE2: DAC	Voltage Output	Enable bit				
		age level is outp		•			
	0 = DACx volta	age level is disco	onnected from t	he DACxOUT2 p	bin		
bit 3	Unimplemente	ed: Read as '0'					
bit 2	DACPSS: DAC	Positive Source	e Select bit				
	1 = VREF+ pi	in					
	0 = VDD						
bit 1-0	Unimplemente	ed: Read as '0'					

#### REGISTER 16-2: DACxCON1: VOLTAGE REFERENCE CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
_	_	_			DACR<4:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 Unimplemented: Read as '0'

bit 4-0 DACR<4:0>: DAC Voltage Output Select bits

#### TABLE 16-1: SUMMARY OF REGISTERS ASSOCIATED WITH THE DAC MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
DAC1CON0	DACEN	_	DACOE1	DACOE2	_	DACPSS	_	—	126
DAC1CON1	_			DACR<4:0>					126

Legend: — = Unimplemented location, read as '0'. Shaded cells are not used with the DAC module.

# 17.0 COMPARATOR MODULE

Comparators are used to interface analog circuits to a digital circuit by comparing two analog voltages and providing a digital indication of their relative magnitudes. Comparators are very useful mixed signal building blocks because they provide analog functionality independent of program execution. The analog comparator module includes the following features:

- · Independent comparator control
- · Programmable input selection
- · Comparator output is available internally/externally
- · Programmable output polarity
- Interrupt-on-change
- · Wake-up from Sleep
- Programmable Speed/Power optimization
- PWM shutdown
- · Programmable and fixed voltage reference

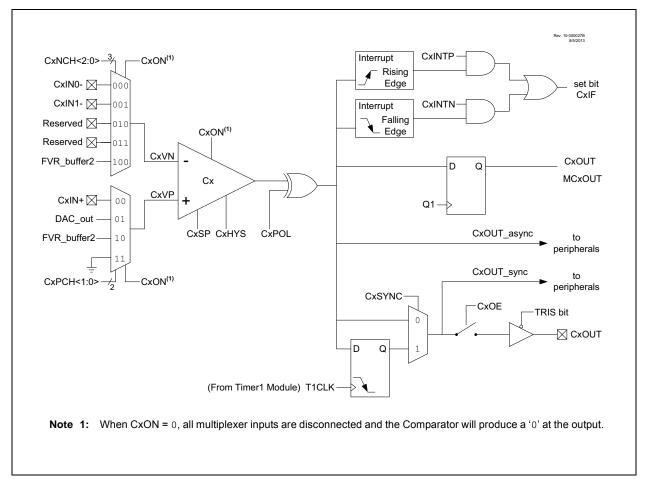
# 17.1 Comparator Overview

A single comparator is shown in Figure 17-2 along with the relationship between the analog input levels and the digital output. When the analog voltage at VIN+ is less than the analog voltage at VIN-, the output of the comparator is a digital low level. When the analog voltage at VIN+ is greater than the analog voltage at VIN-, the output of the comparator is a digital high level.

The comparators available for this device are listed in Table 17-1.

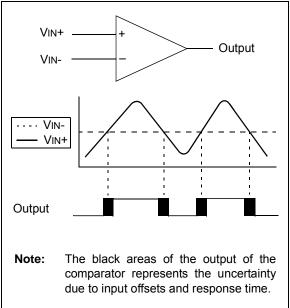
#### TABLE 17-1: AVAILABLE COMPARATORS

Device	C1	C2
PIC12(L)F1501	•	



# FIGURE 17-1: COMPARATOR MODULE SIMPLIFIED BLOCK DIAGRAM

#### FIGURE 17-2: SINGLE COMPARATOR



# 17.2 Comparator Control

Each comparator has two control registers: CMxCON0 and CMxCON1.

The CMxCON0 registers (see Register 17-1) contain Control and Status bits for the following:

- Enable
- Output selection
- Output polarity
- Speed/Power selection
- Hysteresis enable
- Output synchronization

The CMxCON1 registers (see Register 17-2) contain Control bits for the following:

- · Interrupt enable
- · Interrupt edge polarity
- · Positive input channel selection
- Negative input channel selection

#### 17.2.1 COMPARATOR ENABLE

Setting the CxON bit of the CMxCON0 register enables the comparator for operation. Clearing the CxON bit disables the comparator resulting in minimum current consumption.

#### 17.2.2 COMPARATOR POSITIVE INPUT SELECTION

Configuring the CxPCH<1:0> bits of the CMxCON1 register directs an internal voltage reference or an analog pin to the non-inverting input of the comparator:

- CxIN+ analog pin
- DAC1_output
- FVR buffer2
- Vss

See Section 13.0 "Fixed Voltage Reference (FVR)" for more information on the Fixed Voltage Reference module.

See Section 16.0 "5-Bit Digital-to-Analog Converter (DAC) Module" for more information on the DAC input signal.

Any time the comparator is disabled (CxON = 0), all comparator inputs are disabled.

#### 17.2.3 COMPARATOR NEGATIVE INPUT SELECTION

The CxNCH<2:0> bits of the CMxCON0 register direct one of the input sources to the comparator inverting input.

Note: To use CxIN+ and CxINx- pins as analog input, the appropriate bits must be set in the ANSEL register and the corresponding TRIS bits must also be set to disable the output drivers.

## 17.2.4 COMPARATOR OUTPUT SELECTION

The output of the comparator can be monitored by reading either the CxOUT bit of the CMxCON0 register or the MCxOUT bit of the CMOUT register. In order to make the output available for an external connection, the following conditions must be true:

- CxOE bit of the CMxCON0 register must be set
- · Corresponding TRIS bit must be cleared
- CxON bit of the CMxCON0 register must be set

The synchronous comparator output signal (CxOUT_sync) is available to the following peripheral(s):

- Configurable Logic Cell (CLC)
- Analog-to-Digital Converter (ADC)
- Timer1

The asynchronous comparator output signal (CxOUT_async) is available to the following peripheral(s):

- Complementary Waveform Generator (CWG)
  - Note 1: The CxOE bit of the CMxCON0 register overrides the PORT data latch. Setting the CxON bit of the CMxCON0 register has no impact on the port override.
    - The internal output of the comparator is latched with each instruction cycle. Unless otherwise specified, external outputs are not latched.

#### 17.2.5 COMPARATOR OUTPUT POLARITY

Inverting the output of the comparator is functionally equivalent to swapping the comparator inputs. The polarity of the comparator output can be inverted by setting the CxPOL bit of the CMxCON0 register. Clearing the CxPOL bit results in a non-inverted output.

 Table 17-2
 shows
 the output
 state
 versus
 input

 conditions, including polarity control.

 <t

TABLE 17-2: COMPARATOR OUTPUT STATE VS. INPUT CONDITIONS

Input Condition	CxPOL	CxOUT
CxVN > CxVP	0	0
CxVN < CxVP	0	1
CxVN > CxVP	1	1
CxVN < CxVP	1	0

#### 17.2.6 COMPARATOR SPEED/POWER SELECTION

The trade-off between speed or power can be optimized during program execution with the CxSP control bit. The default state for this bit is '1' which selects the Normal-Speed mode. Device power consumption can be optimized at the cost of slower comparator propagation delay by clearing the CxSP bit to '0'.

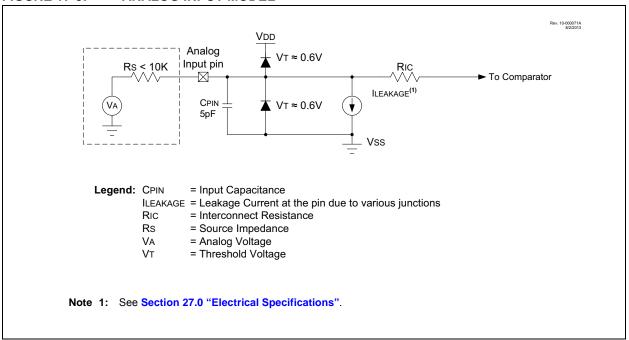


## 17.3 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 17-3. Since the analog input pins share their connection with a digital input, they have reverse biased ESD protection diodes to VDD and Vss. The analog input, therefore, must be between Vss and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up may occur.

A maximum source impedance of  $10 \text{ k}\Omega$  is recommended for the analog sources. Also, any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current to minimize inaccuracies introduced.

- Note 1: When reading a PORT register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert as an analog input, according to the input specification.
  - Analog levels on any pin defined as a digital input, may cause the input buffer to consume more current than is specified.



# 17.4 Comparator Hysteresis

A selectable amount of separation voltage can be added to the input pins of each comparator to provide a hysteresis function to the overall operation. Hysteresis is enabled by setting the CxHYS bit of the CMxCON0 register.

See **Section 27.0 "Electrical Specifications**" for more information.

# 17.5 Timer1 Gate Operation

The output resulting from a comparator operation can be used as a source for gate control of Timer1. See **Section 19.5 "Timer1 Gate"** for more information. This feature is useful for timing the duration or interval of an analog event.

It is recommended that the comparator output be synchronized to Timer1. This ensures that Timer1 does not increment while a change in the comparator is occurring.

#### 17.5.1 COMPARATOR OUTPUT SYNCHRONIZATION

The output from the Cx comparator can be synchronized with Timer1 by setting the CxSYNC bit of the CMxCON0 register.

Once enabled, the comparator output is latched on the falling edge of the Timer1 source clock. If a prescaler is used with Timer1, the comparator output is latched after the prescaling function. To prevent a race condition, the comparator output is latched on the falling edge of the Timer1 clock source and Timer1 increments on the rising edge of its clock source. See the Comparator Block Diagram (Figure 17-2) and the Timer1 Block Diagram (Figure 19-2) for more information.

# 17.6 Comparator Interrupt

An interrupt can be generated upon a change in the output value of the comparator for each comparator, a rising edge detector and a falling edge detector are present.

When either edge detector is triggered and its associated enable bit is set (CxINTP and/or CxINTN bits of the CMxCON1 register), the Corresponding Interrupt Flag bit (CxIF bit of the PIR2 register) will be set.

To enable the interrupt, you must set the following bits:

- CxON, CxPOL and CxSP bits of the CMxCON0
   register
- CxIE bit of the PIE2 register
- CxINTP bit of the CMxCON1 register (for a rising edge detection)
- CxINTN bit of the CMxCON1 register (for a falling edge detection)
- · PEIE and GIE bits of the INTCON register

The associated interrupt flag bit, CxIF bit of the PIR2 register, must be cleared in software. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

Note:	Although a comparator is disabled, an
	interrupt can be generated by changing
	the output polarity with the CxPOL bit of
	the CMxCON0 register, or by switching
	the comparator on or off with the CxON bit
	of the CMxCON0 register.

# 17.7 Comparator Response Time

The comparator output is indeterminate for a period of time after the change of an input source or the selection of a new reference voltage. This period is referred to as the response time. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response time to a comparator input change. See the Comparator and Voltage Reference Specifications in Section 27.0 "Electrical Specifications" for more details.

# 17.8 Register Definitions: Comparator Control

R/W-0/0	R-0/0	R/W-0/0	R/W-0/0	U-0	R/W-1/1	R/W-0/0	R/W-0/0					
CxON	CxOUT	CxOE	CxPOL	_	CxSP	CxHYS	CxSYNC					
bit 7							bit 0					
Logondi												
Legend: R = Readable	∍ hit	W = Writable	hit	II = I Inimpler	mented bit, read	1 as '0'						
u = Bit is unc		x = Bit is unki		-	at POR and BC		other Resets					
'1' = Bit is set		'0' = Bit is cle										
bit 7	CxON: Com	parator Enable	bit									
		ator is enabled										
	-	ator is disabled		s no active pow	ver							
bit 6		nparator Output										
		(inverted polar	<u>ity):</u>									
	1 = CxVP < 0 = CxVP >	-										
		) (non-inverted)	oolaritv):									
	1 = CxVP >		<b>, ,</b>									
	0 = CxVP <	CxVN										
bit 5	CxOE: Com	parator Output	Enable bit									
		is present on th		Requires that th	ne associated T	RIS bit be clea	red to actually					
		e pin. Not affect	ed by CxON.									
		is internal only										
bit 4		nparator Outpu		ct bit								
		ator output is inv ator output is no										
bit 3	-	-										
	•	nted: Read as '		:1								
bit 2		parator Speed/F										
		ator mode in no ator mode in lov										
bit 1	-	nparator Hyster	-									
		ator hysteresis										
		ator hysteresis										
bit 0	-	omparator Outp		is Mode bit								
			•		onous to chand	ges on Timer1	clock source					
		1 = Comparator output to Timer1 and I/O pin is synchronous to changes on Timer1 clock source. Output updated on the falling edge of Timer1 clock source.										
	0 0.00 0.0	updated on the	falling edge of	Limer1 clock s	ource.							

### REGISTER 17-1: CMxCON0: COMPARATOR Cx CONTROL REGISTER 0

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0				
CxINTP	CxINTP CxINTN CxPCH<1:0>					CxNCH<2:0>					
bit 7							bit (				
Legend:											
R = Readabl	e bit	W = Writable	bit	U = Unimple	mented bit, read	d as '0'					
u = Bit is unc	hanged	x = Bit is unki	nown	-n/n = Value	at POR and BC	R/Value at all	other Resets				
'1' = Bit is se	t	'0' = Bit is cle	ared								
bit 7	CxINTP: Co	mparator Interru	upt on Positive	Going Edge E	Enable bits						
					ing edge of the						
					of the CxOUT	bit					
bit 6		kINTN: Comparator Interrupt on Negative Going Edge Enable bits The CxIF interrupt flag will be set upon a negative going edge of the CxOUT bit									
bit 5-4		<ul> <li>0 = No interrupt flag will be set on a negative going edge of the CxOUT bit</li> <li>CxPCH&lt;1:0&gt;: Comparator Positive Input Channel Select bits</li> </ul>									
		11 = CxVP connects to Vss									
	10 = CxVP connects to FVR Voltage Reference										
	01 = CxVP connects to DAC Voltage Reference										
	00 = CxVP connects to CxIN+ pin										
bit 3	Unimpleme	nted: Read as '	0'								
bit 2-0	CxNCH<2:0>: Comparator Negative Input Channel Select bits										
	111 = Reserved										
	110 = Reserved										
	101 = Reserved										
		100 = CxVN connects to FVR Voltage reference 011 = Reserved									
	010 = Rese										
		I connects to C	xIN1- pin								
	000 = CxVN		•								

# REGISTER 17-2: CMxCON1: COMPARATOR Cx CONTROL REGISTER 1

# REGISTER 17-3: CMOUT: COMPARATOR OUTPUT REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R-0/0
_	—	_	—	_	—	_	MC1OUT
bit 7			•	•			bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

## bit 7-1 Unimplemented: Read as '0'

bit 0 MC1OUT: Mirror Copy of C1OUT bit

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA			_	ANSA4		ANSA2	ANSA1	ANSA0	99
CM1CON0	C10N	C10UT	C10E	C1POL	_	C1SP	C1HYS	C1SYNC	131
CM1CON1	C1NTP	C1INTN	C1PCI	H<1:0>	H<1:0> —		C1NCH<2:0>	•	132
CMOUT	_	_	_	_	_	_	_	MC10UT	132
DAC1CON0	DACEN	_	DACOE1	DACOE2	_	DACPSS	—	—	126
DAC1CON1	_	_	—	DACR<4:0>					126
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFV	R<1:0>	ADFV	R<1:0>	107
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
PIE2	_	_	C1IE	—	_	NCO1IE	—	_	66
PIR2	_	_	C1IF	—	_	NCO1IF	—	_	69
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	98
LATA	_	_	LATA5	LATA4	_	LATA2	LATA1	LATA0	99
TRISA	_	_	TRISA5	TRISA4	(1)	TRISA2	TRISA1	TRISA0	98

# TABLE 17-3: SUMMARY OF REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Legend: — = unimplemented location, read as '0'. Shaded cells are unused by the comparator module.

Note 1: Unimplemented, read as '1'.

# 18.0 TIMER0 MODULE

The Timer0 module is an 8-bit timer/counter with the following features:

- 8-bit timer/counter register (TMR0)
- 3-bit prescaler (independent of Watchdog Timer)
- · Programmable internal or external clock source
- Programmable external clock edge selection
- Interrupt on overflow
- TMR0 can be used to gate Timer1

Figure 18-1 is a block diagram of the Timer0 module.

# 18.1 Timer0 Operation

The Timer0 module can be used as either an 8-bit timer or an 8-bit counter.

#### 18.1.1 8-BIT TIMER MODE

The Timer0 module will increment every instruction cycle, if used without a prescaler. 8-bit Timer mode is selected by clearing the TMR0CS bit of the OPTION REG register.

When TMR0 is written, the increment is inhibited for two instruction cycles immediately following the write.

**Note:** The value written to the TMR0 register can be adjusted, in order to account for the two instruction cycle delay when TMR0 is written.

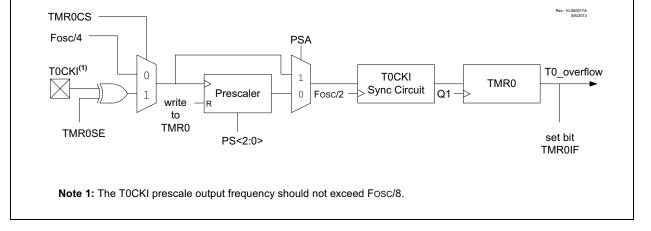
### FIGURE 18-1: TIMER0 BLOCK DIAGRAM

#### 18.1.2 8-BIT COUNTER MODE

In 8-Bit Counter mode, the Timer0 module will increment on every rising or falling edge of the T0CKI pin.

8-Bit Counter mode using the T0CKI pin is selected by setting the TMR0CS bit in the OPTION_REG register to '1'.

The rising or falling transition of the incrementing edge for either input source is determined by the TMR0SE bit in the OPTION_REG register.



#### 18.1.3 SOFTWARE PROGRAMMABLE PRESCALER

A software programmable prescaler is available for exclusive use with Timer0. The prescaler is enabled by clearing the PSA bit of the OPTION_REG register.

Note:	The Watchdog Timer (WDT) uses its own
	independent prescaler.

There are eight prescaler options for the Timer0 module ranging from 1:2 to 1:256. The prescale values are selectable via the PS<2:0> bits of the OPTION_REG register. In order to have a 1:1 prescaler value for the Timer0 module, the prescaler must be disabled by setting the PSA bit of the OPTION_REG register.

The prescaler is not readable or writable. All instructions writing to the TMR0 register will clear the prescaler.

# 18.1.4 TIMER0 INTERRUPT

Timer0 will generate an interrupt when the TMR0 register overflows from FFh to 00h. The TMR0IF interrupt flag bit of the INTCON register is set every time the TMR0 register overflows, regardless of whether or not the Timer0 interrupt is enabled. The TMR0IF bit can only be cleared in software. The Timer0 interrupt enable is the TMR0IE bit of the INTCON register.

Note:	The Timer0 interrupt cannot wake the								
	processor from Sleep since the timer is								
	frozen during Sleep.								

## 18.1.5 8-BIT COUNTER MODE SYNCHRONIZATION

When in 8-Bit Counter mode, the incrementing edge on the T0CKI pin must be synchronized to the instruction clock. Synchronization can be accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the instruction clock. The high and low periods of the external clocking source must meet the timing requirements as shown in Section 27.0 "Electrical Specifications".

# 18.1.6 OPERATION DURING SLEEP

Timer0 cannot operate while the processor is in Sleep mode. The contents of the TMR0 register will remain unchanged while the processor is in Sleep mode.

# 18.2 Register Definitions: Option Register

# REGISTER 18-1: OPTION_REG: OPTION REGISTER

TEDG TM W = x = E	os are disa	own ired ole bit	-n/n = Value a	R/W-1/1 nented bit, read		R/W-1/1 bit 0		
W = x = E '0' = JEN: Weak Pul All weak pull-up Veak pull-ups a :DG: Interrupt	Writable b Bit is unkno Bit is clea I-Up Enab os are disa	bit own ired ble bit	U = Unimpler -n/n = Value a		d as '0'			
x = E '0' = JEN: Weak Pul All weak pull-up Veak pull-ups a :DG: Interrupt	Bit is unkno Bit is clea II-Up Enab os are disa	own ired ole bit	-n/n = Value a					
x = E '0' = JEN: Weak Pul All weak pull-up Veak pull-ups a :DG: Interrupt	Bit is unkno Bit is clea II-Up Enab os are disa	own ired ole bit	-n/n = Value a			other Resets		
x = E '0' = JEN: Weak Pul All weak pull-up Veak pull-ups a :DG: Interrupt	Bit is unkno Bit is clea II-Up Enab os are disa	own ired ole bit	-n/n = Value a			other Resets		
x = E '0' = JEN: Weak Pul All weak pull-up Veak pull-ups a :DG: Interrupt	Bit is unkno Bit is clea II-Up Enab os are disa	own ired ole bit	-n/n = Value a			other Resets		
'0' = JEN: Weak Pul All weak pull-up Veak pull-ups a :DG: Interrupt	Bit is clea II-Up Enab os are disa	nred		at POR and BO	R/Value at all o	other Resets		
<b>JEN:</b> Weak Pul All weak pull-up Weak pull-ups a E <b>DG:</b> Interrupt	I-Up Enab os are disa	ble bit						
All weak pull-up Veak pull-ups a E <b>DG:</b> Interrupt l	os are disa							
	ng edge o	ed by individu ect bit f INT pin						
<ul> <li>0 = Interrupt on falling edge of INT pin</li> <li>TMR0CS: Timer0 Clock Source Select bit</li> <li>1 = Transition on T0CKI pin</li> <li>0 = Internal instruction cycle clock (Fosc/4)</li> </ul>								
	igh-to-low	transition on						
<b>PSA:</b> Prescaler Assignment bit 1 = Prescaler is not assigned to the Timer0 module 0 = Prescaler is assigned to the Timer0 module								
2:0>: Prescale	r Rate Sel	ect bits						
Bit Value	Timer0 R	Rate						
000 001 010 011 100 101 110 111	1 : 32 1 : 64 1 : 12	8						
	ncrement on lo Prescaler is not Prescaler is ass 2:0>: Prescale Bit Value 000 001 010 011 100 101 110 111	Bit Value       Timer0 F         000       1:2         001       1:4         010       1:32         101       1:64         110       1:12         111       1:25	ncrement on low-to-high transition on Prescaler Assignment bit Prescaler is not assigned to the Timer Prescaler is assigned to the Timer0 m 2:0>: Prescaler Rate Select bits Bit Value Timer0 Rate 000 1 : 2 001 1 : 4 010 1 : 8 011 1 : 16 100 1 : 32 101 1 : 64 110 1 : 128 111 1 : 256	Prescaler is not assigned to the Timer0 module Prescaler is assigned to the Timer0 module 2:0>: Prescaler Rate Select bits $\begin{array}{c c c c c c c c c c c c c c c c c c c $	Increment on low-to-high transition on TOCKI pinPrescaler Assignment bitPrescaler is not assigned to the Timer0 modulePrescaler is assigned to the Timer0 modulePrescaler is assigned to the Timer0 modulePrescaler Rate Select bitsBit ValueTimer0 Rate0001 : 20011 : 40101 : 321011 : 641101 : 1281111 : 256	Increment on low-to-high transition on TOCKI pinPrescaler Assignment bitPrescaler is not assigned to the Timer0 modulePrescaler is assigned to the Timer0 modulePrescaler Rate Select bitsBit Value Timer0 Rate $000$ 1:2 $001$ 1:4 $010$ 1:8 $011$ 1:16 $100$ 1:32 $101$ 1:64 $110$ 1:128		

IABLE 18-1:	SUMMARY OF REGISTERS ASSOCIATED WITH TIMERU	

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ADCON2	N2 TRIGSEL<3:0>				—	—	_	_	118
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
OPTION_REG	WPUEN	INTEDG	TMR0CS	TMR0SE	PSA		136		
TMR0 Holding Register for the 8-bit Timer0 Count									134*
TRISA	—		TRISA5	TRISA4	(1)	TRISA2	TRISA1	TRISA0	98

**Legend:** — = Unimplemented location, read as '0'. Shaded cells are not used by the Timer0 module.

* Page provides register information.

Note 1: Unimplemented, read as '1'.

# 19.0 TIMER1 MODULE WITH GATE CONTROL

The Timer1 module is a 16-bit timer/counter with the following features:

- 16-bit timer/counter register pair (TMR1H:TMR1L)
- Programmable internal or external clock source
- · 2-bit prescaler
- · Optionally synchronized comparator out
- Multiple Timer1 gate (count enable) sources

- · Interrupt on overflow
- Wake-up on overflow (external clock, Asynchronous mode only)
- ADC Auto-Conversion Trigger(s)
- Selectable Gate Source Polarity
- · Gate Toggle mode
- · Gate Single-Pulse mode
- · Gate Value Status
- · Gate Event Interrupt

Figure 19-1 is a block diagram of the Timer1 module.

T1GSS<1:0> Rev. 10-000018E T1GSPM T1G 00 T0 overflow 01 1 T1GVAL C1OUT_sync 10 D 0 Q Single Pulse 0 Acq. Control Reserved 11 1 Q1 ō D T1GGO/DONE T1GPOL -CK Q Interrupt TMR10N set bit R det TMR1GIF T1GTM TMR1GE set flag bit TMR1IF TMR10N ΕN TMR1⁽²⁾ T1_overflow Synchronized Clock Input TMR1H TMR1L 0 D O 1 T1CLK **T1SYNC** TMR1CS<1:0> LFINTOSC 11 (1) T1CKI 10 Prescaler Synchronize⁽³⁾ Fosc 1,2,4,8 01 Internal Clock det 00 2 Fosc/4 Fosc/2 T1CKPS<1:0> Internal Clock Internal Sleep Clock Input Note 1: ST Buffer is high speed type when using T1CKI. 2: Timer1 register increments on rising edge. 3: Synchronize does not operate while in Sleep.

#### FIGURE 19-1: TIMER1 BLOCK DIAGRAM

# 19.1 Timer1 Operation

The Timer1 module is a 16-bit incrementing counter which is accessed through the TMR1H:TMR1L register pair. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter and increments on every selected edge of the external source.

Timer1 is enabled by configuring the TMR1ON and TMR1GE bits in the T1CON and T1GCON registers, respectively. Table 19-1 displays the Timer1 enable selections.

TABLE 19-1:	TIMER1 ENABLE
	SELECTIONS

TMR10N	TMR1GE	Timer1 Operation
0	0	Off
0	1	Off
1	0	Always On
1	1	Count Enabled

# **19.2 Clock Source Selection**

The TMR1CS<1:0> bits of the T1CON register are used to select the clock source for Timer1. Table 19-2 displays the clock source selections.

#### 19.2.1 INTERNAL CLOCK SOURCE

When the internal clock source is selected, the TMR1H:TMR1L register pair will increment on multiples of Fosc as determined by the Timer1 prescaler.

When the Fosc internal clock source is selected, the Timer1 register value will increment by four counts every instruction clock cycle. Due to this condition, a 2 LSB error in resolution will occur when reading the Timer1 value. To utilize the full resolution of Timer1, an asynchronous input signal must be used to gate the Timer1 clock input.

The following asynchronous sources may be used:

- Asynchronous event on the T1G pin to Timer1 gate
- · C1 or C2 comparator input to Timer1 gate

#### 19.2.2 EXTERNAL CLOCK SOURCE

When the external clock source is selected, the Timer1 module may work as a timer or a counter.

When enabled to count, Timer1 is incremented on the rising edge of the external clock input T1CKI. The external clock source can be synchronized to the microcontroller system clock or it can run asynchronously.

**Note:** In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge after any one or more of the following conditions:

- Timer1 enabled after POR
- Write to TMR1H or TMR1L
- · Timer1 is disabled
- Timer1 is disabled (TMR1ON = 0) when T1CKI is high then Timer1 is enabled (TMR1ON=1) when T1CKI is low.

## TABLE 19-2: CLOCK SOURCE SELECTIONS

TMR1CS<1:0>	Clock Source	
11	LFINTOSC	
10	External Clocking on T1CKI Pin	
01	System Clock (Fosc)	
00	Instruction Clock (Fosc/4)	

# 19.3 Timer1 Prescaler

Timer1 has four prescaler options allowing 1, 2, 4 or 8 divisions of the clock input. The T1CKPS bits of the T1CON register control the prescale counter. The prescale counter is not directly readable or writable; however, the prescaler counter is cleared upon a write to TMR1H or TMR1L.

# 19.4 Timer1 Operation in Asynchronous Counter Mode

If control bit T1SYNC of the T1CON register is set, the external clock input is not synchronized. The timer increments asynchronously to the internal phase clocks. If the external clock source is selected then the timer will continue to run during Sleep and can generate an interrupt on overflow, which will wake-up the processor. However, special precautions in software are needed to read/write the timer (see Section 19.4.1 "Reading and Writing Timer1 in Asynchronous Counter Mode").

**Note:** When switching from synchronous to asynchronous operation, it is possible to skip an increment. When switching from asynchronous to synchronous operation, it is possible to produce an additional increment.

#### 19.4.1 READING AND WRITING TIMER1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L while the timer is running from an external asynchronous clock will ensure a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself, poses certain problems, since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers, while the register is incrementing. This may produce an unpredictable value in the TMR1H:TMR1L register pair.

# 19.5 Timer1 Gate

Timer1 can be configured to count freely or the count can be enabled and disabled using Timer1 gate circuitry. This is also referred to as Timer1 Gate Enable.

Timer1 gate can also be driven by multiple selectable sources.

## 19.5.1 TIMER1 GATE ENABLE

The Timer1 Gate Enable mode is enabled by setting the TMR1GE bit of the T1GCON register. The polarity of the Timer1 Gate Enable mode is configured using the T1GPOL bit of the T1GCON register. When Timer1 Gate Enable mode is enabled, Timer1 will increment on the rising edge of the Timer1 clock source. When Timer1 Gate Enable mode is disabled, no incrementing will occur and Timer1 will hold the current count. See Figure 19-3 for timing details.

#### TABLE 19-3: TIMER1 GATE ENABLE SELECTIONS

T1CLK	T1GPOL	T1G	Timer1 Operation
$\uparrow$	0	0	Counts
$\uparrow$	0	1	Holds Count
1	1	0	Holds Count
1	1	1	Counts

#### 19.5.2 TIMER1 GATE SOURCE SELECTION

Timer1 gate source selections are shown in Table 19-4. Source selection is controlled by the T1GSS<1:0> bits of the T1GCON register. The polarity for each available source is also selectable. Polarity selection is controlled by the T1GPOL bit of the T1GCON register.

#### TABLE 19-4: TIMER1 GATE SOURCES

T1GSS	Timer1 Gate Source
00	Timer1 Gate pin (T1G)
01	Overflow of Timer0 (T0_overflow) (TMR0 increments from FFh to 00h)
10	Comparator 1 Output (C1OUT_sync) ⁽¹⁾
11	Reserved

Note 1: Optionally synchronized comparator output.

#### 19.5.2.1 T1G Pin Gate Operation

The T1G pin is one source for Timer1 gate control. It can be used to supply an external source to the Timer1 gate circuitry.

#### 19.5.2.2 Timer0 Overflow Gate Operation

When Timer0 increments from FFh to 00h, a low-tohigh pulse will automatically be generated and internally supplied to the Timer1 gate circuitry.

# 19.5.3 TIMER1 GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1 gate signal, as opposed to the duration of a single level pulse.

The Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 19-4 for timing details.

Timer1 Gate Toggle mode is enabled by setting the T1GTM bit of the T1GCON register. When the T1GTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

**Note:** Enabling Toggle mode at the same time as changing the gate polarity may result in indeterminate operation.

#### 19.5.4 TIMER1 GATE SINGLE-PULSE MODE

When Timer1 Gate Single-Pulse mode is enabled, it is possible to capture a single pulse gate event. Timer1 Gate Single-Pulse mode is first enabled by setting the T1GSPM bit in the T1GCON register. Next, the T1GGO/ DONE bit in the T1GCON register must be set. The Timer1 will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the T1GGO/ DONE bit will automatically be cleared. No other gate events will be allowed to increment Timer1 until the T1GGO/DONE bit is once again set in software. See Figure 19-5 for timing details.

If the Single Pulse Gate mode is disabled by clearing the T1GSPM bit in the T1GCON register, the T1GGO/DONE bit should also be cleared.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the Timer1 gate source to be measured. See Figure 19-6 for timing details.

## 19.5.5 TIMER1 GATE VALUE STATUS

When Timer1 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the T1GVAL bit in the T1GCON register. The T1GVAL bit is valid even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

## 19.5.6 TIMER1 GATE EVENT INTERRUPT

When Timer1 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of T1GVAL occurs, the TMR1GIF flag bit in the PIR1 register will be set. If the TMR1GIE bit in the PIE1 register is set, then an interrupt will be recognized.

The TMR1GIF flag bit operates even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

# **19.6** Timer1 Interrupt

The Timer1 register pair (TMR1H:TMR1L) increments to FFFFh and rolls over to 0000h. When Timer1 rolls over, the Timer1 interrupt flag bit of the PIR1 register is set. To enable the interrupt on rollover, you must set these bits:

- TMR10N bit of the T1CON register
- TMR1IE bit of the PIE1 register
- · PEIE bit of the INTCON register
- GIE bit of the INTCON register

The interrupt is cleared by clearing the TMR1IF bit in the Interrupt Service Routine.

**Note:** The TMR1H:TMR1L register pair and the TMR1IF bit should be cleared before enabling interrupts.

# 19.7 Timer1 Operation During Sleep

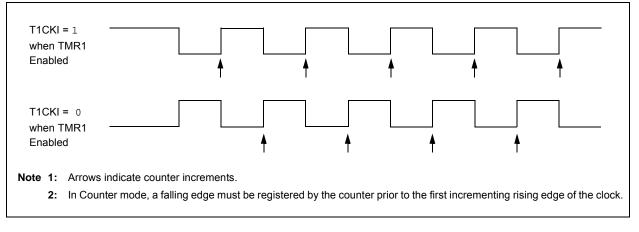
Timer1 can only operate during Sleep when setup in Asynchronous Counter mode. In this mode, an external crystal or clock source can be used to increment the counter. To set up the timer to wake the device:

- · TMR1ON bit of the T1CON register must be set
- TMR1IE bit of the PIE1 register must be set
- PEIE bit of the INTCON register must be set
- T1SYNC bit of the T1CON register must be set
- TMR1CS bits of the T1CON register must be configured

The device will wake-up on an overflow and execute the next instructions. If the GIE bit of the INTCON register is set, the device will call the Interrupt Service Routine.

Timer1 oscillator will continue to operate in Sleep regardless of the T1SYNC bit setting.

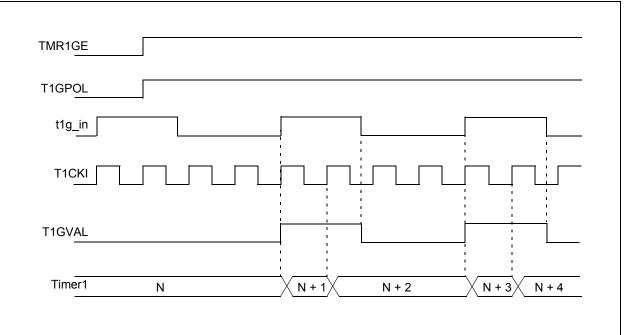
#### FIGURE 19-2: TIMER1 INCREMENTING EDGE



#### 19.7.1 ALTERNATE PIN LOCATIONS

This module incorporates I/O pins that can be moved to other locations with the use of the alternate pin function register, APFCON. To determine which pins can be moved and what their default locations are upon a Reset, see Section 11.1 "Alternate Pin Function" for more information.





# FIGURE 19-4: TIMER1 GATE TOGGLE MODE

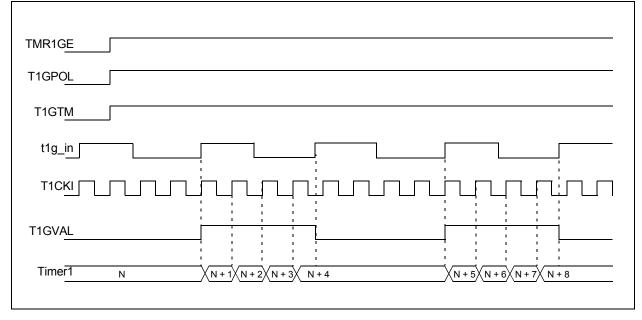


FIGURE 19-3.	TIMERT GATE SINGLE-PULSE	
TMR1GE		
T1GPOL		
T1GSPM		
T1GG <u>O/</u> DONE	← Set by software Counting enabled on	Cleared by hardware on falling edge of T1GVAL
t1g_in	rising edge of T1G	
T1CKI		
T1GVAL		
Timer1	N N + 1	N + 2
TMR1GIF	Cleared by software	← Set by hardware on falling edge of T1GVAL ← Software

FIGURE 19-6:	TIMER1 GATE SINGLE	-PULSE AND TOGGLE COMBINED MODE
TMR1GE		
T1GP <u>OL</u> T1GSP <u>M</u>		
T1GT <u>M</u>		
T1GG <u>O/</u> DONE	← Set by software Counting enabled rising edge of T10	Cleared by hardware on falling edge of T1GVAL
t1g_in		
тіскі		
T1GV <u>AL</u>		
Timer1	Ν	N + 1     N + 2     N + 3     N + 4       Set by hardware on     Cleared by
TMR1GIF	<ul> <li>Cleared by software</li> </ul>	falling edge of T1GVAL —

# 19.8 Register Definitions: Timer1 Control

#### REGISTER 19-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	U-0	R/W-0/u	U-0	R/W-0/u			
TMR1CS<1:0>		T1CKP	S<1:0>	—	T1SYNC	_	TMR10N			
bit 7							bit 0			
Legend:										
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'				
u = Bit is unch	nanged	x = Bit is unkn	iown	-n/n = Value a	at POR and BO	R/Value at al	l other Resets			
1' = Bit is set		'0' = Bit is clea	ared							
bit 7-6	TMR1CS<1:	0>: Timer1 Cloc	k Source Sele	ect bits						
	11 = Timer1 clock source is LFINTOSC									
	10 = Timer1 clock source is T1CKI pin (on the rising edge)									
	01 = Timer1 clock source is system clock (Fosc)									
		I clock source is instruction clock (Fosc/4)								
bit 5-4	T1CKPS<1:0>: Timer1 Input Clock Prescale Select bits									
	11 = 1:8 Prescale value									
	10 = 1:4 Prescale value									
	01 = 1:2 Prescale value 00 = 1:1 Prescale value									
bit 3		nted: Read as '	ר <b>י</b>							
bit 2				bit						
5112	<b>T1SYNC:</b> Timer1 Synchronization Control bit 1 = Do not synchronize asynchronous clock input									
	<ul> <li>0 = Synchronize asynchronous clock input with system clock (Fosc)</li> </ul>									
bit 1	Unimplemen	nted: Read as '	כ'							
bit 0	TMR1ON: Ti	mer1 On bit								
	1 = Enables Timer1									
	0 = Stops Ti									

R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W/HC-0/u	R-x/x	R/W-0/u	R/W-0/u			
TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ DONE	T1GVAL	T1GS	S<1:0>			
bit 7			·				bit (			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimplen	nented bit, read	d as '0'				
u = Bit is uncl	nanged	x = Bit is unki	nown	-n/n = Value a	at POR and BC	R/Value at all o	other Resets			
'1' = Bit is set		'0' = Bit is cle	ared	HC = Bit is cle	eared by hardw	vare				
bit 7	If TMR1ON = This bit is ign If TMR1ON = 1 = Timer1 c	ored <u>1</u> :	rolled by the T	imer1 gate func ate function	tion					
bit 6	1 = Timer1 g		gh (Timer1 cou	unts when gate nts when gate i						
bit 5	1 = Timer1 0 0 = Timer1 0	<ul> <li>0 = Timer1 gate is active-low (Timer1 counts when gate is low)</li> <li>T1GTM: Timer1 Gate Toggle Mode bit</li> <li>1 = Timer1 Gate Toggle mode is enabled</li> <li>0 = Timer1 Gate Toggle mode is disabled and toggle flip-flop is cleared</li> <li>Timer1 gate flip-flop toggles on every rising edge.</li> </ul>								
bit 4	1 = Timer1 g	mer1 Gate Sing ate Single-Puls ate Single-Puls	se mode is ena	abled and is cor	ntrolling Timer1	gate				
bit 3	1 = Timer1 g	ate single-puls	e acquisition is	Acquisition Sta s ready, waiting as completed o	for an edge	n started				
bit 2	<ul> <li>0 = Timer1 gate single-pulse acquisition has completed or has not been started</li> <li>T1GVAL: Timer1 Gate Value Status bit</li> <li>Indicates the current state of the Timer1 gate that could be provided to TMR1H:TMR1L.</li> <li>Unaffected by Timer1 Gate Enable (TMR1GE)</li> </ul>									
bit 1-0	Unaffected by Timer1 Gate Enable (TMR1GE). <b>T1GSS&lt;1:0&gt;:</b> Timer1 Gate Source Select bits 11 = Reserved 10 = Comparator 1 optionally synchronized output (C1OUT_sync) 01 = Timer0 overflow output (T0_overflow) 00 = Timer1 gate pin (T1G)									

# REGISTER 19-2: T1GCON: TIMER1 GATE CONTROL REGISTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	—	—	—	ANSA4	—	ANSA2	ANSA1	ANSA0	99
APFCON	CWG1BSEL	CWGA1SEL	—	—	T1GSEL	—	CLC1SEL	NCO1SEL	96
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
PIE1	TMR1GIE	ADIE	_	—	—	_	TMR2IE	TMR1IE	65
PIR1	TMR1GIF	ADIF	_	—	_	—	TMR2IF	TMR1IF	68
TMR1H	Holding Regi	ster for the M	ost Significan	t Byte of the	16-bit TMR1 (	Count			141*
TMR1L	Holding Regi	ster for the Le	east Significa	nt Byte of the	16-bit TMR1	Count			141*
TRISA	_	_	TRISA5	TRISA4	(1)	TRISA2	TRISA1	TRISA0	98
T1CON	TMR1C	S<1:0>	0> T1CKPS<1:0>		—	T1SYNC	—	TMR10N	145
T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ DONE	T1GVAL	T1GSS<1:0>		146

TABLE 19-5: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER1

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by the Timer1 module. * Page provides register information.

Note 1: Unimplemented, read as '1'.

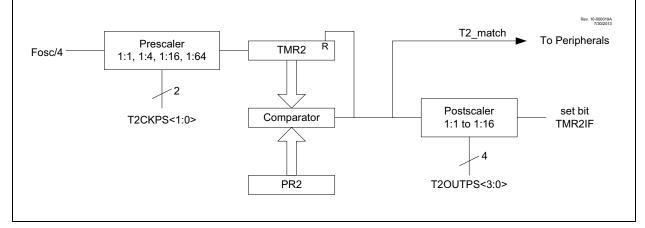
# 20.0 TIMER2 MODULE

The Timer2 module incorporates the following features:

- 8-bit Timer and Period registers (TMR2 and PR2, respectively)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4, 1:16, and 1:64)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on TMR2 match with PR2

See Figure 20-1 for a block diagram of Timer2.

### FIGURE 20-1: TIMER2 BLOCK DIAGRAM



# FIGURE 20-2: TIMER2 TIMING DIAGRAM

		Rev. 10.0000204 7/30/2013
Fosc/4		
Prescale	1:4	
PR2	0x03	
TMR2 ( 0x00 ) 0x01 ) 0x02	0x03	<u>0x00</u> <u>0x01</u> <u>0x02</u>
T2_match	Pulse Width ⁽¹⁾ ◀	
<b>Note 1:</b> The Pulse Width of T2_match is equal to	the scaled inpu	it of TMR2.

#### 20.1 Timer2 Operation

The clock input to the Timer2 module is the system instruction clock (Fosc/4).

TMR2 increments from 00h on each clock edge.

A 4-bit counter/prescaler on the clock input allows direct input, divide-by-4 and divide-by-16 prescale options. These options are selected by the prescaler control bits, T2CKPS<1:0> of the T2CON register. The value of TMR2 is compared to that of the Period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/ postscaler (see Section 20.2 "Timer2 Interrupt").

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, whereas the PR2 register initializes to FFh. Both the prescaler and postscaler counters are cleared on the following events:

- a write to the TMR2 register
- · a write to the T2CON register
- Power-on Reset (POR)
- Brown-out Reset (BOR)
- MCLR Reset
- Watchdog Timer (WDT) Reset
- Stack Overflow Reset
- Stack Underflow Reset
- RESET Instruction

Note: TMR2 is not cleared when T2CON is written.

# 20.2 Timer2 Interrupt

Timer2 can also generate an optional device interrupt. The Timer2 output signal (T2_match) provides the input for the 4-bit counter/postscaler. This counter generates the TMR2 match interrupt flag which is latched in TMR2IF of the PIR1 register. The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE of the PIE1 register.

A range of 16 postscale options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS<3:0>, of the T2CON register.

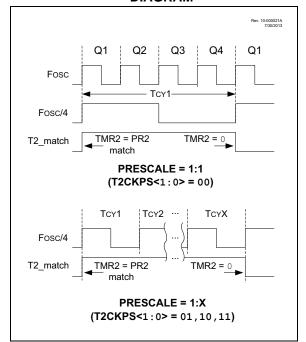
### 20.3 Timer2 Output

The output of TMR2 is T2_match. T2_match is available to the following peripherals:

- Configurable Logic Cell (CLC)
- Numerically Controlled Oscillator (NCO)
- Pulse Width Modulator (PWM)

The T2_match signal is synchronous with the system clock. Figure 20-3 shows two examples of the timing of the T2_match signal relative to Fosc and prescale value, T2CKPS<1:0>. The upper diagram illustrates 1:1 prescale timing and the lower diagram, 1:X prescale timing.

#### FIGURE 20-3: T2_MATCH TIMING DIAGRAM



# 20.4 Timer2 Operation During Sleep

Timer2 cannot be operated while the processor is in Sleep mode. The contents of the TMR2 and PR2 registers will remain unchanged while the processor is in Sleep mode.

#### 20.5 **Register Definitions: Timer2 Control**

#### **T2CON: TIMER2 CONTROL REGISTER** REGISTER 20-1: U-0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 R/W-0/0 T2OUTPS<3:0> TMR2ON T2CKPS<1:0> bit 7 bit 0 Legend: R = Readable bit U = Unimplemented bit, read as '0' W = Writable bit -n/n = Value at POR and BOR/Value at all other Resets u = Bit is unchanged x = Bit is unknown '1' = Bit is set '0' = Bit is cleared bit 7 Unimplemented: Read as '0' bit 6-3 T2OUTPS<3:0>: Timer2 Output Postscaler Select bits 0000 = 1:1 Postscaler 0001 = 1:2 Postscaler 0010 = 1:3 Postscaler 0011 = 1:4 Postscaler 0100 = 1:5 Postscaler 0101 = 1:6 Postscaler 0110 = 1:7 Postscaler 0111 = 1:8 Postscaler 1000 = 1:9 Postscaler 1001 = 1:10 Postscaler 1010 = 1:11 Postscaler 1011 = 1:12 Postscaler 1100 = 1:13 Postscaler 1101 = 1:14 Postscaler 1110 = 1:15 Postscaler 1111 = 1:16 Postscaler bit 2 TMR2ON: Timer2 On bit 1 = Timer2 is on 0 = Timer2 is off bit 1-0 T2CKPS<1:0>: Timer2 Clock Prescale Select bits 00 = Prescaler is 1 01 = Prescaler is 4 10 = Prescaler is 16 11 = Prescaler is 64 SUMMARY OF REGISTERS ASSOCIATED WITH TIMER2 **TABLE 20-1:**

#### 

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
PIE1	TMR1GIE	ADIE	—	_	—	—	TMR2IE	TMR1IE	65
PIR1	TMR1GIF	ADIF	_	—	—	—	TMR2IF	TMR1IF	68
PR2	Timer2 Mod	ule Period Re	gister						148*
T2CON	—		T2OUT	PS<3:0>		TMR2ON T2CKPS<1:0>			150
TMR2	Holding Reg	ister for the 8	-bit TMR2 Co	unt		•			148*

- = unimplemented location, read as '0'. Shaded cells are not used for Timer2 module. Legend:

Page provides register information.

Figure 21-1 shows a simplified block diagram of PWM

For a step-by-step procedure on how to set up this

module for PWM operation, refer to Section

21.1.9 "Setup for PWM Operation using PWMx

operation.

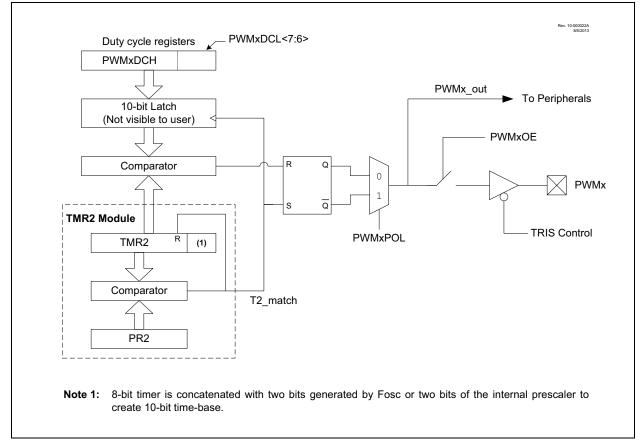
Pins".

# 21.0 PULSE-WIDTH MODULATION (PWM) MODULE

The PWM module generates a Pulse-Width Modulated signal determined by the duty cycle, period, and resolution that are configured by the following registers:

- PR2
- T2CON
- PWMxDCH
- PWMxDCL
- PWMxCON

# FIGURE 21-1: SIMPLIFIED PWM BLOCK DIAGRAM



# 21.1 **PWMx Pin Configuration**

All PWM outputs are multiplexed with the PORT data latch. The user must configure the pins as outputs by clearing the associated TRIS bits.

Note:	Clearing the PWMxOE bit will relinquish
	control of the PWMx pin.

#### 21.1.1 FUNDAMENTAL OPERATION

The PWM module produces a 10-bit resolution output. Timer2 and PR2 set the period of the PWM. The PWMxDCL and PWMxDCH registers configure the duty cycle. The period is common to all PWM modules, whereas the duty cycle is independently controlled.

Note:	The Timer2 postscaler is not used in the
	determination of the PWM frequency. The
	postscaler could be used to have a servo
	update rate at a different frequency than
	the PWM output.

All PWM outputs associated with Timer2 are set when TMR2 is cleared. Each PWMx is cleared when TMR2 is equal to the value specified in the corresponding PWMxDCH (8 MSb) and PWMxDCL<7:6> (2 LSb) registers. When the value is greater than or equal to PR2, the PWM output is never cleared (100% duty cycle).

Note: The PWMxDCH and PWMxDCL registers are double buffered. The buffers are updated when Timer2 matches PR2. Care should be taken to update both registers before the timer match occurs.

#### 21.1.2 PWM OUTPUT POLARITY

The output polarity is inverted by setting the PWMxPOL bit of the PWMxCON register.

#### 21.1.3 PWM PERIOD

The PWM period is specified by the PR2 register of Timer2. The PWM period can be calculated using the formula of Equation 21-1.

#### EQUATION 21-1: PWM PERIOD

$$PWM Period = [(PR2) + 1] \bullet 4 \bullet Tosc \bullet$$

(TMR2 Prescale Value)

Note: Tosc = 1/Fosc

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The PWM output is active. (Exception: When the PWM duty cycle = 0%, the PWM output will remain inactive.)
- The PWMxDCH and PWMxDCL register values are latched into the buffers.

Note:	The Timer2 postscaler has no effect on
	the PWM operation.

#### 21.1.4 PWM DUTY CYCLE

The PWM duty cycle is specified by writing a 10-bit value to the PWMxDCH and PWMxDCL register pair. The PWMxDCH register contains the eight MSbs and the PWMxDCL<7:6>, the two LSbs. The PWMxDCH and PWMxDCL registers can be written to at any time.

Equation 21-2 is used to calculate the PWM pulse width.

Equation 21-3 is used to calculate the PWM duty cycle ratio.

#### EQUATION 21-2: PULSE WIDTH

 $Pulse Width = (PWMxDCH:PWMxDCL<7:6>) \bullet$ 

TOSC • (TMR2 Prescale Value)

Note: Tosc = 1/Fosc

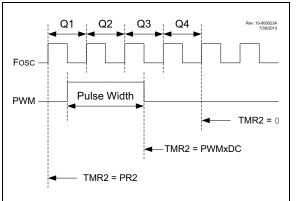
#### EQUATION 21-3: DUTY CYCLE RATIO

$$Duty Cycle Ratio = \frac{(PWMxDCH:PWMxDCL<7:6>)}{4(PR2+1)}$$

The 8-bit timer TMR2 register is concatenated with the two Least Significant bits of 1/Fosc, adjusted by the Timer2 prescaler to create the 10-bit time base. The system clock is used if the Timer2 prescaler is set to 1:1.

Figure 21-2 shows a waveform of the PWM signal when the duty cycle is set for the smallest possible pulse.

#### FIGURE 21-2: PWM OUTPUT



#### 21.1.5 PWM RESOLUTION

The resolution determines the number of available duty cycles for a given period. For example, a 10-bit resolution will result in 1024 discrete duty cycles, whereas an 8-bit resolution will result in 256 discrete duty cycles.

The maximum PWM resolution is ten bits when PR2 is 255. The resolution is a function of the PR2 register value as shown by Equation 21-4.

# EQUATION 21-4: PWM RESOLUTION

Resolution =  $\frac{\log[4(PR2 + 1)]}{\log(2)}$  bits

**Note:** If the pulse width value is greater than the period the assigned PWM pin(s) will remain unchanged.

PWM Frequency	0.31 kHz	4.88 kHz	19.53 kHz	78.12 kHz	156.3 kHz	208.3 kHz
Timer Prescale	64	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0x3F	0x1F	0x17
Maximum Resolution (bits)	10	10	10	8	7	6.6

#### TABLE 21-2: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (Fosc = 8 MHz)

PWM Frequency	0.31 kHz	4.90 kHz	19.61 kHz	76.92 kHz	153.85 kHz	200.0 kHz
Timer Prescale	64	4	1	1	1	1
PR2 Value	0x65	0x65	0x65	0x19	0x0C	0x09
Maximum Resolution (bits)	8	8	8	6	5	5

#### 21.1.6 OPERATION IN SLEEP MODE

In Sleep mode, the TMR2 register will not increment and the state of the module will not change. If the PWMx pin is driving a value, it will continue to drive that value. When the device wakes up, TMR2 will continue from its previous state.

#### 21.1.7 CHANGES IN SYSTEM CLOCK FREQUENCY

The PWM frequency is derived from the system clock frequency (Fosc). Any changes in the system clock frequency will result in changes to the PWM frequency. Refer to **Section 5.0 "Oscillator Module"** for additional details.

#### 21.1.8 EFFECTS OF RESET

Any Reset will force all ports to Input mode and the PWM registers to their Reset states.

#### 21.1.9 SETUP FOR PWM OPERATION USING PWMx PINS

The following steps should be taken when configuring the module for PWM operation using the PWMx pins:

- 1. Disable the PWMx pin output driver(s) by setting the associated TRIS bit(s).
- 2. Clear the PWMxCON register.
- 3. Load the PR2 register with the PWM period value.
- 4. Clear the PWMxDCH register and bits <7:6> of the PWMxDCL register.
- 5. Configure and start Timer2:
  - Clear the TMR2IF interrupt flag bit of the PIR1 register. See note below.
  - Configure the T2CKPS bits of the T2CON register with the Timer2 prescale value.
  - Enable Timer2 by setting the TMR2ON bit of the T2CON register.
- 6. Enable PWM output pin and wait until Timer2 overflows, TMR2IF bit of the PIR1 register is set. See note below.
- 7. Enable the PWMx pin output driver(s) by clearing the associated TRIS bit(s) and setting the PWMxOE bit of the PWMxCON register.
- 8. Configure the PWM module by loading the PWMxCON register with the appropriate values.
  - Note 1: In order to send a complete duty cycle and period on the first PWM output, the above steps must be followed in the order given. If it is not critical to start with a complete PWM signal, then move Step 8 to replace Step 4.
    - **2:** For operation with other peripherals only, disable PWMx pin outputs.

# 21.2 Register Definitions: PWM Control

R/W-0/0	R/W-0/0	R-0/0	R/W-0/0	U-0	U-0	U-0	U-0
PWMxEN	PWMxOE	PWMxOUT	PWMxPOL	—	—	—	—
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
u = Bit is unch	anged	x = Bit is unkr	nown	-n/n = Value a	at POR and BO	R/Value at all o	ther Resets
'1' = Bit is set		'0' = Bit is clea	ared				
bit 7	PWMxEN: P\	WM Module En	able bit				
	1 = PWM mc	odule is enable	d				
	0 = PWM mc	odule is disable	d				
bit 6	PWMxOE: P	WM Module Ou	itput Enable bi	t			
		PWMx pin is enabled					
	•	PWMx pin is a					
bit 5	PWMxOUT: F	PWM Module C	output Value bi	t			
bit 4	PWMxPOL:	PWMx Output F	Polarity Select	bit			
	1 = PWM out	tput is active-lo	W				
	0 = PWM out	tput is active-hi	gh				
bit 3-0	Unimplemen	ted: Read as '	0'				

#### REGISTER 21-1: PWMxCON: PWM CONTROL REGISTER

#### REGISTER 21-2: PWMxDCH: PWM DUTY CYCLE HIGH BITS

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
			PWMx	DCH<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit		W = Writable bit		U = Unimpleme	ented bit, read as	'0'	
u = Bit is unchang	ged	x = Bit is unknowr	า	-n/n = Value at	POR and BOR/V	alue at all other F	Resets
'1' = Bit is set		'0' = Bit is cleared					

bit 7-0

**PWMxDCH<7:0>:** PWM Duty Cycle Most Significant bits These bits are the MSbs of the PWM duty cycle. The two LSbs are found in the PWMxDCL register.

#### REGISTER 21-3: PWMxDCL: PWM DUTY CYCLE LOW BITS

R/W-x/u	R/W-x/u	U-0	U-0	U-0	U-0	U-0	U-0
PWMxD	CL<7:6>	—	—	—		_	—
bit 7				•			bit 0
Legend:							
R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'				

u = Bit is unchanged '1' = Bit is set	x = Bit is unknown '0' = Bit is cleared	-n/n = Value at POR and BOR/Value at all other Resets
bit 7-6 PWM	xDCL<7:6>: PWM Duty Cycle Least :	Significant bits

bit 7-6 **PWMxDCL</?6>:** PWM Duty Cycle Least Significant bits These bits are the LSbs of the PWM duty cycle. The MSbs are found in the PWMxDCH register.

bit 5-0 Unimplemented: Read as '0'

#### TABLE 21-3: SUMMARY OF REGISTERS ASSOCIATED WITH PWM

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PR2			1	Timer2 module I	Period Register				148*
PWM1CON	PWM1EN	PWM10E	PWM10UT	PWM1POL	_	_	-	-	155
PWM1DCH				PWM1D0	CH<7:0>				156
PWM1DCL	PWM1D	PWM1DCL<7:6>		_	—	—	—	—	156
PWM2CON	PWM2EN	PWM2OE	PWM2OUT	PWM2POL	_	—	—	—	155
PWM2DCH			•	PWM2D0	CH<7:0>				156
PWM2DCL	PWM2D	PWM2DCL<7:6>		_	—	—	—	—	156
PWM3CON	PWM3EN	PWM3OE	PWM3OUT	PWM3POL	_	—	—	—	155
PWM3DCH				PWM3D0	CH<7:0>				156
PWM3DCL	PWM3D	CL<7:6>	_	_	—	—	—	—	156
PWM4CON	PWM4EN	PWM4OE	PWM4OUT	PWM4POL	_	—	—	—	155
PWM4DCH				PWM4D0	CH<7:0>				156
PWM4DCL	PWM4D	CL<7:6>	_	_	_	_	_	_	156
T2CON	_		T2OUT	PS<3:0>		TMR2ON	T2CKP	S<1:0>	150
TMR2				Timer2 modu	ule Register	•	•		148*
TRISA	—	_	TRISA5	TRISA4	—(1)	TRISA2	TRISA1	TRISA0	98

Legend: -= Unimplemented locations, read as '0', u = unchanged, x = unknown. Shaded cells are not used by the PWM.

* Page provides register information.

Note 1: Unimplemented, read as '1'.

# 22.0 CONFIGURABLE LOGIC CELL (CLC)

The Configurable Logic Cell (CLCx) provides programmable logic that operates outside the speed limitations of software execution. The logic cell takes up to 16 input signals, and through the use of configurable gates, reduces the 16 inputs to four logic lines that drive one of eight selectable single-output logic functions.

Input sources are a combination of the following:

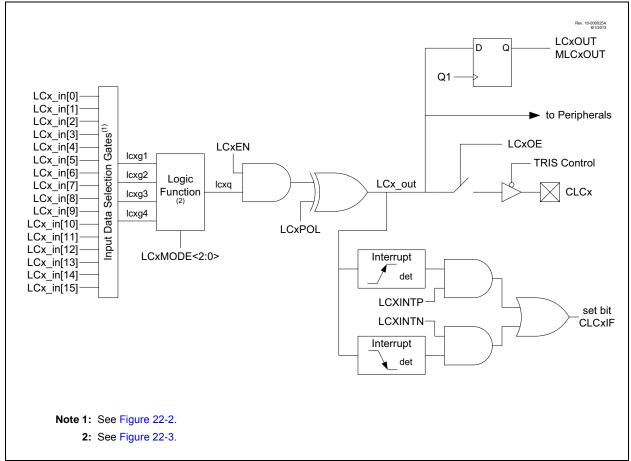
- · I/O pins
- Internal clocks
- · Peripherals
- · Register bits

The output can be directed internally to peripherals and to an output pin.

Refer to Figure 22-1 for a simplified diagram showing signal flow through the CLCx.

Possible configurations include:

- Combinatorial Logic
  - AND
  - NAND
  - AND-OR
  - AND-OR-INVERT
  - OR-XOR
  - OR-XNOR
- Latches
  - S-R
  - Clocked D with Set and Reset
  - Transparent D with Set and Reset
  - Clocked J-K with Reset



#### FIGURE 22-1: CONFIGURABLE LOGIC CELL BLOCK DIAGRAM

# 22.1 CLCx Setup

Programming the CLCx module is performed by configuring the four stages in the logic signal flow. The four stages are:

- Data selection
- Data gating
- · Logic function selection
- Output polarity

Each stage is setup at run time by writing to the corresponding CLCx Special Function Registers. This has the added advantage of permitting logic reconfiguration on-the-fly during program execution.

#### 22.1.1 DATA SELECTION

There are 16 signals available as inputs to the configurable logic. Four 8-input multiplexers are used to select the inputs to pass on to the next stage. The 16 inputs to the multiplexers are arranged in groups of four. Each group is available to two of the four multiplexers, in each case, paired with a different group. This arrangement makes possible selection of up to two from a group without precluding a selection from another group.

Data selection is through four multiplexers as indicated on the left side of Figure 22-2. Data inputs in the figure are identified by a generic numbered input name.

Table 22-1 correlates the generic input name to the actual signal for each CLC module. The columns labeled lcxd1 through lcxd4 indicate the MUX output for the selected data input. D1S through D4S are abbreviations for the MUX select input codes: LCxD1S<2:0> through LCxD4S<2:0>, respectively. Selecting a data input in a column excludes all other inputs in that column.

Data inputs are selected with CLCxSEL0 and CLCxSEL1 registers (Register 22-3 and Register 22-5, respectively).

**Note:** Data selections are undefined at power-up.

Data Input	lcxd1 D1S	lcxd2 D2S	lcxd3 D3S	lcxd4 D4S	CLC 1	CLC 2		
LCx_in[0]	000	—	—	100	CLC1IN0	CLC2IN0		
LCx_in[1]	001	_	_	101	CLC1IN1	CLC2IN1		
LCx_in[2]	010	—	—	110	C1OUT_sync	C1OUT_sync		
LCx_in[3]	011	_	_	111	Reserved	Reserved		
LCx_in[4]	100	000	—	—	Fosc	Fosc		
LCx_in[5]	101	001	—	—	T0_overflow	T0_overflow		
LCx_in[6]	110	010	_	_	T1_overflow	T1_overflow		
LCx_in[7]	111	011	—	—	T2_match	T2_match		
LCx_in[8]	—	100	000	—	LC1_out	LC1_out		
LCx_in[9]	_	101	001	_	LC2_out	LC2_out		
LCx_in[10]	—	110	010	—	Reserved	Reserved		
LCx_in[11]	—	111	011	—	Reserved	Reserved		
LCx_in[12]	_	_	100	000	NCO1_out	LFINTOSC		
LCx_in[13]	_	_	101	001	HFINTOSC	FRC		
LCx_in[14]	_	_	110	010	PWM3_out	PWM1_out		
LCx_in[15]	_	_	111	011	PWM4_out	PWM2_out		

TABLE 22-1: CLCx DATA INPUT SELECTION

#### 22.1.2 DATA GATING

Outputs from the input multiplexers are directed to the desired logic function input through the data gating stage. Each data gate can direct any combination of the four selected inputs.

#### Note: Data gating is undefined at power-up.

The gate stage is more than just signal direction. The gate can be configured to direct each input signal as inverted or non-inverted data. Directed signals are ANDed together in each gate. The output of each gate can be inverted before going on to the logic function stage.

The gating is in essence a 1-to-4 input AND/NAND/OR/NOR gate. When every input is inverted and the output is inverted, the gate is an OR of all enabled data inputs. When the inputs and output are not inverted, the gate is an AND or all enabled inputs.

Table 22-2 summarizes the basic logic that can be obtained in gate 1 by using the gate logic select bits. The table shows the logic of four input variables, but each gate can be configured to use less than four. If no inputs are selected, the output will be zero or one, depending on the gate output polarity bit.

TABLE 22-2: DATA GATING LOGIC

CLCxGLS0	LCxG1POL	Gate Logic	
0x55	1	AND	
0x55	0	NAND	
0xAA	1	NOR	
0xAA	0	OR	
0x00	0	Logic 0	
0x00	1	Logic 1	

It is possible (but not recommended) to select both the true and negated values of an input. When this is done, the gate output is zero, regardless of the other inputs, but may emit logic glitches (transient-induced pulses). If the output of the channel must be zero or one, the recommended method is to set all gate bits to zero and use the gate polarity bit to set the desired level.

Data gating is configured with the logic gate select registers as follows:

- Gate 1: CLCxGLS0 (Register 22-5)
- Gate 2: CLCxGLS1 (Register 22-6)
- Gate 3: CLCxGLS2 (Register 22-7)
- Gate 4: CLCxGLS3 (Register 22-8)

Register number suffixes are different than the gate numbers because other variations of this module have multiple gate selections in the same register. Data gating is indicated in the right side of Figure 22-2. Only one gate is shown in detail. The remaining three gates are configured identically with the exception that the data enables correspond to the enables for that gate.

#### 22.1.3 LOGIC FUNCTION

There are eight available logic functions including:

- AND-OR
- OR-XOR
- AND
- S-R Latch
- D Flip-Flop with Set and Reset
- D Flip-Flop with Reset
- J-K Flip-Flop with Reset
- · Transparent Latch with Set and Reset

Logic functions are shown in Figure 22-3. Each logic function has four inputs and one output. The four inputs are the four data gate outputs of the previous stage. The output is fed to the inversion stage and from there to other peripherals, an output pin, and back to the CLCx itself.

### 22.1.4 OUTPUT POLARITY

The last stage in the configurable logic cell is the output polarity. Setting the LCxPOL bit of the CLCxCON register inverts the output signal from the logic stage. Changing the polarity while the interrupts are enabled will cause an interrupt for the resulting output transition.

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# 22.1.5 CLCx SETUP STEPS

The following steps should be followed when setting up the CLCx:

- Disable CLCx by clearing the LCxEN bit.
- Select desired inputs using CLCxSEL0 and CLCxSEL1 registers (See Table 22-3).
- Clear any associated ANSEL bits.
- Set all TRIS bits associated with inputs.
- · Clear all TRIS bits associated with outputs.
- Enable the chosen inputs through the four gates using CLCxGLS0, CLCxGLS1, CLCxGLS2, and CLCxGLS3 registers.
- Select the gate output polarities with the LCxPOLy bits of the CLCxPOL register.
- Select the desired logic function with the LCxMODE<2:0> bits of the CLCxCON register.
- Select the desired polarity of the logic output with the LCxPOL bit of the CLCxPOL register. (This step may be combined with the previous gate output polarity step).
- If driving a device, set the LCxOE bit in the CLCxCON register and also clear the TRIS bit corresponding to that output.
- If interrupts are desired, configure the following bits:
  - Set the LCxINTP bit in the CLCxCON register for rising event.
  - Set the LCxINTN bit in the CLCxCON register or falling event.
  - Set the CLCxIE bit of the associated PIE registers.
  - Set the GIE and PEIE bits of the INTCON register.
- Enable the CLCx by setting the LCxEN bit of the CLCxCON register.

# 22.2 CLCx Interrupts

An interrupt will be generated upon a change in the output value of the CLCx when the appropriate interrupt enables are set. A rising edge detector and a falling edge detector are present in each CLC for this purpose.

The CLCxIF bit of the associated PIR registers will be set when either edge detector is triggered and its associated enable bit is set. The LCxINTP enables rising edge interrupts and the LCxINTN bit enables falling edge interrupts. Both are located in the CLCxCON register.

To fully enable the interrupt, set the following bits:

- · LCxON bit of the CLCxCON register
- · CLCxIE bit of the associated PIE registers
- LCxINTP bit of the CLCxCON register (for a rising edge detection)
- LCxINTN bit of the CLCxCON register (for a falling edge detection)
- · PEIE and GIE bits of the INTCON register

The CLCxIF bit of the associated PIR registers, must be cleared in software as part of the interrupt service. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

# 22.3 Output Mirror Copies

Mirror copies of all LCxCON output bits are contained in the CLCxDATA register. Reading this register reads the outputs of all CLCs simultaneously. This prevents any reading skew introduced by testing or reading the CLCxOUT bits in the individual CLCxCON registers.

# 22.4 Effects of a Reset

The CLCxCON register is cleared to zero as the result of a Reset. All other selection and gating values remain unchanged.

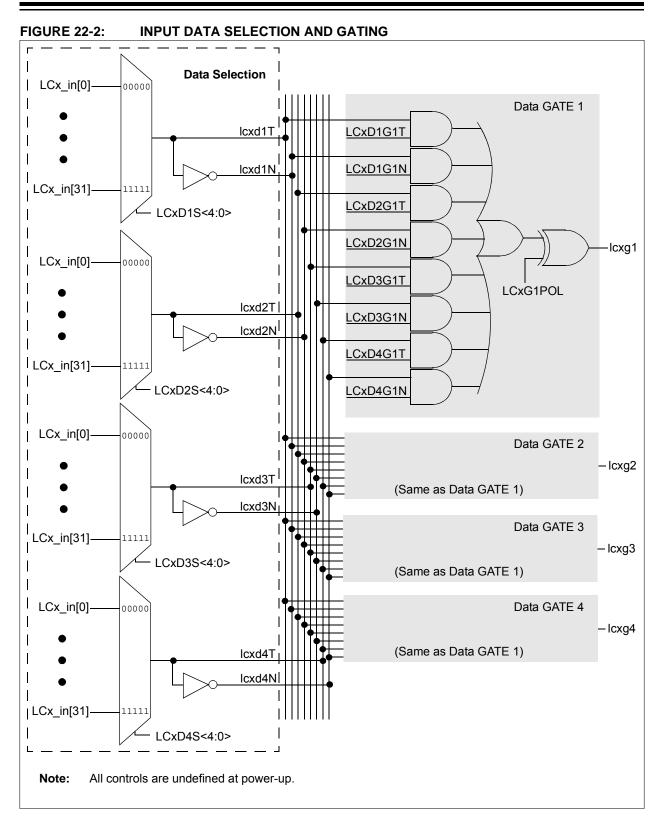
# 22.5 Operation During Sleep

The CLC module operates independently from the system clock and will continue to run during Sleep, provided that the input sources selected remain active.

The HFINTOSC remains active during Sleep when the CLC module is enabled and the HFINTOSC is selected as an input source, regardless of the system clock source selected.

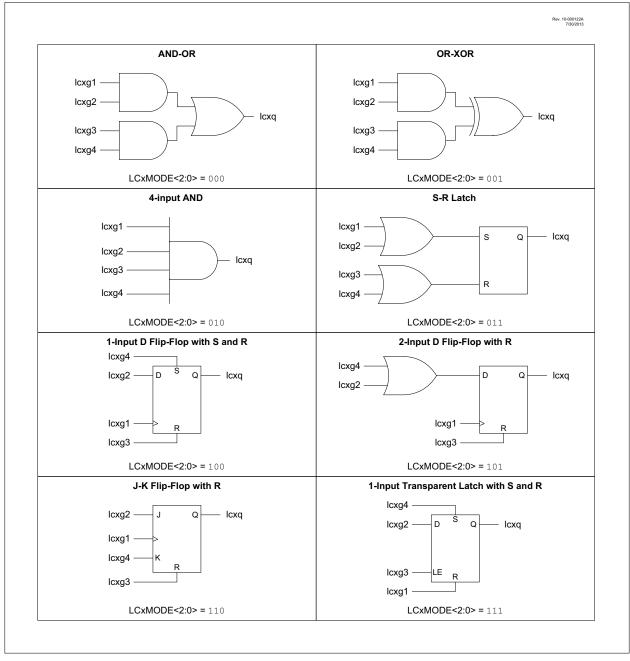
In other words, if the HFINTOSC is simultaneously selected as the system clock and as a CLC input source, when the CLC is enabled, the CPU will go idle during Sleep, but the CLC will continue to operate and the HFINTOSC will remain active.

This will have a direct effect on the Sleep mode current.



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#### FIGURE 22-3: PROGRAMMABLE LOGIC FUNCTIONS



# 22.6 Register Definitions: CLC Control

R/W-0/0	R/W-0/0	R-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0				
LCxEN	LCxOE	LCxOUT	LCxINTP	LCxINTN	L	CxMODE<2:0>	•				
bit 7							bit				
Legend:											
R = Readable	e bit	W = Writable	bit	•	nented bit, read						
u = Bit is unc	hanged	x = Bit is unkr	nown	-n/n = Value a	t POR and BO	R/Value at all o	ther Resets				
'1' = Bit is set		'0' = Bit is cle	ared								
bit 7	LCxEN: Con	figurable Logic	Cell Enable bi	it							
	<ul> <li>1 = Configurable logic cell is enabled and mixing input signals</li> <li>0 = Configurable logic cell is disabled and has logic zero output</li> </ul>										
bit 6	LCxOE: Con	figurable Logic	Cell Output E	nable bit							
		rable logic cell p rable logic cell p									
bit 5	LCxOUT: Co	LCxOUT: Configurable Logic Cell Data Output bit									
	Read-only: lo	ogic cell output	data, after LC>	<pol; sampled<="" td=""><td>from lcx_out w</td><td>/ire.</td><td></td></pol;>	from lcx_out w	/ire.					
bit 4	LCxINTP: Co	LCxINTP: Configurable Logic Cell Positive Edge Going Interrupt Enable bit									
		<ul> <li>1 = CLCxIF will be set when a rising edge occurs on lcx_out</li> <li>0 = CLCxIF will not be set</li> </ul>									
bit 3	<b>LCxINTN:</b> Configurable Logic Cell Negative Edge Going Interrupt Enable bit										
	1 = CLCxIF	will be set when will not be set	•	• •	•						
bit 2-0			ble I ogic Cell	Functional Mo	de hits						
dit 2-0	111 = Cell is 110 = Cell is 101 = Cell is 100 = Cell is 011 = Cell is	s 4-input AND s OR-XOR	arent latch with th R lop with R	h S and R	de dits						

#### REGISTER 22-1: CLCxCON: CONFIGURABLE LOGIC CELL CONTROL REGISTER

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R/W-0/0	U-0	U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u					
LCxPOL	—	—	—	LCxG4POL	LCxG3POL	LCxG2POL	LCxG1POL					
bit 7							bit 0					
Legend:												
R = Readat	ole bit	W = Writable	bit	U = Unimpler	mented bit, read	l as '0'						
u = Bit is ur	changed	x = Bit is unkr	iown	-n/n = Value a	at POR and BO	R/Value at all o	other Resets					
'1' = Bit is s	•	'0' = Bit is clea	ared									
bit 7	LCxPOL: L	COUT Polarity C	ontrol bit									
		The output of the logic cell is inverted										
	0 = The ou	tput of the logic of	ell is not inv	erted								
bit 6-4	Unimpleme	ented: Read as '	o'									
bit 3	LCxG4POL	.: Gate 4 Output	Polarity Con	trol bit								
	1 = The ou	1 = The output of gate 4 is inverted when applied to the logic cell										
	0 = The ou	0 = The output of gate 4 is not inverted										
bit 2		LCxG3POL: Gate 3 Output Polarity Control bit										
		tput of gate 3 is i		n applied to the	logic cell							
		tput of gate 3 is r										
bit 1		: Gate 2 Output	•									
		tput of gate 2 is i tput of gate 2 is r		n applied to the	logic cell							
bit 0				tral hit								
DILU		.: Gate 1 Output tput of gate 1 is i										
		tput of gate 1 is r		in applied to the								
	· · · · · · · · · · · · · · · · · · ·											

#### REGISTER 22-2: CLCxPOL: SIGNAL POLARITY CONTROL REGISTER

U-0	R/W-x/u	R/W-x/u	R/W-x/u	U-0	R/W-x/u	R/W-x/u	R/W-x/u					
_		LCxD2S<2:0>(1)		—	L	_CxD1S<2:0> ⁽¹⁾						
bit 7							bit 0					
Legend:												
R = Readable	e bit	W = Writable b	bit	U = Unimple	mented bit, read	d as '0'						
u = Bit is und	hanged	x = Bit is unkn	own	-n/n = Value	at POR and BO	R/Value at all of	her Resets					
'1' = Bit is se	t	'0' = Bit is clea	red									
bit 7	Unimpleme	ented: Read as '0	,									
bit 6-4 LCxD2S<2:0>: Input Data 2 Selection Control bits ⁽¹⁾												
	111 = LCx	111 = LCx_in[11] is selected for lcxd2										
	110 = LCx	110 = LCx_in[10] is selected for lcxd2										
	101 = LCx	101 = LCx_in[9] is selected for lcxd2										
	100 = LCx	_in[8] is selected t	for lcxd2									
	011 = LCx	_in[7] is selected for lcxd2										
	010 = LCx	010 = LCx_in[6] is selected for lcxd2										
	-	001 = LCx_in[5] is selected for lcxd2										
	000 = LCx	000 = LCx_in[4] is selected for lcxd2										
bit 3	Unimpleme	ented: Read as '0	'									
bit 2-0	LCxD1S<2	:0>: Input Data 1	Selection Co	ntrol bits ⁽¹⁾								
	111 = LCx	in[7] is selected t	for lcxd1									
	-	110 = LCx in[6] is selected for lcxd1										
		101 = LCx_in[5] is selected for lcxd1										
		in[4] is selected										
	011 = LCx	in[3] is selected	for lcxd1									
	010 = LCx	in[2] is selected	for lcxd1									
	001 = LCx	_in[1] is selected t	for lcxd1									
	000 = LCx	in[0] is selected	for lcxd1									

# REGISTER 22-3: CLCxSEL0: MULTIPLEXER DATA 1 AND 2 SELECT REGISTER

**Note 1:** See Table 22-1 for signal names associated with inputs.

U-0	R/W-x/u	ı R/W-x/u	R/W-x/u	U-0	R/W-x/u	R/W-x/u	R/W-x/u						
_		LCxD4S<2:0> ⁽¹⁾		—	L	_CxD3S<2:0> ⁽¹⁾							
bit 7							bit 0						
Legend:													
R = Readab	le bit	W = Writable I	oit	U = Unimple	mented bit, read	d as '0'							
u = Bit is und	changed	x = Bit is unkn	own	-n/n = Value	at POR and BO	R/Value at all o	ther Resets						
'1' = Bit is se	et	'0' = Bit is clea	ared										
bit 7	Unimplem	nented: Read as 'o	)'										
bit 6-4	LCxD4S<	LCxD4S<2:0>: Input Data 4 Selection Control bits ⁽¹⁾											
		x in[3] is selected											
		x in[2] is selected											
		101 = LCx_in[1] is selected for lcxd4											
		100 = LCx_in[0] is selected for lcxd4											
		x in[15] is selected											
	010 = LC:	x_in[14] is selected	l for lcxd4										
	001 = LC:	001 = LCx_in[13] is selected for lcxd4											
	000 = LC	x_in[12] is selected	for lcxd4										
bit 3	Unimplem	nented: Read as 'o	)'										
bit 2-0	LCxD3S<	2:0>: Input Data 3	Selection Co	ntrol bits ⁽¹⁾									
	111 = LC:	x_in[15] is selected	for lcxd3										
	110 = LC:	110 = LCx in[14] is selected for lcxd3											
	101 = LC:	x_in[13] is selected	for lcxd3										
	100 = LC	x_in[12] is selected	for lcxd3										
	011 = LC:	x_in[11] is selected	l for lcxd3										
	010 = LC:	x_in[10] is selected	for lcxd3										
	001 = LC:	x_in[9] is selected	for lcxd3										
	000 = LC	x_in[8] is selected	for lcxd3										
Note 1: S	ee Table 22-1	for signal names a	esociated wi	th inpute									

# REGISTER 22-4: CLCxSEL1: MULTIPLEXER DATA 3 AND 4 SELECT REGISTER

**Note 1:** See Table 22-1 for signal names associated with inputs.

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u		
LCxG1D4T	LCxG1D4N	LCxG1D3T	LCxG1D3N	LCxG1D2T	LCxG1D2N	LCxG1D1T	LCxG1D1N		
bit 7							bit 0		
Legend:									
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	as '0'			
u = Bit is unch	anged	x = Bit is unkr		-n/n = Value a	at POR and BO	R/Value at all c	other Resets		
'1' = Bit is set		'0' = Bit is clea	ared						
bit 7		Gate 1 Data 4 1		rted) bit					
		gated into lcxg not gated into							
bit 6		Gate 1 Data 4	-	ted) bit					
bit o	1 = lcxd4N is gated into lcxg1								
		not gated into							
bit 5	LCxG1D3T: (	Gate 1 Data 3 1	rue (non-inver	rted) bit					
		gated into lcxg							
		not gated into	0						
bit 4		Gate 1 Data 3	•	ted) bit					
		a gated into lcxo not gated into							
bit 3		Gate 1 Data 2 1	-	rted) bit					
		gated into lcxg	•	,					
	0 = Icxd2T is	not gated into	lcxg1						
bit 2		Gate 1 Data 2 I	•	ted) bit					
		s gated into lcxg not gated into							
bit 1				tod) bit					
DILI		Gate 1 Data 1 True (non-inverted) bit s gated into lcxg1							
		not gated into							
bit 0		Gate 1 Data 1 I		ted) bit					
		gated into lcx							
	0 = lcxd1N is								

## REGISTER 22-5: CLCxGLS0: GATE 1 LOGIC SELECT REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u						
LCxG2D4T	LCxG2D4N	LCxG2D3T	LCxG2D3N	LCxG2D2T	LCxG2D2N	LCxG2D1T	LCxG2D1N						
bit 7							bit (						
Legend:													
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'							
u = Bit is unchanged		x = Bit is unkr			at POR and BO		ther Resets						
'1' = Bit is set		'0' = Bit is cle											
bit 7	LCxG2D4T: Gate 2 Data 4 True (non-inverted) bit												
		= lcxd4T is gated into lcxg2											
		not gated into	•										
bit 6	LCxG2D4N: Gate 2 Data 4 Negated (inverted) bit												
		1 = Icxd4N is gated into Icxg2 0 = Icxd4N is not gated into Icxg2											
bit 5		•	rtad) bit										
DIL D		<b>CxG2D3T:</b> Gate 2 Data 3 True (non-inverted) bit = Icxd3T is gated into Icxg2											
		s not gated into loxg2											
bit 4		Gate 2 Data 3	•	rted) bit									
		gated into Icxg2											
	0 = Icxd3N is	not gated into	lcxg2										
bit 3	LCxG2D2T: O	Gate 2 Data 2 1	True (non-invei	rted) bit									
		gated into lcxg											
		not gated into	0										
bit 2		Gate 2 Data 2	<b>0</b> (	rted) bit									
		exd2N is gated into lexg2 exd2N is not gated into lexg2											
bit 1		•	•	rted) hit									
		Gate 2 Data 1 True (non-inverted) bit gated into lcxg2											
		not gated into											
bit 0	LCxG2D1N: (	Gate 2 Data 1	Negated (inver	rted) bit									
		gated into Icx											
	0 = lcxd1N is	not gated into	leva2										

## REGISTER 22-6: CLCxGLS1: GATE 2 LOGIC SELECT REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LCxG3D4T	LCxG3D4N	LCxG3D3T	LCxG3D3N	LCxG3D2T	LCxG3D2N	LCxG3D1T	LCxG3D1N
bit 7							bit 0
Legend:							
R = Readable		W = Writable	bit	U = Unimpler	nented bit, read	as '0'	
u = Bit is unch	anged	x = Bit is unkr		-n/n = Value a	at POR and BO	R/Value at all c	other Resets
'1' = Bit is set		'0' = Bit is clea	ared				
			<b>.</b> , .				
bit 7		Gate 3 Data 4 1	•	ted) bit			
		gated into lcxg not gated into	•				
bit 6		Gate 3 Data 4	-	ted) bit			
		gated into lcx	•				
		not gated into					
bit 5	LCxG3D3T: (	Gate 3 Data 3 1	rue (non-inver	ted) bit			
		gated into lcxc					
1.11.4		not gated into	•	(			
bit 4		Gate 3 Data 3 I gated into Icx	•	ted) bit			
		s not gated into icx					
bit 3		Gate 3 Data 2 1	-	ted) bit			
	1 = lcxd2T is	gated into lcxg	j3	,			
		not gated into	•				
bit 2		Gate 3 Data 2	•	ted) bit			
		s gated into lcxo not gated into					
bit 1		Gate 3 Data 1 1	-	tod) bit			
		gated into lcxg		(eu) bit			
		not gated into					
bit 0		Gate 3 Data 1 I		ted) bit			
		s gated into lcxo					
	0 = lcxd1N is						

# REGISTER 22-7: CLCxGLS2: GATE 3 LOGIC SELECT REGISTER

	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	
LCxG4D4T	LCxG4D4N	LCxG4D3T	LCxG4D3N	LCxG4D2T	LCxG4D2N	LCxG4D1T	LCxG4D1N	
bit 7							bit (	
Legend:								
R = Readable b	oit	W = Writable	bit	U = Unimpler	nented bit, read	as '0'		
u = Bit is uncha	anged	x = Bit is unkr	nown	-n/n = Value a	at POR and BO	R/Value at all c	other Resets	
1' = Bit is set	0	'0' = Bit is clea	ared					
bit 7		Note 4 Date 4 T		rtad) bit				
		Bate 4 Data 4 7 gated into Icxo	,	led) bit				
		not gated into						
bit 6		Gate 4 Data 4	•	ted) bit				
		gated into Icx	•	,				
	0 = lcxd4N is not gated into lcxg4							
bit 5	LCxG4D3T: O	Gate 4 Data 3 1	True (non-inver	rted) bit				
		gated into lcxg	,					
		not gated into	•					
bit 4		Gate 4 Data 3 Negated (inverted) bit						
		gated into lcxg not gated into						
bit 3		Gate 4 Data 2 1	•	ted) hit				
511 5		gated into Icxo						
		not gated into	•					
bit 2	LCxG4D2N: Gate 4 Data 2 Negated (inverted) bit							
	1 = Icxd2N is gated into Icxg4							
	0 = Icxd2N is	not gated into	lcxg4					
bit 1		Gate 4 Data 1 1	•	rted) bit				
		gated into lcxg	•					
		not gated into	•					
bit 0		Gate 4 Data 1	•	ted) bit				
		gated into lcxg not gated into						

### REGISTER 22-8: CLCxGLS3: GATE 4 LOGIC SELECT REGISTER

#### REGISTER 22-9: CLCDATA: CLC DATA OUTPUT

U-0	U-0	U-0	U-0	U-0	U-0	R-0	R-0		
_	—	—	—	—	—	MLC2OUT	MLC1OUT		
bit 7							bit 0		
Legend:									
R = Readab	ole bit	W = Writable	bit	U = Unimplemented bit, read as '0'					
u = Bit is unchanged x = Bit is unknown			nown	-n/n = Value a	at POR and BO	R/Value at all o	ther Resets		
'1' = Bit is s	et	'0' = Bit is clea	ared						
bit 7-2	Unimplemente	ed: Read as '0'	,						
h:+ 4		inner een of l							

bit 1	MLC2OUI: Mirror	copy of LC2OUT bit

bit 0 MLC1OUT: Mirror copy of LC1OUT bit

Name	Bit7	Bit6	Bit5	Bit4	Blt3	Bit2	Bit1	Bit0	Register on Page
ANSELA	_	—	_	ANSA4	—	ANSA2	ANSA1	ANSA0	99
CLC1CON	LC1EN	LC10E	LC10UT	LC1INTP	LC1INTN	l	C1MODE<2:0	>	163
CLCDATA	_	—	—	—	_	MLC3OUT	MLC2OUT	MLC1OUT	171
CLC1GLS0	LC1G1D4T	LC1G1D4N	LC1G1D3T	LC1G1D3N	LC1G1D2T	LC1G1D2N	LC1G1D1T	LC1G1D1N	167
CLC1GLS1	LC1G2D4T	LC1G2D4N	LC1G2D3T	LC1G2D3N	LC1G2D2T	LC1G2D2N	LC1G2D1T	LC1G2D1N	168
CLC1GLS2	LC1G3D4T	LC1G3D4N	LC1G3D3T	LC1G3D3N	LC1G3D2T	LC1G3D2N	LC1G3D1T	LC1G3D1N	169
CLC1GLS3	LC1G4D4T	LC1G4D4N	LC1G4D3T	LC1G4D3N	LC1G4D2T	LC1G4D2N	LC1G4D1T	LC1G4D1N	170
CLC1POL	LC1POL	_	_	_	LC1G4POL	LC1G3POL	LC1G2POL	LC1G1POL	164
CLC1SEL0	—		LC1D2S<2:0>		—		LC1D1S<2:0>		165
CLC1SEL1	-		LC1D4S<2:0>		—		LC1D3S<2:0>		166
CLC2CON	LC2EN	LC2OE	LC2OUT	LC2INTP	LC2INTN	l	C2MODE<2:0>		163
CLC2GLS0	LC2G1D4T	LC2G1D4N	LC2G1D3T	LC2G1D3N	LC2G1D2T	LC2G1D2N	LC2G1D1T	LC2G1D1N	167
CLC2GLS1	LC2G2D4T	LC2G2D4N	LC2G2D3T	LC2G2D3N	LC2G2D2T	LC2G2D2N	LC2G2D1T	LC2G2D1N	168
CLC2GLS2	LC2G3D4T	LC2G3D4N	LC2G3D3T	LC2G3D3N	LC2G3D2T	LC2G3D2N	LC2G3D1T	LC2G3D1N	169
CLC2GLS3	LC2G4D4T	LC2G4D4N	LC2G4D3T	LC2G4D3N	LC2G4D2T	LC2G4D2N	LC2G4D1T	LC2G4D1N	170
CLC2POL	LC2POL	_	_	_	LC2G4POL	LC2G3POL	LC2G2POL	LC2G1POL	164
CLC2SEL0	-		LC2D2S<2:0>		—	LC2D1S<2:0>		165	
CLC2SEL1	—		LC2D4S<2:0>		—	LC2D3S<2:0>		166	
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
PIE3	—	—	_	—	—	—	CLC2IE	CLC1IE	67
PIR3	—	—	_	—	—	—	CLC2IF	CLC1IF	70
TRISA	_	—	TRISA5	TRISA4	(1)	TRISA2	TRISA1	TRISA0	98

#### TABLE 22-3: SUMMARY OF REGISTERS ASSOCIATED WITH CLCx

 Legend:
 — = unimplemented read as '0',. Shaded cells are not used for CLC module.

 Note
 1:
 Unimplemented, read as '1'.

# 23.0 NUMERICALLY CONTROLLED OSCILLATOR (NCO) MODULE

The Numerically Controlled Oscillator (NCOx) module is a timer that uses the overflow from the addition of an increment value to divide the input frequency. The advantage of the addition method over simple counter driven timer is that the resolution of division does not vary with the divider value. The NCOx is most useful for applications that require frequency accuracy and fine resolution at a fixed duty cycle.

Features of the NCOx include:

- · 16-bit increment function
- Fixed Duty Cycle (FDC) mode
- Pulse Frequency (PF) mode
- Output pulse width control
- · Multiple clock input sources
- Output polarity control
- · Interrupt capability

Figure 23-1 is a simplified block diagram of the NCOx module.

# 23.1 NCOx Operation

The NCOx operates by repeatedly adding a fixed value to an accumulator. Additions occur at the input clock rate. The accumulator will overflow with a carry periodically, which is the raw NCOx output (NCO_overflow). This effectively reduces the input clock by the ratio of the addition value to the maximum accumulator value. See Equation 23-1.

The NCOx output can be further modified by stretching the pulse or toggling a flip-flop. The modified NCOx output is then distributed internally to other peripherals and optionally output to a pin. The accumulator overflow also generates an interrupt (NCO_interrupt).

The NCOx period changes in discrete steps to create an average frequency. This output depends on the ability of the receiving circuit (i.e., CWG or external resonant converter circuitry) to average the NCOx output to reduce uncertainty.

#### 23.1.1 NCOx CLOCK SOURCES

Clock sources available to the NCOx include:

- HFINTOSC
- Fosc
- LC1_out
- CLKIN pin

The NCOx clock source is selected by configuring the NxCKS<2:0> bits in the NCOxCLK register.

#### EQUATION 23-1:

FOVERFLOW= <u>NCO Clock Frequency × Increment Value</u>

 $2^n$ 

n = Accumulator width in bits

#### 23.1.2 ACCUMULATOR

The accumulator is a 20-bit register. Read and write access to the accumulator is available through three registers:

- NCOxACCL
- NCOxACCH
- NCOxACCU

#### 23.1.3 ADDER

The NCOx adder is a full adder, which operates independently from the system clock. The addition of the previous result and the increment value replaces the accumulator value on the rising edge of each input clock.

#### 23.1.4 INCREMENT REGISTERS

The increment value is stored in two 8-bit registers making up a 16-bit increment. In order of LSB to MSB they are:

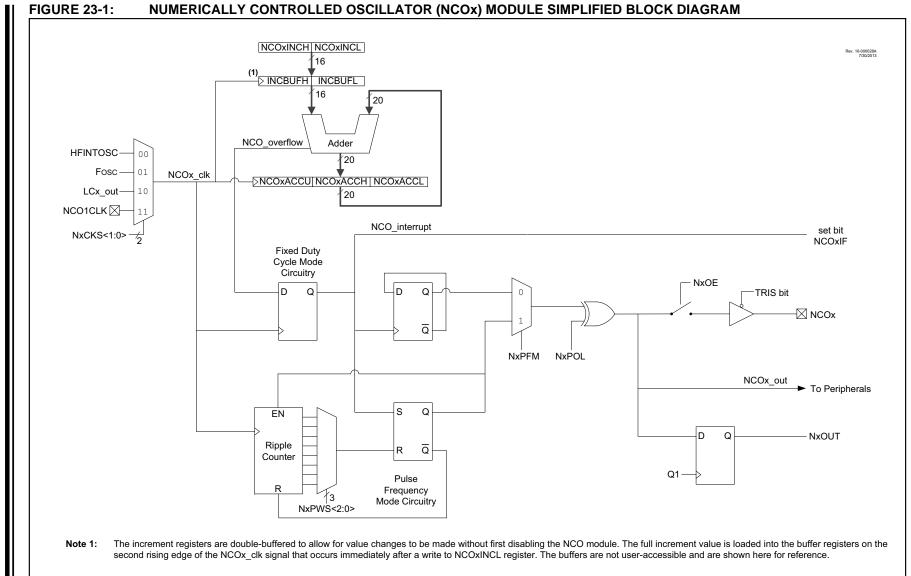
- NCOxINCL
- NCOxINCH

When the NCO module is enabled, the NCOxINCH should be written first, then the NCOxINCL register. Writing to the NCOxINCL register initiates the increment buffer registers to be loaded simultaneously on the second rising edge of the NCOx_clk signal.

The registers are readable and writable. The increment registers are double-buffered to allow value changes to be made without first disabling the NCOx module.

When the NCO module is disabled, the increment buffers are loaded immediately after a write to the increment registers.

Note: The increment buffer registers are not user-accessible.



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# 23.2 Fixed Duty Cycle (FDC) Mode

In Fixed Duty Cycle (FDC) mode, every time the accumulator overflows (NCO_overflow), the output is toggled. This provides a 50% duty cycle, provided that the increment value remains constant. For more information, see Figure 23-2.

The FDC mode is selected by clearing the NxPFM bit in the NCOxCON register.

# 23.3 Pulse Frequency (PF) Mode

In Pulse Frequency (PF) mode, every time the accumulator overflows (NCO_overflow), the output becomes active for one or more clock periods. Once the clock period expires, the output returns to an inactive state. This provides a pulsed output.

The output becomes active on the rising clock edge immediately following the overflow event. For more information, see Figure 23-2.

The value of the active and inactive states depends on the polarity bit, NxPOL in the NCOxCON register.

The PF mode is selected by setting the NxPFM bit in the NCOxCON register.

23.3.1 OUTPUT PULSE WIDTH CONTROL

When operating in PF mode, the active state of the output can vary in width by multiple clock periods. Various pulse widths are selected with the NxPWS<2:0> bits in the NCOxCLK register.

When the selected pulse width is greater than the accumulator overflow time frame, the output of the NCOx operation is indeterminate.

#### 23.4 Output Polarity Control

The last stage in the NCOx module is the output polarity. The NxPOL bit in the NCOxCON register selects the output polarity. Changing the polarity while the interrupts are enabled will cause an interrupt for the resulting output transition.

The NCOx output can be used internally by source code or other peripherals. Accomplish this by reading the NxOUT (read-only) bit of the NCOxCON register.

The NCOx output signal is available to the following peripherals:

- CLC
- CWG

### 23.5 Interrupts

When the accumulator overflows (NCO_overflow), the NCOx Interrupt Flag bit, NCOxIF, of the PIRx register is set. To enable the interrupt event (NCO_interrupt), the following bits must be set:

- NxEN bit of the NCOxCON register
- · NCOxIE bit of the PIEx register
- · PEIE bit of the INTCON register
- GIE bit of the INTCON register

The interrupt must be cleared by software by clearing the NCOxIF bit in the Interrupt Service Routine.

# 23.6 Effects of a Reset

All of the NCOx registers are cleared to zero as the result of a Reset.

# 23.7 Operation In Sleep

The NCO module operates independently from the system clock and will continue to run during Sleep, provided that the clock source selected remains active.

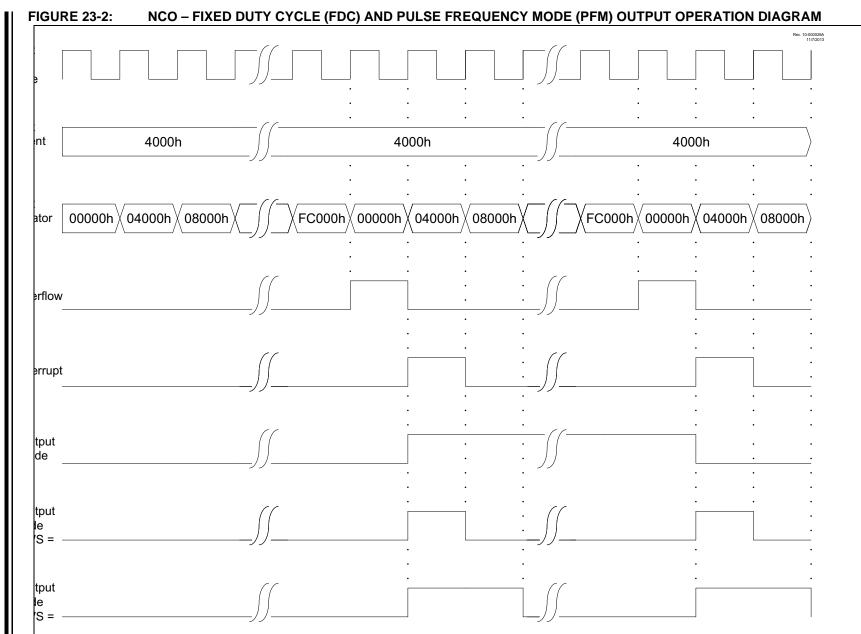
The HFINTOSC remains active during Sleep when the NCO module is enabled and the HFINTOSC is selected as the clock source, regardless of the system clock source selected.

In other words, if the HFINTOSC is simultaneously selected as the system clock and the NCO clock source, when the NCO is enabled, the CPU will go idle during Sleep, but the NCO will continue to operate and the HFINTOSC will remain active.

This will have a direct effect on the Sleep mode current.

# 23.8 Alternate Pin Locations

This module incorporates I/O pins that can be moved to other locations with the use of the alternate pin function register, APFCON. To determine which pins can be moved and what their default locations are upon a Reset, see Section 11.1 "Alternate Pin Function" for more information.



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# 23.9 Register Definitions: NCOx Control Registers

### REGISTER 23-1: NCOxCON: NCOx CONTROL REGISTER

R/W-0/0	R/W-0/0	R-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
NxEN	NxOE	NxOUT	NxPOL	_	—	—	NxPFM
bit 7		2				•	bit 0
Legend:							
R = Readable I	oit	W = Writable bi	t	U = Unimplem	ented bit, read as	; 'O'	
u = Bit is uncha	anged	x = Bit is unkno	wn	•	POR and BOR/		Resets
1' = Bit is set (0' = Bit is cleared							
bit 7	NxEN: NCOx Enable bit 1 = NCOx module is enabled 0 = NCOx module is disabled						
bit 6	1 = NCOx outp	Output Enable bit out pin is enabled out pin is disabled					
bit 5	NxOUT: NCOx Output bit 1 = NCOx output is high 0 = NCOx output is low						
bit 4	NxPOL: NCOx Polarity bit 1 = NCOx output signal is active low (inverted) 0 = NCOx output signal is active high (non-inverted)						
bit 3-1	Unimplemente	ed: Read as '0'					
bit 0	1 = NCOx oper	Pulse Frequenc rates in Pulse Fre rates in Fixed Du	equency mode				

#### REGISTER 23-2: NCOxCLK: NCOx INPUT CLOCK CONTROL REGISTER

NxPWS<2:0>(1, 2)         —         —         —         NxCKS<1:0>           bit 7         bit 7	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
bit 7 bit		NxPWS<2:0>(1, 2)		—	—	—	NxCKS	S<1:0>
	bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 NxPWS<2:0>: NCOx Output Pulse Width Select bits^(1, 2)

- 111 = 128 NCOx clock periods
- 110 = 64 NCOx clock periods
- 101 = 32 NCOx clock periods
- 100 = 16 NCOx clock periods
- 011 = 8 NCOx clock periods
- 010 = 4 NCOx clock periods
- 001 = 2 NCOx clock periods
- 000 = 1 NCOx clock periods
- bit 4-2 Unimplemented: Read as '0'
- bit 1-0 NxCKS<1:0>: NCOx Clock Source Select bits
  - 11 = NCO1CLK pin
  - 10 = LC1_out
  - 01 = Fosc
  - 00 = HFINTOSC (16 MHz)

Note 1: NxPWS applies only when operating in Pulse Frequency mode.

2: If NCOx pulse width is greater than NCO_overflow period, operation is indeterminate.

#### REGISTER 23-3: NCOxACCL: NCOx ACCUMULATOR REGISTER – LOW BYTE

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
			NCOxA	CC<7:0>			
bit 7							bit 0
Legend:							
R = Readable b	it	W = Writable bit	ł	U = Unimplen	nented bit read	l as '0'	

'1' = Bit is set	'0' = Bit is cleared	
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
R – Reauable bit		0 – Onimpiementeu bit, reau as 0

bit 7-0	NCOxACC<7:0>: NCOx Accumulator, Low Byte
---------	------------------------------------------

#### **REGISTER 23-4: NCOXACCH: NCOX ACCUMULATOR REGISTER – HIGH BYTE**

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0		
			NCOxAC	C<15:8>					
bit 7							bit 0		
Legend:									
R = Readable	dable bit W = Writable bit			U = Unimplemented bit, read as '0'					
u = Bit is unch	anged	x = Bit is unkr	nown	-n/n = Value at POR and BOR/Value at all other Resets					

#### bit 7-0 NCOxACC<15:8>: NCOx Accumulator, High Byte

'0' = Bit is cleared

#### REGISTER 23-5: NCOxACCU: NCOx ACCUMULATOR REGISTER – UPPER BYTE

U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—		NCOXAC	C<19:16>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-4 Unimplemented: Read as '0'

bit 3-0 NCOxACC<19:16>: NCOx Accumulator, Upper Byte

'1' = Bit is set

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#### **REGISTER 23-6:** NCOxINCL: NCOx INCREMENT REGISTER – LOW BYTE⁽¹⁾

R/W-0/0	R/W-1/1						
			NCOXIN	C<7:0>			
bit 7							bit 0

# Legend:

=ogonan		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

#### bit 7-0 NCOxINC<7:0>: NCOx Increment, Low Byte

Note 1: Write the NCOxINCH register first, then the NCOxINCL register. See 23.1.4 "Increment Registers" for more information.

# REGISTER 23-7: NCOxINCH: NCOx INCREMENT REGISTER – HIGH BYTE⁽¹⁾

| R/W-0/0 |
|---------|---------|---------|---------|---------|---------|---------|---------|
|         |         |         | NCOxIN  | C<15:8> |         |         |         |
| bit 7   |         |         |         |         |         |         | bit 0   |

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 NCOxINC<15:8>: NCOx Increment, High Byte

**Note 1:** Write the NCOxINCH register first, then the NCOxINCL register. See **23.1.4** "Increment Registers" for more information.

#### TABLE 23-1: SUMMARY OF REGISTERS ASSOCIATED WITH NCOX

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
APFCON	CWG1BSEL	CWGA1SEL		—	T1GSEL	_	CLC1SEL	NCO1SEL	96
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
NCO1ACCH				NCO1AC	C<15:8>				178
NCO1ACCL				NCO1A	CC<7:0>				178
NCO1ACCU		-	_		NCO1ACC<19:16>				178
NCO1CLK		N1PWS<2:0> —			_	_	N1CK	177	
NCO1CON	N1EN	N1OE	N1OUT	N1POL	_	_	_	N1PFM	177
NCO1INCH	NCO1INC<15:8>								
NCO1INCL				NCO1IN	NC<7:0>				179
PIE2	_	_	C1IE	_	—	NCO1IE	_	—	66
PIR2		_	C1IF	_	_	NCO1IF	_	_	69
TRISA	_	_	TRISA5	TRISA4	_(1)	TRISA2	TRISA1	TRISA0	98

Legend: x = unknown, u = unchanged, - = unimplemented read as '0', g = value depends on condition. Shaded cells are not used for NCOx module.

Note 1: Unimplemented, read as '1'.

# 24.0 COMPLEMENTARY WAVEFORM GENERATOR (CWG) MODULE

The Complementary Waveform Generator (CWG) produces a complementary waveform with dead-band delay from a selection of input sources.

The CWG module has the following features:

- · Selectable dead-band clock source control
- · Selectable input sources
- · Output enable control
- · Output polarity control
- Dead-band control with independent 6-bit rising and falling edge dead-band counters
- Auto-shutdown control with:
- Selectable shutdown sources
- Auto-restart enable
- Auto-shutdown pin override control

### 24.1 Fundamental Operation

The CWG generates two output waveforms from the selected input source.

The off-to-on transition of each output can be delayed from the on-to-off transition of the other output, thereby, creating a time delay immediately where neither output is driven. This is referred to as dead time and is covered in **Section 24.5 "Dead-Band Control"**. A typical operating waveform, with dead band, generated from a single input signal is shown in Figure 24-2.

It may be necessary to guard against the possibility of circuit faults or a feedback event arriving too late or not at all. In this case, the active drive must be terminated before the Fault condition causes damage. This is referred to as auto-shutdown and is covered in Section 24.9 "Auto-Shutdown Control".

#### 24.2 Clock Source

The CWG module allows the following clock sources to be selected:

- Fosc (system clock)
- HFINTOSC (16 MHz only)

The clock sources are selected using the G1CS0 bit of the CWGxCON0 register (Register 24-1).

### 24.3 Selectable Input Sources

The CWG generates the output waveforms from the input sources in Table 24-1.

TABLE 24-1:	SELECTABLE INPUT		
	SOURCES		

Source Peripheral	Signal Name
Comparator C1	C1OUT_sync
PWM1	PWM1_out
PWM2	PWM2_out
PWM3	PWM3_out
PWM4	PWM4_out
NCO1	NCO1_out
CLC1	LC1_out

The input sources are selected using the GxIS<2:0> bits in the CWGxCON1 register (Register 24-2).

# 24.4 Output Control

Immediately after the CWG module is enabled, the complementary drive is configured with both CWGxA and CWGxB drives cleared.

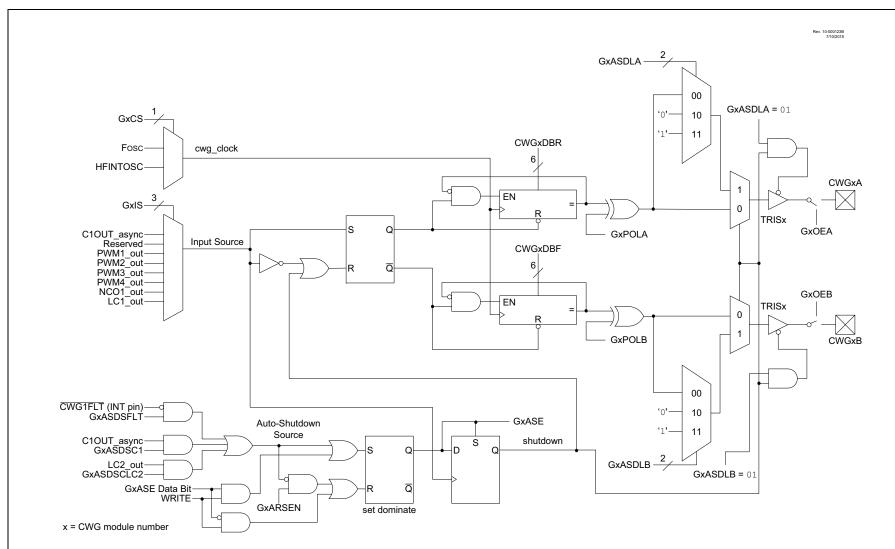
### 24.4.1 OUTPUT ENABLES

Each CWG output pin has individual output enable control. Output enables are selected with the GxOEA and GxOEB bits of the CWGxCON0 register. When an output enable control is cleared, the module asserts no control over the pin. When an output enable is set, the override value or active PWM waveform is applied to the pin per the port priority selection. The output pin enables are dependent on the module enable bit, GxEN. When GxEN is cleared, CWG output enables and CWG drive levels have no effect.

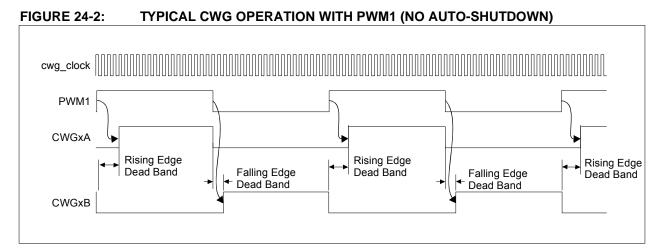
#### 24.4.2 POLARITY CONTROL

The polarity of each CWG output can be selected independently. When the output polarity bit is set, the corresponding output is active-high. Clearing the output polarity bit configures the corresponding output as active-low. However, polarity does not affect the override levels. Output polarity is selected with the GxPOLA and GxPOLB bits of the CWGxCON0 register.

#### FIGURE 24-1: SIMPLIFIED CWG BLOCK DIAGRAM



PIC12(L)F1501



### 24.5 Dead-Band Control

Dead-band control provides for non-overlapping output signals to prevent shoot-through current in power switches. The CWG contains two 6-bit dead-band counters. One dead-band counter is used for the rising edge of the input source control. The other is used for the falling edge of the input source control.

Dead band is timed by counting CWG clock periods from zero up to the value in the rising or falling deadband counter registers. See CWGxDBR and CWGxDBF registers (Register 24-4 and Register 24-5, respectively).

## 24.6 Rising Edge Dead Band

The rising edge dead-band delays the turn-on of the CWGxA output from when the CWGxB output is turned off. The rising edge dead-band time starts when the rising edge of the input source signal goes true. When this happens, the CWGxB output is immediately turned off and the rising edge dead-band delay time starts. When the rising edge dead-band delay time is reached, the CWGxA output is turned on.

The CWGxDBR register sets the duration of the deadband interval on the rising edge of the input source signal. This duration is from 0 to 64 counts of dead band.

Dead band is always counted off the edge on the input source signal. A count of 0 (zero), indicates that no dead band is present.

If the input source signal is not present for enough time for the count to be completed, no output will be seen on the respective output.

## 24.7 Falling Edge Dead Band

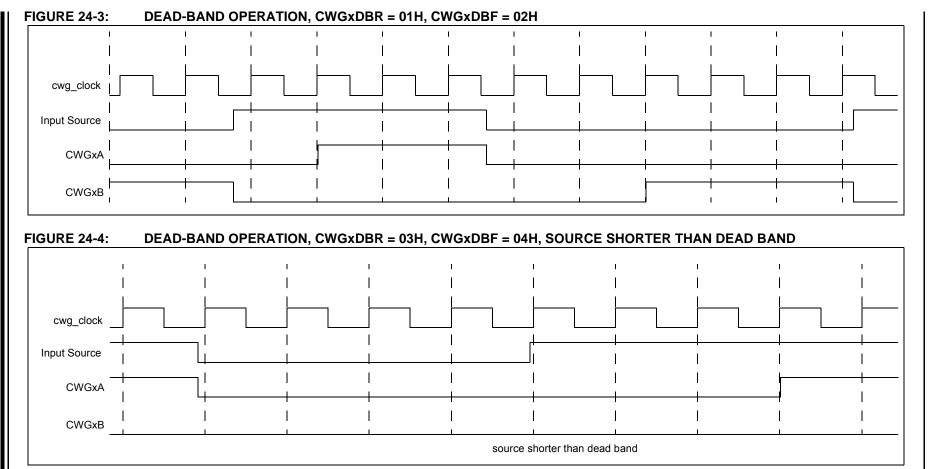
The falling edge dead band delays the turn-on of the CWGxB output from when the CWGxA output is turned off. The falling edge dead-band time starts when the falling edge of the input source goes true. When this happens, the CWGxA output is immediately turned off and the falling edge dead-band delay time starts. When the falling edge dead-band delay time is reached, the CWGxB output is turned on.

The CWGxDBF register sets the duration of the deadband interval on the falling edge of the input source signal. This duration is from 0 to 64 counts of dead band.

Dead band is always counted off the edge on the input source signal. A count of 0 (zero), indicates that no dead band is present.

If the input source signal is not present for enough time for the count to be completed, no output will be seen on the respective output.

Refer to Figure 24-3 and Figure 24-4 for examples.



### 24.8 Dead-Band Uncertainty

When the rising and falling edges of the input source triggers the dead-band counters, the input may be asynchronous. This will create some uncertainty in the dead-band time delay. The maximum uncertainty is equal to one CWG clock period. Refer to Equation 24-1 for more detail.

#### EQUATION 24-1: DEAD-BAND UNCERTAINTY

$$TDEADBAND_UNCERTAINTY = \frac{1}{Fcwg_clock}$$
  
Example:  
$$Fcwg_clock = 16 MHz$$
  
Therefore:  
$$TDEADBAND_UNCERTAINTY = \frac{1}{Fcwg_clock}$$
$$= \frac{1}{16 MHz}$$
$$= 62.5 ns$$

### 24.9 Auto-Shutdown Control

Auto-shutdown is a method to immediately override the CWG output levels with specific overrides that allow for safe shutdown of the circuit. The shutdown state can be either cleared automatically or held until cleared by software.

#### 24.9.1 SHUTDOWN

The shutdown state can be entered by either of the following two methods:

- Software generated
- External Input

#### 24.9.1.1 Software Generated Shutdown

Setting the GxASE bit of the CWGxCON2 register will force the CWG into the shutdown state.

When auto-restart is disabled, the shutdown state will persist as long as the GxASE bit is set.

When auto-restart is enabled, the GxASE bit will clear automatically and resume operation on the next rising edge event. See Figure 24-6.

#### 24.9.1.2 External Input Source

External shutdown inputs provide the fastest way to safely suspend CWG operation in the event of a Fault condition. When any of the selected shutdown inputs goes active, the CWG outputs will immediately go to the selected override levels without software delay. Any combination of two input sources can be selected to cause a shutdown condition. The sources are:

- Comparator C1 C1OUT_async
- CLC2 LC2_out
- CWG1FLT

Shutdown inputs are selected in the CWGxCON2 register. (Register 24-3).

Note: Shutdown inputs are level sensitive, not edge sensitive. The shutdown state cannot be cleared, except by disabling auto-shutdown, as long as the shutdown input level persists.

### 24.10 Operation During Sleep

The CWG module operates independently from the system clock and will continue to run during Sleep, provided that the clock and input sources selected remain active.

The HFINTOSC remains active during Sleep, provided that the CWG module is enabled, the input source is active, and the HFINTOSC is selected as the clock source, regardless of the system clock source selected.

In other words, if the HFINTOSC is simultaneously selected as the system clock and the CWG clock source, when the CWG is enabled and the input source is active, the CPU will go idle during Sleep, but the CWG will continue to operate and the HFINTOSC will remain active.

This will have a direct effect on the Sleep mode current.

## 24.11 Configuring the CWG

The following steps illustrate how to properly configure the CWG to ensure a synchronous start:

- 1. Ensure that the TRIS control bits corresponding to CWGxA and CWGxB are set so that both are configured as inputs.
- 2. Clear the GxEN bit, if not already cleared.
- 3. Set desired dead-band times with the CWGxDBR and CWGxDBF registers.
- 4. Setup the following controls in CWGxCON2 auto-shutdown register:
  - · Select desired shutdown source.
  - Select both output overrides to the desired levels (this is necessary even if not using auto-shutdown because start-up will be from a shutdown state).
  - Set the GxASE bit and clear the GxARSEN bit.
- 5. Select the desired input source using the CWGxCON1 register.
- 6. Configure the following controls in CWGxCON0 register:
  - · Select desired clock source.
  - Select the desired output polarities.
  - Set the output enables for the outputs to be used.
- 7. Set the GxEN bit.
- Clear TRIS control bits corresponding to CWGxA and CWGxB to be used to configure those pins as outputs.
- If auto-restart is to be used, set the GxARSEN bit and the GxASE bit will be cleared automatically. Otherwise, clear the GxASE bit to start the CWG.

#### 24.11.1 PIN OVERRIDE LEVELS

The levels driven to the output pins, while the shutdown input is true, are controlled by the GxASDLA and GxASDLB bits of the CWGxCON1 register (Register 24-3). GxASDLA controls the CWG1A override level and GxASDLB controls the CWG1B override level. The control bit logic level corresponds to the output logic drive level while in the shutdown state. The polarity control does not apply to the override level.

#### 24.11.2 AUTO-SHUTDOWN RESTART

After an auto-shutdown event has occurred, there are two ways to have resume operation:

- Software controlled
- Auto-restart

The restart method is selected with the GxARSEN bit of the CWGxCON2 register. Waveforms of software controlled and automatic restarts are shown in Figure 24-5 and Figure 24-6.

#### 24.11.2.1 Software Controlled Restart

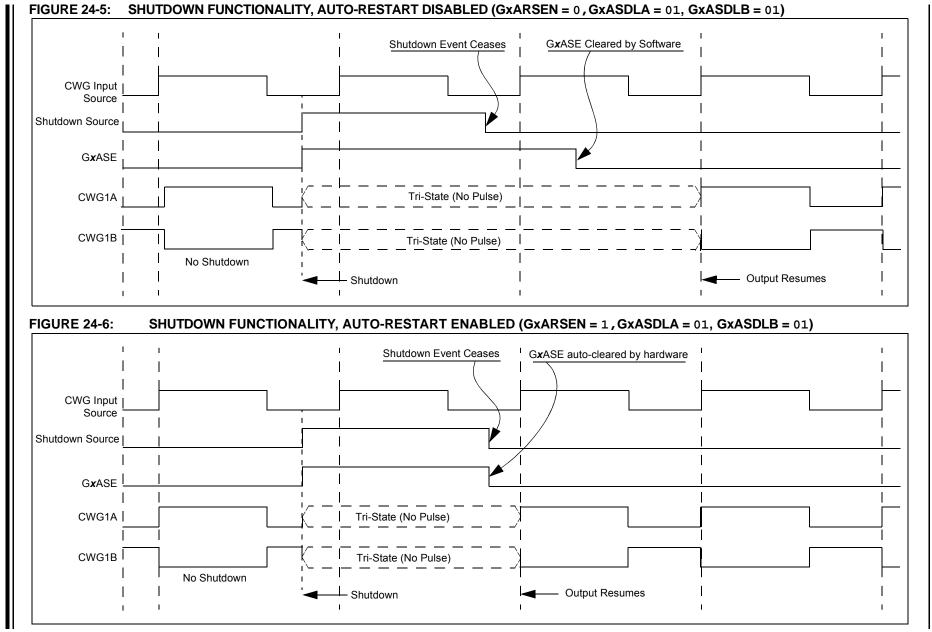
When the GxARSEN bit of the CWGxCON2 register is cleared, the CWG must be restarted after an auto-shut-down event by software.

Clearing the shutdown state requires all selected shutdown inputs to be low, otherwise the GxASE bit will remain set. The overrides will remain in effect until the first rising edge event after the GxASE bit is cleared. The CWG will then resume operation.

#### 24.11.2.2 Auto-Restart

When the GxARSEN bit of the CWGxCON2 register is set, the CWG will restart from the auto-shutdown state automatically.

The GxASE bit will clear automatically when all shutdown sources go low. The overrides will remain in effect until the first rising edge event after the GxASE bit is cleared. The CWG will then resume operation.



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Status

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## 24.12 Register Definitions: CWG Control

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	R/W-0/0
GxEN	GxOEB	GxOEA	GxPOLB	GxPOLA		_	GxCS0
bit 7		•	•				bit 0
Legend:							
R = Readable	bit	W = Writable bit		U = Unimpler	mented bit, read	as '0'	
u = Bit is unch	nanged	x = Bit is unki	nown	-n/n = Value a	at POR and BOF	R/Value at all o	other Resets
'1' = Bit is set		'0' = Bit is cle	ared	q = Value dep	pends on conditi	on	
bit 7	GxEN: CWG	x Enable bit					
	1 = Module is 0 = Module is						
bit 6	1 = CWGxB	GxB Output Er is available on is not available	appropriate I/				
bit 5	1 = CWGxA	GxA Output Er is available on is not available	appropriate I/				
bit 4	1 = Output is	VGxB Output F inverted polar normal polarit	ity				
bit 3	1 = Output is	VGxA Output F inverted polar normal polarit	ity				
bit 2-1	Unimplemen	ted: Read as '	0'				
bit 0	<b>GxCS0:</b> CWC 1 = HFINTOS 0 = Fosc	Gx Clock Sourc SC	e Select bit				

## REGISTER 24-1: CWGxCON0: CWG CONTROL REGISTER 0

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	U-0	R/W-0/0	R/W-0/0	R/W-0/0			
GxAS	DLB<1:0>	GxASD	LA<1:0>	_		GxIS<2:0>				
bit 7		•			•		bit C			
Legend:										
R = Readabl	e bit	W = Writable	bit	U = Unimpler	mented bit, rea	d as '0'				
u = Bit is unchanged		x = Bit is unk	nown	-n/n = Value a	at POR and BC	R/Value at all c	ther Resets			
'1' = Bit is set		'0' = Bit is cle	ared	q = Value de	pends on condi	ition				
bit 7-6	GxASDLB<	1:0>: CWGx Sh	utdown State	for CWGxB						
	When an auto shutdown event is present (GxASE = 1):									
	11 = CWGxB pin is driven to '1', regardless of the setting of the GxPOLB bit.									
	10 = CWGxB pin is driven to '0', regardless of the setting of the GxPOLB bit.									
	01 = CWGxB pin is tri-stated									
		00 = CWGxB pin is driven to its inactive state after the selected dead-band interval. GxPOLB still will control the polarity of the output.								
			-							
bit 5-4		1:0>: CWGx Sh								
	When an auto shutdown event is present (GxASE = 1):									
	11 = CWGxA pin is driven to '1', regardless of the setting of the GxPOLA bit.									
	10 = CWGxA pin is driven to '0', regardless of the setting of the GxPOLA bit. 0.1 = CWGxA pin is tri stated									
	<ul> <li>01 = CWGxA pin is tri-stated</li> <li>00 = CWGxA pin is driven to its inactive state after the selected dead-band interval. GxPOLA still will</li> </ul>									
		the polarity of t								
bit 3	Unimpleme	nted: Read as '	0'							
bit 2-0	GxIS<2:0>: CWGx Input Source Select bits									
	111 = CLC1	I – LC1_out								
	$110 = NCO1 - NCO1_out$									
		l4 – PWM4_out								
		I3 – PWM3_out								
		2 – PWM2_out								
		1 – PWM1_out								
	001 = Rese									

#### REGISTER 24-2: CWGxCON1: CWG CONTROL REGISTER 1

000 = Comparator C1 – C1OUT_async

R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
GxASE	GxARSEN	_	—	_	GxASDSC1	GxASDSFLT	GxASDSCLC2
bit 7					•		bit 0
<u> </u>							
Legend:							
R = Readabl		W = Writable			mented bit, read		
u = Bit is unchanged		x = Bit is unk	is unknown -n/n = Value at POR and BOR/Va				other Resets
'1' = Bit is se	t	'0' = Bit is cle	eared	q = Value dep	pends on condit	ion	
bit 7 bit 6	1 = An auto- 0 = No auto- <b>GxARSEN:</b> A 1 = Auto-rest	GxASE: Auto-Shutdown Event Status bit 1 = An auto-shutdown event has occurred 0 = No auto-shutdown event has occurred GxARSEN: Auto-Restart Enable bit 1 = Auto-restart is enabled 0 = Auto-restart is disabled					
bit 5-3	Unimplemen	ted: Read as	'0'				
bit 2	1 = Shutdow		arator C1 out	omparator C1 I put (C1OUT_a on shutdown			
bit 1	1 = Shutdow	: CWG Auto-s n when CWG ⁻ T input has no	1FLT input is I	ow			
bit 0	1 = Shutdow	<ul> <li>= CWG1FLT input has no effect on shutdown</li> <li>GxASDSCLC2: CWG Auto-shutdown on CLC2 Enable bit</li> <li>= Shutdown when CLC2 output (LC2_out) is high</li> <li>= CLC2 output has no effect on shutdown</li> </ul>					

#### REGISTER 24-3: CWGxCON2: CWG CONTROL REGISTER 2

## REGISTER 24-4: CWGxDBR: COMPLEMENTARY WAVEFORM GENERATOR (CWGx) RISING DEAD-BAND COUNT REGISTER

	DEA	AD-BAND COUL	NI REGISTI	ER					
U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u		
_	_	CWGxDBR<5:0>							
bit 7							bit 0		
Legend:									
R = Readal	ble bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'			
u = Bit is ur	nchanged	x = Bit is unkr	nown	-n/n = Value at POR and BOR/Value at all other Resets					
'1' = Bit is s	set	'0' = Bit is cle	ared	q = Value dep	ends on condit	ion			
hit 7 C	Unimalam	ented. Dood oo '	0'						
bit 7-6	-	ented: Read as '							
bit 5-0		<b>R&lt;5:0&gt;:</b> Complerr = 63-64 counts of		form Generator	(CWGx) Rising	Counts			
		= 62-63 counts of							
	•								
	•								
	•								
	00 0010	= $2-3$ counts of de	ad band						

00 0010 = 2-3 counts of dead band

00 0001 = 1-2 counts of dead band

00 0000 = 0 counts of dead band

## REGISTER 24-5: CWGxDBF: COMPLEMENTARY WAVEFORM GENERATOR (CWGx) FALLING DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
_	_			CWGxD	BF<5:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7-6	Unimplemented: Read as '0'
bit 5-0	CWGxDBF<5:0>: Complementary Waveform Generator (CWGx) Falling Counts
	11 1111 = 63-64 counts of dead band
	11 1110 = 62-63 counts of dead band

- •
- •
- 00 0010 = 2-3 counts of dead band
- 00 0001 = 1-2 counts of dead band
- 00 0000 = 0 counts of dead band. Dead-band generation is bypassed.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	_	—	-	ANSA4	_	ANSA2	ANSA1	ANSA0	99
CWG1CON0	G1EN	G10EB	G10EA	G1POLB	G1POLA	_	—	G1CS0	187
CWG1CON1	G1ASD	LB<1:0>	G1ASD	LA<1:0>	_	_	G1IS	<1:0>	188
CWG1CON2	G1ASE	G1ARSEN	_	_	_	G1ASDSC1	G1ASDSFLT	G1ASDSCLC2	189
CWG1DBF	_	_			CV	VG1DBF<5:0>			190
CWG1DBR	_	_			CV	VG1DBR<5:0>			190
TRISA		—	TRISA5	TRISA4	_(1)	TRISA2	TRISA1	TRISA0	98

 Legend:
 x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by CWG.

 Note
 1:
 Unimplemented, read as '1'.

## 25.0 IN-CIRCUIT SERIAL PROGRAMMING[™] (ICSP[™])

ICSP[™] programming allows customers to manufacture circuit boards with unprogrammed devices. Programming can be done after the assembly process allowing the device to be programmed with the most recent firmware or a custom firmware. Five pins are needed for ICSP[™] programming:

- ICSPCLK
- ICSPDAT
- MCLR/VPP
- VDD
- Vss

In Program/Verify mode the program memory, user IDs and the Configuration Words are programmed through serial communications. The ICSPDAT pin is a bidirectional I/O used for transferring the serial data and the ICSPCLK pin is the clock input. For more information on ICSPTM refer to the "*PIC12(L)F1501/PIC16(L)F150X Memory Programming Specification*" (DS41573).

#### 25.1 High-Voltage Programming Entry Mode

The device is placed into High-Voltage Programming Entry mode by holding the ICSPCLK and ICSPDAT pins low then raising the voltage on MCLR/VPP to VIHH.

### 25.2 Low-Voltage Programming Entry Mode

The Low-Voltage Programming Entry mode allows the PIC[®] Flash MCUs to be programmed using VDD only, without high voltage. When the LVP bit of Configuration Words is set to '1', the ICSP Low-Voltage Programming Entry mode is enabled. To disable the Low-Voltage ICSP mode, the LVP bit must be programmed to '0'.

Entry into the Low-Voltage Programming Entry mode requires the following steps:

- 1. MCLR is brought to VIL.
- 2. A 32-bit key sequence is presented on ICSPDAT, while clocking ICSPCLK.

Once the key sequence is complete,  $\overline{\text{MCLR}}$  must be held at VIL for as long as Program/Verify mode is to be maintained.

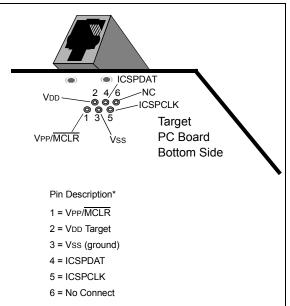
If low-voltage programming is enabled (LVP = 1), the  $\overline{\text{MCLR}}$  Reset function is automatically enabled and cannot be disabled. See **Section 6.5** "MCLR" for more information.

The LVP bit can only be reprogrammed to '0' by using the High-Voltage Programming mode.

### 25.3 Common Programming Interfaces

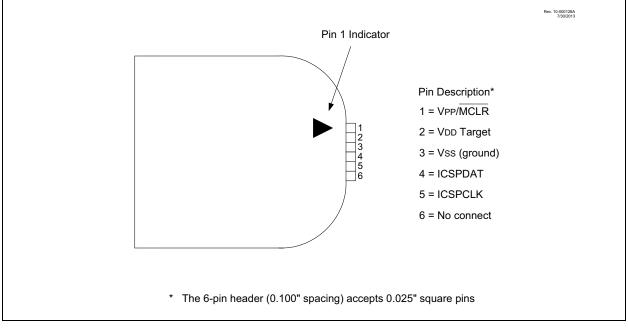
Connection to a target device is typically done through an ICSP[™] header. A commonly found connector on development tools is the RJ-11 in the 6P6C (6-pin, 6-connector) configuration. See Figure 25-1.





Another connector often found in use with the PICkit[™] programmers is a standard 6-pin header with 0.1 inch spacing. Refer to Figure 25-2.

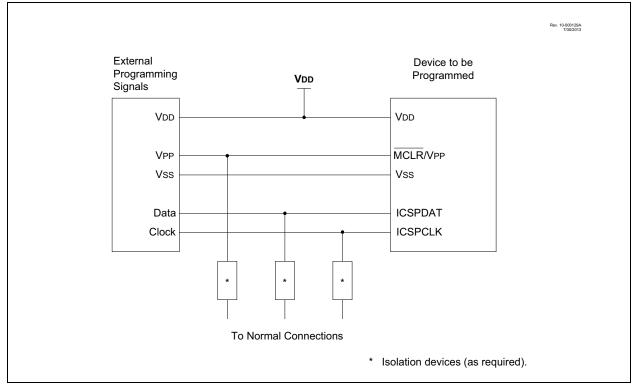
FIGURE 25-2: PICkit[™] PROGRAMMER STYLE CONNECTOR INTERFACE



For additional interface recommendations, refer to your specific device programmer manual prior to PCB design.

It is recommended that isolation devices be used to separate the programming pins from other circuitry. The type of isolation is highly dependent on the specific application and may include devices such as resistors, diodes, or even jumpers. See Figure 25-3 for more information.

#### FIGURE 25-3: TYPICAL CONNECTION FOR ICSP™ PROGRAMMING



## 26.0 INSTRUCTION SET SUMMARY

Each instruction is a 14-bit word containing the operation code (opcode) and all required operands. The opcodes are broken into three broad categories.

- · Byte Oriented
- · Bit Oriented
- · Literal and Control

The literal and control category contains the most varied instruction word format.

Table 26-3 lists the instructions recognized by the MPASMTM assembler.

All instructions are executed within a single instruction cycle, with the following exceptions, which may take two or three cycles:

- Subroutine takes two cycles (CALL, CALLW)
- Returns from interrupts or subroutines take two cycles (RETURN, RETLW, RETFIE)
- Program branching takes two cycles (GOTO, BRA, BRW, BTFSS, BTFSC, DECFSZ, INCSFZ)
- One additional instruction cycle will be used when any instruction references an indirect file register and the file select register is pointing to program memory.

One instruction cycle consists of 4 oscillator cycles; for an oscillator frequency of 4 MHz, this gives a nominal instruction execution rate of 1 MHz.

All instruction examples use the format '0xhh' to represent a hexadecimal number, where 'h' signifies a hexadecimal digit.

### 26.1 Read-Modify-Write Operations

Any instruction that specifies a file register as part of the instruction performs a Read-Modify-Write (R-M-W) operation. The register is read, the data is modified, and the result is stored according to either the instruction, or the destination designator 'd'. A read operation is performed on a register even if the instruction writes to that register.

#### TABLE 26-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= $0$ or $1$ ). The assembler will generate code with x = $0$ . It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1.
n	FSR or INDF number. (0-1)
mm	Pre-post increment-decrement mode selection

## TABLE 26-2: ABBREVIATION DESCRIPTIONS

Field	Description
PC	Program Counter
TO	Time-Out bit
С	Carry bit
DC	Digit Carry bit
Z	Zero bit
PD	Power-Down bit

## FIGURE 26-1: GENERAL FORMAT FOR INSTRUCTIONS

13	3         8         7         6         0           OPCODE         d         f (FILE #)         1
	d = 0 for destination W
	d = 1 for destination f f = 7-bit file register address
<b>Bit-</b> 0	oriented file register operations 3 10 9 7 6 0
Γ	OPCODE b (BIT #) f (FILE #)
	b = 3-bit bit address f = 7-bit file register address
Lite	ral and control operations
	leral
13	
	OPCODE k (literal)
	k = 8-bit immediate value
CAL	L and GOTO instructions only
13	
	OPCODE k (literal)
	k = 11-bit immediate value
MOV	LP instruction only
13	
	OPCODE k (literal)
	k = 7-bit immediate value
MOV	LB instruction only
13	3 5 4 0
	OPCODE k (literal)
	k = 5-bit immediate value
BRA	instruction only
1:	<u>3 98</u> 0
	OPCODE k (literal)
	k = 9-bit immediate value
FSR	Offset instructions
13	3 7 6 5 0
	OPCODE n k (literal)
	n = appropriate FSR k = 6-bit immediate value
FSR 13	Increment instructions 3 3 2 1 0
	OPCODE n m (mode
	n = appropriate FSR m = 2-bit mode value
OP( 13	CODE only 3 0

TABLE 2	0-3.	ENHANCED MID-RANGE INSTRU						1	
Mnemonic,		Description	Cycles	14-Bit Opcode				Status	Notes
Oper	ands	Description	Cycles	MSb			LSb	Affected	Notes
		BYTE-ORIENTED FILE	REGISTER OPE	RATIC	NS				
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C, DC, Z	2
ADDWFC	f, d	Add with Carry W and f	1	11	1101	dfff	ffff	C, DC, Z	2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	2
ASRF	f, d	Arithmetic Right Shift	1	11	0111	dfff	ffff	C, Z	2
LSLF	f, d	Logical Left Shift	1	11	0101	dfff	ffff	C, Z	2
LSRF	f, d	Logical Right Shift	1	11	0110	dfff	ffff	C, Z	2
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2
CLRW	_	Clear W	1	00	0001	0000	00xx	z	
COMF	f. d	Complement f	1	00	1001	dfff	ffff	z	2
DECF	f. d	Decrement f	1	00		dfff		z	2
INCF	f. d	Increment f	1	00	1010	dfff		z	2
IORWF	f, d	Inclusive OR W with f	1	00	0100			z	2
MOVF	f, d	Move f	1	00	1000		ffff	Z	2
MOVWF	f, C	Move W to f	1	00	0000		ffff	-	2
RLF	f, d	Rotate Left f through Carry	1	00		dfff		С	2
RRF	f, d	Rotate Right f through Carry	1	00		dfff		C	2
SUBWF	f, d	Subtract W from f	1	00		dfff		-	2
SUBWFB	f, d	Subtract with Borrow W from f	1	11		dfff		C, DC, Z	2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff		0, 00, 2	2
XORWF	f. d	Exclusive OR W with f	1	00	0110		ffff	z	2
XOIWI	1, U	BYTE ORIENTED			0110	uIII	LLLL	2	2
	f, d	Decrement f, Skip if 0		00	1011	2555	<i></i>		1 2
DECFSZ			1(2)		1011	dfff	ffff		1, 2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1, 2
		BIT-ORIENTED FILE R	REGISTER OPER	ATION	NS				
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		2
		BIT-ORIENTED S	SKIP OPERATIO	NS					
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		1, 2
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		1, 2
			OPERATIONS						
ADDLW	k	Add literal and W	1	11	1110	kkkk	kkkk	C, DC, Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLB	k	Move literal to BSR	1	00	0000	001k	kkkk		
MOVLP	k	Move literal to PCLATH	1	11	0001	1kkk	kkkk		
	k	Move literal to W	1	11	0000	kkkk	kkkk		
MOVLW	N								
MOVLW SUBLW	k	Subtract W from literal	1	11	1100	kkkk		C, DC, Z	

## TABLE 26-3: ENHANCED MID-RANGE INSTRUCTION SET

Note 1: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

2: If this instruction addresses an INDF register and the MSb of the corresponding FSR is set, this instruction will require one additional instruction cycle.

Mnemonic, Operands		Description	Cycles	14-Bit Opcode			Status	Netes	
		Description	Cycles	MSb			LSb	Affected	Notes
		CONTROL OPER	TIONS						
BRA	k	Relative Branch	2	11	001k	kkkk	kkkk		
BRW	-	Relative Branch with W	2	00	0000	0000	1011		
CALL	k	Call Subroutine	2	10	0kkk	kkkk	kkkk		
CALLW	-	Call Subroutine with W	2	00	0000	0000	1010		
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
RETFIE	k	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	0100	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	00	0000	0000	1000		
			TIONS						
CLRWDT	_	Clear Watchdog Timer	1	00	0000	0110	0100	TO, PD	
NOP	_	No Operation	1	00	0000	0000	0000		
OPTION	_	Load OPTION_REG register with W	1	00	0000	0110	0010		
RESET	-	Software device Reset	1	00	0000	0000	0001		
SLEEP	_	Go into Standby mode	1	00	0000	0110	0011	TO, PD	
TRIS	f	Load TRIS register with W	1	00	0000	0110	Offf		
		C-COMPILER OPT	IMIZED						
ADDFSR	n, k	Add Literal k to FSRn	1	11	0001	0nkk	kkkk		
MOVIW	n mm	Move Indirect FSRn to W with pre/post inc/dec	1	00	0000	0001	0nmm	Z	2, 3
		modifier, mm					kkkk		
	k[n]	Move INDFn to W, Indexed Indirect.	1	11	1111	0nkk	1nmm	Z	2
MOVWI	n mm	Move W to Indirect FSRn with pre/post inc/dec	1	00	0000	0001	kkkk		2, 3
		modifier, mm							
	k[n]	Move W to INDFn, Indexed Indirect.	1	11	1111	1nkk			2

#### TABLE 26-3: ENHANCED MID-RANGE INSTRUCTION SET (CONTINUED)

Note 1: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

2: If this instruction addresses an INDF register and the MSb of the corresponding FSR is set, this instruction will require one additional instruction cycle.

**3:** See Table in the MOVIW and MOVWI instruction descriptions.

## 26.2 Instruction Descriptions

ADDFSR	Add Literal to FSRn
Syntax:	[ label ] ADDFSR FSRn, k
Operands:	-32 ≤ k ≤ 31 n ∈ [ 0, 1]
Operation:	$FSR(n) + k \rightarrow FSR(n)$
Status Affected:	None
Description:	The signed 6-bit literal 'k' is added to the contents of the FSRnH:FSRnL register pair.
	ESRn is limited to the range 0000h -

FSRn is limited to the range 0000h -FFFFh. Moving beyond these bounds will cause the FSR to wrap-around.

ADDLW	Add literal and W
Syntax:	[ label ] ADDLW k
Operands:	$0 \leq k \leq 255$
Operation:	$(W) + k \to (W)$
Status Affected:	C, DC, Z
Description:	The contents of the W register are added to the 8-bit literal 'k' and the result is placed in the W register.

ANDLW	AND literal with W
Syntax:	[ <i>label</i> ] ANDLW k
Operands:	$0 \leq k \leq 255$
Operation:	(W) .AND. (k) $\rightarrow$ (W)
Status Affected:	Z
Description:	The contents of W register are AND'ed with the 8-bit literal 'k'. The result is placed in the W register.

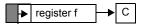
ANDWF	AND W with f
Syntax:	[label] ANDWF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(W) .AND. (f) $\rightarrow$ (destination)
Status Affected:	Z
Description:	AND the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

ADDWF	Add W and f		
Syntax:	[label] ADDWF f,d		
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$		
Operation:	(W) + (f) $\rightarrow$ (destination)		
Status Affected:	C, DC, Z		
Description:	Add the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.		

### ADDWFC ADD W and CARRY bit to f

Syntax:	[ <i>label</i> ] ADDWFC f {,d}
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$
Operation:	$(W) + (f) + (C) \rightarrow dest$
Status Affected:	C, DC, Z
Description:	Add W, the Carry flag and data mem- ory location 'f'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed in data memory location 'f'.

ASRF	Arithmetic Right Shift
Syntax:	[ <i>label</i> ]ASRF f{,d}
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$
Operation:	$(f<7>) \rightarrow dest<7>$ $(f<7:1>) \rightarrow dest<6:0>,$ $(f<0>) \rightarrow C,$
Status Affected:	C, Z
Description:	The contents of register 'f' are shifted one bit to the right through the Carry flag. The MSb remains unchanged. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



BCF	Bit Clear f
Syntax:	[label]BCF f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	$0 \rightarrow (f \le b >)$
Status Affected:	None
Description:	Bit 'b' in register 'f' is cleared.

BTFSC	Bit Test f, Skip if Clear
Syntax:	[ label ] BTFSC f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	skip if (f <b>) = 0</b>
Status Affected:	None
Description:	If bit 'b' in register 'f' is '1', the next instruction is executed. If bit 'b', in register 'f', is '0', the next instruction is discarded, and a NOP is executed instead, making this a 2-cycle instruction.

BRA	Relative Branch
Syntax:	[ <i>label</i> ]BRA label [ <i>label</i> ]BRA \$+k
Operands:	-256 $\leq$ label - PC + 1 $\leq$ 255 -256 $\leq$ k $\leq$ 255
Operation:	$(PC) + 1 + k \rightarrow PC$
Status Affected:	None
Description:	Add the signed 9-bit literal 'k' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 1 + k. This instruction is a 2-cycle instruction. This branch has a limited range.

BRW	Relative Branch with W
Syntax:	[ label ] BRW
Operands:	None
Operation:	$(PC) + (W) \to PC$
Status Affected:	None
Description:	Add the contents of W (unsigned) to the PC. Since the PC will have incre- mented to fetch the next instruction, the new address will be PC + $1 + (W)$ . This instruction is a 2-cycle instruc- tion.

BSF	Bit Set f
Syntax:	[label]BSF f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	1 → (f <b>)</b>
Status Affected:	None
Description:	Bit 'b' in register 'f' is set.

BTFSS	Bit Test f, Skip if Set
Syntax:	[ label ] BTFSS f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b < 7 \end{array}$
Operation:	skip if (f <b>) = 1</b>
Status Affected:	None
Description:	If bit 'b' in register 'f' is '0', the next instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2-cycle instruction.

CALL	Call Subroutine
Syntax:	[ <i>label</i> ] CALL k
Operands:	$0 \leq k \leq 2047$
Operation:	(PC)+ 1→ TOS, k → PC<10:0>, (PCLATH<6:3>) → PC<14:11>
Status Affected:	None
Description:	Call Subroutine. First, return address (PC + 1) is pushed onto the stack. The 11-bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a 2-cycle instruc- tion.

CLRWDT	Clear Watchdog Timer
Syntax:	[label] CLRWDT
Operands:	None
Operation:	$00h \rightarrow WDT$ $0 \rightarrow WDT \text{ prescaler,}$ $1 \rightarrow \overline{TO}$ $1 \rightarrow PD$ $\overline{TO, PD}$
Description:	CLRWDT instruction resets the Watch- dog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are set.

CALLW	Subroutine Call With W
Syntax:	[ label ] CALLW
Operands:	None
Operation:	$\begin{array}{l} (\text{PC}) +1 \rightarrow \text{TOS}, \\ (\text{W}) \rightarrow \text{PC} < 7:0 >, \\ (\text{PCLATH} < 6:0 >) \rightarrow \text{PC} < 14:8 > \end{array}$
Status Affected:	None
Description:	Subroutine call with W. First, the return address (PC + 1) is pushed onto the return stack. Then, the contents of W is loaded into PC<7:0>, and the contents of PCLATH into PC<14:8>. CALLW is a 2-cycle instruction.

COMF	Complement f
Syntax:	[label] COMF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$
Operation:	$(\overline{f}) \rightarrow (destination)$
Status Affected:	Z
Description:	The contents of register 'f' are com- plemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

CLRF	Clear f
Syntax:	[ <i>label</i> ] CLRF f
Operands:	$0 \leq f \leq 127$
Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Description:	The contents of register 'f' are cleared and the Z bit is set.

CLRW	Clear W
Syntax:	[label] CLRW
Operands:	None
Operation:	$\begin{array}{l} \text{00h} \rightarrow (\text{W}) \\ 1 \rightarrow \text{Z} \end{array}$
Status Affected:	Z
Description:	W register is cleared. Zero bit (Z) is set.

DECF	Decrement f
Syntax:	[label] DECF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$
Operation:	(f) - 1 $\rightarrow$ (destination)
Status Affected:	Z
Description:	Decrement register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

DECFSZ	Decrement f, Skip if 0
Syntax:	[label] DECFSZ f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$
Operation:	(f) - 1 $\rightarrow$ (destination); skip if result = 0
Status Affected:	None
Description:	The contents of register 'f' are decre- mented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'. If the result is '1', the next instruction is executed. If the result is '0', then a NOP is executed instead, making it a 2-cycle instruction.

GOTO	Unconditional Branch
Syntax:	[ <i>label</i> ] GOTO k
Operands:	$0 \leq k \leq 2047$
Operation:	$k \rightarrow PC<10:0>$ PCLATH<6:3> $\rightarrow$ PC<14:11>
Status Affected:	None
Description:	GOTO is an unconditional branch. The 11-bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a 2-cycle instruction.

INCFSZ	Increment f, Skip if 0	
Syntax:	[label] INCFSZ f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$	
Operation:	(f) + 1 $\rightarrow$ (destination), skip if result = 0	
Status Affected:	None	
Description:	None The contents of register 'f' are incre- mented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'. If the result is '1', the next instruction is executed. If the result is '0', a NOP is executed instead, making it a 2-cycle instruction.	

IORLW	Inclusive OR literal with W	
Syntax:	[ <i>label</i> ] IORLW k	
Operands:	$0 \leq k \leq 255$	
Operation:	(W) .OR. $k \rightarrow$ (W)	
Status Affected:	Z	
Description:	The contents of the W register are OR'ed with the 8-bit literal 'k'. The result is placed in the W register.	

INCF	Increment f	
Syntax:	[ <i>label</i> ] INCF f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$	
Operation:	(f) + 1 $\rightarrow$ (destination)	
Status Affected:	Z	
Description:	The contents of register 'f' are incre- mented. If 'd' is '0', the result is placed in the W register. If 'd' is ' $1$ ', the result is placed back in register 'f'.	

IORWF	Inclusive OR W with f		
Syntax:	[ <i>label</i> ] IORWF f,d		
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$		
Operation:	(W) .OR. (f) $\rightarrow$ (destination)		
Status Affected:	Z		
Description:	Inclusive OR the W register with regis- ter 'f'. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.		

LSLF	Logical Left Shift	MOVF	Move f
Syntax:	[ <i>label</i> ]LSLF f{,d}	Syntax:	[ <i>label</i> ] MOVF f,d
Operands:	$0 \le f \le 127$ d $\in$ [0,1]	Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	$(f < 7 >) \rightarrow C$	Operation:	$(f) \rightarrow (dest)$
	$(f<6:0>) \rightarrow dest<7:1>$ 0 $\rightarrow dest<0>$	Status Affected:	Z
Status Affected:	C, Z	Description:	The contents of register f is moved to a destination dependent upon the
Description:	The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.		status of d. If $d = 0$ , destination is W register. If $d = 1$ , the destination is file register f itself. $d = 1$ is useful to test a file register since status flag Z is affected.
	C register f -0	Words:	1
		Cycles:	1
		Example:	MOVF FSR, 0
LSRF	Logical Right Shift		After Instruction W = value in FSR register
Syntax:	[ <i>label</i> ]LSRF f{,d}		Z = 1

Syntax:	[ <i>label</i> ]LSRF f{,d}	
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$	
Operation:	$\begin{array}{l} 0 \rightarrow dest < 7 > \\ (f < 7:1 >) \rightarrow dest < 6:0 >, \\ (f < 0 >) \rightarrow C, \end{array}$	
Status Affected:	C, Z	
Description:	The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.	
	$0 \longrightarrow \text{register f} C$	

MOVIW	Move INDFn to W
Syntax:	[ <i>label</i> ] MOVIW ++FSRn [ <i>label</i> ] MOVIWFSRn [ <i>label</i> ] MOVIW FSRn++ [ <i>label</i> ] MOVIW FSRn [ <i>label</i> ] MOVIW k[FSRn]
Operands:	n ∈ [0,1] mm ∈ [00,01,10,11] -32 ≤ k ≤ 31
Operation:	$\begin{split} &\text{INDFn} \rightarrow W \\ &\text{Effective address is determined by} \\ &\text{•}  FSR + 1 (preincrement) \\ &\text{•}  FSR + 1 (predecrement) \\ &\text{•}  FSR + k (relative offset) \\ &\text{After the Move, the FSR value will be either:} \\ &\text{•}  FSR + 1 (all increments) \\ &\text{•}  FSR + 1 (all decrements) \\ &\text{•}  Unchanged \end{split}$
Status Affected:	Z

Mode	Syntax	mm
Preincrement	++FSRn	00
Predecrement	FSRn	01
Postincrement	FSRn++	10
Postdecrement	FSRn	11

This instruction is used to move data between W and one of the indirect registers (INDFn). Before/after this move, the pointer (FSRn) is updated by pre/post incrementing/decrementing it.

> **Note:** The INDFn registers are not physical registers. Any instruction that accesses an INDFn register actually accesses the register at the address specified by the FSRn.

FSRn is limited to the range 0000h -FFFFh. Incrementing/decrementing it beyond these bounds will cause it to wrap-around.

#### MOVLB Move literal to BSR

Description:

Syntax:	[ <i>label</i> ]MOVLB k
Operands:	$0 \leq k \leq 31$
Operation:	$k \rightarrow BSR$
Status Affected:	None
Description:	The 5-bit literal 'k' is loaded into the Bank Select Register (BSR).

MOVLP	Move literal to PCLATH		
Syntax:	[ label ] MOVLP k		
Operands:	$0 \le k \le 127$		
Operation:	$k \rightarrow PCLATH$		
Status Affected:	None		
Description:	The 7-bit literal 'k' is loaded into the PCLATH register.		
MOVLW	Move literal to W		
Syntax:	[ <i>label</i> ] MOVLW k		
Operands:	$0 \leq k \leq 255$		
Operation:	$k \rightarrow (W)$		
Status Affected:	None		
Description:	The 8-bit literal 'k' is loaded into W reg- ister. The "don't cares" will assemble as '0's.		
Words:	1		
Cycles:	1		
Example:	MOVLW 0x5A		
	After Instruction		
	W = 0x5A		
MOVWF	Move W to f		
Syntax:	[ <i>label</i> ] MOVWF f		
Operands:	$0 \leq f \leq 127$		
Operation:	$(W) \to (f)$		
Status Affected:	None		
Description:	Move data from W register to register 'f'.		
Words:	1		
Cycles:	1		
Example:	MOVWF OPTION_REG		
	Before Instruction OPTION_REG = 0xFF W = 0x4F After Instruction OPTION_REG = 0x4F W = 0x4F		

ΜΟΥΨΙ	Move W to INDFn
Syntax:	[ <i>label</i> ] MOVWI ++FSRn [ <i>label</i> ] MOVWIFSRn [ <i>label</i> ] MOVWI FSRn++ [ <i>label</i> ] MOVWI FSRn [ <i>label</i> ] MOVWI k[FSRn]
Operands:	$\begin{array}{l} n \in [0,1] \\ mm \in [00,01,10,11] \\ -32 \leq k \leq 31 \end{array}$
Operation:	$\label{eq:W} \begin{split} W &\to INDFn \\ \text{Effective address is determined by} \\ \bullet \ FSR + 1 \ (preincrement) \\ \bullet \ FSR + 1 \ (predecrement) \\ \bullet \ FSR + k \ (relative offset) \\ \text{After the Move, the FSR value will be} \\ \text{either:} \\ \bullet \ FSR + 1 \ (all increments) \\ \bullet \ FSR - 1 \ (all increments) \\ \text{Unchanged} \end{split}$
Status Affected:	None

Mode	Syntax	mm
Preincrement	++FSRn	00
Predecrement	FSRn	01
Postincrement	FSRn++	10
Postdecrement	FSRn	11

#### Description:

This instruction is used to move data between W and one of the indirect registers (INDFn). Before/after this move, the pointer (FSRn) is updated by pre/post incrementing/decrementing it.

**Note:** The INDFn registers are not physical registers. Any instruction that accesses an INDFn register actually accesses the register at the address specified by the FSRn.

FSRn is limited to the range 0000h -FFFFh. Incrementing/decrementing it beyond these bounds will cause it to wrap-around.

The increment/decrement operation on FSRn WILL NOT affect any Status bits.

NOP	No Operation
Syntax:	[label] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Description:	No operation.
Words:	1
Cycles:	1
Example:	NOP

OPTION	Load OPTION_REG Register with W
Syntax:	[label] OPTION
Operands:	None
Operation:	$(W) \to OPTION_REG$
Status Affected:	None
Description:	Move data from W register to OPTION_REG register.

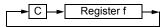
RESET	Software Reset
Syntax:	[label] RESET
Operands:	None
Operation:	Execute a device Reset. Resets the nRI flag of the PCON register.
Status Affected:	None
Description:	This instruction provides a way to execute a hardware Reset by software.

RETFIE	Return from Interrupt
Syntax:	[label] RETFIE
Operands:	None
Operation:	$\begin{array}{l} TOS \to PC, \\ 1 \to GIE \end{array}$
Status Affected:	None
Description:	Return from Interrupt. Stack is POPed and Top-of-Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a 2-cycle instruction.
Words:	1
Cycles:	2
Example:	RETFIE
	After Interrupt PC = TOS GIE = 1

RETURN	Return from Subroutine
Syntax:	[label] RETURN
Operands:	None
Operation:	$TOS\toPC$
Status Affected:	None
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a 2-cycle instruction.

RETLW	Return with literal in W	RLF	Detate Loft f through Corry
Syntax:	[ <i>label</i> ] RETLW k		Rotate Left f through Carry
Operands:	$0 \le k \le 255$	Syntax:	[ <i>label</i> ] RLF f,d
Operation:	$k \rightarrow (W);$ TOS $\rightarrow$ PC	Operands:	$0 \le f \le 127$ $d \in [0,1]$
Status Affected:	None	Operation:	See description below
Description:	The W register is loaded with the 8-bit	Status Affected:	С
Description.	literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a 2-cycle instruction.	Description:	The contents of register 'f' are rotated one bit to the left through the Carry flag. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is
Words:	1		stored back in register 'f'.
Cycles:	2		
Example:	CALL TABLE;W contains table	Words:	1
	;offset value • ;W now has table value	Cycles:	1
TABLE	•	Example:	RLF REG1,0
			Before Instruction
	ADDWF PC ;W = offset RETLW kl ;Begin table		REG1 = 1110 0110
	RETLW k2 ;		C = 0
	•		After Instruction REG1 = 1110 0110
	•		W = 1100 1100
	• RETLW kn ; End of table		C = 1
	Before Instruction W = 0x07 After Instruction W = value of k8		

RRF	Rotate Right f through Carry
Syntax:	[label] RRF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	See description below
Status Affected:	С
Description:	The contents of register 'f' are rotated one bit to the right through the Carry flag. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.



SUBLW	Subtract W from literal	
Syntax:	[ <i>label</i> ] SUBLW k	
Operands:	$0 \leq k \leq 255$	
Operation:	$k - (W) \to (W)$	
Status Affected:	C, DC, Z	
Description:	The W register is subtracted (2's com- plement method) from the 8-bit literal 'k'. The result is placed in the W regis- ter.	
	C = 0 W > k	
	$C = 1$ $W \le k$	
	DC = 0 W<3:0> > k<3:0>	

DC = 1

 $W<3:0> \le k<3:0>$ 

SLEEP	Enter Sleep mode
Syntax:	[label] SLEEP
Operands:	None
Operation:	$\begin{array}{l} \text{O0h} \rightarrow \text{WDT}, \\ 0 \rightarrow \text{WDT prescaler}, \\ 1 \rightarrow \overline{\text{TO}}, \\ 0 \rightarrow \overline{\text{PD}} \end{array}$
Status Affected:	TO, PD
Description:	The power-down Status bit, $\overline{PD}$ is cleared. Time-out Status bit, $\overline{TO}$ is set. Watchdog Timer and its pres- caler are cleared. The processor is put into Sleep mode with the oscillator stopped.

SUBWF	Subtract W	from f
Syntax:	[label] SU	IBWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$	
Operation:	(f) - (W) $\rightarrow$ (destination)	
Status Affected:	C, DC, Z	
Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f.	
	<b>C</b> = 0	W > f
	<b>C =</b> 1	$W \leq f$
	DC = 0	W<3:0> > f<3:0>
	DC = 1	$W<3:0> \le f<3:0>$

SUBWFB	Subtract W from f with Borrow
Syntax:	SUBWFB f {,d}
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	$(f) - (W) - (\overline{B}) \rightarrow dest$
Status Affected:	C, DC, Z
Description:	Subtract W and the BORROW flag (CARRY) from register 'f' (2's comple- ment method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

SWAPF	Swap Nibbles in f
Syntax:	[label] SWAPF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d  \in  [0,1] \end{array}$
Operation:	$(f<3:0>) \rightarrow (destination<7:4>),$ $(f<7:4>) \rightarrow (destination<3:0>)$
Status Affected:	None
Description:	The upper and lower nibbles of regis- ter 'f' are exchanged. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in register 'f'.

XORLW	Exclusive OR literal with W								
Syntax:	[ <i>label</i> ] XORLW k								
Operands:	$0 \leq k \leq 255$								
Operation:	(W) .XOR. $k \rightarrow (W)$								
Status Affected:	Z								
Description:	The contents of the W register are XOR'ed with the 8-bit literal 'k'. The result is placed in the W register.								

TRIS	Load TRIS Register with W
Syntax:	[label] TRIS f
Operands:	$5 \le f \le 7$
Operation:	(W) $\rightarrow$ TRIS register 'f'
Status Affected:	None
Description:	Move data from W register to TRIS register. When 'f' = 5, TRISA is loaded. When 'f' = 6, TRISB is loaded. When 'f' = 7, TRISC is loaded.

XORWF	Exclusive OR W with f								
Syntax:	[label] XORWF f,d								
Operands:	$0 \le f \le 127$ d $\in [0,1]$								
Operation:	(W) .XOR. (f) $\rightarrow$ (destination)								
Status Affected:	Z								
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.								

NOTES:

## 27.0 ELECTRICAL SPECIFICATIONS

## 27.1 Absolute Maximum Ratings^(†)

Ambient temperature under bias	-40°C to +125°C
Storage temperature	
Voltage on pins with respect to Vss	
on VDD pin	
	0.2 (to $1.6.5$ )
PIC12F1501	
PIC12LF1501	
on MCLR pin	-0.3V to +9.0V
on all other pins	0.3V to (VDD + 0.3V)
Maximum current	
on Vss pin ⁽¹⁾	
-40°C $\leq$ Ta $\leq$ +85°C	250 mA
+85°C $\leq$ TA $\leq$ +125°C	85 mA
on VDD pin ⁽¹⁾	
-40°C $\leq$ Ta $\leq$ +85°C $\ldots$	250 mA
+85°C $\leq$ TA $\leq$ +125°C	85 mA
Sunk by any standard I/O pin	50 mA
Sourced by any standard I/O pin	50 mA
Clamp current, IK (VPIN < 0 or VPIN > VDD)	±20 mA
Total power dissipation ⁽²⁾	800 mW

**Note 1:** Maximum current rating requires even load distribution across I/O pins. Maximum current rating may be limited by the device package power dissipation characterizations, see Table 27-6 to calculate device specifications.

2: Power dissipation is calculated as follows: PDIS = VDD x {IDD  $-\Sigma$  IOH} +  $\Sigma$  {(VDD - VOH) x IOH} +  $\Sigma$ (VOI x IOL).

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability.

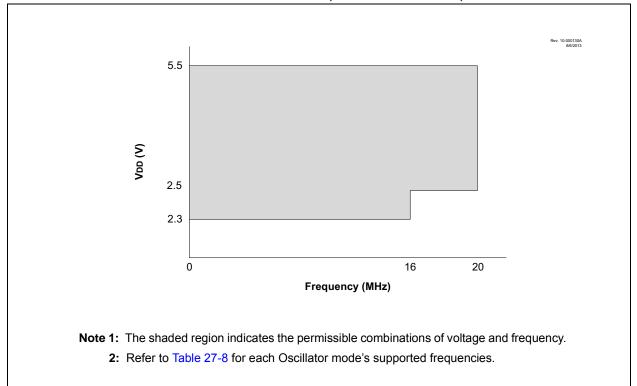
### 27.2 Standard Operating Conditions

The standard operating conditions for any device are defined as:

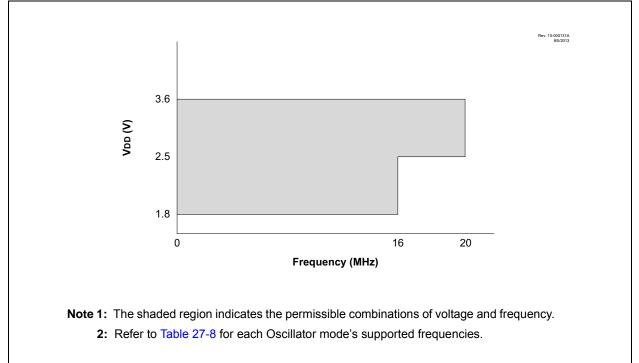
Operating Voltage: $VDDMIN \le VDD \le VDDMAX$	
Operating Temperature: $TA_MIN \le TA \le TA_MAX$	
VDD — Operating Supply Voltage ⁽¹⁾	
PIC12LF1501	
VDDMIN (Fosc $\leq$ 16 MHz) +1.8V	
VDDMIN (16 MHz < Fosc $\leq$ 20 MHz)	
VDDMAX	
PIC12F1501	
VDDMIN (Fosc $\leq$ 16 MHz) +2.3V	
VDDMIN (16 MHz < Fosc $\leq$ 20 MHz)	
VDDMAX	
TA — Operating Ambient Temperature Range	
Industrial Temperature	
TA_MIN40°C	
TA_MAX	
Extended Temperature	
TA_MIN40°C	
TA_MAX +125°C	

Note 1: See Parameter D001, DC Characteristics: Supply Voltage.









## 27.3 DC Characteristics

### TABLE 27-1: SUPPLY VOLTAGE

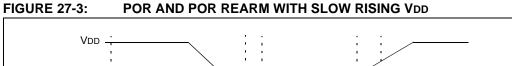
PIC12LF	PIC12LF1501				Standard Operating Conditions (unless otherwise stated)						
PIC12F1501											
Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions				
D001	Vdd	Supply Voltage									
			VDDMIN 1.8 2.5	_	VDDMAX 3.6 3.6	V V	Fosc ≤ 16 MHz Fosc ≤ 20 MHz				
D001			2.3 2.5	_	5.5 5.5	V V	Fosc ≤ 16 MHz Fosc ≤ 20 MHz				
D002*	Vdr	RAM Data Retention Voltage ⁽¹⁾									
			1.5	-	—	V	Device in Sleep mode				
D002*			1.7		_	V	Device in Sleep mode				
D002A*	VPOR	Power-on Reset Release Voltage	2)								
			—	1.6	—	V					
D002A*			_	1.6	_	V					
D002B*	VPORR*	Power-on Reset Rearm Voltage ⁽²⁾									
			—	0.8	—	V					
D002B*			_	1.5	_	V					
D003	VFVR	Fixed Voltage Reference Voltage									
		1x gain (1.024V nominal) 2x gain (2.048V nominal) 4x gain (4.096V nominal)	-11	_	+7	%	$ \begin{array}{l} V{\rm DD} \geq 2.5V, \ -40^{\circ}{\rm C} \leq {\rm TA} \leq +85^{\circ}{\rm C} \\ V{\rm DD} \geq 2.5V, \ -40^{\circ}{\rm C} \leq {\rm TA} \leq +85^{\circ}{\rm C} \\ V{\rm DD} \geq 4.75V, \ -40^{\circ}{\rm C} \leq {\rm TA} \leq +85^{\circ}{\rm C} \end{array} $				
D004*	SVDD	VDD Rise Rate ⁽²⁾	0.05	—	—	V/ms	Ensures that the Power-on Reset signal is released properly.				

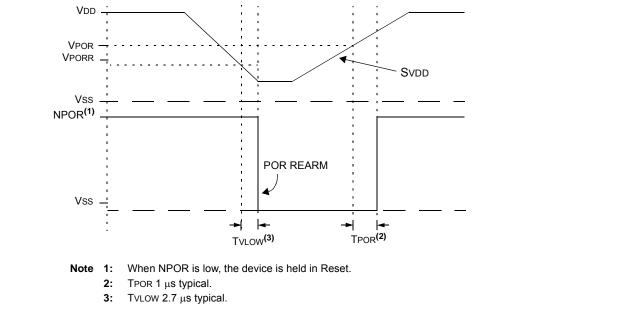
* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which VDD can be lowered in Sleep mode without losing RAM data.

2: See Figure 27-3, POR and POR REARM with Slow Rising VDD.





## TABLE 27-2: SUPPLY CURRENT (IDD)^(1,2)

PIC12LF	1501	Standard Operating Conditions (unless otherwise stated)								
PIC12F1	501									
Param. Device		Min.	Typt	Max.	Units	Conditions				
No.	Characteristics		711			Vdd	Note			
D013			30	65	μA	1.8	Fosc = 1 MHz,			
		—	55	100	μΑ	3.0	External Clock (ECM), Medium Power mode			
D013			65	110	μA	2.3	Fosc = 1 MHz,			
			85	140	μA	3.0	External Clock (ECM),			
			115	190	μA	5.0	Medium Power mode			
D014		—	115	190	μA	1.8	Fosc = 4 MHz,			
		_	210	310	μA	3.0	External Clock (ECM), Medium Power mode			
D014			180	270	μA	2.3	Fosc = 4 MHz,			
			240	365	μA	3.0	External Clock (ECM),			
			295	460	μA	5.0	Medium Power mode			
D015		—	3.2	12	μA	1.8	Fosc = 31 kHz,			
		_	5.4	20	μA	3.0	LFINTOSC, -40°C $\leq$ TA $\leq$ +85°C			
D015		—	13	28	μA	2.3	Fosc = 31 kHz,			
			15	30	μA	3.0				
			17	36	μA	5.0	$-40^{\circ}C \le TA \le +85^{\circ}C$			
D016		—	215	360	μA	1.8	Fosc = 500 kHz,			
		—	275	480	μA	3.0	HFINTOSC			
D016			270	450	μA	2.3	Fosc = 500 kHz,			
			300	500	μA	3.0	HFINTOSC			
			350	620	μA	5.0				
D017*		—	410	660	μA	1.8	Fosc = 8 MHz,			
			630	970	μA	3.0	HFINTOSC			
D017*		_	530	750	μA	2.3	Fosc = 8 MHz,			
			660	1100	μA	3.0	HFINTOSC			
		_	730	1200	μA	5.0				
D018		_	600	940	μA	1.8	Fosc = 16 MHz,			
			970	1400	μA	3.0	HFINTOSC			
D018		_	780	1200	μA	2.3	Fosc = 16 MHz,			
		—	1000	1550	μA	3.0	HFINTOSC			
			1090	1700	μA	5.0				

Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance t only and are not tested.

Note 1: The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to Vss; MCLR = VDD; WDT disabled.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

PIC12LF	1501	Standard Operating Conditions (unless otherwise stated)								
PIC12F1	501									
Param.	Device	Min.	Tunt	Max.	Units		Conditions			
No.	Characteristics	WIIII.	Тур†	WIdX.	Max. Units	Vdd	Note			
D019C		_	1030	1500	μA	3.0	Fosc = 20 MHz, External Clock (ECH), High-Power mode			
D019C		_	1060	1600	μA	3.0	Fosc = 20 MHz,			
		—	1220	1800	μA	5.0	External Clock (ECH), High-Power mode			
D019A		—	6	16	μA	1.8	Fosc = 32 kHz,			
		—	8	22	μA	3.0	External Clock (ECL), Low-Power mode			
D019A		—	13	28	μA	2.3	Fosc = 32 kHz,			
		_	15	31	μA	3.0	External Clock (ECL), Low-Power mode			
			16	36	μA	5.0	Low-Power mode			
D019B		_	19	35	μA	1.8	Fosc = 500 kHz,			
			32	55	μA	3.0	External Clock (ECL), Low-Power mode			
D019B		—	31	52	μA	2.3	Fosc = 500 kHz,			
			38	65	μA	3.0	External Clock (ECL),			
			44	74	μA	5.0	Low-Power mode			

## TABLE 27-2: SUPPLY CURRENT (IDD)^(1,2) (CONTINUED)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to Vss; MCLR = VDD; WDT disabled.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

TABLE 27-3:	POWER-DOWN CURRENTS (IPD) ^(1,2)
-------------	--------------------------------------------

PIC12LF1	501	Operating Conditions: (unless otherwise stated) Low-Power Sleep Mode									
PIC12F15	01	Low-Power Sleep Mode, VREGPM = 1									
Param.			<b>T</b> 1	Max.	Max.			Conditions			
No.	Device Characteristics	Min.	Тур†	+85°C	+125°C	Units	Vdd	Note			
D022	Base IPD	_	0.020	1.0	8.0	μA	1.8	WDT, BOR, FVR and SOSC			
		—	0.03	2.0	9.0	μA	3.0	disabled, all Peripherals inactive			
D022	Base IPD	—	0.25	3.0	10	μA	2.3	WDT, BOR, FVR and SOSC			
		_	0.30	4.0	12	μA	3.0	disabled, all Peripherals inactive,			
		—	0.40	6.0	15	μA	5.0	Low-Power Sleep mode			
D022A	Base IPD	_	10	16	18	μA	2.3	WDT, BOR, FVR and SOSC			
		_	11	18	20	μA	3.0	disabled, all Peripherals inactive,			
		—	12	21	26	μA	5.0	Normal Power Sleep mode, VREGPM = 0			
D023		_	0.26	2.0	9.0	μA	1.8	WDT Current			
		_	0.44	3.0	10	μA	3.0	]			
D023		—	0.43	6.0	15	μA	2.3	WDT Current			
		—	0.53	7.0	20	μA	3.0				
		—	0.64	8.0	22	μA	5.0				
D023A		—	15	28	30	μA	1.8	FVR Current			
		-	18	30	33	μA	3.0				
D023A		—	18	33	35	μA	2.3	FVR Current			
		_	19	35	37	μA	3.0				
		—	20	37	39	μA	5.0				
D024		_	6.0	17	20	μA	3.0	BOR Current			
D024			7.0	17	30	μA	3.0	BOR Current			
			8.0	20	40	μA	5.0				
D24A		—	0.1	4.0	10	μA	3.0	LPBOR Current			
D24A		_	0.35	5.0	14	μA	3.0	LPBOR Current			
		_	0.45	8.0	17	μA	5.0				

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The peripheral △ current can be determined by subtracting the base IPD current from this limit. Max. values should be used when calculating total current consumption.

2: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to Vss.

**3:** ADC clock source is FRC.

PIC12LF1	501	Operating Conditions: (unless otherwise stated) Low-Power Sleep Mode										
PIC12F15	01	Low-Po	Low-Power Sleep Mode, VREGPM = 1									
Param.		Min.		Max.	Max.	Units	Conditions					
No.	Device Characteristics	MIN.	Тур†	+85°C	+125°C	Units	Vdd	Note				
D026		—	0.11	1.5	9.0	μA	1.8	ADC Current (Note 3),				
		_	0.12	2.7	12	μA	3.0	No conversion in progress				
D026		_	0.30	4.0	11	μA	2.3	ADC Current (Note 3),				
			0.35	5.0	13	μA	3.0	No conversion in progress				
			0.45	8.0	16	μA	5.0					
D026A*			250	_	_	μA	1.8	ADC Current (Note 3),				
			250	—	—	μA	3.0	Conversion in progress				
D026A*			280			μA	2.3	ADC Current (Note 3),				
			280	—	—	μA	3.0	Conversion in progress				
			280			μA	5.0					
D027		_	7	22	25	μA	1.8	Comparator,				
		_	8	23	27	μA	3.0	CxSP = 0				
D027			17	35	37	μA	2.3	Comparator,				
			18	37	38	μA	3.0	CxSP = 0				
			19	38	40	μA	5.0					

#### TABLE 27-3: POWER-DOWN CURRENTS (IPD)^(1,2) (CONTINUED)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The peripheral ∆ current can be determined by subtracting the base IPD current from this limit. Max. values should be used when calculating total current consumption.

2: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to Vss.

3: ADC clock source is FRC.

#### TABLE 27-4: I/O PORTS

Standard (	Operating	Conditions	unless	otherwise stated)
Stanuaru	Just alling	Conditions	luiness	Uniel wise stateu)

Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions
	VIL	Input Low Voltage	•				•
		I/O PORT:					
D030		with TTL buffer	—		0.8	V	$4.5V \leq V\text{DD} \leq 5.5V$
D030A			—	_	0.15 VDD	V	$1.8V \le VDD \le 4.5V$
D032		MCLR	_	_	0.2 VDD	V	
	VIH	Input High Voltage			•	•	·
		I/O PORT:					
D040		with TTL buffer	2.0		_	V	$4.5V \leq V\text{DD} \leq 5.5V$
D040A			0.25 VDD +	_	—	V	$1.8V \leq V\text{DD} \leq 4.5V$
			0.8				
D042		MCLR	0.8 VDD	—	—	V	
	lı∟	Input Leakage Current ⁽¹⁾					
D060		I/O Ports	—	± 5	± 125	nA	$Vss \le VPIN \le VDD$ , Pin at high-impedance, 85°C
			—	± 5	± 1000	nA	$Vss \le VPIN \le VDD$ , Pin at high-impedance, 125°C
D061		MCLR ⁽²⁾	—	± 50	± 200	nA	$Vss \le VPIN \le VDD$ , Pin at high-impedance, 85°C
	IPUR	Weak Pull-up Current					•
D070*			25	100	200	μA	VDD = 3.3V, VPIN = VSS
			25	140	300	μA	VDD = 5.0V, VPIN = VSS
	Vol	Output Low Voltage			•	•	·
D080		I/O Ports	_	_	0.6	V	IOL = 8 mA, VDD = 5V IOL = 6 mA, VDD = 3.3V IOL = 1.8 mA, VDD = 1.8V
	Voн	Output High Voltage					•
D090		I/O Ports	Vdd - 0.7	_	_	v	IOH = 3.5 mA, VDD = 5V IOH = 3 mA, VDD = 3.3V IOH = 1 mA, VDD = 1.8V
		Capacitive Loading Specifi	ications on Out	put Pins		1	1
D101A*	CIO	All I/O pins		_	50	pF	
						· · ·	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** Negative current is defined as current sourced by the pin.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions
		Program Memory Programming Specifications					
D110	VIHH	Voltage on MCLR/VPP pin	8.0	—	9.0	V	(Note 2)
D112	VPBE	VDD for Bulk Erase	2.7	_	VDDMAX	V	
D113	VPEW	VDD for Write or Row Erase	VDDMIN	_	VDDMAX	V	
D114	IPPPGM	Current on MCLR/VPP during Erase/Write	—	1.0	_	mA	
D115	IDDPGM	Current on VDD during Erase/Write	—	5.0	—	mA	
D121	Ep	Program Flash Memory Cell Endurance	10K	_		E/W	-40°C ≤ TA ≤ +85°C (Note 1)
D122	VPRW	VDD for Read/Write	VDDMIN		VDDMAX	V	
D123	Tiw	Self-timed Write Cycle Time	_	2	2.5	ms	
D124	TRETD	Characteristic Retention	-	40	—	Year	Provided no other specifications are violated
D125	EHEFC	High-Endurance Flash Cell	100K	_	—	E/W	$0^{\circ}C \le TA \le +60^{\circ}C$ , lower byte last 128 addresses

#### TABLE 27-5: MEMORY PROGRAMMING SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** Self-write and Block Erase.

2: Required only if single-supply programming is disabled.

#### TABLE 27-6: THERMAL CONSIDERATIONS

	•	Conditions (unless otherwise stated) re $-40^{\circ}C \le TA \le +125^{\circ}C$			
Param No.	Sym.	Characteristic	Тур.	Units	Conditions
TH01	θJA	Thermal Resistance Junction to Ambient	89.3	°C/W	8-pin PDIP package
			149.5	°C/W	8-pin SOIC package
			211	°C/W	8-pin MSOP package
			56.7	°C/W	8-pin DFN 3X3mm package
			68	°C/W	8-pin DFN 2X3mm package
			60	°C/W	8-pin UDFN 2X3mm package
TH02	θJC	Thermal Resistance Junction to Case	43.1	°C/W	8-pin PDIP package
			39.9	°C/W	8-pin SOIC package
			39	°C/W	8-pin MSOP package
			10.7	°C/W	8-pin DFN 3X3mm package
			12.7	°C/W	8-pin DFN 2X3mm package
			11	°C/W	8-pin UDFN 2X3mm package
TH03	TJMAX	Maximum Junction Temperature	150	°C	
TH04	PD	Power Dissipation	_	W	PD = PINTERNAL + PI/O
TH05	PINTERNAL	Internal Power Dissipation	_	W	PINTERNAL = IDD x VDD ⁽¹⁾
TH06	Pi/o	I/O Power Dissipation		W	$PI/O = \Sigma (IOL * VOL) + \Sigma (IOH * (VDD - VOH))$
TH07	Pder	Derated Power		W	Pder = PDmax (Τj - Τa)/θja ⁽²⁾

**Note 1:**IDD is current to run the chip alone without driving any load on the output pins.

**2:** TA = Ambient Temperature.

**3:** T_J = Junction Temperature.

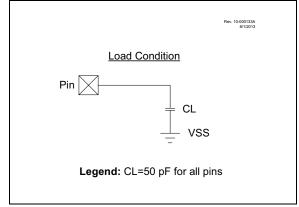
#### 27.4 AC Characteristics

Timing Parameter Symbology has been created with one of the following formats:

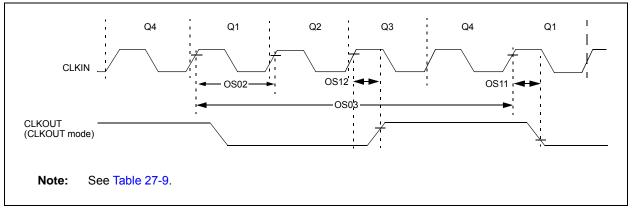
- 1. TppS2ppS
- 2. TppS

Т			
F	Frequency	Т	Time
Lowerc	ase letters (pp) and their meanings:		
рр			
сс	CCP1	OSC	CLKIN
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDIx	sc	SCKx
do	SDO	SS	SS
dt	Data in	t0	TOCKI
io	I/O PORT	t1	T1CKI
mc	MCLR	wr	WR
Upperc	case letters and their meanings:		
S			
F	Fall	Р	Period
Н	High	R	Rise
I	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance

#### FIGURE 27-4: LOAD CONDITIONS







#### TABLE 27-7: CLOCK OSCILLATOR TIMING REQUIREMENTS

Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions					
OS01	Fosc	External CLKIN Frequency ⁽¹⁾	DC	—	0.5	MHz	External Clock (ECL)					
			DC	—	4	MHz	External Clock (ECM)					
			DC	—	20	MHz	External Clock (ECH)					
OS02	Tosc	External CLKIN Period ⁽¹⁾	50		×	ns	External Clock (EC)					
OS03	TCY	Instruction Cycle Time ⁽¹⁾	200	TCY	DC	ns	Tcy = 4/Fosc					

#### Standard Operating Conditions (unless otherwise stated)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min" values with an external clock applied to CLKIN pin. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

#### TABLE 27-8: OSCILLATOR PARAMETERS

Standar	Standard Operating Conditions (unless otherwise stated)									
Param. No.	Sym.	Characteristic	Freq. Tolerance	Min.	Тур†	Max.	Units	Conditions		
OS08	HFosc	Internal Calibrated HFINTOSC Frequency ⁽¹⁾	±2%		16.0		MHz	VDD = 3.0V, TA = 25°C, (Note 2)		
OS09	LFosc	Internal LFINTOSC Frequency	—	_	31	_	kHz	(Note 3)		
OS10*	TIOSC ST	HFINTOSC Wake-up from Sleep Start-up Time	—	_	5	15	μS			
OS10A*	TLFOSC ST	LFINTOSC Wake-up from Sleep Start-up Time	—		0.5		ms	$-40^\circ C \le T A \le +125^\circ C$		

These parameters are characterized but not tested.

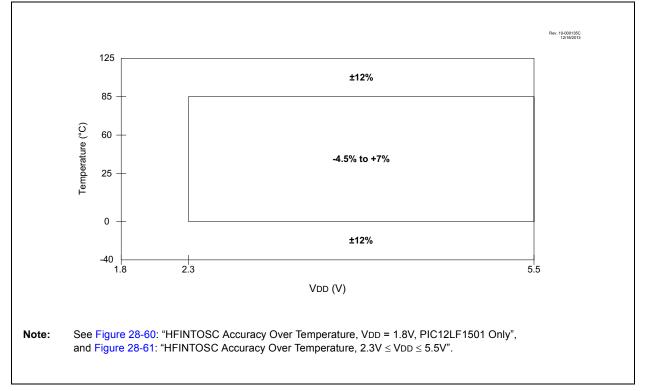
† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: To ensure these oscillator frequency tolerances, VDD and Vss must be capacitively decoupled as close to the device as possible. 0.1  $\mu$ F and 0.01  $\mu$ F values in parallel are recommended.

2: See Figure 27-6: "HFINTOSC Frequency Accuracy over Device VDD and Temperature", Figure 28-60: "HFINTOSC Accuracy Over Temperature, VDD = 1.8V, PIC12LF1501 Only", and Figure 28-61: "HFINTOSC Accuracy Over Temperature, 2.3V ≤ VDD ≤ 5.5V".

3: See Figure 28-58: "LFINTOSC Frequency over VDD and Temperature, PIC12LF1501 Only", and Figure 28-59: "LFINTOSC Frequency over VDD and Temperature, PIC12F1501".

#### FIGURE 27-6: HFINTOSC FREQUENCY ACCURACY OVER VDD AND TEMPERATURE





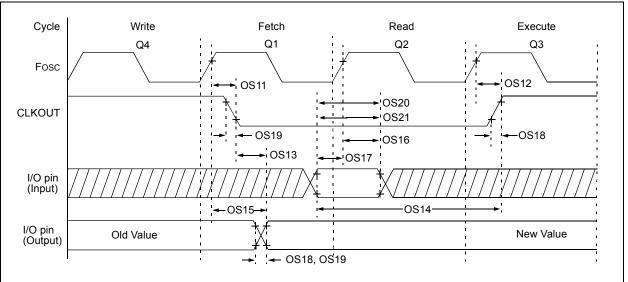


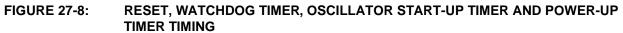
TABLE 27-9:	CLKOUT AND I/O TIMING PARAMETERS
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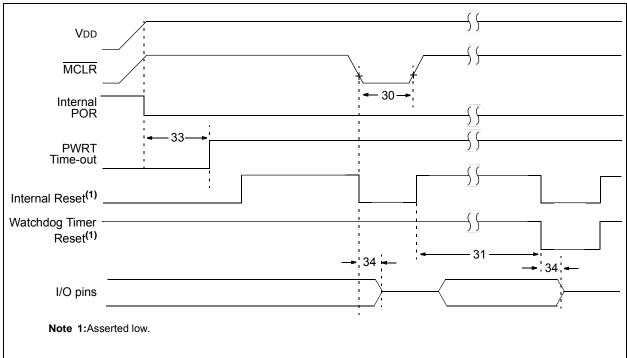
Standard	d Operating (	Conditions (unless otherwise stated)					
Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions
OS11	TosH2ckL	Fosc↑ to CLKOUT↓ ⁽¹⁾	_	_	70	ns	$3.3V \le V\text{DD} \le 5.0V$
OS12	TosH2ckH	Fosc↑ to CLKOUT↑ ⁽¹⁾	_	_	72	ns	$3.3V \le V\text{DD} \le 5.0V$
OS13	TckL2ioV	CLKOUT↓ to Port out valid ⁽¹⁾	—	_	20	ns	
OS14	TioV2ckH	Port input valid before CLKOUT ⁽¹⁾	Tosc + 200 ns			ns	
OS15	TosH2ioV	Fosc↑ (Q1 cycle) to Port out valid	—	50	70*	ns	$3.3V \leq V\text{DD} \leq 5.0V$
OS16	TosH2iol	Fosc [↑] (Q2 cycle) to Port input invalid (I/O in setup time)	50	—	_	ns	$3.3V \le V\text{DD} \le 5.0V$
OS17	TioV2osH	Port input valid to Fosc↑ (Q2 cycle) (I/O in setup time)	20	—	—	ns	
OS18*	TioR	Port output rise time		40 15	72 32	ns	$\begin{array}{l} VDD\texttt{D}\texttt{=}1.8V\\ 3.3V \leq VDD \leq 5.0V \end{array}$
OS19*	TioF	Port output fall time	—	28 15	55 30	ns	$\begin{array}{l} VDD \mbox{=} \mbox{1.8V} \\ 3.3V \leq VDD \leq 5.0V \end{array}$
OS20*	Tinp	INT pin input high or low time	25	—	—	ns	
OS21*	Tioc	Interrupt-on-change new input level time	25	—	—	ns	

* These parameters are characterized but not tested.

 $\dagger$  Data in "Typ" column is at 3.0V, 25°C unless otherwise stated.

**Note 1:** Measurements are taken in EXTRC mode where CLKOUT output is 4 x Tosc.





### TABLE 27-10:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER<br/>AND BROWN-OUT RESET PARAMETERS

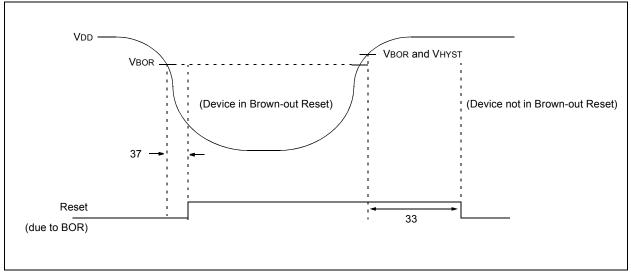
Standar	Standard Operating Conditions (unless otherwise stated)									
Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions			
30	ТмсL	MCLR Pulse Width (low)	2	—	_	μS				
31	TWDTLP	Low-Power Watchdog Timer Time-out Period	10	16	27	ms	VDD = 3.3V-5V, 1:512 Prescaler used			
33*	TPWRT	Power-up Timer Period	40	65	140	ms	PWRTE = 0			
34*	Tioz	I/O high-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.0	μS				
35	VBOR	Brown-out Reset Voltage ⁽¹⁾	2.55	2.70	2.85	V	BORV = 0			
			2.35 1.80	2.45 1.90	2.58 2.05	V V	BORV = 1 (PIC12F1501) BORV = 1 (PIC12LF1501)			
36*	VHYST	Brown-out Reset Hysteresis	0	25	75	mV	$-40^{\circ}C \le TA \le +85^{\circ}C$			
37*	TBORDC	Brown-out Reset DC Response Time	1	16	35	μS	$VDD \leq VBOR$			
38	Vlpbor	Low-Power Brown-Out Reset Voltage	1.8	2.1	2.5	V	LPBOR = 1			

These parameters are characterized but not tested.

*

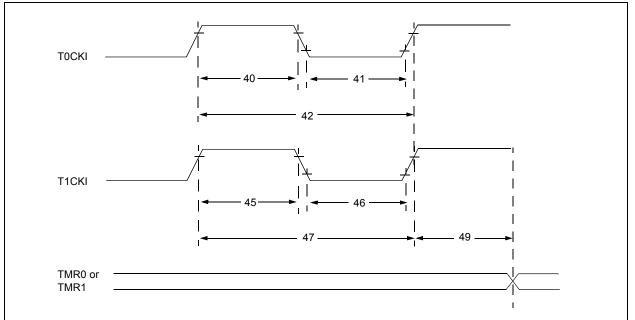
† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

#### FIGURE 27-9: BROWN-OUT RESET TIMING AND CHARACTERISTICS



Note 1: To ensure these voltage tolerances, VDD and Vss must be capacitively decoupled as close to the device as possible. 0.1  $\mu$ F and 0.01  $\mu$ F values in parallel are recommended.

#### FIGURE 27-10: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

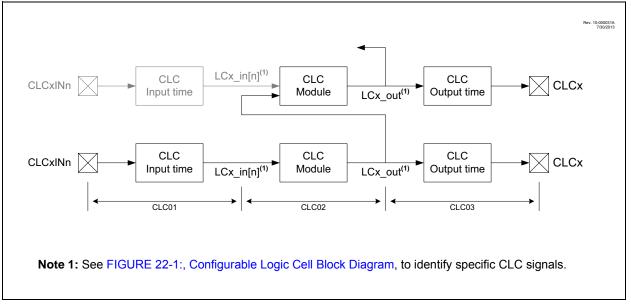


Standard Operating Conditions (unless otherwise stated)										
Param. No.	Sym.		Characteristic		Min.	Тур†	Max.	Units	Conditions	
40*	T⊤0H	T0CKI High F	Pulse Width	No Prescaler	0.5 Tcy + 20	_	-	ns		
			With Prescaler		10	_	_	ns		
41*	TT0L	T0CKI Low Pulse Width No Prescaler With Prescaler		No Prescaler	0.5 Tcy + 20	_	_	ns		
				10	_	_	ns			
42*	Тт0Р	T0CKI Period	l		Greater of: 20 or <u>Tcy + 40</u> N	_	_	ns	N = prescale value	
45*	T⊤1H	T1CKI High Time	Synchronous, No Prescaler		0.5 Tcy + 20	_		ns		
			Synchronous, with Prescaler		15	_		ns		
			Asynchronous		30	_		ns		
46*	TT1L	T1CKI Low Time	Synchronous, No Prescaler		0.5 Tcy + 20	_		ns		
			Synchronous, with Prescaler		15		_	ns		
			Asynchronous		30	_	_	ns		
47*	TT1P	T1CKI Input Period	Synchronous		Greater of: 30 or <u>Tcy + 40</u> N	—	—	ns	N = prescale value	
			Asynchronous		60	_	_	ns		
49*	TCKEZTMR1	Delay from E Increment	om External Clock Edge to Timer		2 Tosc	_	7 Tosc	—	Timers in Sync mode	

These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.





Standard Operating Conditions (unless otherwise stated)								
Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions	
CLC01*	TCLCIN	CLC input time	_	7	_	ns		
CLC02*	TCLC	CLC module input to output propagation time	_	24 12		ns ns	VDD = 1.8V VDD > 3.6V	
CLC03*	TCLCOUT	CLC output time Rise Time		OS18			(Note 1)	
		Fall Time		OS19	_		(Note 1)	
CLC04*	FCLCMAX	CLC maximum switching frequency		45	_	MHz		
*	These para	ameters are characterized but not tested.		•		•	•	

These parameters are characterized but not tested.

Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance t only and are not tested.

Note 1:See Table 27-9 for OS18 and OS19 rise and fall times.

### TABLE 27-13: ANALOG-TO-DIGITAL CONVERTER (ADC) CHARACTERISTICS^(1,2,3)

#### Operating Conditions (unless otherwise stated)

Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions
AD01	NR	Resolution	—	_	10	bit	
AD02	EIL	Integral Error	—	±1	±1.7	LSb	VREF = 3.0V
AD03	Edl	Differential Error	—	±1	±1	LSb	No missing codes VREF = 3.0V
AD04	EOFF	Offset Error	_	±1	±2.5	LSb	VREF = 3.0V
AD05	Egn	Gain Error	_	±1	±2.0	LSb	VREF = 3.0V
AD06	VREF	Reference Voltage	1.8	_	Vdd	V	VREF = (VRPOS - VRNEG) (Note 4)
AD07	VAIN	Full-Scale Range	Vss		VREF	V	
AD08	Zain	Recommended Impedance of Analog Voltage Source	-	—	10	kΩ	Can go higher if external 0.01µF capacitor is present on input pin.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

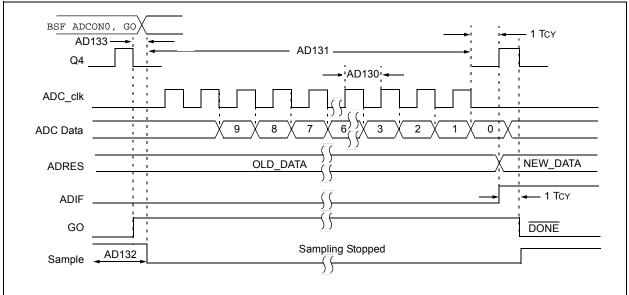
**Note 1:**Total Absolute Error includes integral, differential, offset and gain errors.

2: The ADC conversion result never decreases with an increase in the input voltage and has no missing codes.

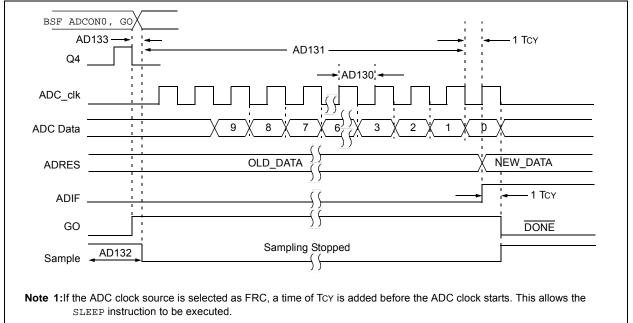
3: See Section 28.0 "DC and AC Characteristics Graphs and Charts" for operating characterization.

**4:** ADC VREF is selected by ADPREF<0> bit.









#### TABLE 27-14: ADC CONVERSION REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)									
Param. No.	Sym.	Characteristic	Min.	Тур†	Max.	Units	Conditions		
AD130*	TAD	ADC Clock Period (TADC)	1.0	_	6.0	μS	Fosc-based		
		ADC Internal FRC Oscillator Period (TFRC)	1.0	2.0	6.0	μS	ADCS<2:0> = x11 (ADC FRC mode)		
AD131	TCNV	Conversion Time (not including Acquisition Time) ⁽¹⁾	—	11	—	Tad	Set GO/DONE bit to conversion complete		
AD132*	TACQ	Acquisition Time		5.0	—	μS			
AD133*	THCD	Holding Capacitor Disconnect Time	—	1/2 TAD 1/2 TAD + 1TCY	_		Fosc-based ADCS<2:0> = x11 (ADC FRC mode)		

These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The ADRES register may be read on the following TCY cycle.

#### TABLE 27-15: COMPARATOR SPECIFICATIONS⁽¹⁾

**Operating Conditions (unless otherwise stated)**  $V_{DD} = 3.0V$  T_A = 25°C

VDD = 3.0V	, TA = 25°C						
Param. No.	Sym.	Characteristics	Min.	Тур.	Max.	Units	Comments
CM01	VIOFF	Input Offset Voltage		±7.5	±60	mV	CxSP = 1, Vicм = Vdd/2
CM02	VICM	Input Common Mode Voltage	0	—	Vdd	V	
CM03	CMRR	Common Mode Rejection Ration	_	50	—	dB	
CM04A		Response Time Rising Edge	_	400	800	ns	CxSP = 1
CM04B	TRESP ⁽²⁾	Response Time Falling Edge	_	200	400	ns	CxSP = 1
CM04C	TRESP	Response Time Rising Edge	_	1200	—	ns	CxSP = 0
CM04D		Response Time Falling Edge	_	550	—	ns	<b>CxSP =</b> 0
CM05*	Тмс2о∨	Comparator Mode Change to Output Valid	—	—	10	μS	
CM06	CHYSTER	Comparator Hysteresis	_	25	—	mV	CxHYS = 1, CxSP = 1

* These parameters are characterized but not tested.

Note 1: See Section 28.0 "DC and AC Characteristics Graphs and Charts" for operating characterization.

2: Response time measured with one comparator input at VDD/2, while the other input transitions from Vss to VDD.

### TABLE 27-16: DIGITAL-TO-ANALOG CONVERTER (DAC) SPECIFICATIONS⁽¹⁾

VDD = 3.0V,	TA = 25°C
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VDD = 3.0V, TA = 25°C									
Param. No.	Sym.	Characteristics	Min.	Тур.	Max.	Units	Comments		
DAC01*	Clsb	Step Size	—	VDD/32	_	V			
DAC02*	CACC	Absolute Accuracy	—	—	± 1/2	LSb			
DAC03*	CR	Unit Resistor Value (R)	—	5K	_	Ω			
DAC04*	CST	Settling Time ⁽²⁾	_	—	10	μS			

* These parameters are characterized but not tested.

Note 1: See Section 28.0 "DC and AC Characteristics Graphs and Charts" for operating characterization.

2: Settling time measured while DACR<4:0> transitions from '00000' to '01111'.

### 28.0 DC AND AC CHARACTERISTICS GRAPHS AND CHARTS

The graphs and tables provided in this section are for **design guidance** and are **not tested**.

In some graphs or tables, the data presented are **outside specified operating range** (i.e., outside specified VDD range). This is for **information only** and devices are ensured to operate properly only within the specified range.

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

"Typical" represents the mean of the distribution at 25°C. "MAXIMUM", "Max.", "MINIMUM" or "Min." represents (mean +  $3\sigma$ ) or (mean -  $3\sigma$ ) respectively, where  $\sigma$  is a standard deviation, over each temperature range.

FIGURE 28-1: IDD, EXTERNAL CLOCK (ECL), LOW-POWER MODE, Fosc = 32 kHz, PIC12LF1501 ONLY

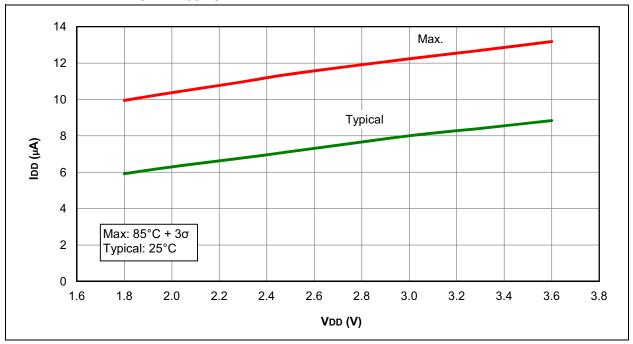


FIGURE 28-2: IDD, EXTERNAL CLOCK (ECL), LOW-POWER MODE, Fosc = 32 kHz, PIC12F1501 ONLY

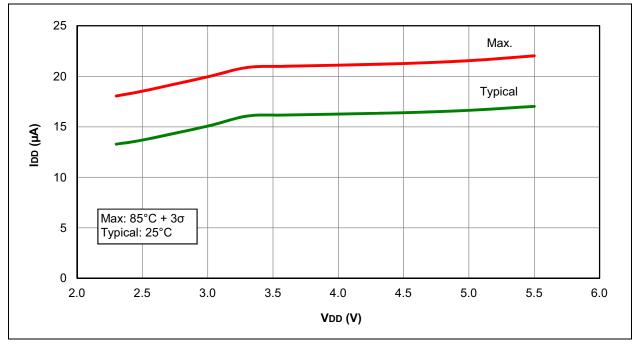


FIGURE 28-3: IDD, EXTERNAL CLOCK (ECL), LOW-POWER MODE, Fosc = 500 kHz, PIC12LF1501 ONLY

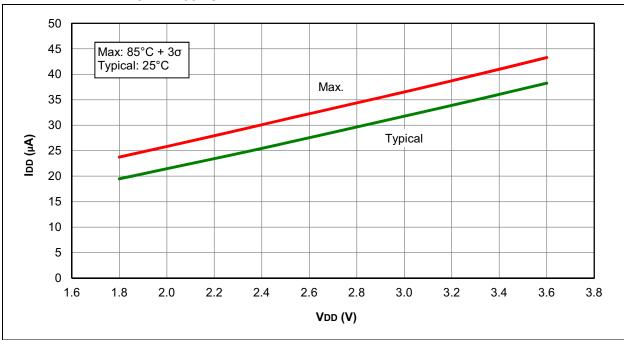


FIGURE 28-4: IDD, EXTERNAL CLOCK (ECL), LOW-POWER MODE, Fosc = 500 kHz, PIC12F1501 ONLY

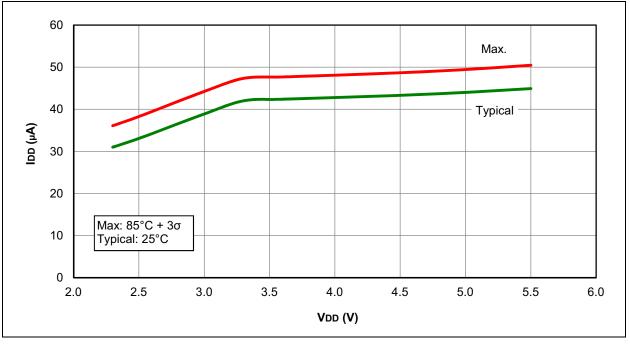


FIGURE 28-5: IDD TYPICAL, EXTERNAL CLOCK (ECM), MEDIUM POWER MODE, PIC12LF1501 ONLY

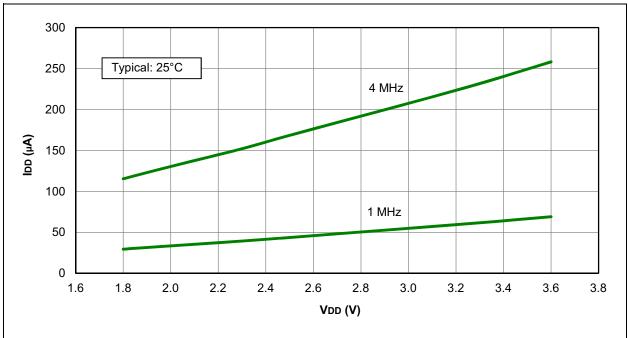
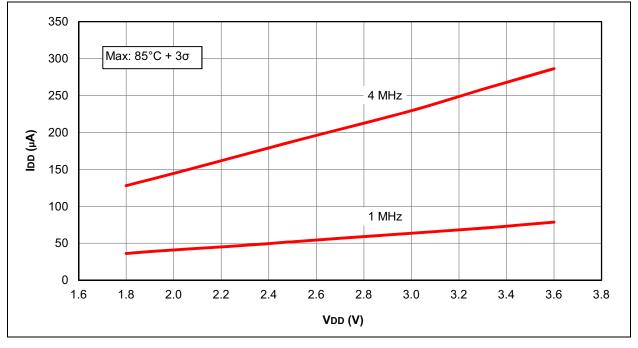
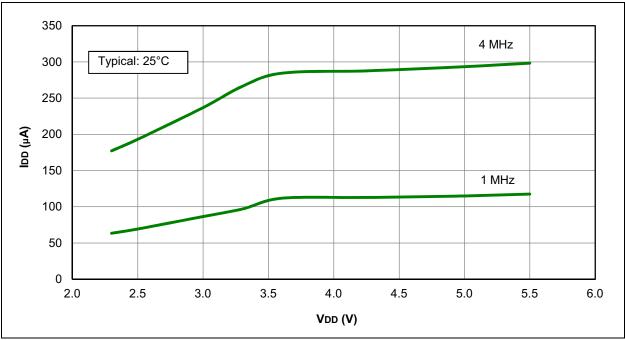


FIGURE 28-6: IDD MAXIMUM, EXTERNAL CLOCK (ECM), MEDIUM POWER MODE, PIC12LF1501 ONLY









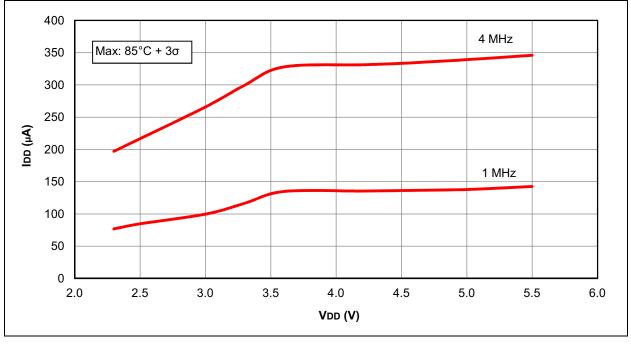


FIGURE 28-9: IDD TYPICAL, EXTERNAL CLOCK (ECH), HIGH-POWER MODE, PIC12LF1501 ONLY

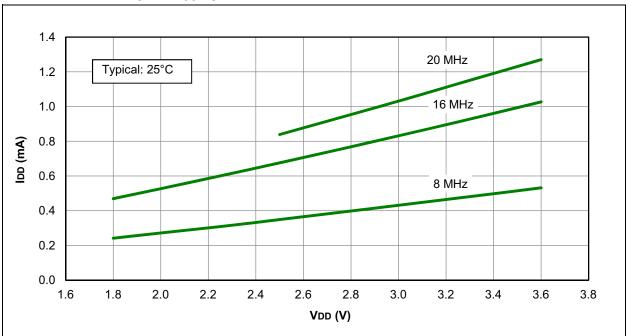


FIGURE 28-10: IDD MAXIMUM, EXTERNAL CLOCK (ECH), HIGH-POWER MODE, PIC12LF1501 ONLY

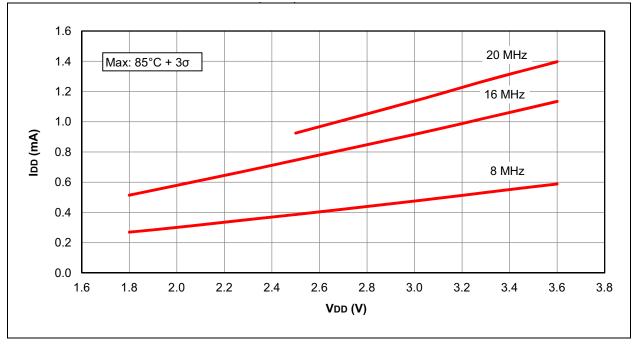


FIGURE 28-11: IDD TYPICAL, EXTERNAL CLOCK (ECH), HIGH-POWER MODE, PIC12F1501 ONLY

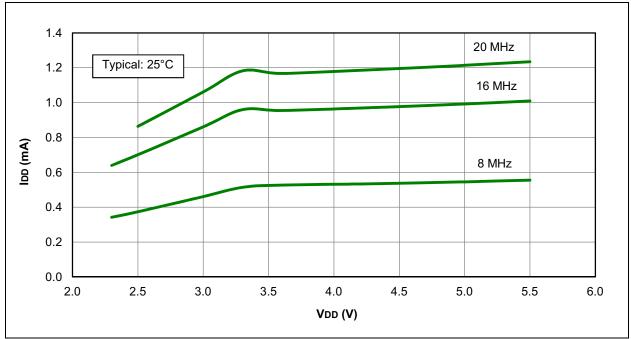
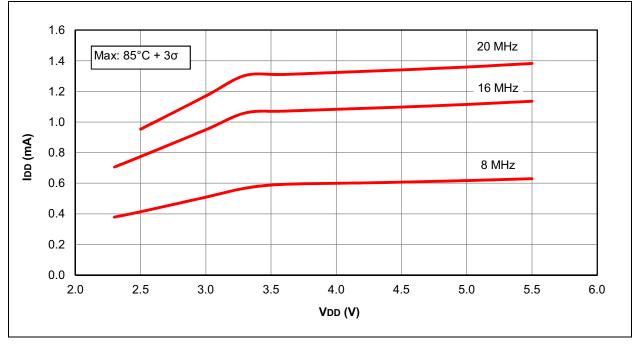


FIGURE 28-12: IDD MAXIMUM, EXTERNAL CLOCK (ECH), HIGH-POWER MODE, PIC12F1501 ONLY



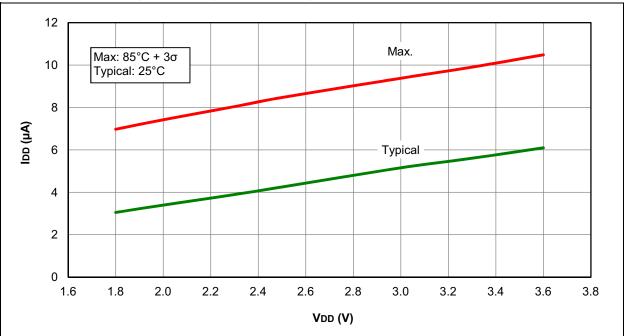
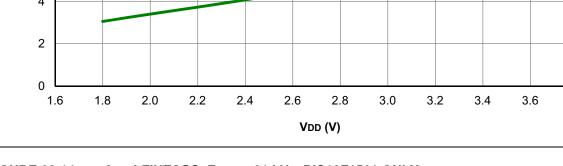
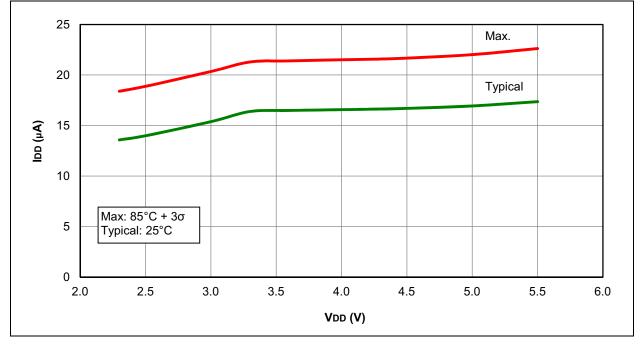
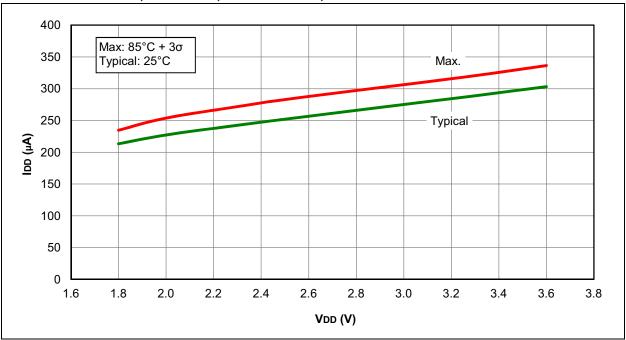


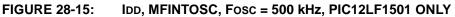
FIGURE 28-13: IDD, LFINTOSC, Fosc = 31 kHz, PIC12LF1501 ONLY

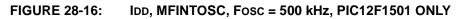


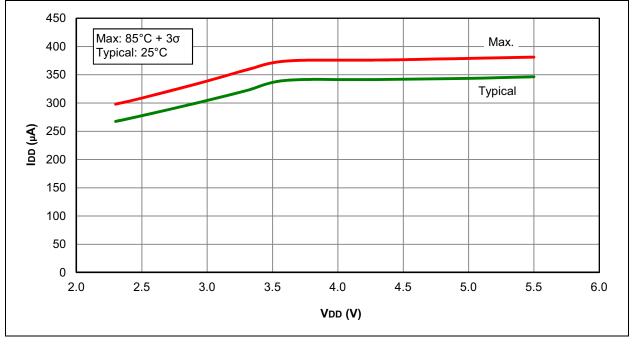




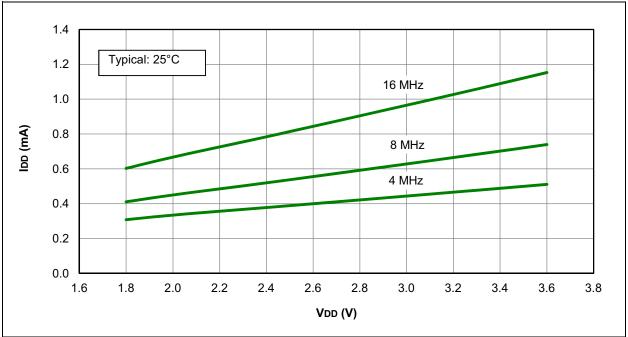


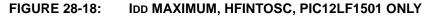


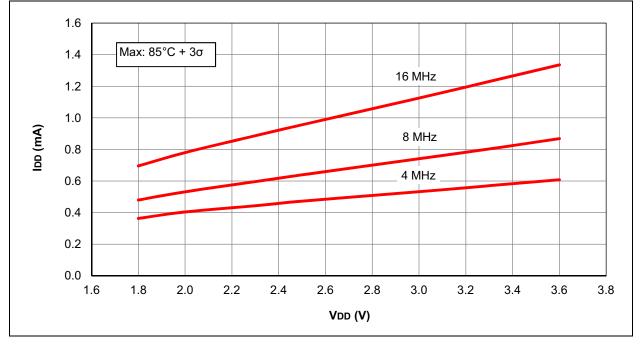


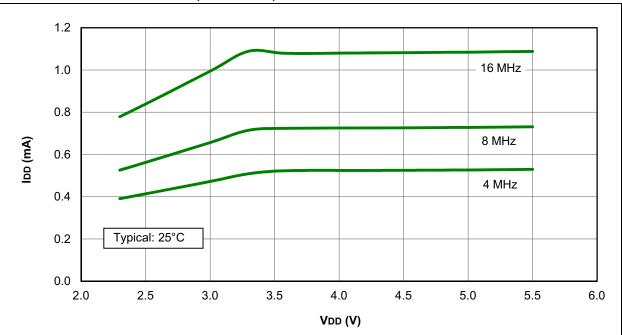






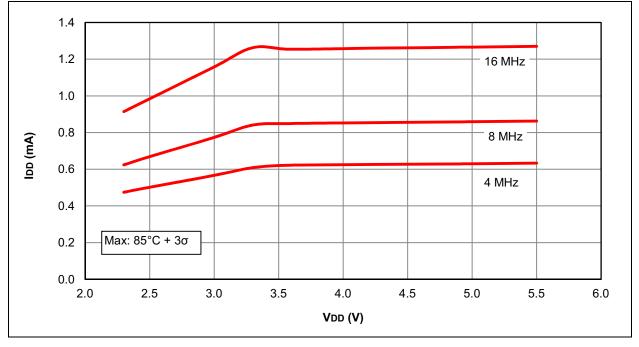












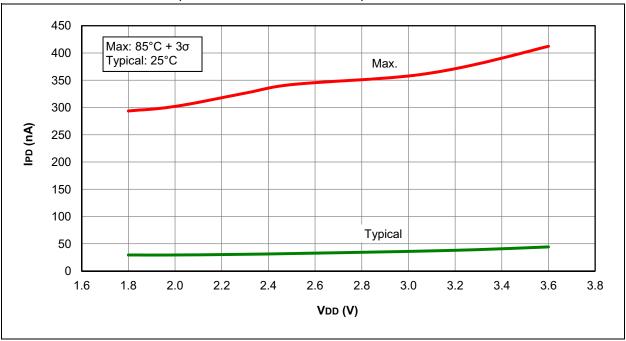
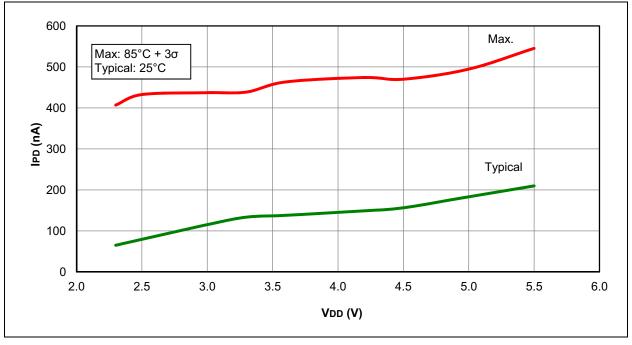
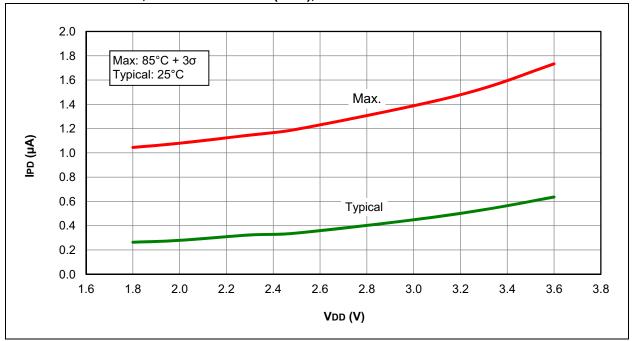


FIGURE 28-21: IPD BASE, LOW-POWER SLEEP MODE, PIC12LF1501 ONLY

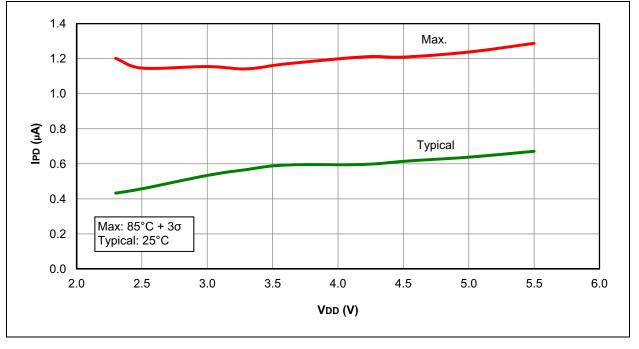












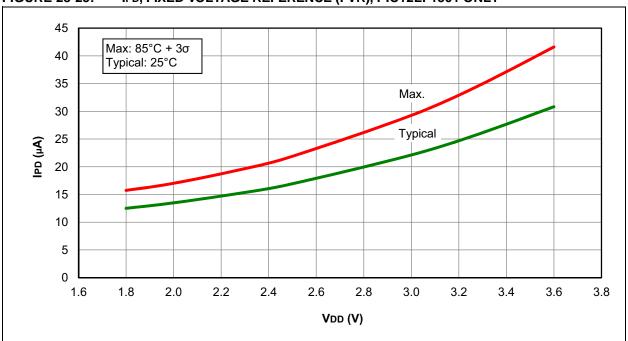
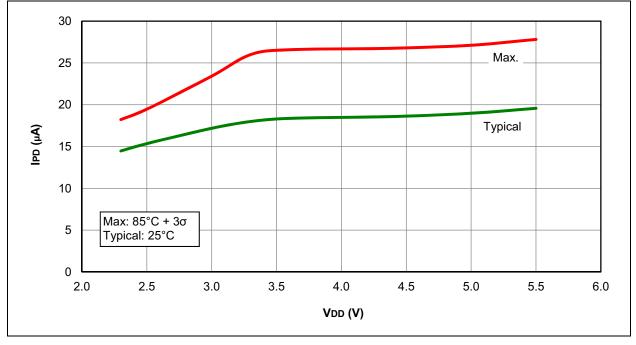
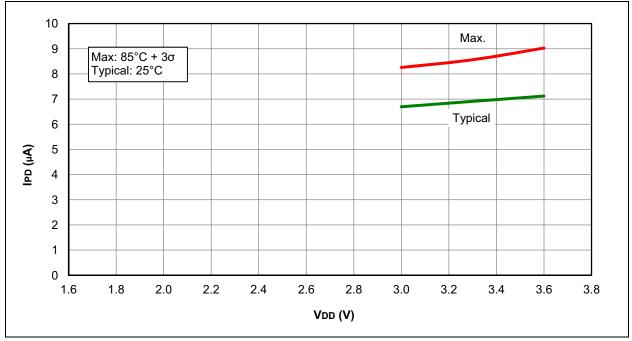


FIGURE 28-25: IPD, FIXED VOLTAGE REFERENCE (FVR), PIC12LF1501 ONLY

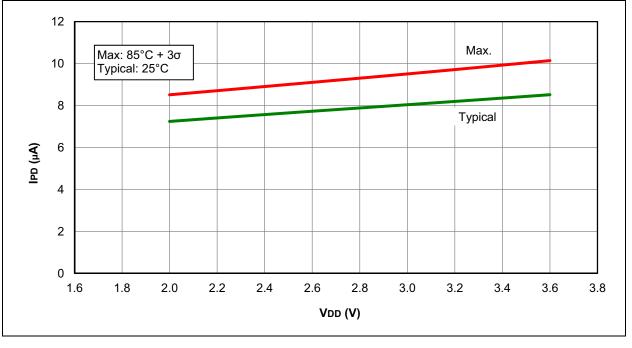




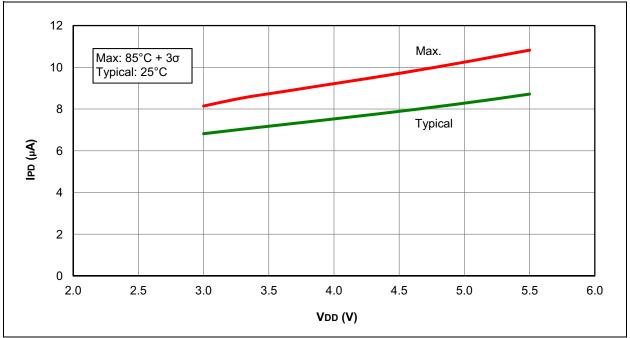




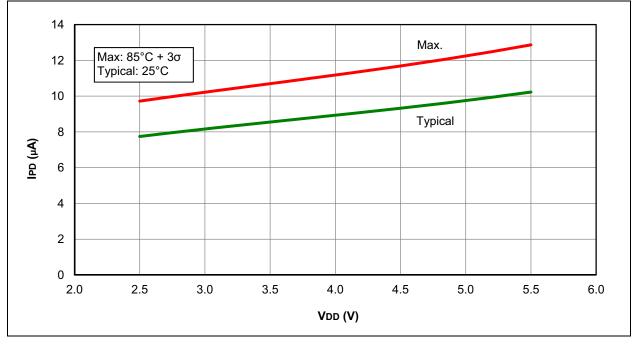














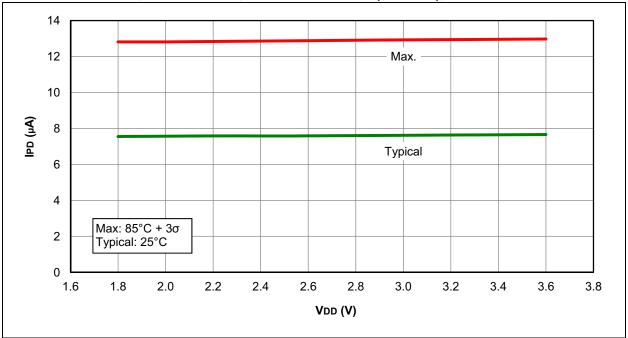
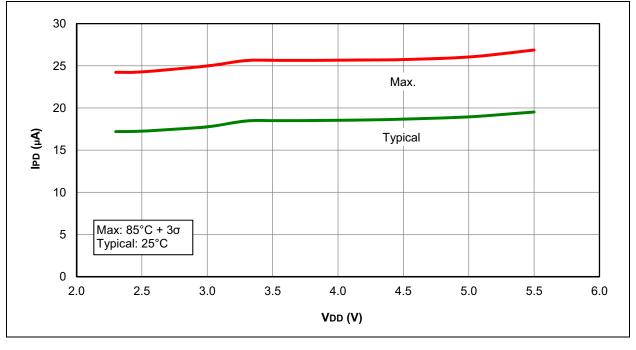


FIGURE 28-32: IPD, COMPARATOR, LOW-POWER MODE (CxSP = 0), PIC12F1501 ONLY



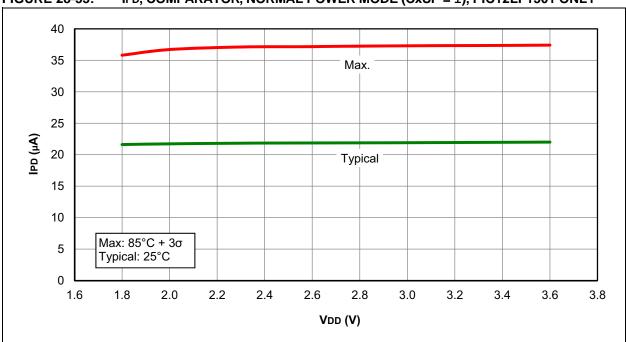
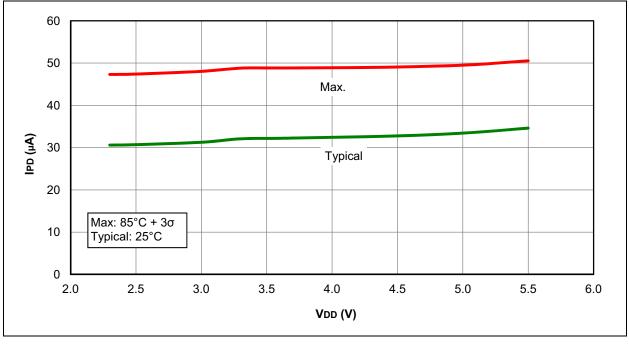
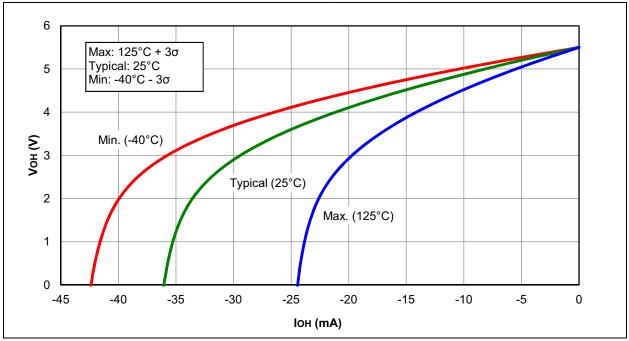


FIGURE 28-33: IPD, COMPARATOR, NORMAL POWER MODE (CxSP = 1), PIC12LF1501 ONLY

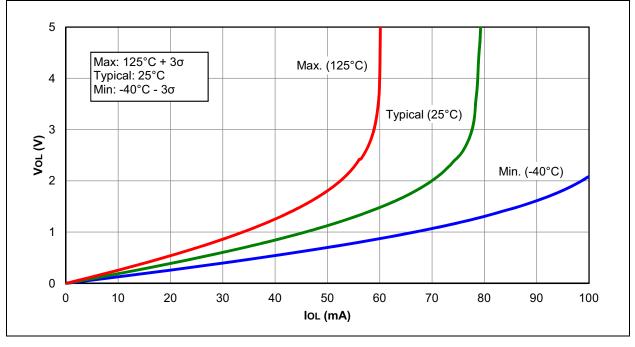




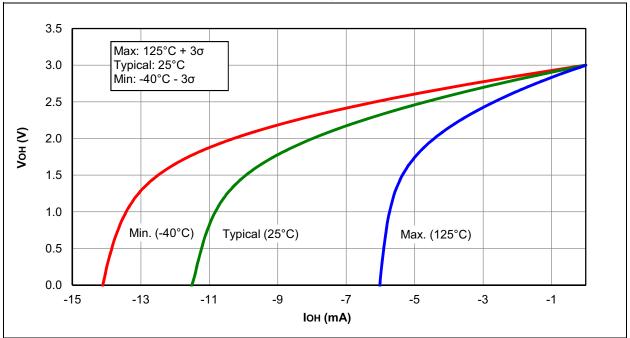




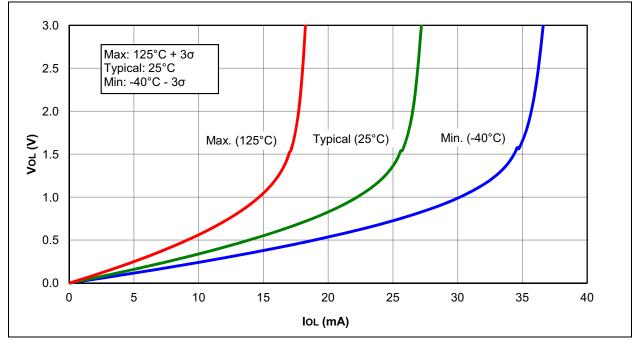












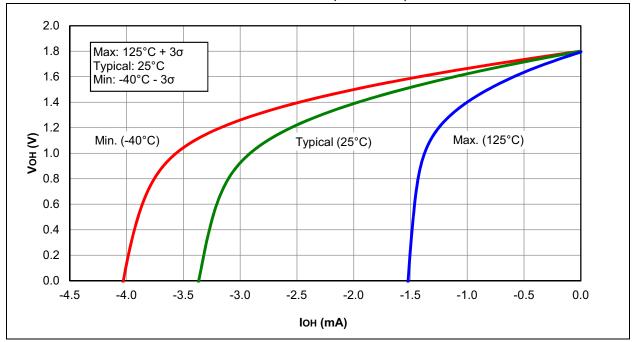
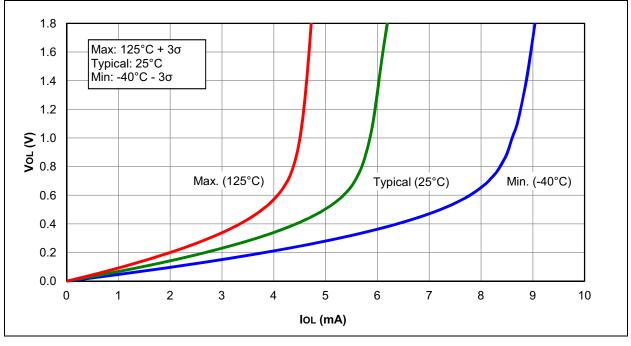
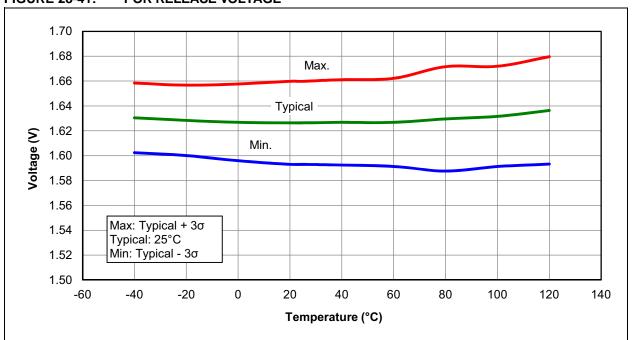


FIGURE 28-39: VOH vs. IOH OVER TEMPERATURE, VDD = 1.8V, PIC12LF1501 ONLY

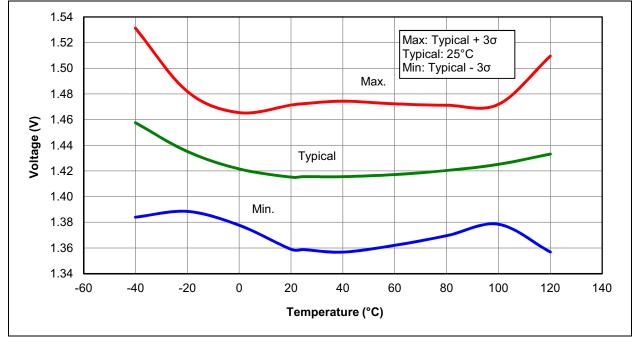


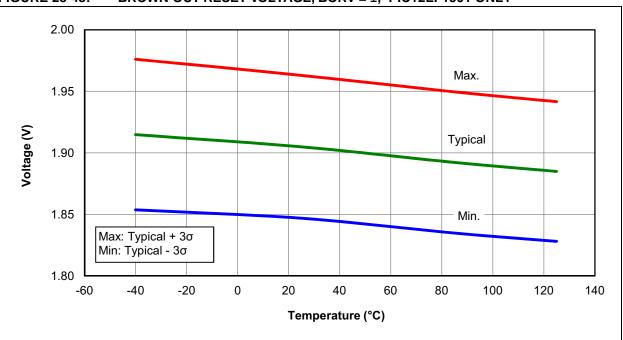






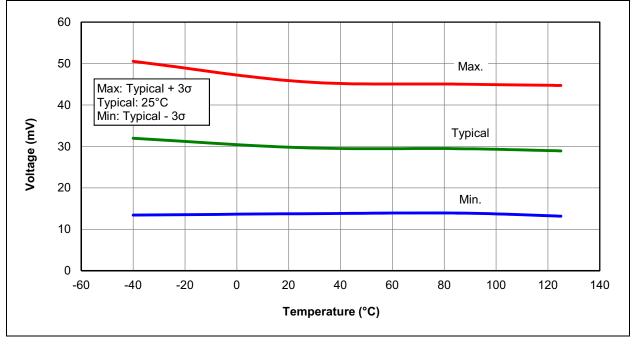


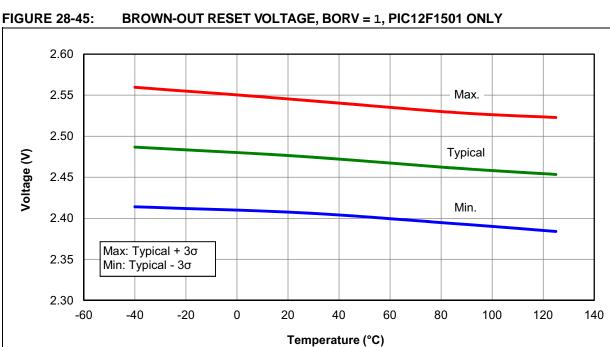




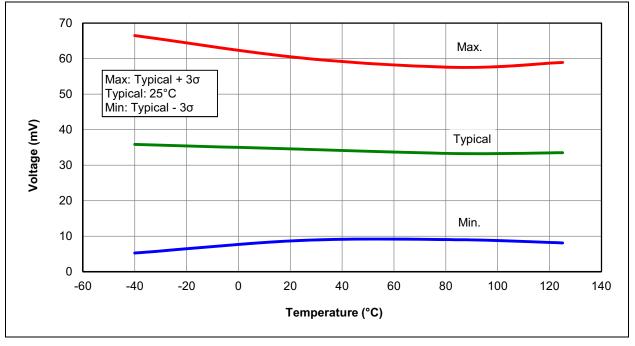




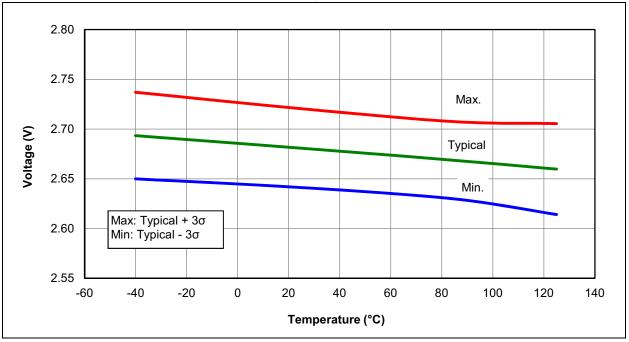












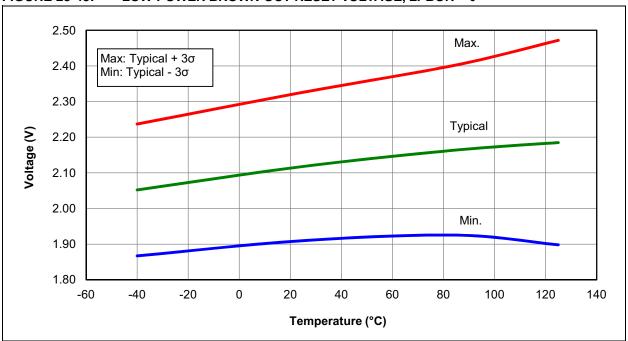
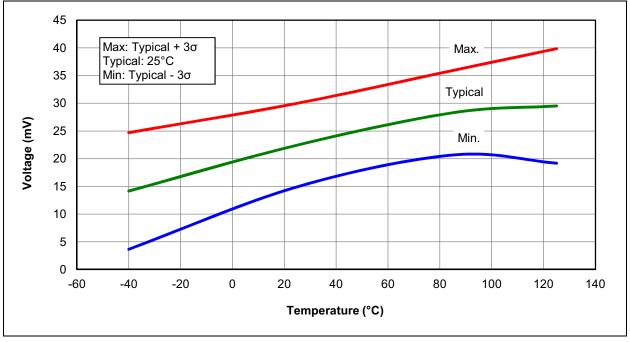
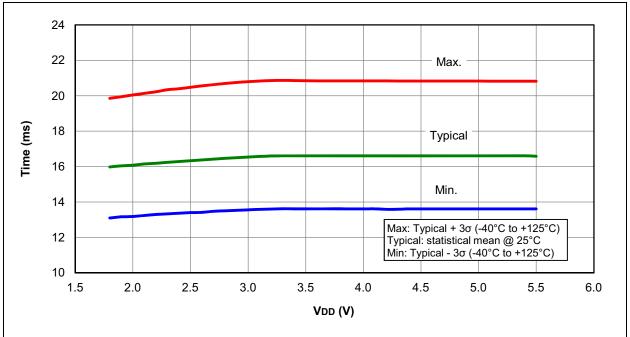


FIGURE 28-48: LOW-POWER BROWN-OUT RESET VOLTAGE, LPBOR = 0

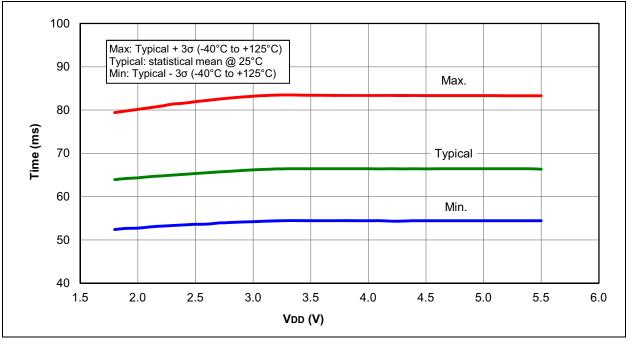




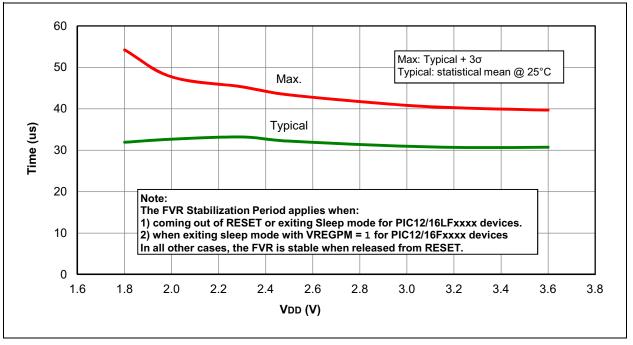












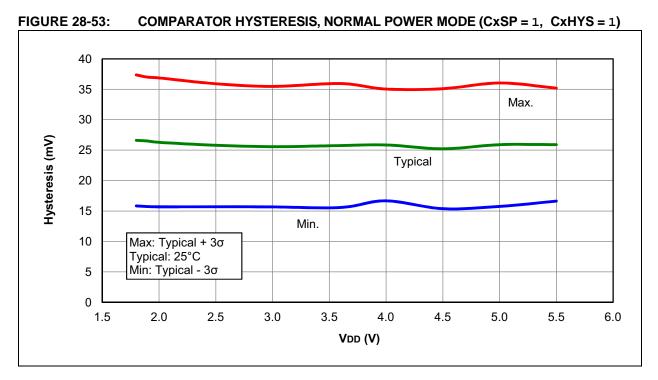
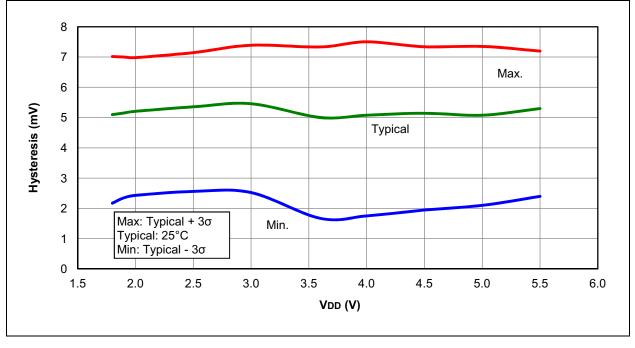


FIGURE 28-54: COMPARATOR HYSTERESIS, LOW-POWER MODE (CxSP = 0, CxHYS = 1)



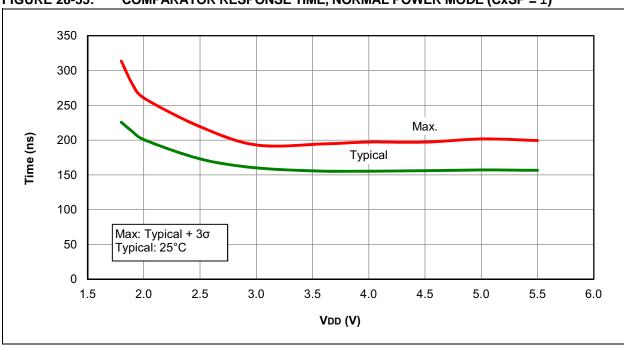
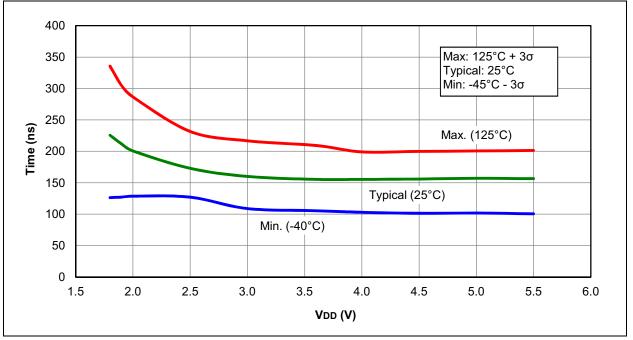
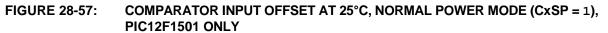
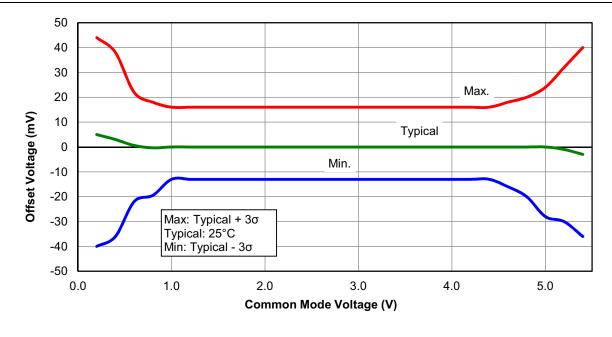


FIGURE 28-55: COMPARATOR RESPONSE TIME, NORMAL POWER MODE (CxSP = 1)











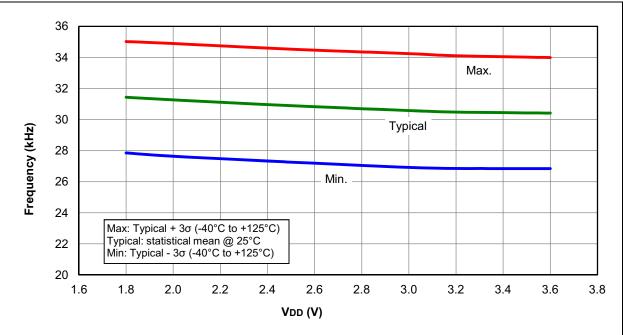
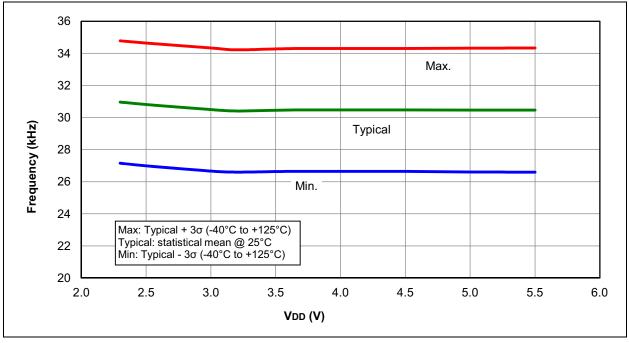
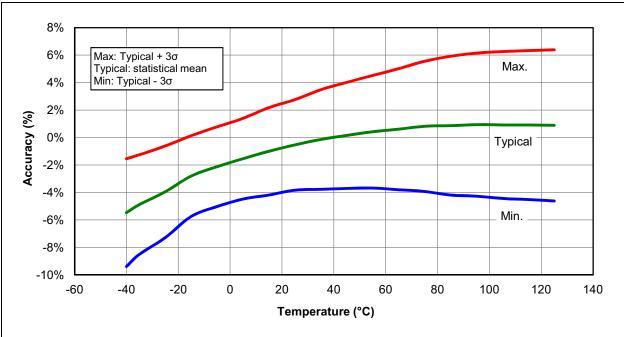


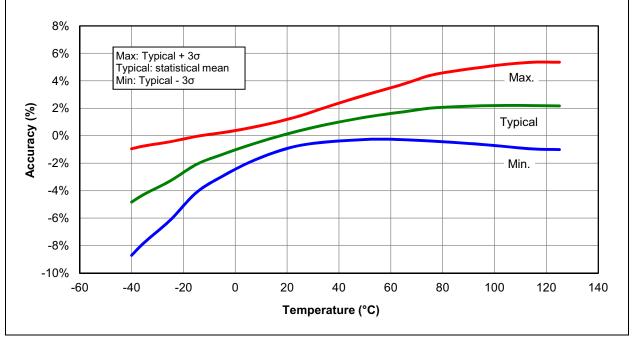
FIGURE 28-59: LFINTOSC FREQUENCY OVER VDD AND TEMPERATURE, PIC12F1501 ONLY











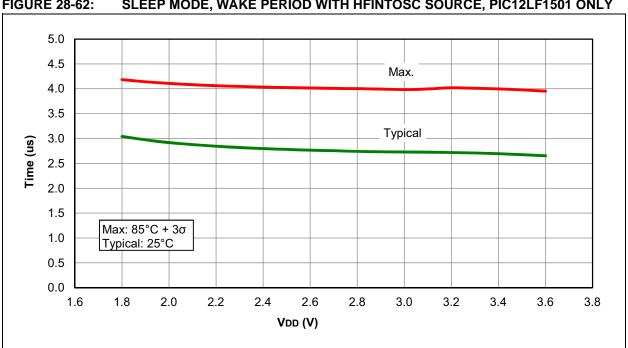
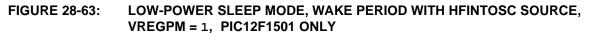


FIGURE 28-62: SLEEP MODE, WAKE PERIOD WITH HFINTOSC SOURCE, PIC12LF1501 ONLY



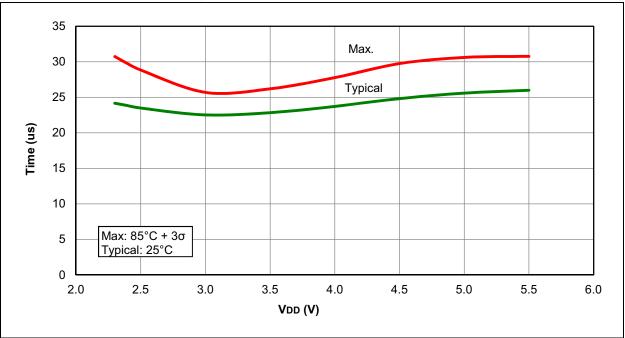
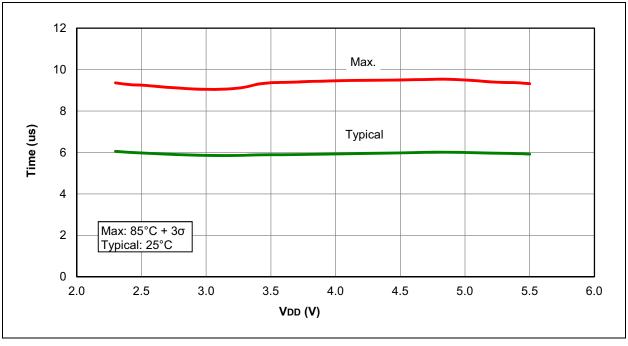


FIGURE 28-64: SLEEP MODE, WAKE PERIOD WITH HFINTOSC SOURCE, VREGPM = 0, PIC12F1501 ONLY



## 29.0 DEVELOPMENT SUPPORT

The PIC[®] microcontrollers (MCU) and dsPIC[®] digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- Integrated Development Environment
  - MPLAB[®] X IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB XC Compiler
  - MPASM[™] Assembler
  - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
  - MPLAB X SIM Software Simulator
- Emulators
- MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
  - MPLAB ICD 3
  - PICkit™ 3
- Device Programmers
- MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits and Starter Kits
- Third-party development tools

### 29.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows[®], Linux and Mac  $OS^{®}$  X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- · Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- · Call graph window

Project-Based Workspaces:

- · Multiple projects
- · Multiple tools
- Multiple configurations
- · Simultaneous debugging sessions

File History and Bug Tracking:

- · Local file history feature
- · Built-in support for Bugzilla issue tracker

#### 29.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- · Command-line interface
- Rich directive set
- Flexible macro language
- · MPLAB X IDE compatibility

#### 29.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel[®] standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline
   assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

#### 29.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

#### 29.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- · Command-line interface
- · Rich directive set
- · Flexible macro language
- · MPLAB X IDE compatibility

#### 29.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

### 29.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

#### 29.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a highspeed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

#### 29.9 PICkit 3 In-Circuit Debugger/ Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a fullspeed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming[™] (ICSP[™]).

### 29.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

#### 29.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM[™] and dsPICDEM[™] demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ[®] security ICs, CAN, IrDA[®], PowerSmart battery management, SEEVAL[®] evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

### 29.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

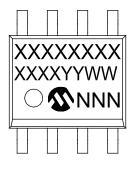
- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent[®] and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika[®]

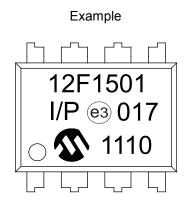
## **30.0 PACKAGING INFORMATION**

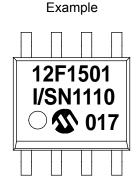
## 30.1 Package Marking Information

8-Lead PDIP (300 mil)

8-Lead SOIC (3.90 mm)







Legend:	XXX Y YY WW NNN @3	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ( $_{(e3)}$ ) can be found on the outer packaging for this package.
I	be carried	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

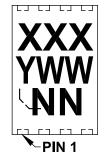
* Standard PICmicro[®] device marking consists of Microchip part number, year code, week code and traceability code. For PICmicro device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

## Package Marking Information (Continued)

8-Lead MSOP (3x3 mm)



8-Lead DFN (2x3x0.9 mm) 8-Lead UDFN (2x3x0.5 mm)



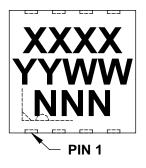
Example



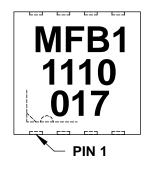
Example



8-Lead DFN (3x3x0.9 mm)



Example



# TABLE 30-1:8-LEAD 2x3 DFN (MC) TOP<br/>MARKING

Part Number	Marking
PIC12F1501-E/MC	BAK
PIC12F1501-I/MC	BAL
PIC12LF1501-E/MC	BAM
PIC12LF1501-I/MC	BAP

# TABLE 30-2:8-LEAD 3x3 DFN (MF) TOP<br/>MARKING

Part Number	Marking
PIC12F1501-E/MF	MFA1
PIC12F1501-I/MF	MFB1
PIC12LF1501-E/MF	MFC1
PIC12LF1501-I/MF	MFD1

# TABLE 30-3:8-LEAD 2X3 UDFN (MU) TOP<br/>MARKING

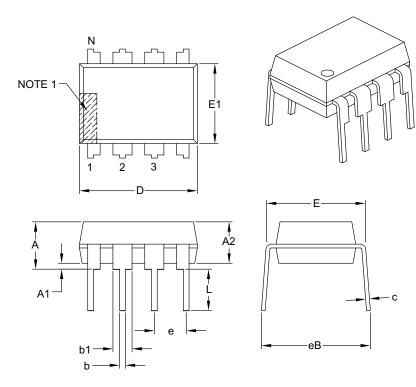
Part Number	Marking
PIC12F1501-E/MU	BAR
PIC12F1501-I/MU	BAQ
PIC12LF1501-E/MU	BAT
PIC12LF1501-I/MU	BAS

#### 30.2 Package Details

The following sections give the technical details of the packages.

### 8-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES		
Dimension	n Limits	MIN	NOM	MAX	
Number of Pins	Ν		8		
Pitch	е		.100 BSC		
Top to Seating Plane	А	-	-	.210	
Molded Package Thickness	A2	.115	.130	.195	
Base to Seating Plane	A1	.015	-	-	
Shoulder to Shoulder Width	E	.290	.310	.325	
Molded Package Width	E1	.240	.250	.280	
Overall Length	D	.348	.365	.400	
Tip to Seating Plane	L	.115	.130	.150	
Lead Thickness	С	.008	.010	.015	
Upper Lead Width	b1	.040	.060	.070	
Lower Lead Width	b	.014	.018	.022	
Overall Row Spacing §	eB	_	_	.430	

#### Notes:

1. Pin 1 visual index feature may vary, but must be located with the hatched area.

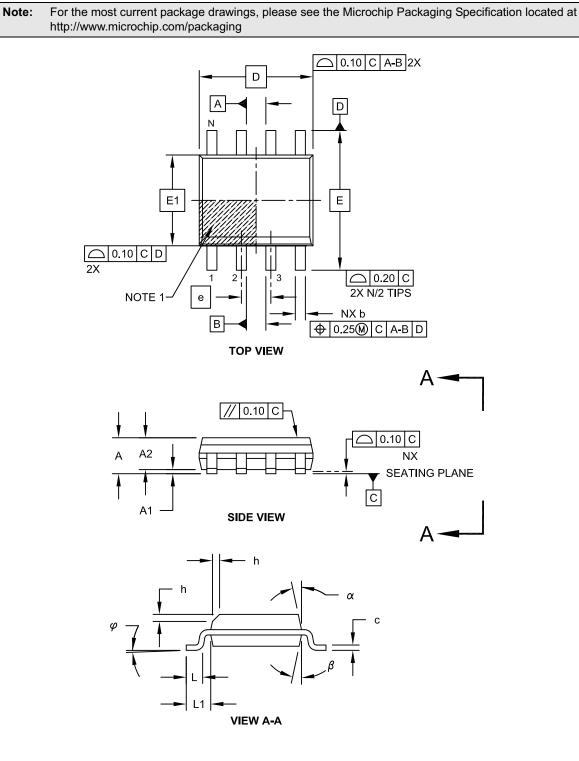
2. § Significant Characteristic.

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-018B

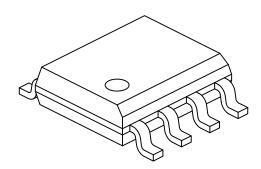


#### 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

Microchip Technology Drawing No. C04-057C Sheet 1 of 2

#### 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Number of Pins	Ν		8	
Pitch	е		1.27 BSC	
Overall Height	А	-	-	1.75
Molded Package Thickness	A2	1.25	-	-
Standoff §	A1	0.10	-	0.25
Overall Width	Е	6.00 BSC		
Molded Package Width	E1	3.90 BSC		
Overall Length	D	4.90 BSC		
Chamfer (Optional)	h	0.25	-	0.50
Foot Length	L	0.40	-	1.27
Footprint	L1	1.04 REF		
Foot Angle	φ	0°	-	8°
Lead Thickness	С	0.17	_	0.25
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. § Significant Characteristic

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.

4. Dimensioning and tolerancing per ASME Y14.5M

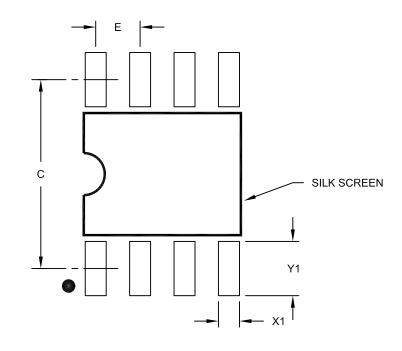
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2

### 8-Lead Plastic Small Outline (SN) – Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	С		5.40	
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

Notes:

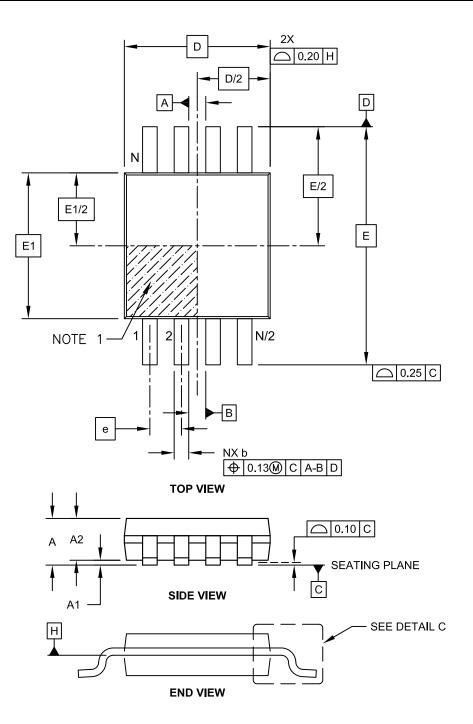
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

## 8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

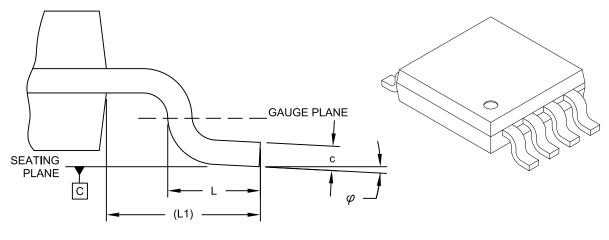
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-111C Sheet 1 of 2

#### 8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



DETAIL C

	MILLIMETERS				
Dimensior	Dimension Limits		NOM	MAX	
Number of Pins	N		8		
Pitch	е		0.65 BSC		
Overall Height	A	-	-	1.10	
Molded Package Thickness	A2	0.75	0.85	0.95	
Standoff	A1	0.00	-	0.15	
Overall Width	E	4.90 BSC			
Molded Package Width	E1	3.00 BSC			
Overall Length	D	3.00 BSC			
Foot Length	L	0.40	0.60	0.80	
Footprint	L1	0.95 REF			
Foot Angle	φ	0°	-	8°	
Lead Thickness	С	0.08	-	0.23	
Lead Width	b	0.22	-	0.40	

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or

protrusions shall not exceed 0.15mm per side. 3. Dimensioning and tolerancing per ASME Y14.5M.

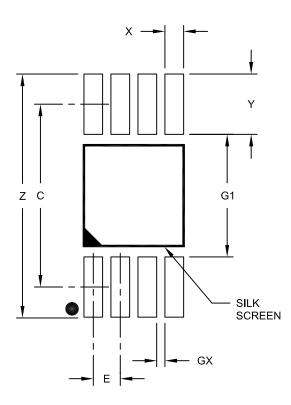
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-111C Sheet 2 of 2

## 8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



### RECOMMENDED LAND PATTERN

	Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX		
Contact Pitch E		0.65 BSC				
Contact Pad Spacing	С		4.40			
Overall Width	Z			5.85		
Contact Pad Width (X8)	X1			0.45		
Contact Pad Length (X8)	Y1			1.45		
Distance Between Pads	G1	2.95				
Distance Between Pads	GX	0.20				

Notes:

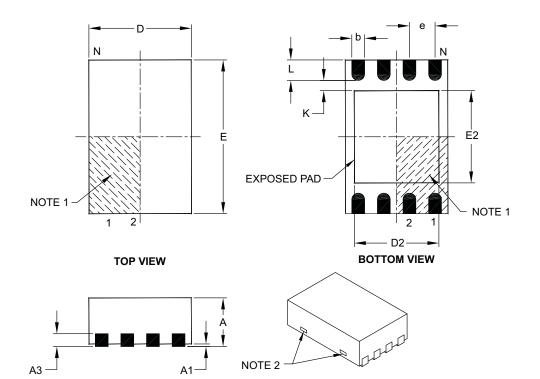
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2111A

#### 8-Lead Plastic Dual Flat, No Lead Package (MC) – 2x3x0.9 mm Body [DFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			MILLIMETERS		
Dimension Lir		MIN	NOM	MAX		
Number of Pins	N	N 8				
Pitch	e		0.50 BSC			
Overall Height	A	0.80	0.90	1.00		
Standoff	A1	0.00	0.02	0.05		
Contact Thickness	A3	0.20 REF				
Overall Length	D	2.00 BSC				
Overall Width	E	3.00 BSC				
Exposed Pad Length	D2	1.30	-	1.55		
Exposed Pad Width	E2	1.50	-	1.75		
Contact Width	b	0.20	0.25	0.30		
Contact Length	L	0.30	0.40	0.50		
Contact-to-Exposed Pad	К	0.20	-	-		

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package may have one or more exposed tie bars at ends.

- 3. Package is saw singulated.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

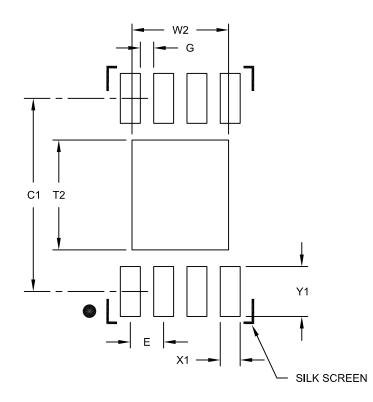
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-123C

8-Lead Plastic Dual Flat, No Lead Package (MC) - 2x3x0.9mm Body [DFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



### RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Optional Center Pad Width	W2			1.45
Optional Center Pad Length	T2			1.75
Contact Pad Spacing	C1	2.90		
Contact Pad Width (X8)	X1			0.30
Contact Pad Length (X8)	Y1			0.75
Distance Between Pads	G	0.20		

#### Notes:

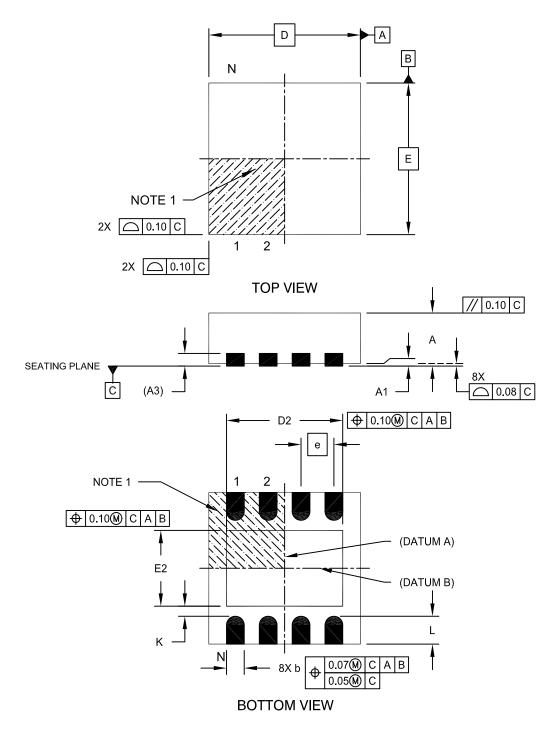
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2123B

#### 8-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

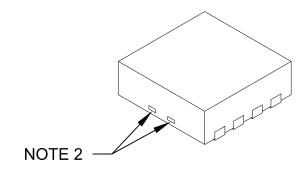
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing No. C04-062C Sheet 1 of 2

#### 8-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	8		
Pitch	е		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.20 REF		
Overall Length	D	3.00 BSC		
Exposed Pad Width	E2	1.34	-	1.60
Overall Width	E	3.00 BSC		
Exposed Pad Length	D2	1.60	-	2.40
Contact Width	b	0.25	0.30	0.35
Contact Length	L	0.20	0.30	0.55
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package may have one or more exposed tie bars at ends.

3. Package is saw singulated

4. Dimensioning and tolerancing per ASME Y14.5M

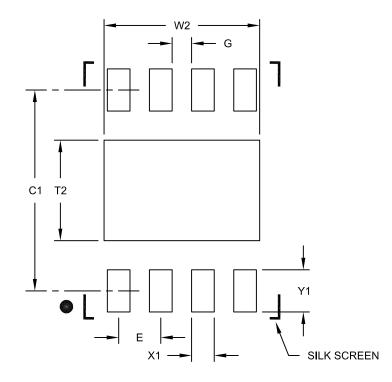
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-062C Sheet 2 of 2

#### 8-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



### RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Optional Center Pad Width	W2			2.40
Optional Center Pad Length	T2			1.55
Contact Pad Spacing	C1		3.10	
Contact Pad Width (X8)	X1			0.35
Contact Pad Length (X8)	Y1			0.65
Distance Between Pads	G	0.30		

Notes:

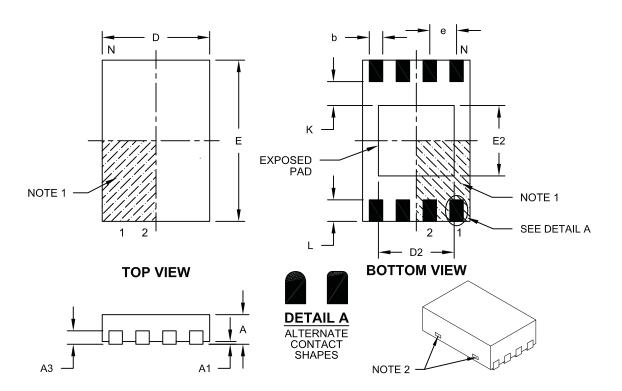
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2062B

#### 8-Lead Plastic Dual Flat, No Lead Package (MU) – 2x3x0.5 mm Body [UDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Pins	Ν		8	
Pitch	е		0.50 BSC	
Overall Height	А	0.45	0.50	0.55
Standoff	A1			0.07
Contact Thickness	A3		0.127 REF	
Overall Length	D	1.95	2.00	2.05
Overall Width	Е	2.95	3.00	3.05
Exposed Pad Length	D2	1.30	1.40	1.50
Exposed Pad Width	E2	1.20	1.30	1.40
Contact Width	b	0.20	0.25	0.30
Contact Length	L	0.25	0.30	0.35
Contact-to-Exposed Pad	К		0.55 REF	

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

- 2. Package may have one or more exposed tie bars at ends.
- 3. Package is saw singulated

4. Dimensioning and tolerancing per ASME Y14.5M

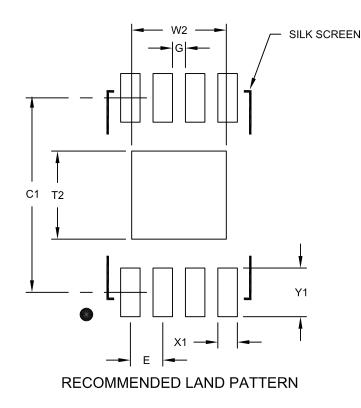
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-136B

#### 8-Lead Plastic Dual Flat, No Lead Package (MU) – 2x3x0.5 mm Body [UDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



				_		
	Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX		
Contact Pitch	E		0.50 BSC			
Optional Center Pad Width	W2			1.46		
Optional Center Pad Length	T2			1.36		
Contact Pad Spacing	C1		3.00			
Contact Pad Width (X8)	X1			0.30		
Contact Pad Length (X8)	Y1			0.75		
Distance Between Pads	G	0.20				

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2136A

## APPENDIX A: DATA SHEET REVISION HISTORY

### **Revision A (11/2011)**

Original release.

#### Revision B (04/2014)

Updated Electrical Specifications and added Characterization Data; Added UDFN package.

### **Revision C (10/2015)**

Added Section 3.2 High Endurance Flash. Updated Equation 15-1; Figure 24-1; Register 24-3; Sections 22.1.5, 24.9.1.2, 24.11.1, and 27.1; and Tables 1-2, 3-5, and 24-2. Updated Product Identification System section.

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Tape and Reel Option:Blank= Standard packaging (tube or tray) TExtended temperature, DFN packageTemperature Range:I= -40°C to+85°C (Industrial) (Extended)Extended temperature, DFN packagePackage:MC= Micro Lead Frame (DFN) 2x3 MF= Micro Lead Frame (DFN) 2x3 MSNote 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel office. Check with your Microchip Sales Office for package availability and marking information, please visit www.microchip.com/packaging or	Device:	PIC12LF1501, PIC12F1501		Industrial temperature
Range:       E       = -40°C to +125°C (Extended)         Package:       MC       = Micro Lead Frame (DFN) 2x3         MF       = Micro Lead Frame (DFN) 3x3         MS       = MSOP         MU       = Micro Lead Frame (DFN) 2x3         P       = Plastic DIP         SN       = SOIC         Pattern:       QTP, SQTP, Code or Special Requirements (blank otherwise)				Extended temperature,
MF       = Micro Lead Frame (DFN) 3x3         MS       = MSOP         MU       = Micro Lead Frame (UDFN) 2x3         P       = Plastic DIP         SN       = SOIC         Pattern:       QTP, SQTP, Code or Special Requirements (blank otherwise)    Pattern:          Pattern:       QTP, SQTP, Code or Special Requirements (blank otherwise)    Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.          2: For other small form-factor package availability and marking information, please visit www.microchip.com/packaging or		( ,		
Pattern:       QTP, SQTP, Code or Special Requirements (blank otherwise)       2:       For other small form-factor package availability and marking information, please visit www.microchip.com/packaging or	Package:	MF = Micro Lead Frame (DFN) 3x3 MS = MSOP MU = Micro Lead Frame (UDFN) 2x3 P = Plastic DIP		catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package
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